

AFE7953 2T2R RF Sampling AFE with 12GSPS DACs and 3GSPS ADCs

1 Features

- [Request full data sheet](#)
- Dual RF sampling 12GSPS transmit DACs
- Dual RF sampling 3GSPS receive ADCs
- Maximum RF signal bandwidth: 400MHz
- RF frequency range: 600MHz - 12GHz
- Digital step attenuators (DSA):
 - TX: 40dB range, 0.125dB steps
 - RX: 25dB range, 0.5dB steps
- Single or dual-band DUC or DDCs
- 16x NCOs per TX or RX
- Optional Internal PLL or VCO for DAC or ADC clocks or external clock at DAC or ADC sample rate
- SerDes data interface:
 - JESD204B and JESD204C compatible
 - 8 SerDes transceivers up to 29.5Gbps
 - Subclass 1 multi-device synchronization
- Package: 17mm × 17mm FCBGA, 0.8mm pitch

2 Applications

- [Radar](#)
- [Seeker front end](#)
- [Defense radio](#)
- Tactical communications infrastructure
- [Wireless communications test](#)

3 Description

The AFE7953 is a high performance, wide bandwidth multi-channel transceiver, integrating two RF sampling transmitter chains and two RF sampling receiver chains. With operation up to 12GHz, this device enables direct RF sampling in the L, S, C and X-band frequency ranges without the need for additional frequency conversions stages. This improvement in density and flexibility enables high-channel-count, multi-mission systems.

The TX signal paths support interpolation and digital up conversion options that deliver up to 400 MHz of signal bandwidth per TX channel. The output of the DUCs drives a 12GSPS DAC (digital to analog converter) with a mixed mode output option to enhance 2nd Nyquist operation. The DAC output includes a variable gain amplifier (TX DSA) with 40dB range and 1dB analog and 0.125dB digital steps.

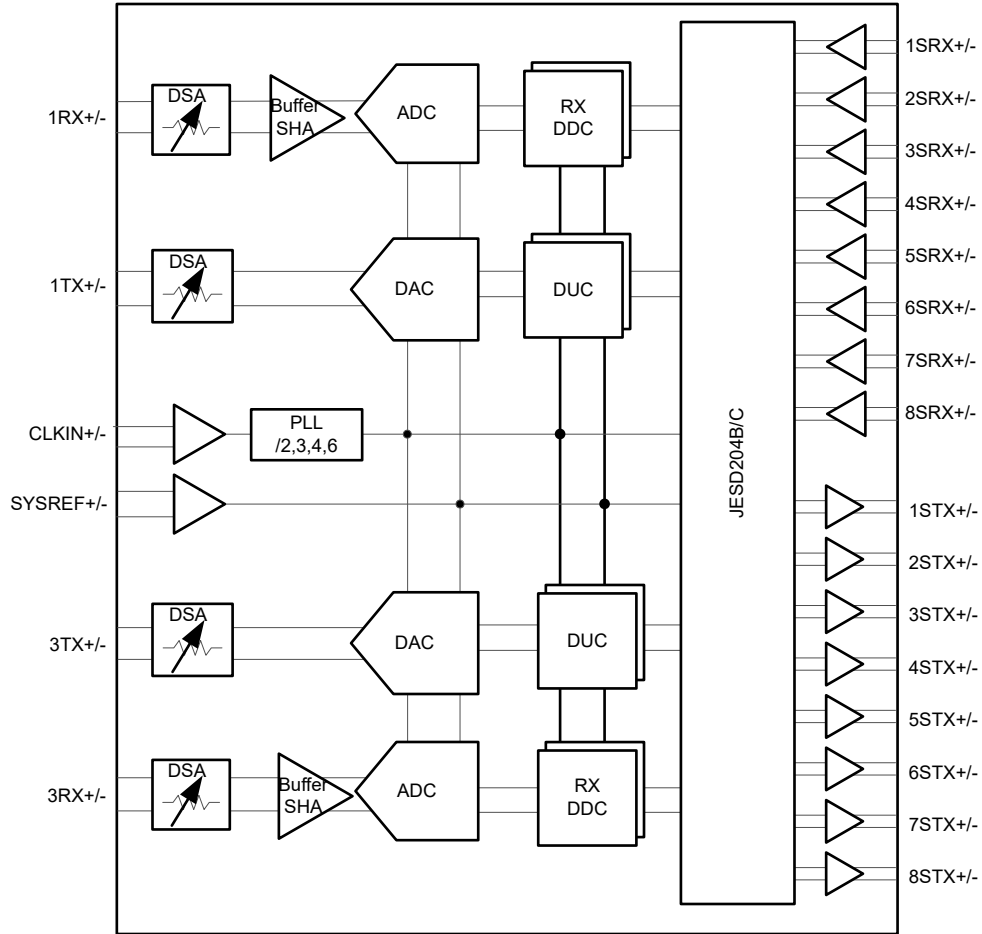
Each receiver chain includes a 25dB range DSA (Digital Step Attenuator), followed by a 3GSPS ADC (analog-to-digital converter). Each receiver channel has an analog peak power detector and various digital power detectors to assist an external or internal autonomous automatic gain controller, and RF overload detectors for device reliability protection. Flexible decimation options provide optimization of signal bandwidth of up to 400MHz per RX channel.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
AFE7953	FC-BGA	17mm × 17mm

- (1) For more information, see *Mechanical, Packaging, and Orderable Information*.
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.





Functional Block Diagram

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4 Specifications

4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Supply Voltage Range	DVDD0P9, VDDT0P9	-0.3	1.2	V
	VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2PLL, VDD1P2PLLCLKREF, VDD1P2FB, VDD1P2FBCML, VDD1P2RXCML	-0.3	1.4	V
	VDD1P8RX, VDD1P8RXCLK, VDD1P8TX, VDD1P8TXDAC, VDD1P8TXENC, VDD1P8PLL, VDD1P8PLLVC0, VDD1P8FB, VDD1P8FBCML, VDD1P8GPIO, VDDA1P8	-0.5	2.1	V
Pin Voltage Range	{1/2}RXIN+/-	-0.5	VDDR1P8+0.3	V
	{1/2}TXOUT+/-	-0.5	VDDTX1P8+0.3	V
	REFCLK+/-, SYSREF+/-	-0.3	1.4	V
	{1:8}SRX+/-	-0.3	1.4	V
	{1:8}STX+/-	-0.3	1.4	V
	GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESET, BISTB0, BISTB1	-0.5	VDD1P8GPIO + 0.3	V
	IFORCE, VSENSE	-0.3	VDDCLK1P8 + 0.3	V
SRDAMUX1, SRDAMUX2	-0.3	VDDA1P8+0.3	V	
P _{MAX} (XRXIN+/-)	Peak differential RF input power at device pins, f _{IN} = 830 MHz, DSA = 20dB		16.7	dBm
	Peak differential RF input power at device pins, f _{IN} = 1760 MHz, DSA = 20dB		17.0	dBm
	Peak differential RF input power at device pins, f _{IN} = 2610 MHz, DSA = 20dB		18	dBm
	Peak differential RF input power at device pins, f _{IN} = 3610 MHz, DSA = 20dB		18.5	dBm
	Peak differential RF input power at device pins, f _{IN} = 4910 MHz, DSA = 20dB		19.3	dBm
	Peak differential RF input power at device pins, f _{IN} = 8150 MHz, DSA = 20dB		21.3	dBm
	Peak differential RF input power at device pins, f _{IN} = 9610 MHz, DSA = 20dB		23.5	dBm
Peak Input Current	any input		20	mA
T _J	Junction temperature		150	°C
T _{stg}	Storage temperature	-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

4.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001, all pins ⁽¹⁾	1000	V
		Charged device model (CDM), per ANSI/ESDA/ JEDEC JS-002, all pins	150	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

4.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
DVDD0P9, VDDT0P9	Supply voltage 0.9V	0.9	0.925	0.95	V
VDD1P2{RX/TXCLK/TXENC/FB/PLL/ PLLCLKREF/FBCML/RXCML}	Supply voltage 1.2V	1.15	1.2	1.25	V
VDD1P8{RX/RXCLK/TX/TXDAC/ TXENC/PLL/PLLVCO/FB/FBCLK/ GPIO}, VDDA1P8	Supply voltage 1.8V	1.75	1.8	1.85	V
T _A	Ambient temperature	-40		85	°C
T _J	Operating Junction Temperature			110 ⁽¹⁾	°C
	Maximum Operating Junction Temperature	125			°C

- (1) Prolonged use at or above this junction temperature can increase the device failure-in-time (FIT) rate. Refer to [SBAA403 application note](#) for additional details

4.4 Thermal Information AFE79xx

THERMAL METRIC ⁽¹⁾		17mmx17mm FC-BGA	UNIT
		400 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	16.2	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	0.42	°C/W
R _{θJB}	Junction-to-board thermal resistance	4.85	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	0.12	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	4.6	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

4.5 Transmitter Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,MIN} = -40^\circ\text{C}$ to $T_{J,MAX} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{DAC} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC _{RES}	DAC resolution			14		bits
f _{RFout}	RF output frequency range	f _{DAC} = 12 GSPS, 1 st Nyquist	600		6000	MHz
		f _{DAC} = 12 GSPS, 2 nd Nyquist	6000		12000	
		f _{DAC} = 9 GSPS, 1 st Nyquist	600		4500	
		f _{DAC} = 9 GSPS, 2 nd Nyquist	4500		9000	
		f _{DAC} = 6 GSPS, 1 st Nyquist	600		3000	
		f _{DAC} = 6 GSPS, 2 nd Nyquist	3000		6000	
P _{max_FS}	Max Full Scale Output Power, max gain 1 tone, at device pins	f _{out} = 850 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS		4.2		dBm
		f _{out} = 1800 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS		4.6		dBm
		f _{out} = 2600 MHz, f _{DAC} = 8847.36 MSPS, -0.5dBFS		4.0		dBm
		f _{out} = 3500 MHz, -0.5dBFS		3.9		dBm
		f _{out} = 4900 MHz, -0.5dBFS		3.1		dBm
		f _{out} = 3500 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		1.0		dBm
		f _{out} = 4900 MHz, f _{DAC} = 5898.24 MSPS, -0.5dBFS, straight mode		0.1		dBm
		f _{out} = 4900 MHz, f _{DAC} = 8847.36 MSPS, -0.5dBFS, straight mode		-0.7		dBm
		f _{out} = 8100 MHz, -0.1dBFS, mixed mode		-2.8		dBm
		f _{out} = 9600 MHz, -0.1dBFS, mixed mode		-4.3		dBm
R _{TERM}	Output termination resistor	Default setting		50		Ω
ATT _{range}	DSA Attenuation range			40		dB
ATT _{step}	DSA Analog Attenuation step			1.0		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, before calibration		±0.2		dB
	DSA Attenuation step accuracy (DNL)	0 < Atten < 40dB, after calibration		±0.1		dB
ATT _{phase-err}	DSA Gain Steps Phase accuracy, any 8dB range	f _{out} = 850MHz ⁽¹⁾		±1		deg
		f _{out} = 1800MHz ⁽¹⁾		±1		deg
		f _{out} = 2600MHz ⁽¹⁾		±1		deg
		f _{out} = 3500MHz ⁽¹⁾		±1		deg
		f _{out} = 4900MHz ⁽¹⁾		±1		deg
		f _{out} = 8100MHz ⁽¹⁾		±2		deg
		f _{out} = 9600MHz ⁽¹⁾		±2		deg
G _{flat}	Gain flatness	any 20MHz		0.1		dB
		600MHz BW, F _{out} < 4.9G		1.2		

4.5 Transmitter Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
IMD3	3rd Order Intermodulation distortion, 2 tones at $f_{\text{IF}} \pm 10$ MHz	$f_{\text{out}} = 850\text{MHz}$, -7dBFS each tone		-66		dBc
		$f_{\text{out}} = 1800\text{MHz}$, -7dBFS each tone		-63		dBc
		$f_{\text{out}} = 2600\text{MHz}$, -7dBFS each tone		-62		dBc
		$f_{\text{out}} = 3500\text{MHz}$, -7dBFS each tone		-61		dBc
		$f_{\text{out}} = 4900\text{MHz}$, -7dBFS each tone		-57		dBc
		$f_{\text{out}} = 8100\text{MHz}$, -7dBFS each tone		-55		dBc
		$f_{\text{out}} = 9600\text{MHz}$, -7dBFS each tone		-52		dBc
		$f_{\text{out}} = 850\text{MHz}$, -13dBFS each tone		-74.4		dBc
		$f_{\text{out}} = 1800\text{MHz}$, -13dBFS each tone		-71.1		dBc
		$f_{\text{out}} = 2600\text{MHz}$, -13dBFS each tone		-73		dBc
		$f_{\text{out}} = 3500\text{MHz}$, -13dBFS each tone		-72		dBc
		$f_{\text{out}} = 4900\text{MHz}$, -13dBFS each tone		-67.8		dBc
		$f_{\text{out}} = 8100\text{MHz}$, -13dBFS each tone		-64		dBc
		$f_{\text{out}} = 9600\text{MHz}$, -13dBFS each tone		-68		dBc
SFDR	Spurious Free Dynamic Range (within Nyquist zone)	$f_{\text{out}} = 850$ MHz		50.8		dBc
		$f_{\text{out}} = 1800$ MHz		51.9		dBc
		$f_{\text{out}} = 2600$ MHz		42		dBc
		$f_{\text{out}} = 3500$ MHz		44		dBc
		$f_{\text{out}} = 4900$ MHz		46.1		dBc
$f_{\text{S}}/2 - f_{\text{OUT}}$	Interleaving Image	$f_{\text{DAC}} = 5898.24\text{MSPS}$, interleave mode		-51.9		dBc
		$f_{\text{DAC}} = 8847.36$ MSPS, interleave mode		-46.0		dBc
		$f_{\text{DAC}} = 11796.48\text{MSPS}$, interleave mode		-41		dBc
HD2	2nd Harmonic Distortion (within Nyquist zone)	$f_{\text{out}} = 850$ MHz		-49		dBc
		$f_{\text{out}} = 1800$ MHz		-53		dBc
		$f_{\text{out}} = 2600$ MHz		-50		dBc
		$f_{\text{out}} = 3500$ MHz		-48		dBc
		$f_{\text{out}} = 4900$ MHz		-47		dBc
		$f_{\text{out}} = 8100$ MHz		-50		dBc
		$f_{\text{out}} = 9600$ MHz		-53		dBc
		$f_{\text{out}} = 850$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-60		dBc
		$f_{\text{out}} = 1800$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-64		dBc
		$f_{\text{out}} = 2600$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-45		dBc
		$f_{\text{out}} = 3500$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-57		dBc
		$f_{\text{out}} = 4900$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-58		dBc
		$f_{\text{out}} = 8100$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-60		dBc
		$f_{\text{out}} = 9600$ MHz, $A_{\text{OUT}} = -12\text{dBFS}$		-62		dBc

4.5 Transmitter Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,MIN} = -40^\circ\text{C}$ to $T_{J,MAX} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{DAC} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD3	3rd Harmonic Distortion (within Nyquist zone)	$f_{out} = 850\text{ MHz}$		-62		dBc
		$f_{out} = 1800\text{ MHz}$		-55		dBc
		$f_{out} = 2600\text{ MHz}$		-57		dBc
		$f_{out} = 3500\text{ MHz}$		-60		dBc
		$f_{out} = 4900\text{ MHz}$		-54		dBc
		$f_{out} = 8100\text{ MHz}$		-54		dBc
		$f_{out} = 9600\text{ MHz}$		-56		dBc
		$f_{out} = 850\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-80		dBc
		$f_{out} = 1800\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-79		dBc
		$f_{out} = 2600\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-77		dBc
		$f_{out} = 3500\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-77		dBc
		$f_{out} = 4900\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-78		dBc
		$f_{out} = 8100\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-82		dBc
$f_{out} = 9600\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-80		dBc		
HDn, n >= 4	Harmonic Distortion n >= 4 (within Nyquist zone)	$f_{out} = 850\text{ MHz}$		-81		dBc
		$f_{out} = 1800\text{ MHz}$		-88		dBc
		$f_{out} = 2600\text{ MHz}$		-86		dBc
		$f_{out} = 3500\text{ MHz}$		-79		dBc
		$f_{out} = 4900\text{ MHz}$		-86		dBc
		$f_{out} = 8100\text{ MHz}$		-87		dBc
		$f_{out} = 9600\text{ MHz}$		-85		dBc
		$f_{out} = 850\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-93		dBc
		$f_{out} = 1800\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-98		dBc
		$f_{out} = 2600\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-84		dBc
		$f_{out} = 3500\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-87		dBc
		$f_{out} = 4900\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-87		dBc
		$f_{out} = 8100\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-87		dBc
$f_{out} = 9600\text{ MHz}, A_{OUT} = -12\text{dBFS}$		-87		dBc		
SFDR +/- 250 MHz	Spurious Free Dynamic Range within +/- 250 MHz	$f_{out} = 850\text{ MHz}$		68.5		dBc
		$f_{out} = 1800\text{ MHz}$		79.4		dBc
		$f_{out} = 2600\text{ MHz}$		77		dBc
		$f_{out} = 3500\text{ MHz}$		75		dBc
		$f_{out} = 4900\text{ MHz}$		76		dBc
		$f_{out} = 8100\text{ MHz}$		61		dBc
		$f_{out} = 9600\text{ MHz}$		64		dBc
$f_s/4$	Fixed Spur	$f_{DAC} = 5898.24\text{MSPS}$		-64		dBFS
		$f_{DAC} = 8847.36\text{MSPS}$		-75		dBFS
		$f_{DAC} = 11796.48\text{MSPS}$		-67		dBFS
$f_s/2$	Fixed Spur	$f_{DAC} = 5898.24\text{MSPS}$		-49		dBFS
		$f_{DAC} = 8847.36\text{MSPS}$		-48		dBFS
		$f_{DAC} = 11796.48\text{MSPS}$		-48		dBFS

4.5 Transmitter Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
3*f _S /4	Fixed Spur	2nd Nyquist, f _{DAC} = 5898.24MSPS		-76		dBFS
		2nd Nyquist, f _{DAC} = 8847.36MSPS		-89		dBFS
		2nd Nyquist, f _{DAC} = 11796.48MSPS		-63		dBFS
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f _{out} = 0.85 GHz	Atten=0dB, Pout=-13dBFS		-68.5		dBc
		Atten=20dB, Pout=-13dBFS		-67.2		dBc
		Atten=28dB, Pout=-13dBFS		-64.5		dBc
		Atten=39dB, Pout=-13dBFS		-53.9		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f _{out} = 1.8425 GHz	Atten=0dB, Pout=-13dBFS		-70.7		dBc
		Atten=20dB, Pout=-13dBFS		-68.3		dBc
		Atten=28dB, Pout=-13dBFS		-62.9		dBc
		Atten=39dB, Pout=-13dBFS		-52.0		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f _{out} = 2.6 GHz	Atten=0dB, Pout=-13dBFS		-71		dBc
		Atten=20dB, Pout=-13dBFS		-68		dBc
		Atten=28dB, Pout=-13dBFS		-62		dBc
		Atten=39dB, Pout=-13dBFS		-51.3		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f _{out} = 3.5 GHz	Atten=0dB, Pout=-13dBFS		-70		dBc
		Atten=20dB, Pout=-13dBFS		-67		dBc
		Atten=28dB, Pout=-13dBFS		-60		dBc
		Atten=39dB, Pout=-13dBFS		-49.8		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, LTE 20MHz E-TM1.1 carrier f _{out} = 4.9 GHz	Atten=0dB, Pout=-13dBFS		-68.8		dBc
		Atten=20dB, Pout=-13dBFS		-65.9		dBc
		Atten=28dB, Pout=-13dBFS		-60.6		dBc
		Atten=39dB, Pout=-13dBFS		-49.5		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f _{out} = 2.6 GHz	Atten=0dB, Pout=-13dBFS		-65		dBc
		Atten=20dB, Pout=-13dBFS		-62		dBc
		Atten=20dB, Pout=-13dBFS		-55		dBc
		Atten=39dB, Pout=-13dBFS		-44.3		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f _{out} = 3.5 GHz	Atten=0dB, Pout=-13dBFS		-64		dBc
		Atten=20dB, Pout=-13dBFS		-59		dBc
		Atten=28dB, Pout=-13dBFS		-52		dBc
		Atten=39dB, Pout=-13dBFS		-41.1		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f _{out} = 4.9 GHz	Atten=0dB, Pout=-13dBFS		-64.1		dBc
		Atten=20dB, Pout=-13dBFS		-60.4		dBc
		Atten=28dB, Pout=-13dBFS		-53.5		dBc
		Atten=39dB, Pout=-13dBFS		-42.5		dBc
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier f _{out} = 8.1 GHz	Atten=0dB, Pout=-13dBFS		-58		dBc
		Atten=20dB, Pout=-13dBFS		-53		dBc
		Atten=28dB, Pout=-13dBFS		-46		dBc
		Atten=39dB, Pout=-13dBFS		-36		dBc

4.5 Transmitter Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ACPR _{1xcarr}	ACPR - 1 carrier, NR 100MHz E-TM1.1 carrier $f_{\text{out}} = 9.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-57		dBc
		Atten=20dB, Pout=-13dBFS		-50		dBc
		Atten=28dB, Pout=-13dBFS		-42		dBc
		Atten=39dB, Pout=-13dBFS		-31		dBc
EVM	Error Vector Magnitude, 1x 20MHz E-TM3.1/3.1a, no ref. clock noise	$F_{\text{out}} = 0.85\text{ GHz}$, $P_{\text{OUT}} = -13\text{dBFS}$		0.2		%
		$F_{\text{out}} = 1.8425\text{ GHz}$, $P_{\text{OUT}} = -13\text{dBFS}$		0.3		%
		$F_{\text{out}} = 2.6\text{ GHz}$, $P_{\text{OUT}} = -13\text{dBFS}$		0.28		%
		$F_{\text{out}} = 3.5\text{ GHz}$, $P_{\text{OUT}} = -13\text{dBFS}$		0.38		%
		$F_{\text{out}} = 4.9\text{ GHz}$, $P_{\text{OUT}} = -13\text{dBFS}$		0.4		%
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 0.85\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-157.6		dBFS/Hz
		Atten=20dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-153.3		dBFS/Hz
		Atten=28dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-147.9		dBFS/Hz
		Atten=39dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-136.9		dBFS/Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 1.8\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-158.4		dBFS/Hz
		Atten=20dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-152.2		dBFS/Hz
		Atten=28dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-145.6		dBFS/Hz
		Atten=39dB, $f_{\text{DAC}} = 5898.24\text{MSPS}$, Pout=-13dBFS		-134.6		dBFS/Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $f_{\text{OUT}} = 2.6\text{ GHz}$	Atten=0dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, Pout=-13dBFS		-157		dBFS/Hz
		Atten=20dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, Pout=-13dBFS		-151		dBFS/Hz
		Atten=28dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, Pout=-13dBFS		-144		dBFS/Hz
		Atten=39dB, $f_{\text{DAC}} = 8847.36\text{MSPS}$, Pout=-13dBFS		-133.0		dBFS/Hz
NSD _{dBFS}	Noise Spectral Density 20MHz offset $F_{\text{out}} = 3.5\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-158		dBFS/Hz
		Atten=20dB, Pout=-13dBFS		-150		dBFS/Hz
		Atten=28dB, Pout=-13dBFS		-143		dBFS/Hz
		Atten=39dB, Pout=-13dBFS		-131.8		dBFS/Hz

4.5 Transmitter Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{DAC}} = 11796.48\text{MSPS}$; PLL clock mode below 6GHz output frequency and External clock mode above 6GHz output frequency; interleave mode for 1st Nyquist, non-interleave mix mode for 2nd Nyquist, nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation =0dB; SerDes rate = 16.22Gbps, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NSD _{dBFS}	Noise Spectral Density 20MHz offset $F_{\text{out}} = 4.9\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-155.5		dBFS/ Hz
		Atten=20dB, Pout=-13dBFS		-147.8		dBFS/ Hz
		Atten=28dB, Pout=-13dBFS		-140.8		dBFS/ Hz
		Atten=39dB, Pout=-13dBFS		-129.6		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 50MHz offset $F_{\text{out}} = 8.1\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-153		dBFS/ Hz
		Atten=20dB, Pout=-13dBFS		-147		dBFS/ Hz
		Atten=28dB, Pout=-13dBFS		-140		dBFS/ Hz
		Atten=39dB, Pout=-13dBFS		-129		dBFS/ Hz
NSD _{dBFS}	Noise Spectral Density 50MHz offset $F_{\text{out}} = 9.6\text{ GHz}$	Atten=0dB, Pout=-13dBFS		-152		dBFS/ Hz
		Atten=20dB, Pout=-13dBFS		-147		dBFS/ Hz
		Atten=28dB, Pout=-13dBFS		-140		dBFS/ Hz
		Atten=39dB, Pout=-13dBFS		-129		dBFS/ Hz
S22	Output Return Loss, <6GHz, +/- fc * 10%	with matching		-17		dB
	Output Return Loss, >8GHz, +/- fc * 10%	with matching		-10		dB
PN _{TXADD}	Additive Phase Noise External Clock Mode ⁽²⁾	$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{Hz}$		-88		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 1\text{kHz}$		-102		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 10\text{kHz}$		-110		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{kHz}$		-123		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 1\text{MHz}$		-136		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 10\text{MHz}$		-143		dBc/Hz
		$f_{\text{out}} = 9.6\text{GHz}$, $f_{\text{OFFSET}} = 100\text{MHz}$		-146		dBc/Hz

- (1) After DSA calibration procedure
 (2) Single side band, input clock phase noise subtracted.

4.6 RF ADC Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,MIN} = -40^\circ\text{C}$ to $T_{J,MAX} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{ADC} = 2949.12\text{MSPS}$; PLL clock mode with $f_{REF} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{CLK} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate =24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADC _{RES}	ADC resolution			14		bits
F _{RFin}	RF input frequency range		600		12000	MHz
P _{FS_CW,min}	Min Full scale input power, at device pins (1)	f _{IN} = 830 MHz, DSA=0dB		-2.9		dBm
		f _{IN} = 1760 MHz, DSA=0dB		-2.8		dBm
		f _{IN} = 2610 MHz, DSA=0dB		-1.8		dBm
		f _{IN} = 3610 MHz, DSA=0dB		-0.4		dBm
		f _{IN} = 4910 MHz, DSA=0dB		0.1		dBm
		f _{IN} = 8150 MHz, DSA=0dB		2.1		dBm
		f _{IN} = 9610 MHz, DSA=0dB		4.3		dBm
S11	Input Return Loss	with matching network		-12.0		dB
ATT _{range}	DSA Attenuation range			25.0		dB
ATT _{step}	DSA Attenuation step			0.5		dB
	DSA Attenuation step accuracy	Delta=Gatt(X)-Gatt(X-1), F _{in} =3610MHz, after calibration		±0.1		dB
	DSA Gain Steps Phase accuracy any 8dB range	F _{in} =3610MHz, after calibration		±0.9		deg
	DSA Gain Steps Phase accuracy any 8dB range	F _{in} =4910MHz, after calibration		±1.8		deg
NSD	Noise Density (small signal)	f _{IN} = 830 MHz, DSA = 3dB ⁽³⁾		-155.2		dBFS/Hz
		f _{IN} = 1760 MHz, DSA = 3dB ⁽³⁾		-155.0		dBFS/Hz
		f _{IN} = 2610 MHz, DSA = 3dB ⁽³⁾		-154.4		dBFS/Hz
		f _{IN} = 3610 MHz, DSA = 3dB ⁽³⁾		-154.1		dBFS/Hz
		f _{IN} = 4910 MHz, DSA = 3dB ⁽³⁾		-155.1		dBFS/Hz
		f _{IN} = 8150 MHz, DSA = 3dB ⁽³⁾		-150		dBFS/Hz
		f _{IN} = 9610 MHz, DSA = 3dB ⁽³⁾		-151		dBFS/Hz
		f _{IN} = 830 MHz, 3<=Atten<=22		-156.0		dBFS/Hz
		f _{IN} = 1760 MHz, 3<=Atten<=25		-155.8		dBFS/Hz
		f _{IN} = 2610 MHz, 3<=Atten<=25		-155.7		dBFS/Hz
		f _{IN} = 3610 MHz, 3<=Atten<=25		-155.4		dBFS/Hz
		f _{IN} = 4910 MHz, 3<=Atten<=25		-155.8		dBFS/Hz
		f _{IN} = 8150 MHz, 3<=Atten<=25		-152.5		dBFS/Hz
		f _{IN} = 9610 MHz, 3<=Atten<=25		-152.5		dBFS/Hz
NF _{min}	Noise Figure min DSA Atten=0 - 3dB	f _{IN} = 830 MHz		19.1		dB
		f _{IN} = 1760 MHz		19.0		dB
		f _{IN} = 2610 MHz		20.9		dB
		f _{IN} = 3610 MHz		22.8		dB
		f _{IN} = 4910 MHz		22.4		dB
		f _{IN} = 8150 MHz		27.3		dB
		f _{IN} = 9610 MHz		30		dB

4.6 RF ADC Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
NF	Noise Figure DSA Atten=4dB	$f_{\text{IN}} = 830\text{ MHz}^{(4)}$		20.0		dB
		$f_{\text{IN}} = 1760\text{ MHz}^{(4)}$		20.6		dB
		$f_{\text{IN}} = 2610\text{ MHz}^{(4)}$		21.9		dB
		$f_{\text{IN}} = 3610\text{ MHz}^{(4)}$		23.5		dB
		$f_{\text{IN}} = 4910\text{ MHz}^{(4)}$		22.3		dB
		$f_{\text{IN}} = 8150\text{ MHz}^{(4)}$		27.9		dB
		$f_{\text{IN}} = 9610\text{ MHz}^{(4)}$		30.7		dB
NF _{max}	Noise Figure DSA Atten=20dB	$f_{\text{IN}} = 830\text{ MHz}$		34.7		dB
		$f_{\text{IN}} = 1760\text{ MHz}$		35.2		dB
		$f_{\text{IN}} = 2610\text{ MHz}$		36.0		dB
		$f_{\text{IN}} = 3610\text{ MHz}$		37.3		dB
		$f_{\text{IN}} = 4910\text{ MHz}$		37.6		dB
		$f_{\text{IN}} = 8150\text{ MHz}$		42.8		dB
		$f_{\text{IN}} = 9610\text{ MHz}$		45		dB
IMD3	3 rd order intermodulation 2 tones at at $f_{\text{IN}} \pm 10\text{MHz}$ -7dBFS each tone	$f_{\text{IN}} = 840\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-82.4		dBc
		$f_{\text{IN}} = 1770\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-84.1		dBc
		$f_{\text{IN}} = 2610\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-74		dBc
		$f_{\text{IN}} = 3610\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-77		dBc
		$f_{\text{IN}} = 4920\text{ MHz}, 3 \leq \text{Atten} \leq 12$		-75.9		dBc
		$f_{\text{IN}} = 8150\text{ MHz}, 3 \leq \text{Atten} \leq 12$, 25MHz tone spacing		-55		dBc
		$f_{\text{IN}} = 9610\text{ MHz}, 3 \leq \text{Atten} \leq 12$, 25MHz tone spacing		-60		dBc
SFDR	Spurious Free Dynamic Range within output bandwidth, $A_{\text{IN}} = -3$ dBFS	$f_{\text{IN}} = 830\text{ MHz}$		88.2		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		80.6		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		84		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		78.9		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		78		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		71		dBFS
HD2	2nd Harmonic Distortion $A_{\text{IN}} = -3\text{ dBFS}^{(2) (5)}$	$f_{\text{IN}} = 830\text{ MHz}$		-85.5		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-90.5		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-87		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-84.2		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-70		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-70		dBFS

4.6 RF ADC Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD3	3rd Harmonic Distortion $A_{\text{IN}} = -3\text{ dBFS}^{(5)}$	$f_{\text{IN}} = 830\text{ MHz}$		-80.2		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-85.3		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-86		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-78		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-75.4		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-70		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-70		dBFS
HDn, n>3	SFDR excl. HD2 and HD3 $A_{\text{IN}} = -3\text{ dBFS}^{(5)}$	$f_{\text{IN}} = 830\text{ MHz}$		-88.2		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-80.6		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-88		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-84		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-81.7		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-78		dBFS
SFDR	Spurious Free Dynamic Range $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16$	$f_{\text{IN}} = 830\text{ MHz}$		89.2		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		88.8		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		95		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		90		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		89.8		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		83		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		80		dBFS
HD2	2nd Harmonic Distortion $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16^{(5)}$	$f_{\text{IN}} = 830\text{ MHz, with board trim}$		-79.0		dBFS
		$f_{\text{IN}} = 1760\text{ MHz, with board trim}$		-101.6		dBFS
		$f_{\text{IN}} = 2610\text{ MHz, with board trim}$		-100		dBFS
		$f_{\text{IN}} = 3610\text{ MHz, with board trim}$		-101		dBFS
		$f_{\text{IN}} = 4910\text{ MHz, with board trim}$		-99.1		dBFS
		$f_{\text{IN}} = 8150\text{ MHz, with board trim}$		-107		dBFS
HD3	3rd Harmonic Distortion $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16^{(5)}$	$f_{\text{IN}} = 830\text{ MHz}$		-95.4		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-95.2		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-98		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-97		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-94		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-100		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-102		dBFS

4.6 RF ADC Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; RX Output Rate = 491.52MSPS below 6GHz, 500MSPS above 6GHz, $f_{\text{ADC}} = 2949.12\text{MSPS}$; PLL clock mode with $f_{\text{REF}} = 491.52\text{MHz}$ below 6GHz input frequency and External clock mode with $f_{\text{CLK}} = 11796.48\text{MHz}$ above 6GHz input frequency; nominal power supplies; DSA Setting = 4dB below 6GHz and 3dB above 6GHz; SerDes rate = 24.33Gbps; unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
HD _n , n>3	SFDR excl. HD2 and HD3 $A_{\text{IN}} = -13\text{ dBFS}$ $0 \leq \text{Atten} \leq 16^{(5)}$	$f_{\text{IN}} = 830\text{ MHz}$		-89.2		dBFS
		$f_{\text{IN}} = 1760\text{ MHz}$		-88.8		dBFS
		$f_{\text{IN}} = 2610\text{ MHz}$		-95		dBFS
		$f_{\text{IN}} = 3610\text{ MHz}$		-90		dBFS
		$f_{\text{IN}} = 4910\text{ MHz}$		-90		dBFS
		$f_{\text{IN}} = 8150\text{ MHz}$		-83		dBFS
		$f_{\text{IN}} = 9610\text{ MHz}$		-80		dBFS

- (1) The input fullscale at minimum attenuation can be reduce by adding a digital gain range to the DSA, extending the useful range of the DSA. The noise figure remains constant over the digital gain range.
- (2) NLE correction of HD2
- (3) From DSA = 3dB down to 0dB, NSD increases 1dB per DSA dB
- (4) NF increase 1dB per DSA 1dB above DSA = 3dB
- (5) DDC Bypass (TI only test mode)

4.7 PLL/VCO/Clock Electrical Characteristics

Typical values at TA = +25°C, full temperature range is T_{A,MIN} = -40°C to T_{J,MAX} = +110°C; Reference clock input frequency 491.52MHz (unless otherwise noted), f_{DAC} = f_{VCO}, f_{OUT} = f_{DAC}/4, normalized to f_{VCO}.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{VCO1}	VCO1 min frequency				7.2	GHz
	VCO1 max frequency		7.68			GHz
f _{VCO2}	VCO2 min frequency				8.8	GHz
	VCO2 max frequency		9.1			GHz
f _{VCO3}	VCO3 min frequency				9.7	GHz
	VCO3 max frequency		10.24			GHz
f _{VCO4}	VCO4 min frequency				11.6	GHz
	VCO4 max frequency		12.08			GHz
DIV _{DAC}	DAC sample rate divider			1, 2 or 3		
DIV _{FBAD} C	ADC sample rate divider from DAC sample rate			1, 2, 3, 4, 6 or 8		
DIV _{RXAD} C	ADC sample rate divider			1, 2, 3, 4, 6 or 8		
PN _{VCO}	Closed Loop Phase Noise F _{PLL} = 11.79848 GHz F _{REF} =491.52MHz	600kHz		-113		dBc/Hz
		800kHz		-116		dBc/Hz
		1MHz		-119		dBc/Hz
		1.8MHz		-125		dBc/Hz
		5MHz		-133		dBc/Hz
		50MHz		-141		dBc/Hz
	Closed Loop Phase Noise F _{PLL} =8.84736 GHz F _{REF} =491.52MHz	600kHz		-114		dBc/Hz
		800kHz		-118		dBc/Hz
		1MHz		-120		dBc/Hz
		1.8MHz		-127		dBc/Hz
		5MHz		-135		dBc/Hz
		50MHz		-142		dBc/Hz
	Closed Loop Phase Noise F _{PLL} = 9.8403 GHz F _{REF} =491.52MHz	600kHz		-113		dBc/Hz
		800kHz		-116		dBc/Hz
		1MHz		-119		dBc/Hz
		1.8MHz		-125		dBc/Hz
		5MHz		-134		dBc/Hz
		50MHz		-140		dBc/Hz
	Closed Loop Phase Noise F _{PLL} = 7.86432GHz F _{REF} =491.52MHz	600kHz		-116		dBc/Hz
		800kHz		-119		dBc/Hz
		1MHz		-122		dBc/Hz
		1.8MHz		-127		dBc/Hz
		5MHz		-136		dBc/Hz
		50MHz		-143		dBc/Hz
F _{rms}	Clock PLL integrated phase error ⁽¹⁾	f _{PLL} =11.79848 GHz, [1KHz, 100MHz]		-43.4		dBc/Hz
		f _{PLL} =8.8536 GHz, [1KHz, 100MHz]		-47.6		dBc/Hz
		f _{PLL} =9.8304 GHz, [1KHz, 100MHz]		-46.2		dBc/Hz
f _{PFD}	PFD frequency		100		500	MHz
PN _{pll_flat}	Normalized PLL flat Noise	f _{VCO} = 11796.48MHz		-226.5		dBc/Hz
F _{REF}	Input Clock frequency		0.1		12	GHz

4.7 PLL/VCO/Clock Electrical Characteristics (continued)

Typical values at TA = +25°C, full temperature range is TA,MIN = -40°C to TJ,MAX = +110°C; Reference clock input frequency 491.52MHz (unless otherwise noted), f_{DAC} = f_{VCO}, f_{OUT} = f_{DAC}/4, normalized to f_{VCO}.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{SS}	Input Clock level		0.6		1.8	Vppdiff
Coupling				AC Coupling Only		
	REFCLK input impedance ⁽²⁾	Parallel resistance		100		Ω
		Parallel capacitance		0.5		pF

- (1) Single Sideband, not including the reference clock contribution
(2) Refer to S11 data available from TI for impedance vs frequency

4.8 Digital Electrical Characteristics

Typical values at TA = +25°C, full temperature range is T_{A,MIN} = -40°C to T_{J,MAX} = +110°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
CML SerDes Inputs [8:1]SRX+/-						
V _{SRDIFF}	SerDes Receiver Input Amplitude	differential	100		1200	mVpp
V _{SRCOM}	SerDes Input Common Mode		0.4	0.5	0.6	V
Z _{SRdiff}	SerDes Internal Differential Termination ⁽¹⁾			100		Ω
F _{SerDes}	SerDes Bit Rate	Full rate mode	19		29.5	Gbps
		Half rate mode	9.5		16.25	Gbps
		Quarter rate mode	4.75		8.125	Gbps
	Insertion Loss Tolerance ⁽²⁾	Serdes supply = 1.8V		25		dB
TJ	Total Jitter Tolerance				0.42	UI
CML SerDes Outputs [8:1]STX+/-						
V _{STDIFF}	SerDes Transmitter Output Amplitude	differential	500		1000	mVpp
V _{STCOM}	SerDes Output Common Mode		0.4	0.45	0.55	V
Z _{STdiff}	SerDes Output Impedance			100		Ω
TRF	Output rise and fall time	20-80%	8			ps
TEQS	Equalization range				7	dB
TTJ	Output total jitter				0.21	UI
CMOS I/O: GPIO{B/C/D/E}x, SPICLK, SPISDIO, SPISDO, SPISEN, RESETZ, BISTB0, BISTB1						
V _{IH}	High-Level Input Voltage		0.6×VDD1 P8GPIO			V
V _{IL}	Low-Level Input Voltage				0.4×VDD1 P8GPIO	V
I _{IH}	High-Level Input Current		-250		250	μA
I _{IL}	Low-Level Input Current		-250		250	μA
C _L	CMOS input capacitance			2		pF
V _{OH}	High-Level Output Voltage		VDD1P8G PIO-0.2			V
V _{OL}	Low-Level Output Voltage				0.2	V
Differential Inputs: SYSREF+/- Mode A						
Clock _{MODE}				PLL Clock Mode Only		
F _{SYSREFMAX}	SYSREF Input Frequency Maximum			40		MHz
V _{SWINGSRMAX}	SYSREF Input Swing Maximum			1.8		Vppdiff ⁽³⁾
V _{SWINGSRMIN}	SYSREF Input Swing Minimum	f _{REF} < 500MHz		0.3		Vppdiff ⁽³⁾
V _{SWINGSRMIN}	SYSREF Input Swing Minimum	f _{REF} > 500MHz		0.6		Vppdiff ⁽³⁾
V _{COMSRMAX}	SYSREF Input Common Mode Voltage Maximum			0.8		V
V _{COMSRMIN}	SYSREF Input Common Mode Voltage Minimum			0.6		V
Z _T	Input termination	differential		100 ⁽¹⁾		Ω
C _L	Input capacitance	Each pin to GND		0.5		pF
LVDS Inputs: 0SYNCIN+/- and 1SYNCIN+/-						
V _{ICOM}	Input Common Voltage			1.2		V
V _{ID}	Differential Input Voltage swing			450		Vppdiff ⁽³⁾

4.8 Digital Electrical Characteristics (continued)

Typical values at TA = +25°C, full temperature range is T_{A,MIN} = -40°C to T_{J,MAX} = +110°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Z _T	Input termination	differential		100		Ω
LVDS Outputs: 0SYNCOUT+/- and 1SYNCOUT+/-						
V _{OCOM}	Output Common Voltage			1.2		V
V _{OD}	Differential Output Voltage swing			500		V _{ppdiff} ⁽³⁾
Z _T	Internal Termination			100		Ω

- (1) SYSREF termination is programmable between 100Ω, 150Ω and 300Ω
- (2) Loss tolerance is bump to bump from STX to SRX
- (3) V_{ppdiff} is the difference between the maximum differential voltage (positive value) and minimum differential voltage (negative value).

4.9 Power Supply Electrical Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$, nominal power supplies, 1 tone at -1 dBFS, DSA Attenuation = 0dB, TX straight mode, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 1a: 2T2R - TDD, 50%/50% duty cycle TX: 125 MSPS input, 24x Int, $f_{\text{DAC}} = 3$ GSPS RX: $f_{\text{ADC}} = 1.5$ GSPS, 12x Dec, 125 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 1$ GHz Serdes: 8b/10b, 10 Gbps TX/RX LMFS: 1-4-8-1		345		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			286		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			69		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			488		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			599		mA
P_{diss}	Power Dissipation			2399		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 1b: 2T2R - TX active, RX in standby, TX: 125 MSPS input, 24x Int, $f_{\text{DAC}} = 3$ GSPS RX: $f_{\text{ADC}} = 1.5$ GSPS, 12x Dec, 125 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 1$ GHz Serdes: 8b/10b, 10 Gbps TX/RX LMFS: 1-4-8-1		349		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			270		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			69		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			531		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			583		mA
P_{diss}	Power Dissipation			2414		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 1c: 2T2R - RX active, TX in standby TX: 125 MSPS input, 24x Int, $f_{\text{DAC}} = 3$ GSPS RX: $f_{\text{ADC}} = 1.5$ GSPS, 12x Dec, 125 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 1$ GHz Serdes: 8b/10b, 10 Gbps TX/RX LMFS: 1-4-8-1		341		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			302		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO			69		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			446		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			616		mA
P_{diss}	Power Dissipation			2384		mW

4.9 Power Supply Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{A,\text{MAX}} = +110^\circ\text{C}$, nominal power supplies, 1 tone at -1 dBFS, DSA Attenuation = 0dB, TX straight mode, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 2: 2T2R - FDD TX: 125MSPS input, 24x Int, $f_{\text{DAC}} = 3\text{GSPS}$ RX: $f_{\text{ADC}} = 1.5\text{GSPS}$, 12x Dec, 125MSPS output $f_{\text{OUT}} = 1\text{GHz}$, $f_{\text{IN}} = 1\text{GHz}$ Serdes: 8b/10b, 10Gbps TX/RX LMFS: 1-4-8-1		600		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			323		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			69		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			703		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			805		mA
P_{diss}	Power Dissipation			3374		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 3a: 2T2R - TDD, 50%/50% duty cycle TX: 500 MSPS input, 24x Int, $f_{\text{DAC}} = 12\text{GSPS}$ RX: $f_{\text{ADC}} = 3\text{GSPS}$, 6x Dec, 500 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 3.5\text{GHz}$ Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 2-4-4-1		361		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			306		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			71		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			875		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1336		mA
P_{diss}	Power Dissipation			3614		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 3b: 2T2R - TX active, RX in standby TX: 500 MSPS input, 24x Int, $f_{\text{DAC}} = 12\text{GSPS}$ RX: $f_{\text{ADC}} = 3\text{GSPS}$, 6x Dec, 500 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 3.5\text{GHz}$ Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 2-4-4-1		345		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			277		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			72		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			1123		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1473		mA
P_{diss}	Power Dissipation			3958		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 3c: 2T2R - RX active, TX in standby TX: 500 MSPS input, 24x Int, $f_{\text{DAC}} = 12\text{GSPS}$ RX: $f_{\text{ADC}} = 3\text{GSPS}$, 6x Dec, 500 MSPS output $f_{\text{OUT}} = f_{\text{IN}} = 3.5\text{GHz}$ Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 2-4-4-1		377		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			336		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLVC0			71		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			627		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1198		mA
P_{diss}	Power Dissipation			3270		mW

4.9 Power Supply Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,MIN} = -40^\circ\text{C}$ to $T_{J,MAX} = +110^\circ\text{C}$, nominal power supplies, 1 tone at -1 dBFS, DSA Attenuation = 0dB, TX straight mode, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 4: 2T2R - FDD TX: 500MSPS input, 24x Int, $f_{DAC} = 12$ GSPS RX: $f_{ADC} = 3$ GSPS, 6x Dec, 500MSPS output $f_{OUT} = 3.5\text{GHz}$, $f_{IN} = 3.7$ GHz Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 2-4-4-1		635		mA	
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			357		mA	
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO				72		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			1417		mA	
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1952		mA	
P_{diss}	Power Dissipation			5421		mW	
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 5a: 2T2R - TDD, 50%/50% duty cycle TX: dual 125 MSPS input, 48x Int, $f_{DAC} = 6$ GSPS, MixMode RX: dual $f_{ADC} = 3$ GSPS, 24x Dec, 125 MSPS output $f_{OUT} = f_{IN} = 3.5$ GHz Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 1-8-16-1		363		mA	
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			302		mA	
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO				71		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF				683		mA
	Group 1A: DVDD0P9 + VDDT0P9				1177		mA
	Power Dissipation				3234		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 5b: 2T2R - TX active, RX in Standby TX: dual 125 MSPS input, 48x Int, $f_{DAC} = 6$ GSPS, MixMode RX: dual $f_{ADC} = 3$ GSPS, 24x Dec, 125 MSPS output $f_{OUT} = f_{IN} = 3.5$ and 3.6 GHz Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 1-8-16-1		349		mA	
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			273		mA	
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO				72		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF				757		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9				1182		mA
P_{diss}	Power Dissipation				3252		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 5c: 2T2R - RX active, TX in standby TX: dual 125 MSPS input, 48x Int, $f_{DAC} = 6$ GSPS, MixMode RX: dual $f_{ADC} = 3$ GSPS, 24x Dec, 125 MSPS output $f_{OUT} = f_{IN} = 3.5$ and 3.6 GHz Serdes: 8b/10b, 20 Gbps TX/RX LMFS: 1-8-16-1		377		mA	
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC+ VDD1P8GPIO + VDDA1P8			331		mA	
	Group 3C: VDD1P8PLL + VDD1P8PLLVCO				71		mA
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF				610		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9				1172		mA
P_{diss}	Power Dissipation				3217		mW

4.9 Power Supply Electrical Characteristics (continued)

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$, nominal power supplies, 1 tone at -1 dBFS, DSA Attenuation = 0dB, TX straight mode, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 6: 2T2R FDD TX: dual 125 MSPS input, 48x Int, $f_{\text{DAC}} = 6$ GSPS, MixMode RX: dual $f_{\text{ADC}} = 3$ GSPS, 24x Dec, 125 MSPS output $f_{\text{OUT}} = 3.5$ and 3.55 GHz, $f_{\text{IN}} = 3.6$ and 3.65 GHz Serdes: 8b/10b, 10 Gbps TX/RX LMFS: 1-8-16-1		639		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			351		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLCO				72	
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			1046		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			1734		mA
P_{diss}	Power Dissipation			4770		mW
I_{VDD1P8}	Group 3A: VDD1P8FB + VDD1P8RX + VDD1P8TX	Mode 7: same configuration as mode 2, Sleep Mode. SLEEP pin is pull high.		22		mA
	Group 3B: VDD1P8FBCLK + VDD1P8RXCLK + VDD1P8TXDAC + VDD1P8GPIO + VDDA1P8			181		mA
	Group 3C: VDD1P8PLL + VDD1P8PLLCO				16	
I_{VDD1P2}	Group 2: VDD1P2FB, VDD1P2RX, VDD1P2TXCLK, VDD1P2TXENC, VDD1P2FBCML, VDD1P2RXCML and VDD1P2PLLCLKREF			49		mA
I_{VDD0P9}	Group 1A: DVDD0P9 + VDDT0P9			213		mA
P_{diss}	Power Dissipation			649		mW

4.10 Timing Requirements

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

		MIN	NOM	MAX	UNIT
Timing: SYSREF+/-					
$t_{\text{s}}(\text{SYSREF})$	Setup Time, SYSREF+/- Valid to Rising Edge of CLK+/-		50		ps
$t_{\text{h}}(\text{SYSREF})$	Hold Time, SYSREF+/- Valid after Rising Edge of CLK+/-		50		ps
Timing: Serial ports					
$t_{\text{s}}(\text{SENB})$	Setup Time, SENB to Rising Edge of SCLK			15	ns
$t_{\text{h}}(\text{SENB})$	Hold Time, SENB after last Rising Edge of SCLK ⁽¹⁾		$5 + t_{\text{SCLK}}$		ns
$t_{\text{s}}(\text{SDIO})$	Setup Time, SDIO valid to Rising Edge of SCLK			15	ns
$t_{\text{h}}(\text{SDIO})$	Hold Time, SDIO valid after Rising Edge of SCLK			5	ns
$t_{\text{SCLK_W}}$	Minimum SCLK period: registers write			25	ns
$t_{\text{SCLK_R}}$	Minimum SCLK period: registers read			50	ns
$t_{\text{d}}(\text{data_out})$	Minimum Data Output delay after Falling Edge of SCLK			0	ns
	Maximum Data Output delay after Falling Edge of SCLK			15	ns
t_{RESET}	Minimum RESET Pulse Width		1		ms

(1) SDEN\ need to be held one more extra clock cycle with the last SCLK edge

4.11 Switching Characteristics

Typical values at $T_A = +25^\circ\text{C}$, full temperature range is $T_{A,\text{MIN}} = -40^\circ\text{C}$ to $T_{J,\text{MAX}} = +110^\circ\text{C}$; TX Input Rate = 491.52MSPS, $f_{\text{DAC}} = 8847.36\text{MSPS}$; $f_{\text{ADC}} = 2949.12\text{MSPS}$; nominal power supplies; 1 tone at -1 dBFS; DSA Attenuation = 0dB; SerDes rate = 24.33Gbps; unless otherwise noted.

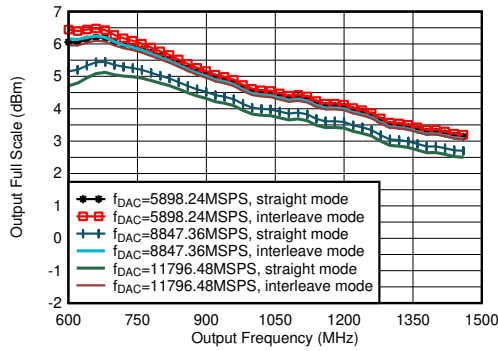
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
TX Channel Latency						
	SerDes Receiver Analog Delay	Full rate		2.8		ns
$t_{\text{JESD TX}}$	JESD to TX output Latency	LMFSHd=2-8-8-1, 368.64 MSPS input rate, 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		152		interface clock cycles ⁽¹⁾
		LMFSHd=8-16-4-1, 491.52 MSPS 24x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		176		
		LMFSHd=4-16-8-1, 245.76 MSPS 48x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		124		
		LMFSHd=2-16-16-1, 122.88 MSPS 96x Interpolation, Serdes rate = 16.22Gbps (JESD204C)		97		
RX Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
$t_{\text{JESD RX}}$	RX input to JESD output Latency	LMFS=2-16-16-1, 122.88 MSPS, 24x Decimation, Serdes rate = 16.22Gbps (JESD204C)		92		interface clock cycles ⁽¹⁾
		LMFS=4-16-8-1, 245.76 MSPS, 12x Decimation, Serdes rate = 16.22Gbps (JESD204C)		108		
		LMFS=4-8-4-1, 491.52 MSPS, 6x Decimation, Serdes rate = 16.22Gbps (JESD204C)		153		
FB Channel Latency						
	SerDes Transmitter Analog Delay			3.6		ns
$t_{\text{JESD FB}}$	FB input to JESD output Latency	LMFS=1-2-8-1, 368.64 MSPS, 8x Decimation		151		interface clock cycles ⁽¹⁾
		LMFS=2-4-4-1, 491.52 MSPS, 6x Decimation		177		

(1) Interface clock cycles is the period of the digital interface sample rate, e.g. 1GSPS = 1ns.

4.12 Typical Characteristics

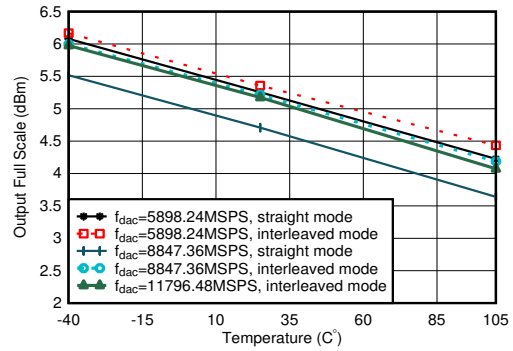
4.12.1 TX Typical Characteristics 800 MHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



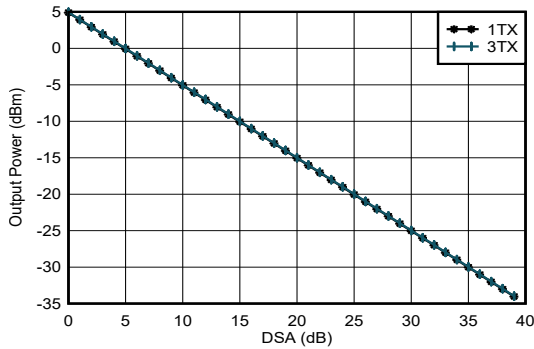
including PCB and cable losses, $A_{\text{out}} = -0.5$ dBFS, DSA = 0, 0.8 GHz matching

Figure 4-1. TX Output Fullscale vs Output Frequency



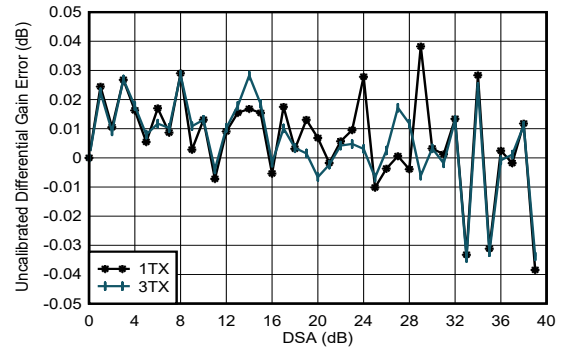
including PCB and cable losses, $A_{\text{out}} = -0.5$ dBFS, DSA = 0, 0.8 GHz matching

Figure 4-2. TX Output Fullscale vs Temperature



$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $A_{\text{out}} = -0.5$ dBFS, matching 0.8 GHz

Figure 4-3. TX Output Power vs DSA Setting and Channel at 0.85 GHz

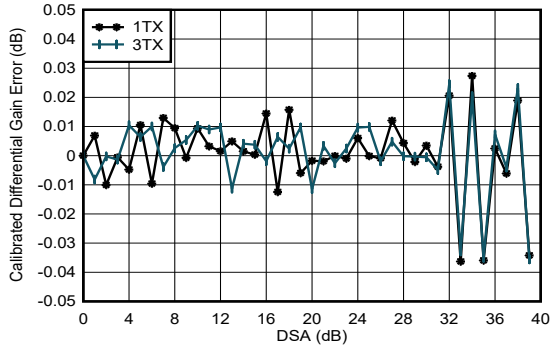


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-4. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 0.85 GHz

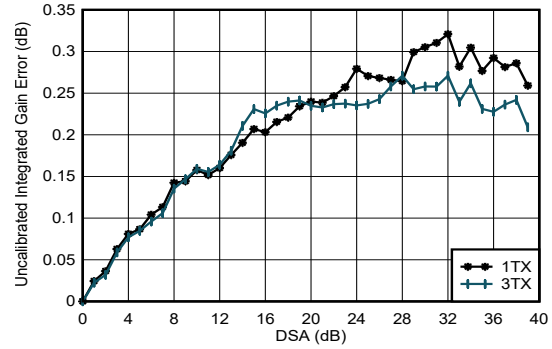
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



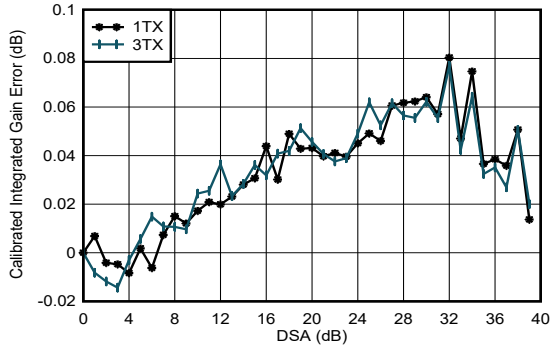
$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Differential Gain Error = $P_{OUT}(DSA \text{ Setting} - 1) - P_{OUT}(DSA \text{ Setting}) + 1$

Figure 4-5. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 0.85 GHz



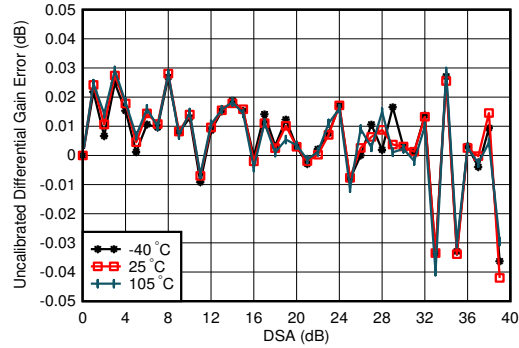
$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Integrated Gain Error = $P_{OUT}(DSA \text{ Setting}) - P_{OUT}(DSA \text{ Setting} = 0) + DSA \text{ Settings}$

Figure 4-6. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 0.85 GHz



$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Integrated Gain Error = $P_{OUT}(DSA \text{ Setting}) - P_{OUT}(DSA \text{ Setting} = 0) + DSA \text{ Setting}$

Figure 4-7. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 0.85 GHz

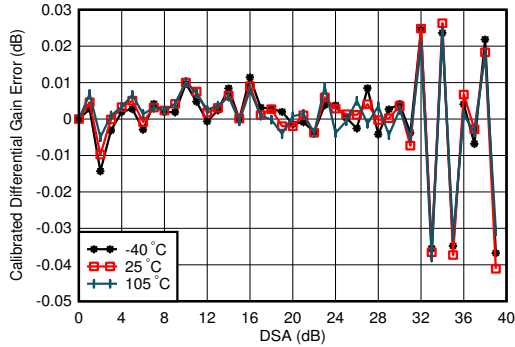


$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Differential Gain Error = $P_{OUT}(DSA \text{ Setting} - 1) - P_{OUT}(DSA \text{ Setting}) + 1$

Figure 4-8. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 0.85 GHz

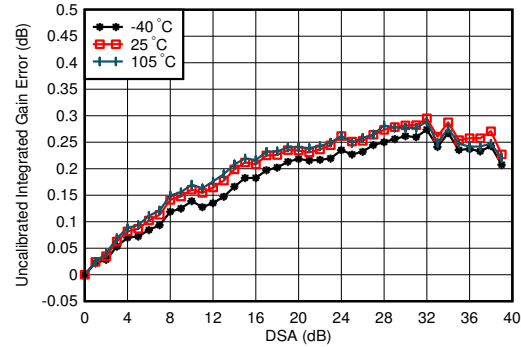
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



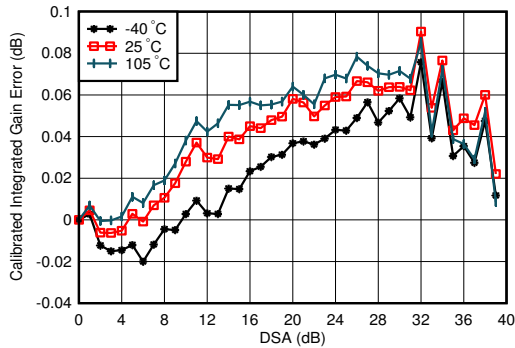
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-9. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 0.85 GHz



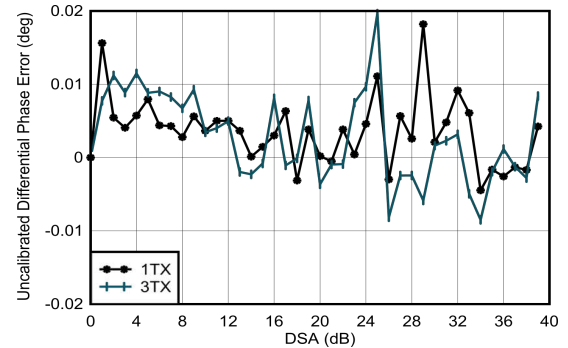
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Setting}$

Figure 4-10. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85 GHz



$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + \text{DSA Setting}$

Figure 4-11. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 0.85 GHz

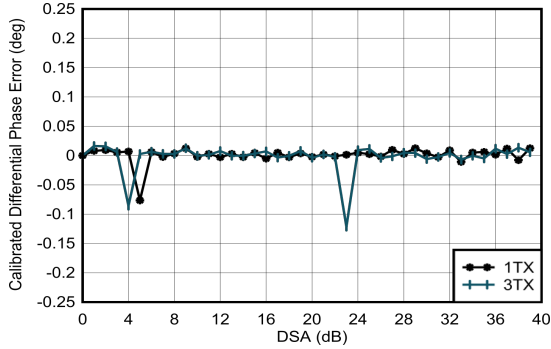


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-12. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 0.85 GHz

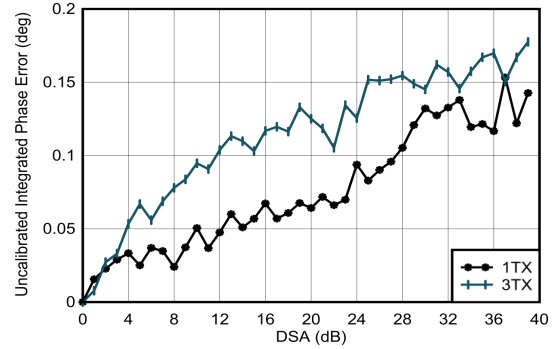
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



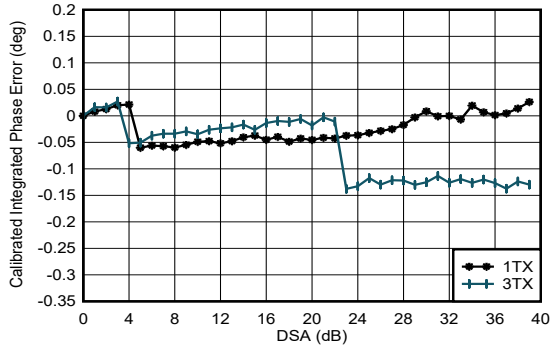
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
 Phase DNL spike may occur at any DSA setting.

Figure 4-13. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 0.85 GHz



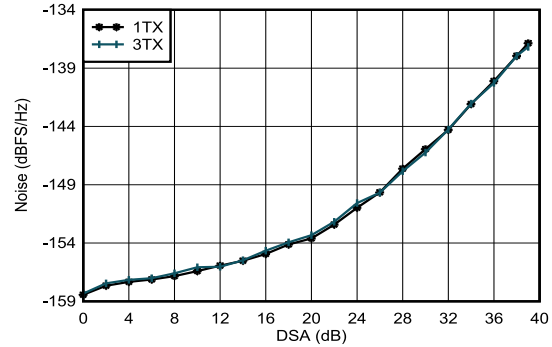
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

Figure 4-14. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 0.85 GHz



$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

Figure 4-15. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 0.85 GHz

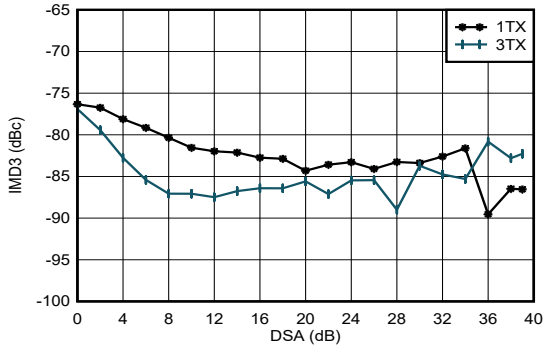


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
 Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

Figure 4-16. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85 GHz

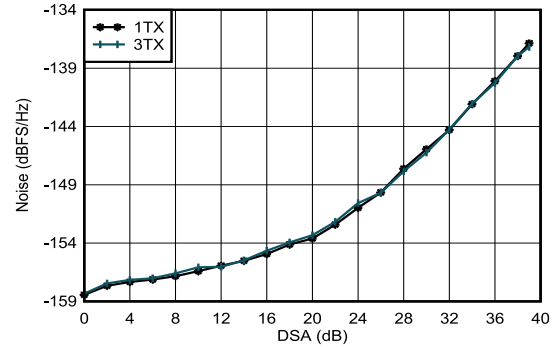
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



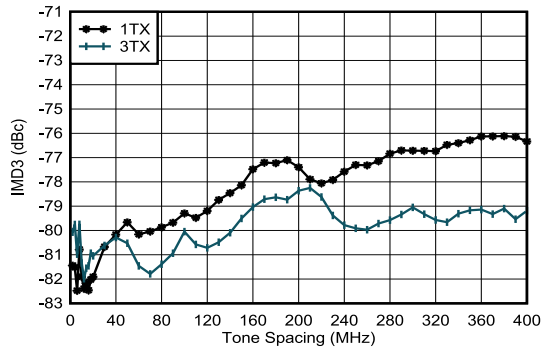
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz
Integrated Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting}) - \text{Phase}_{\text{OUT}}(\text{DSA Setting} = 0)$

Figure 4-17. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 0.85 GHz



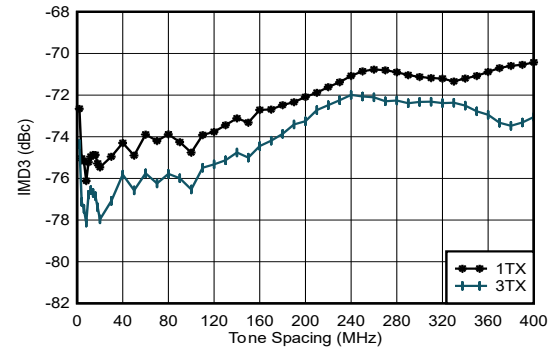
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 0.8 GHz,
 $P_{\text{OUT}} = -13$ dBFS

Figure 4-18. TX Output Noise vs Channel and Attenuation at 0.85 GHz



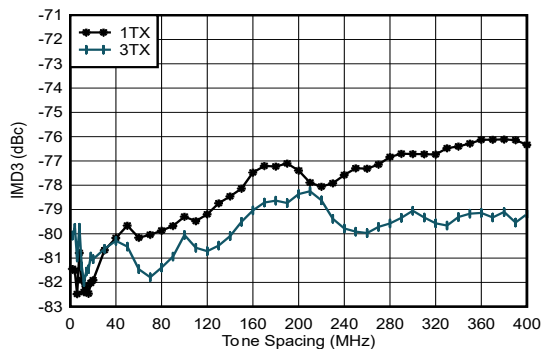
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone

Figure 4-19. TX IMD3 vs DSA Setting at 0.85 GHz



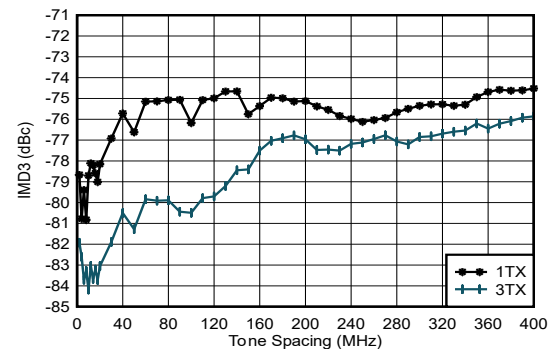
$f_{\text{DAC}} = 5898.24$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone

Figure 4-20. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone

Figure 4-21. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz

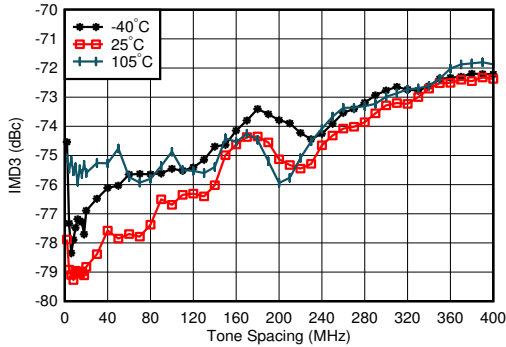


$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone

Figure 4-22. TX IMD3 vs Tone Spacing and Channel at 0.85 GHz

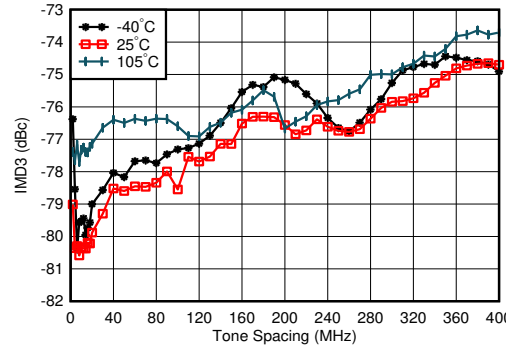
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



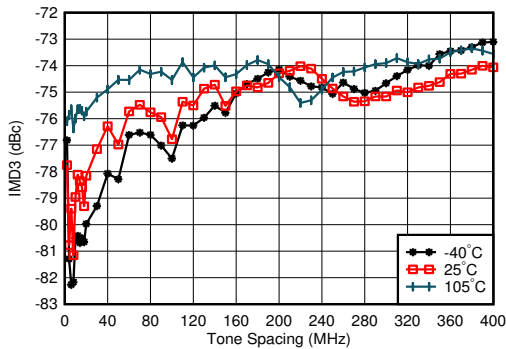
$f_{\text{DAC}} = 5898.24$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone, worst channel

Figure 4-23. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz



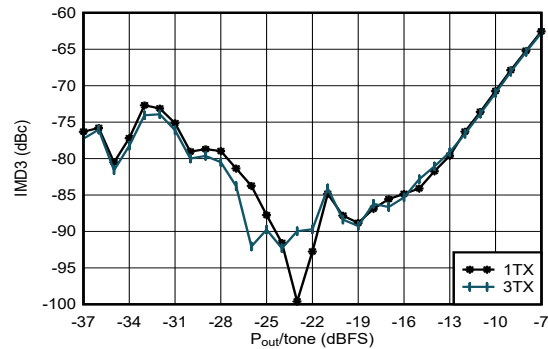
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone, worst channel

Figure 4-24. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz



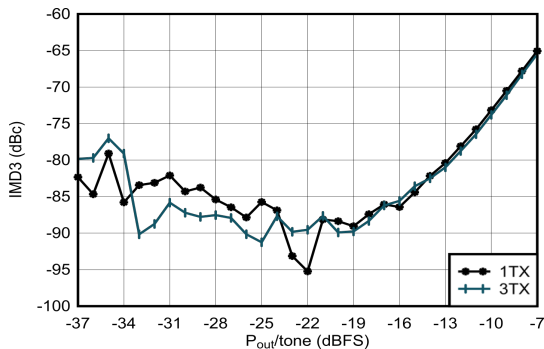
$f_{\text{DAC}} = 11796.48$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, matching at 0.8 GHz, -13 dBFS each tone, worst channel

Figure 4-25. TX IMD3 vs Tone Spacing and Temperature at 0.85 GHz



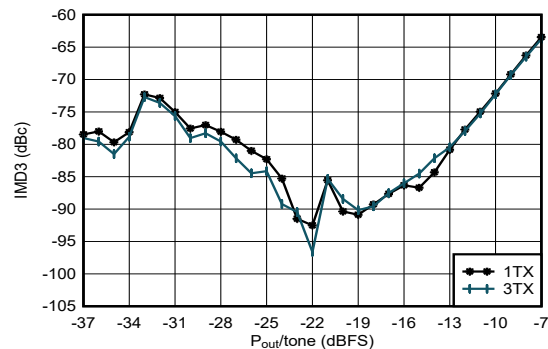
$f_{\text{DAC}} = 5898.24$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, $f_{\text{SPACING}} = 20$ MHz, matching at 0.8 GHz

Figure 4-26. TX IMD3 vs Digital Level at 0.85 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 0.85$ GHz, $f_{\text{SPACING}} = 20$ MHz, matching at 0.8 GHz

Figure 4-27. TX IMD3 vs Digital Level at 0.85 GHz

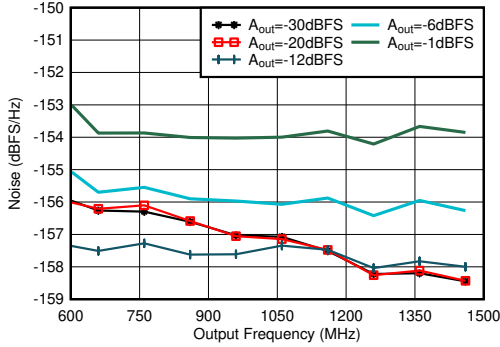


$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 0.85$ GHz, $f_{\text{SPACING}} = 20$ MHz, matching at 0.8 GHz

Figure 4-28. TX IMD3 vs Digital Level at 0.85 GHz

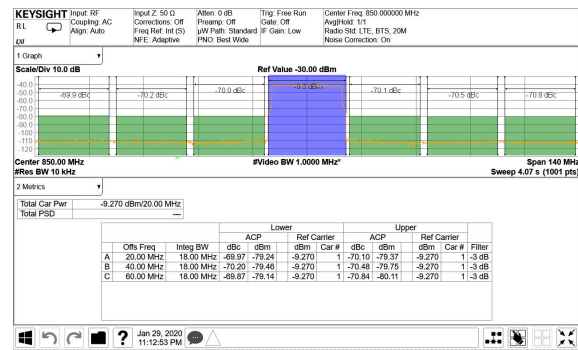
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



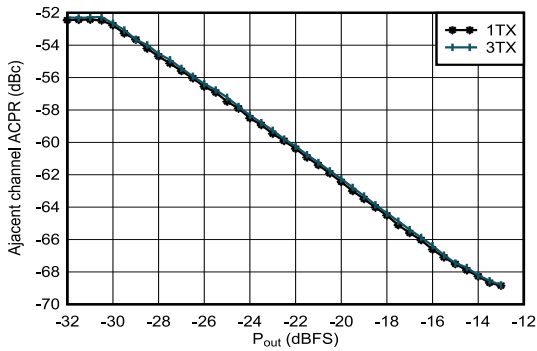
Matching at 2.6 GHz, Single tone, $f_{DAC} = 11.79648$ GSPPS, interleave mode, 40-MHz offset, DSA = 0dB

Figure 4-29. TX Single Tone Output Noise vs Frequency and Amplitude at 0.85 GHz



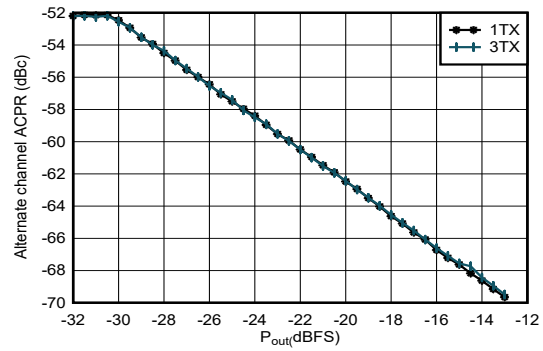
TM1.1, $P_{OUT_RMS} = -13$ dBFS

Figure 4-30. TX 20-MHz LTE Output Spectrum at 0.85 GHz



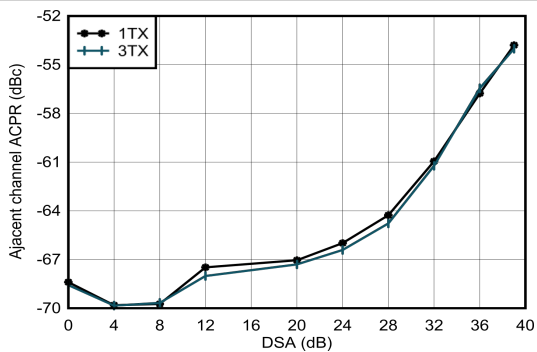
Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-31. TX 20-MHz LTE ACPR vs Digital Level at 0.85 GHz



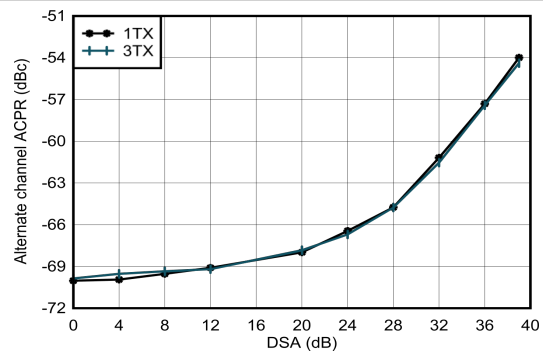
Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-32. TX 20-MHz LTE alt-ACPR vs Digital Level at 0.85 GHz



Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-33. TX 20-MHz LTE ACPR vs DSA at 0.85 GHz

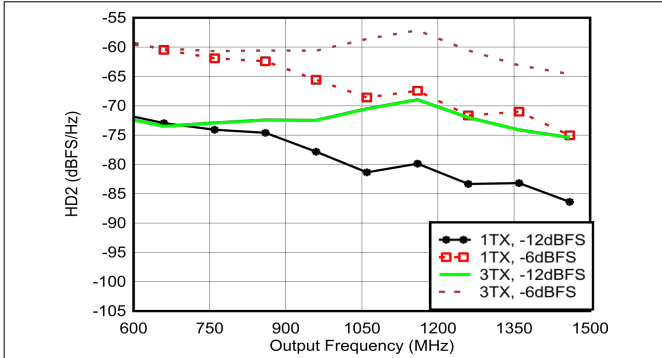


Matching at 0.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-34. TX 20-MHz LTE alt-ACPR vs DSA at 0.85 GHz

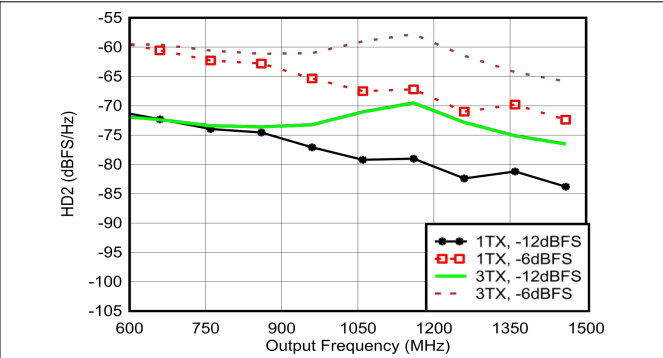
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



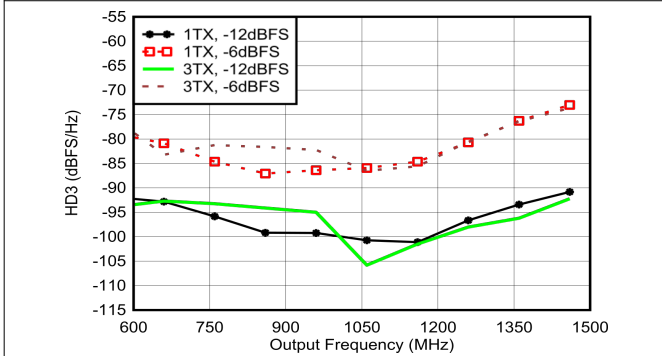
Matching at 0.8 GHz, $f_{DAC} = 5898.24\text{G SPS}$, straight mode

Figure 4-35. TX HD2 vs Digital Amplitude and Output Frequency at 0.85 GHz



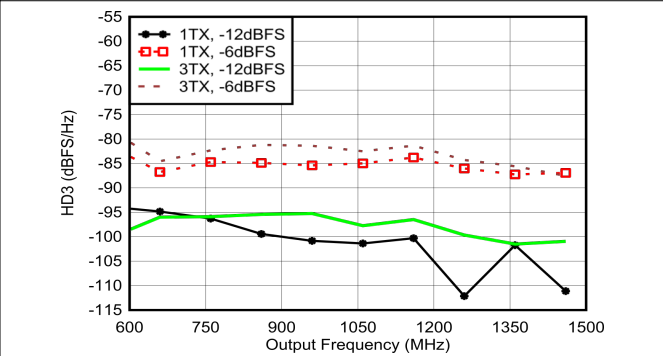
Matching at 0.8 GHz, $f_{DAC} = 8847.36\text{GSPS}$, straight mode

Figure 4-36. TX HD2 vs Digital Amplitude and Output Frequency at 0.85 GHz



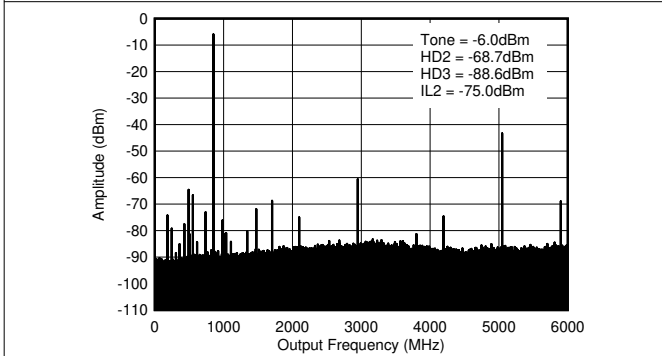
Matching at 0.8 GHz, $f_{DAC} = 5898.24\text{MSPS}$, straight mode, normalized to output power at harmonic frequency

Figure 4-37. TX HD3 vs Digital Amplitude and Output Frequency at 0.85 GHz



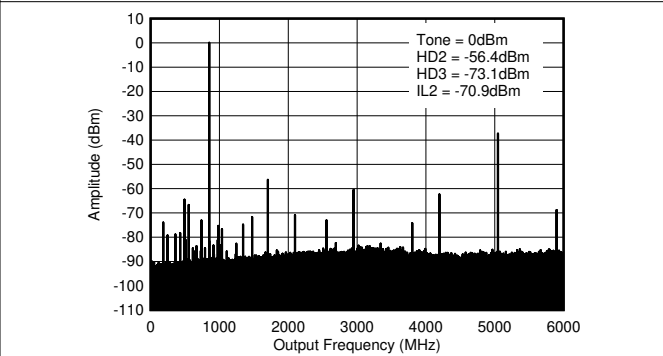
Matching at 0.8 GHz, $f_{DAC} = 8847.36\text{MSPS}$, straight mode, normalized to output power at harmonic frequency

Figure 4-38. TX HD3 vs Digital Amplitude and Output Frequency at 0.85 GHz



$f_{DAC} = 5898.24\text{MSPS}$, interleave mode, 0.8 GHz matching, includes PCB and cable losses. $ILn = f_s/n \pm f_{OUT}$.

Figure 4-39. TX Single Tone (-12 dBFS) Output Spectrum at 0.85 GHz ($0-f_{DAC}$)

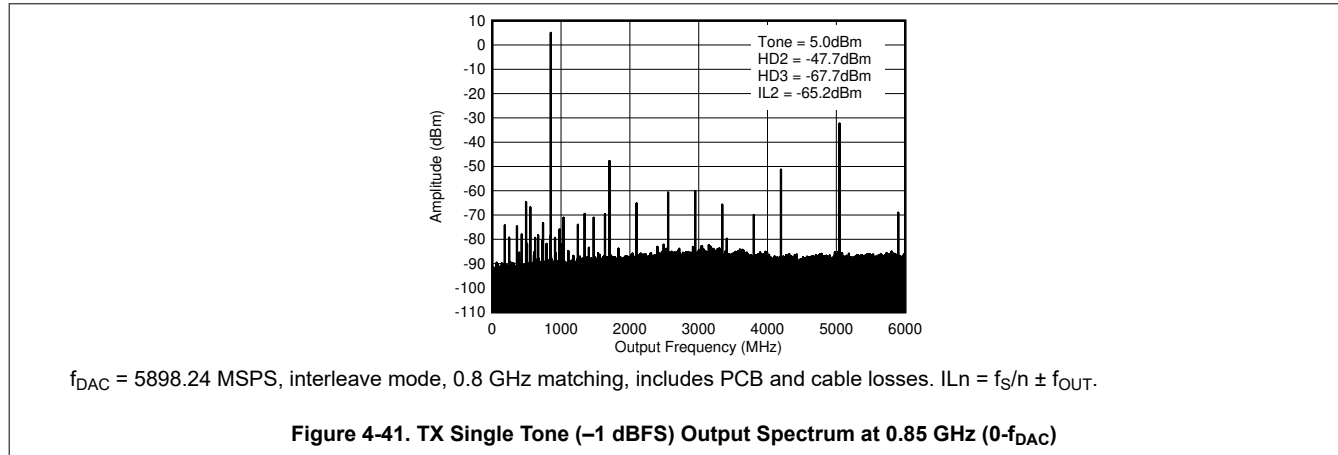


$f_{DAC} = 5898.24\text{MSPS}$, interleave mode, 0.8 GHz matching, includes PCB and cable losses. $ILn = f_s/n \pm f_{OUT}$.

Figure 4-40. TX Single Tone (-6 dBFS) Output Spectrum at 0.85 GHz ($0-f_{DAC}$)

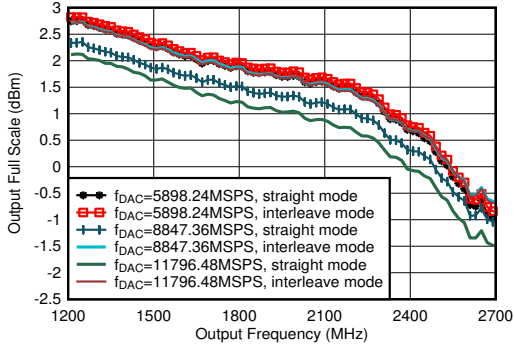
4.12.1 TX Typical Characteristics 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



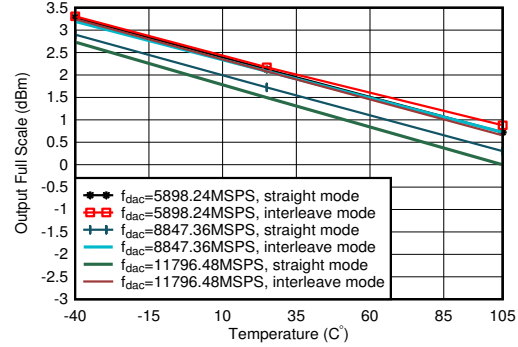
4.12.2 TX Typical Characteristics at 1.8 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



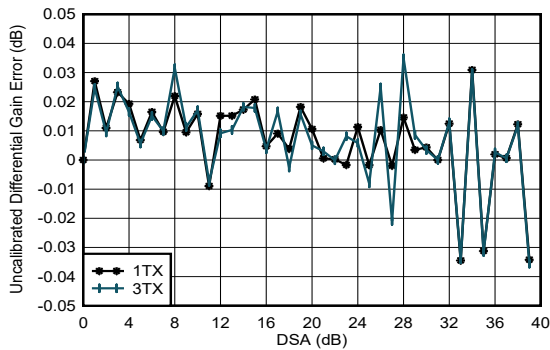
including PCB and cable losses, $A_{out} = -0.5$ dBFS, DSA = 0, 1.8 GHz matching

Figure 4-42. TX Output Fullscale vs Output Frequency



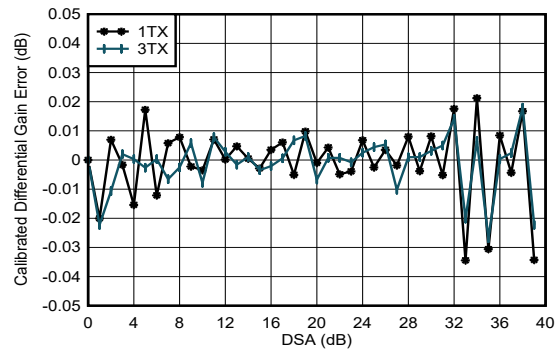
$A_{out} = -0.5$ dBFS, matching 1.8 GHz

Figure 4-43. TX Output Power vs Temperature at 1.8 GHz



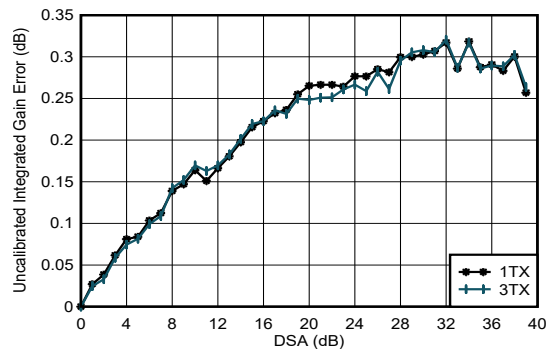
$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Differential Gain Error = $P_{OUT}(\text{DSA Setting} - 1) - P_{OUT}(\text{DSA Setting}) + 1$

Figure 4-44. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 1.8 GHz



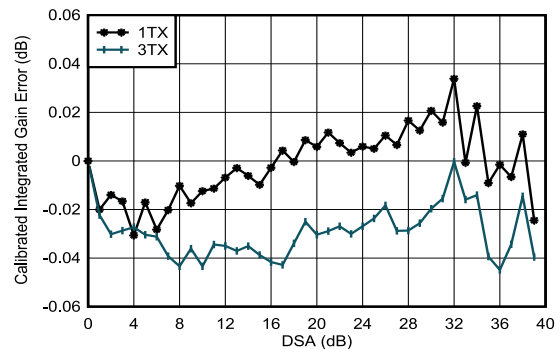
$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Differential Gain Error = $P_{OUT}(\text{DSA Setting} - 1) - P_{OUT}(\text{DSA Setting}) + 1$

Figure 4-45. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 1.8 GHz



$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Integrated Gain Error = $P_{OUT}(\text{DSA Setting}) - P_{OUT}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-46. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 1.8 GHz

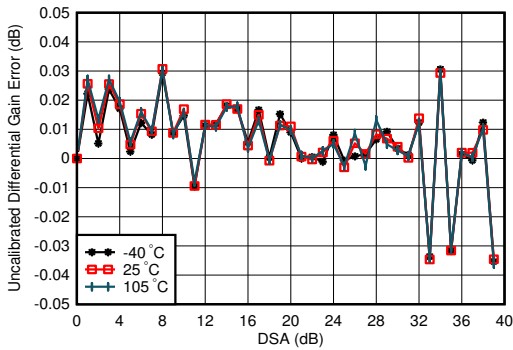


$f_{DAC} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Integrated Gain Error = $P_{OUT}(\text{DSA Setting}) - P_{OUT}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-47. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 1.8 GHz

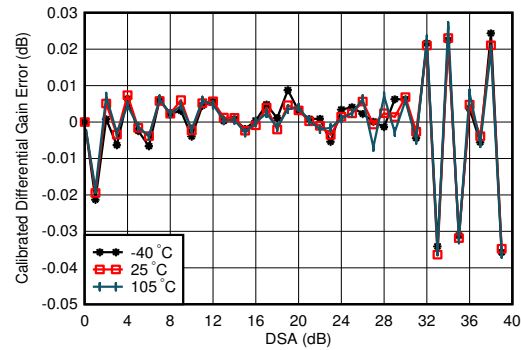
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



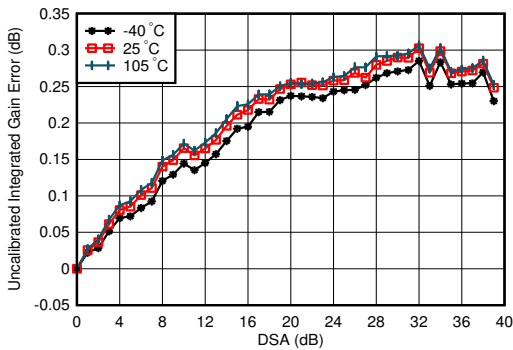
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-48. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 1.8 GHz



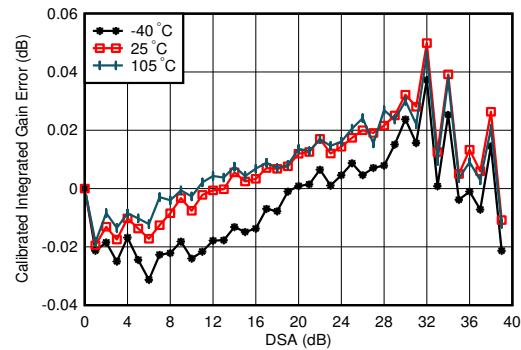
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-49. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 1.8 GHz



$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-50. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8 GHz

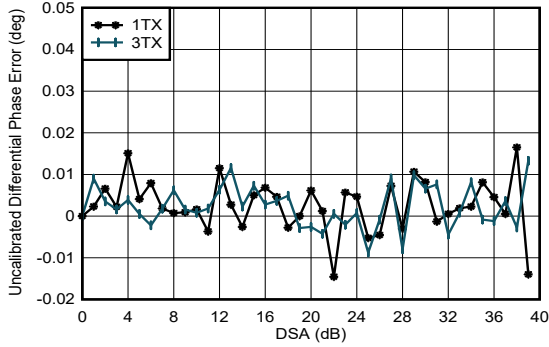


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-51. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 1.8 GHz

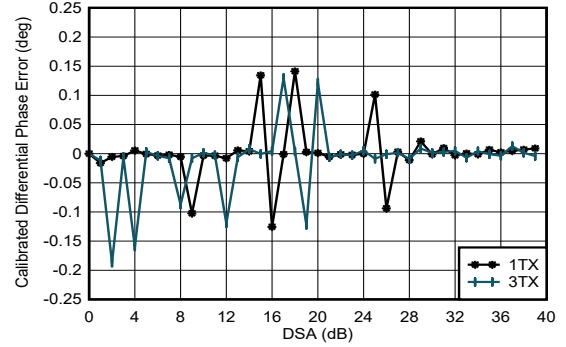
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



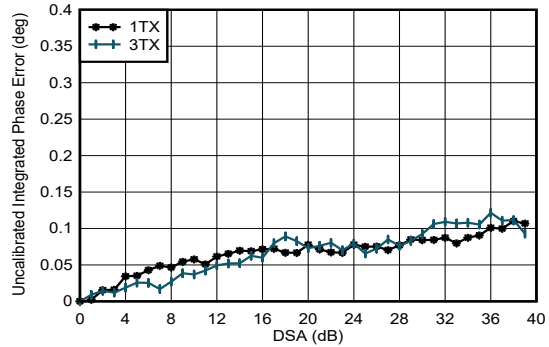
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-52. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 1.8 GHz



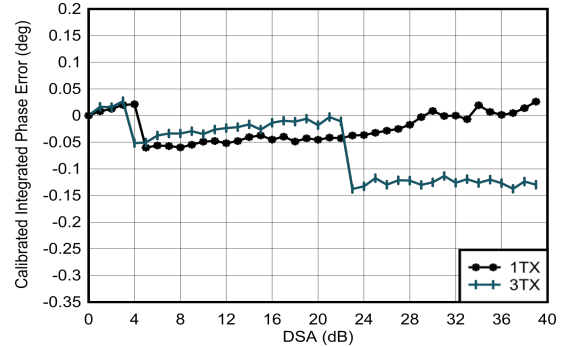
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
 Phase DNL spike may occur at any DSA setting.

Figure 4-53. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 1.8 GHz



$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-54. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 1.8 GHz

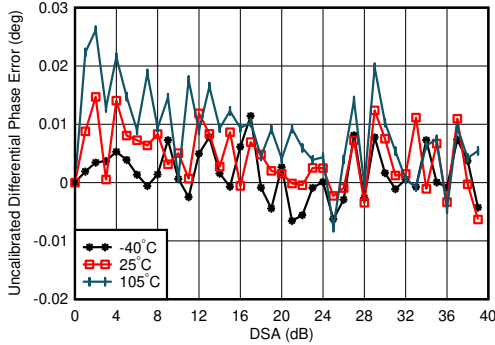


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-55. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 1.8 GHz

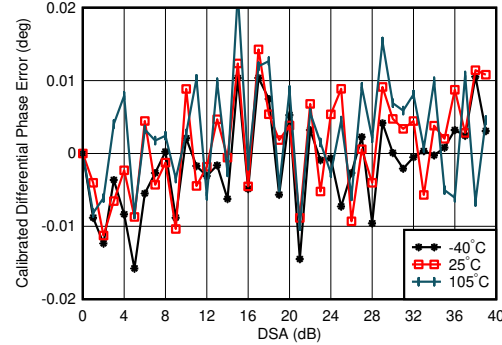
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



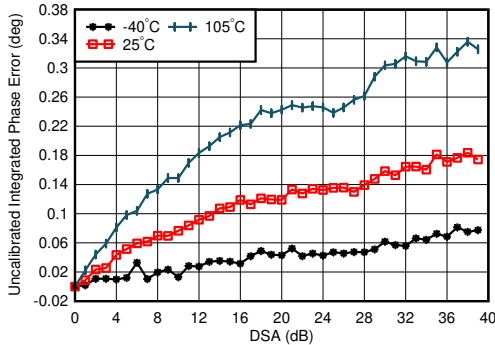
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-56. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 1.8 GHz



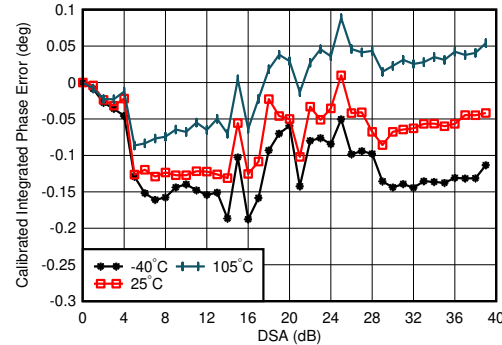
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-57. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 1.8 GHz



$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-58. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8 GHz

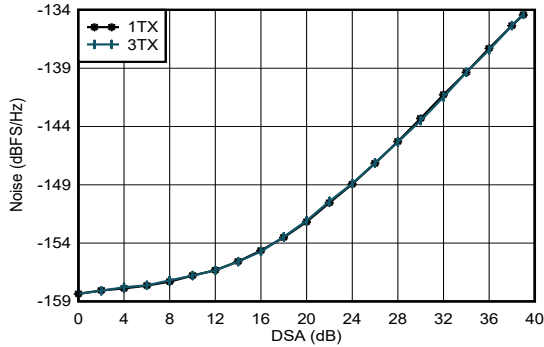


$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-59. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 1.8 GHz

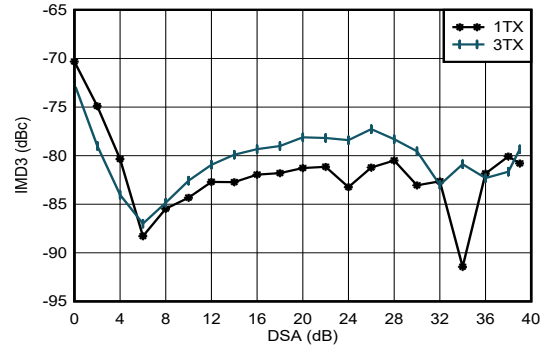
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



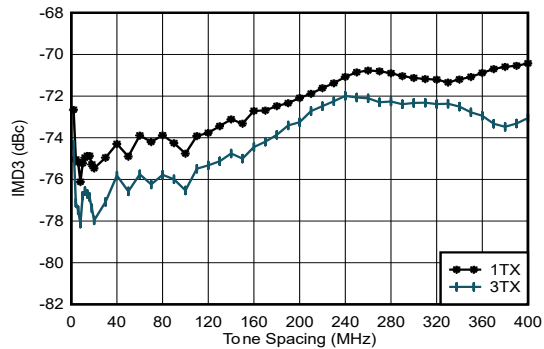
$f_{\text{DAC}} = 5898.24$ MSPS, interleave mode, matching at 1.8 GHz, $P_{\text{OUT}} = -13$ dBFS

Figure 4-60. TX Output Noise vs Channel and Attenuation at 1.8 GHz



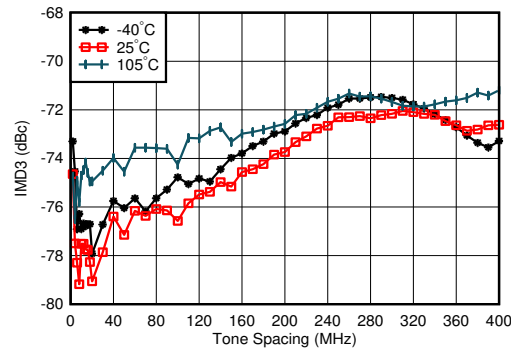
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 1.8$ GHz, matching at 1.8 GHz, -13 dBFS each tone

Figure 4-61. TX IMD3 vs DSA Setting at 1.8 GHz



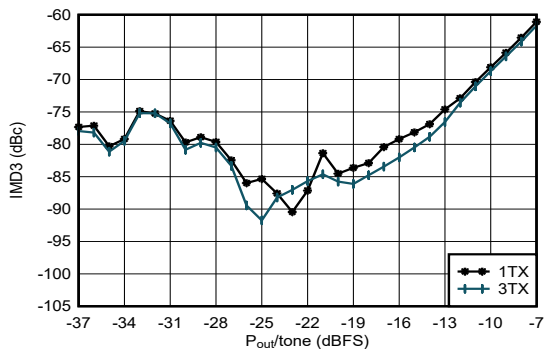
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 1.8$ GHz, matching at 1.8 GHz, -13 dBFS each tone

Figure 4-62. TX IMD3 vs Tone Spacing and Channel at 1.8 GHz



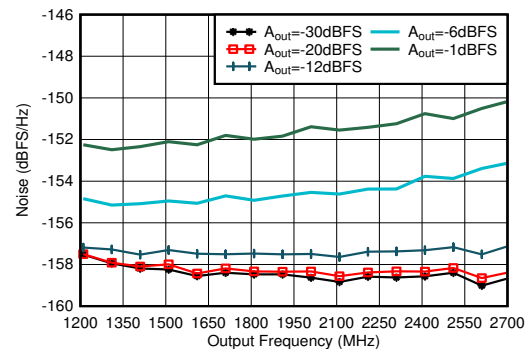
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 1.8$ GHz, matching at 1.8 GHz, -13 dBFS each tone, worst channel

Figure 4-63. TX IMD3 vs Tone Spacing and Temperature at 1.8 GHz



$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, $f_{\text{CENTER}} = 1.8$ GHz, $f_{\text{SPACING}} = 20$ MHz, matching at 1.8 GHz

Figure 4-64. TX IMD3 vs Digital Level at 1.8 GHz

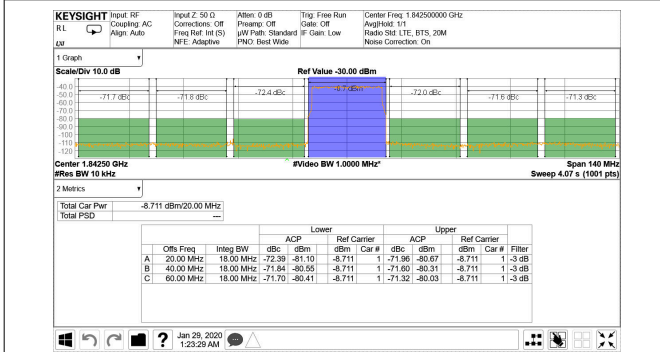


Matching at 2.6 GHz, Single tone, $f_{\text{DAC}} = 11.79648$ GSPPS, interleave mode, 40-MHz offset

Figure 4-65. TX Single Tone Output Noise vs Frequency and Amplitude at 1.8 GHz

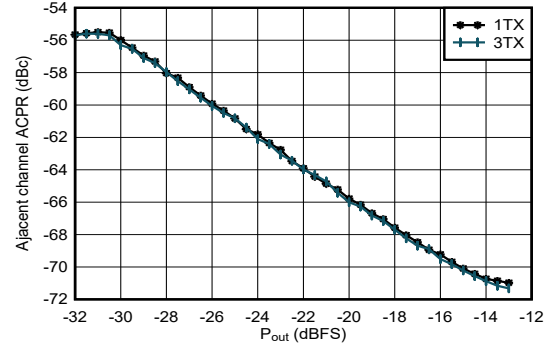
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



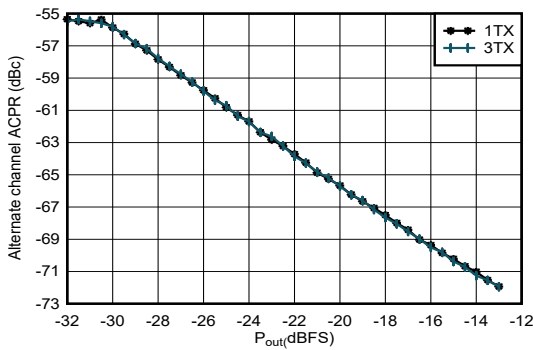
TM1.1, $P_{\text{OUT_RMS}} = -13$ dBFS

Figure 4-66. TX 20-MHz LTE Output Spectrum at 1.8425 GHz



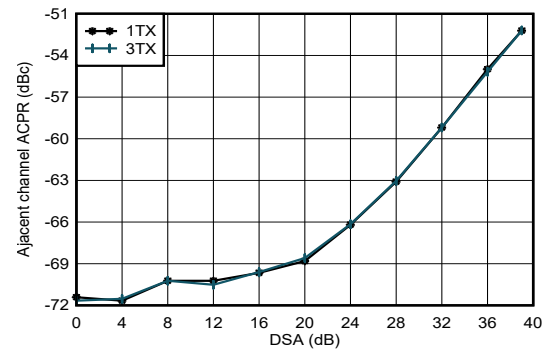
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-67. TX 20-MHz LTE ACPR vs Digital Level at 1.8425 GHz



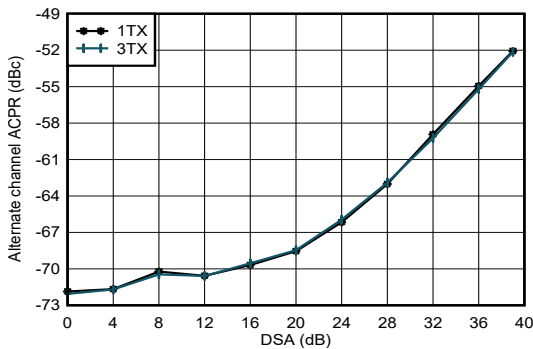
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-68. TX 20-MHz LTE alt-ACPR vs Digital Level at 1.8425 GHz



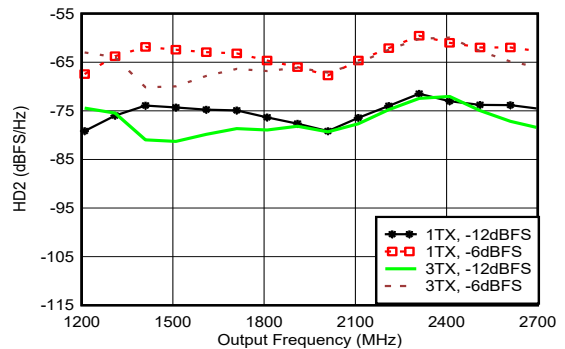
Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-69. TX 20-MHz LTE ACPR vs DSA at 1.8 GHz



Matching at 1.8 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-70. TX 20-MHz LTE alt-ACPR vs DSA at 1.8 GHz

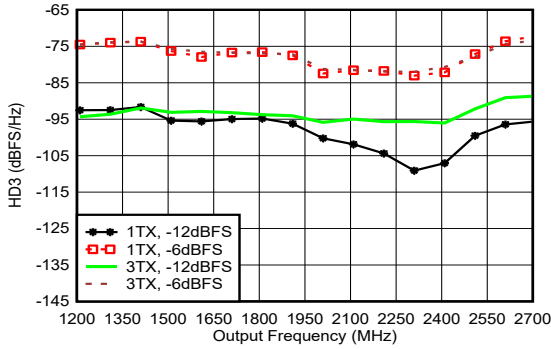


Matching at 1.8 GHz, $f_{\text{DAC}} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-71. TX HD2 vs Digital Amplitude and Output Frequency at 1.8 GHz

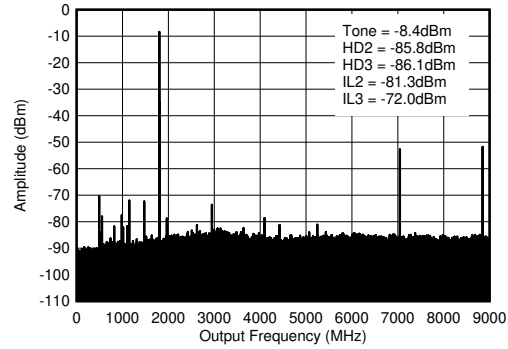
4.12.2 TX Typical Characteristics at 1.8 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



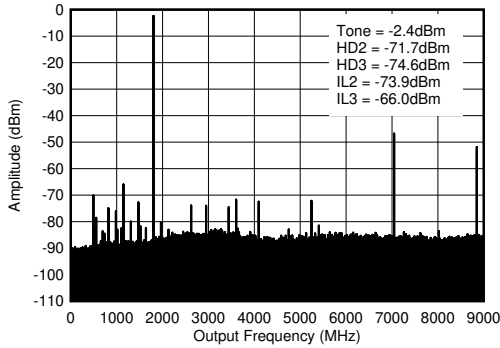
Matching at 1.8 GHz, $f_{DAC} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-72. TX HD3 vs Digital Amplitude and Output Frequency at 1.8 GHz



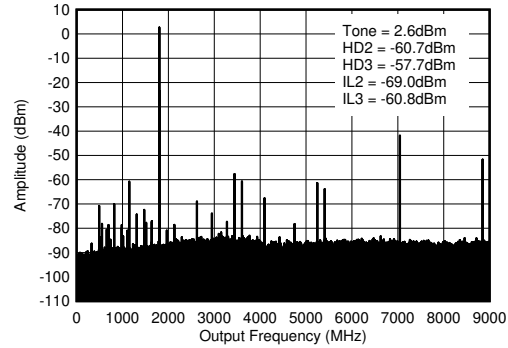
$f_{DAC} = 8847.36$ MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. $IL_n = f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-73. TX Single Tone (-12 dBFS) Output Spectrum at 1.8 GHz ($0-f_{DAC}$)



$f_{DAC} = 8847.36$ MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. $IL_n = f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-74. TX Single Tone (-6 dBFS) Output Spectrum at 1.8 GHz ($0-f_{DAC}$)

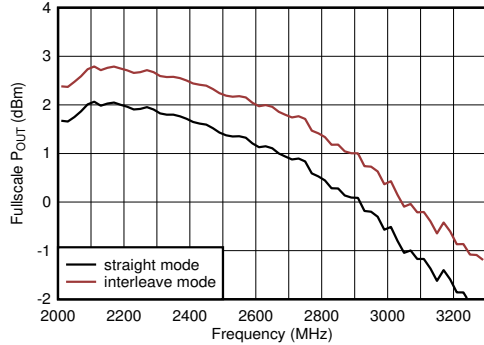


$f_{DAC} = 8847.36$ MSPS, straight mode, 1.8 GHz matching, includes PCB and cable losses. $IL_n = f_S/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-75. TX Single Tone (-1 dBFS) Output Spectrum at 1.8 GHz ($0-f_{DAC}$)

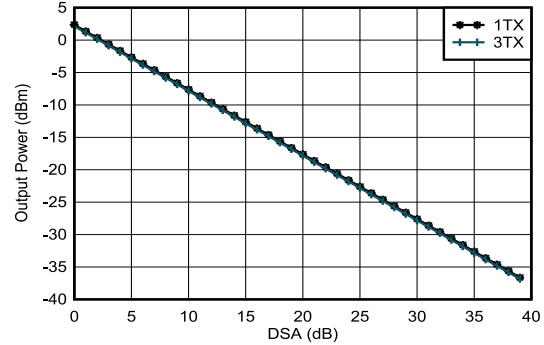
4.12.3 TX Typical Characteristics at 2.6 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



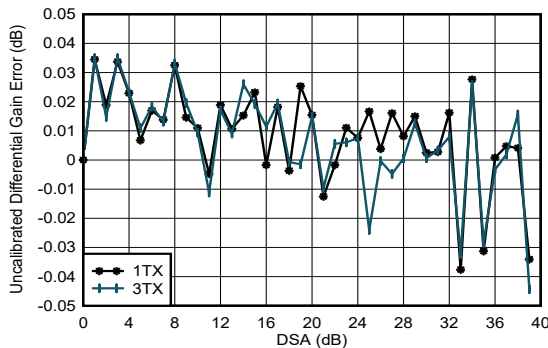
Including PCB and cable losses, $A_{\text{out}} = -0.5$ dBFS, DSA = 0, 2.6 GHz matching

Figure 4-76. TX Full Scale vs RF Frequency at 11796.48 MSPS



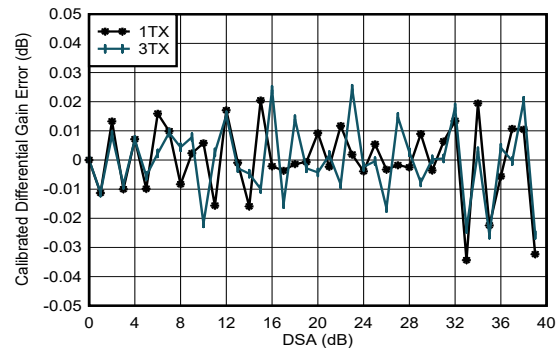
$f_{\text{DAC}} = 8847.36$ MSPS, $A_{\text{out}} = -0.5$ dBFS, matching 2.6 GHz

Figure 4-77. TX Output Power vs DSA Setting and Channel at 2.6 GHz



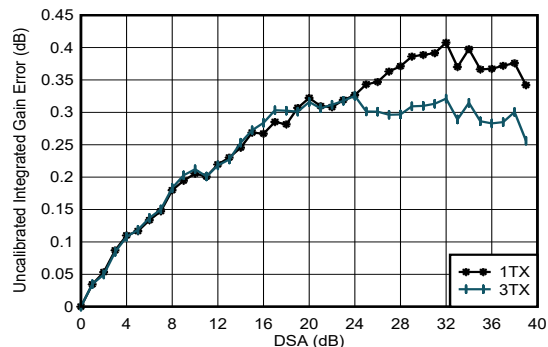
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-78. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 2.6 GHz



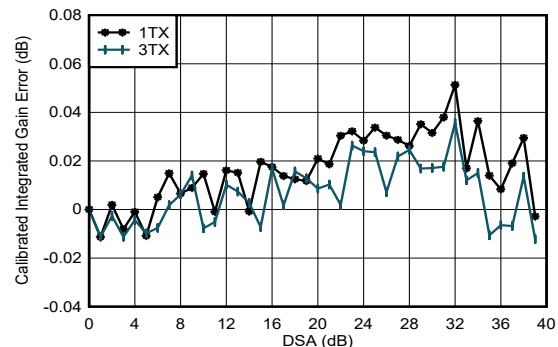
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-79. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 2.6 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-80. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 2.6 GHz

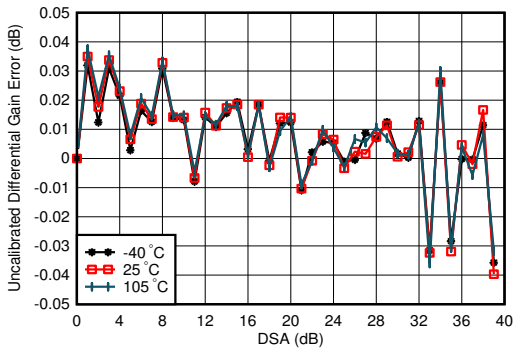


$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-81. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 2.6 GHz

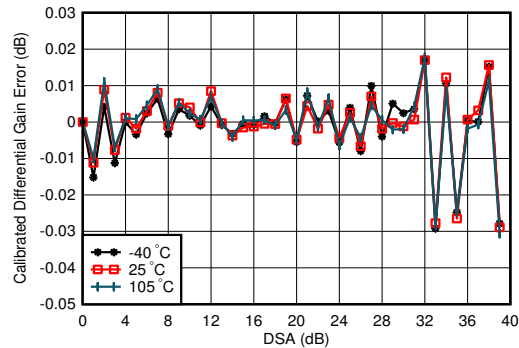
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



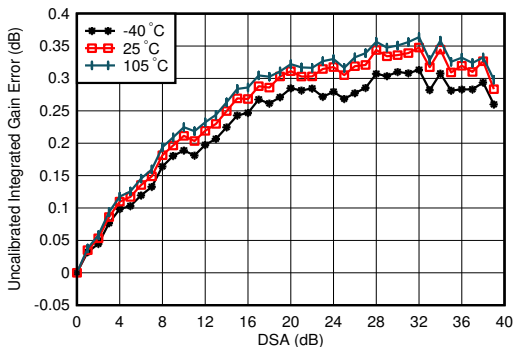
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-82. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 2.6 GHz



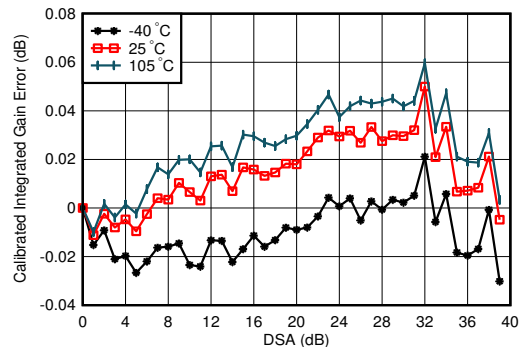
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-83. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 2.6 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-84. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6 GHz

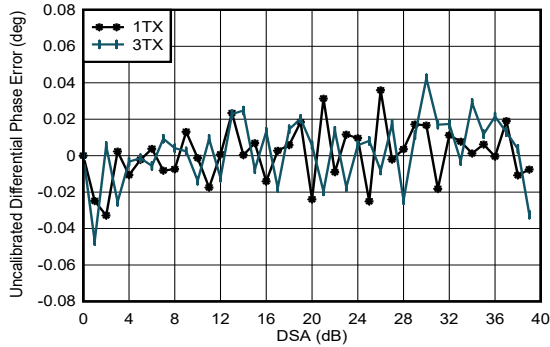


$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-85. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 2.6 GHz

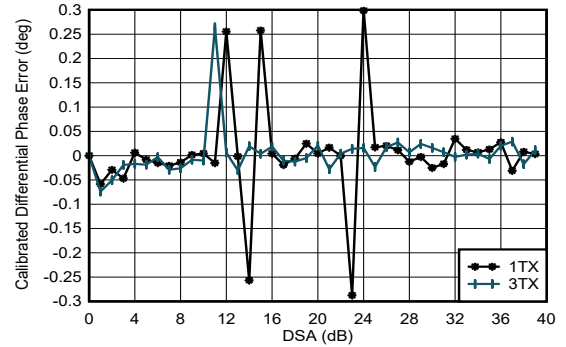
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



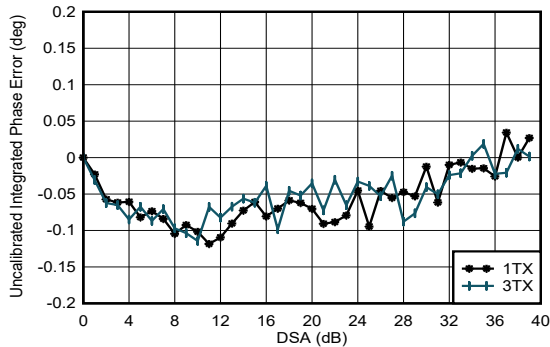
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-86. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 2.6 GHz



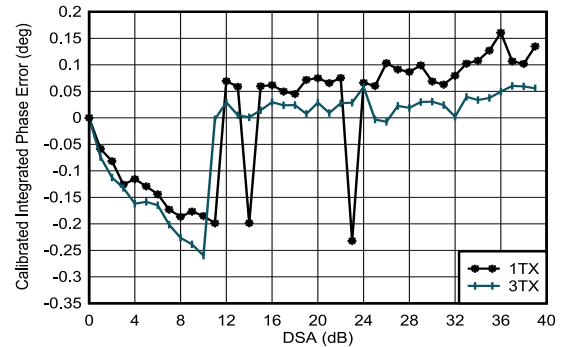
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
Phase DNL spike may occur at any DSA setting.

Figure 4-87. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 2.6 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-88. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 2.6 GHz

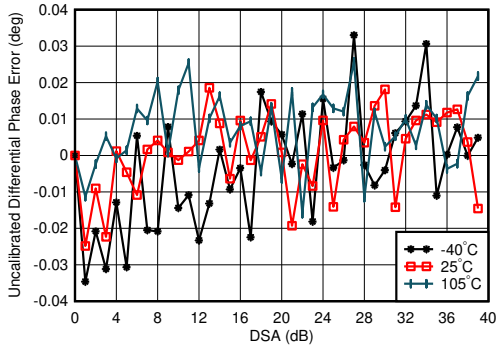


$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-89. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 2.6 GHz

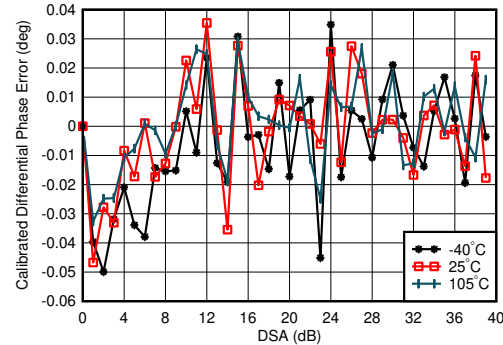
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



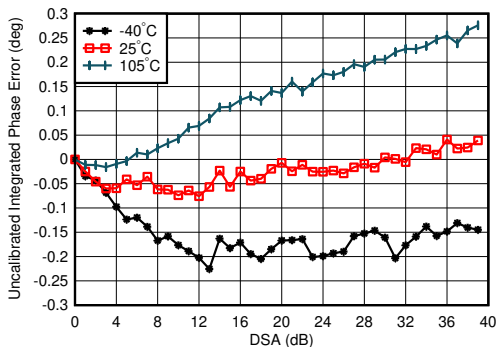
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-90. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 2.6 GHz



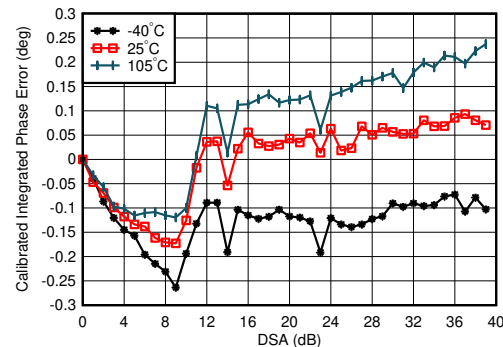
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-91. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 2.6 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the medium variation over DSA setting at 25°C
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-92. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6 GHz

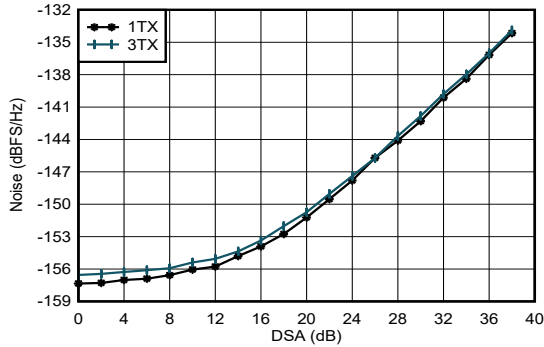


$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, channel with the median variation over DSA setting at 25°C
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-93. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 2.6 GHz

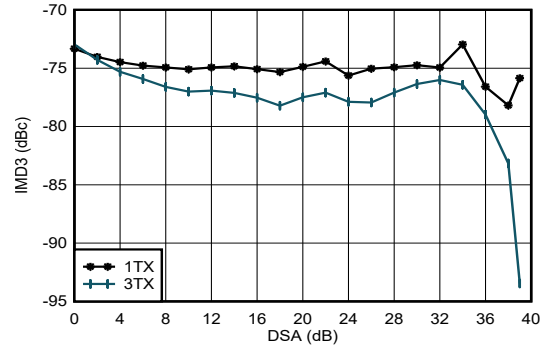
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



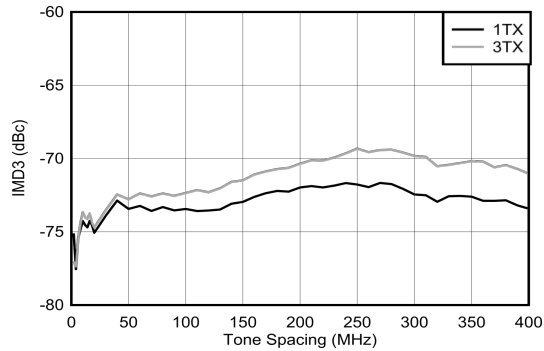
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, matching at 2.6 GHz, $P_{\text{OUT}} = -13$ dBFS

Figure 4-94. TX Output Noise vs Channel and Attenuation at 2.6 GHz



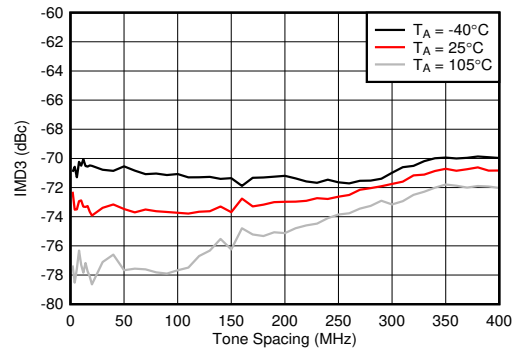
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 2.6$ GHz, matching at 2.6 GHz, -13 dBFS each tone

Figure 4-95. TX IMD3 vs DSA Setting at 2.6 GHz



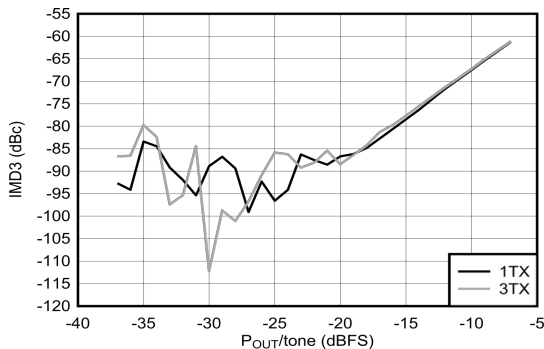
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 2.6$ GHz, matching at 2.6 GHz, -13 dBFS each tone

Figure 4-96. TX IMD3 vs Tone Spacing and Channel at 2.6 GHz



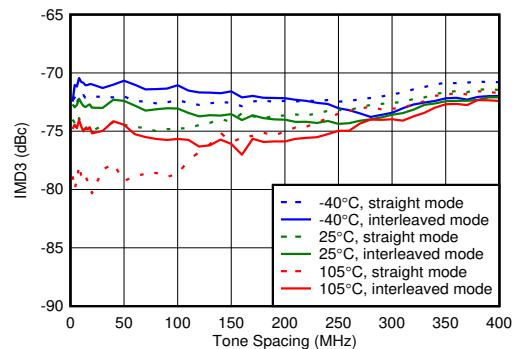
$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 2.6$ GHz, matching at 2.6 GHz, -13 dBFS each tone, worst channel.

Figure 4-97. TX IMD3 vs Tone Spacing and Temperature at 2.6 GHz



$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 2.6$ GHz, $f_{\text{SPACING}} = 20$ MHz, matching at 2.6 GHz

Figure 4-98. TX IMD3 vs Digital Level at 2.6 GHz

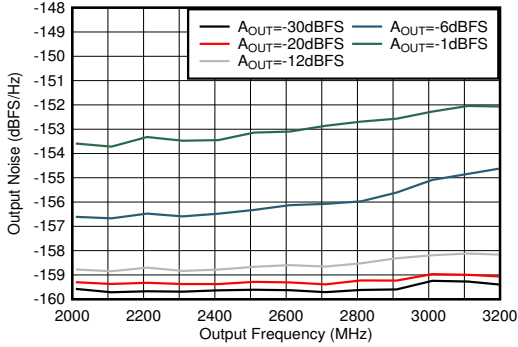


$f_{\text{DAC}} = 8847.36$ MSPS, straight mode, $f_{\text{CENTER}} = 2.6$ GHz, matching at 2.6 GHz, -13 dBFS each tone

Figure 4-99. TX IMD3 vs Tone Spacing and Temperature

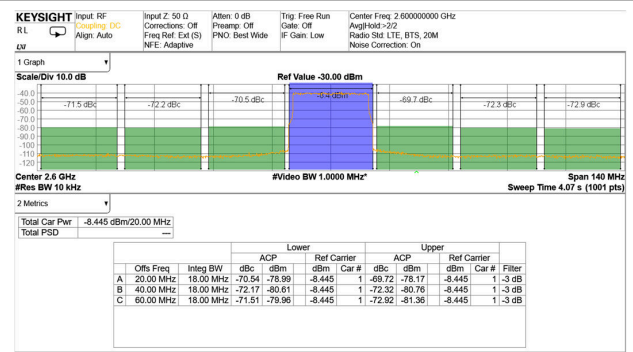
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



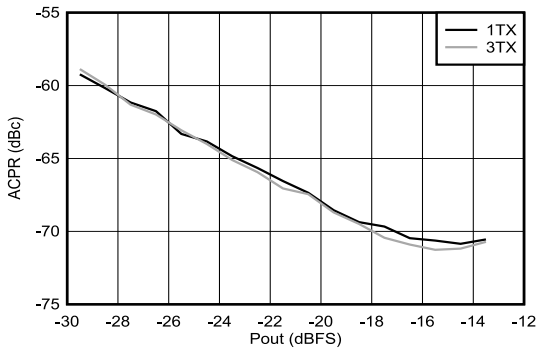
Matching at 2.6 GHz, Single tone, $f_{DAC} = 11.79648\text{GS}$, interleave mode, 40-MHz offset

Figure 4-100. TX Single Tone Output Noise vs Frequency and Amplitude at 2.6 GHz



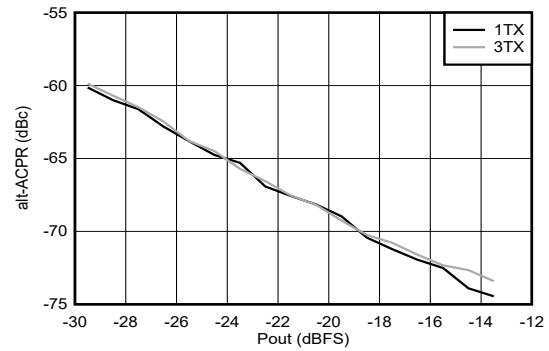
TM1.1, $P_{OUT_RMS} = -13$ dBFS

Figure 4-101. TX 20-MHz LTE Output Spectrum at 2.6 GHz (Band 41)



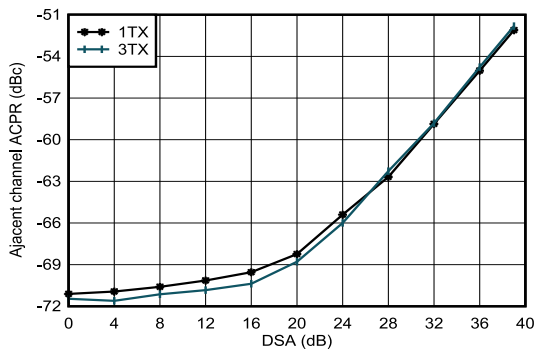
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-102. TX 20-MHz LTE ACPR vs Digital Level at 2.6 GHz



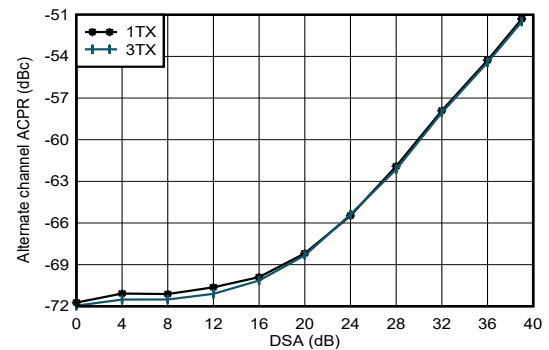
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-103. TX 20-MHz LTE alt-ACPR vs Digital Level at 2.6 GHz



Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-104. TX 20-MHz LTE ACPR vs DSA at 2.6 GHz

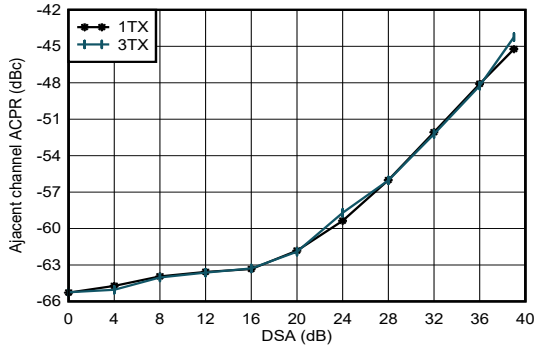


Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-105. TX 20-MHz LTE alt-ACPR vs DSA at 2.6 GHz

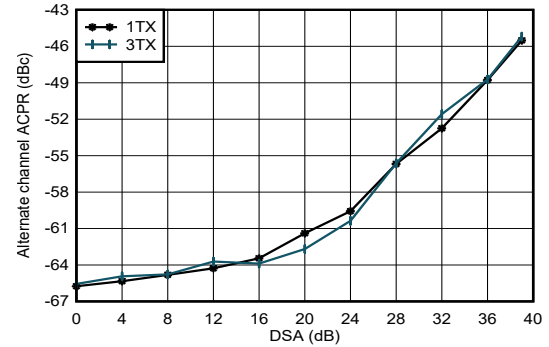
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



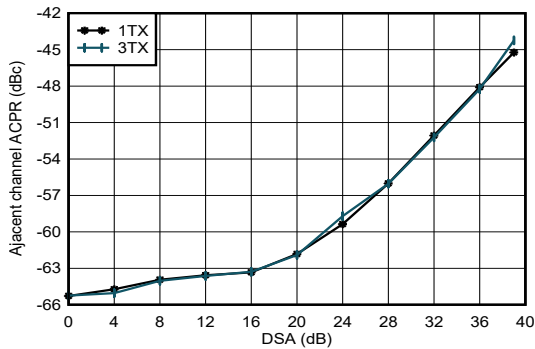
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-106. TX 20-MHz LTE ACPR vs DSA at 2.6 GHz



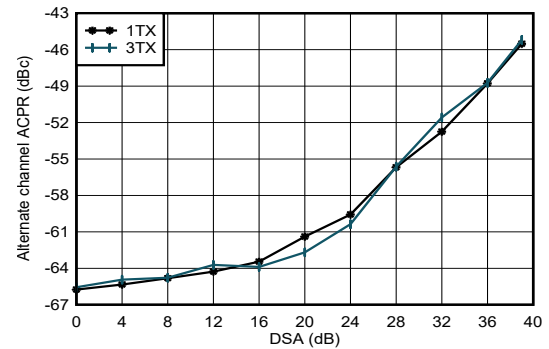
Matching at 2.6 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-107. TX 20-MHz LTE alt-ACPR vs DSA at 2.6 GHz



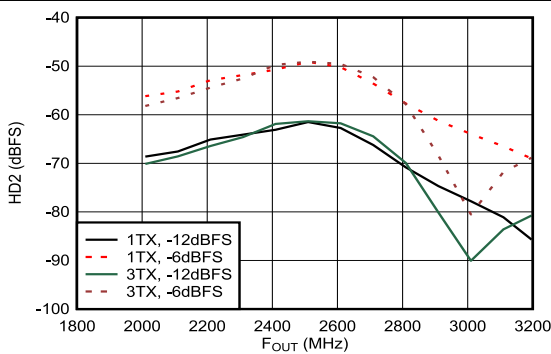
Matching at 2.6 GHz, single carrier 100-MHz BW TM1.1 NR

Figure 4-108. TX 100-MHz NR ACPR vs DSA at 2.6 GHz



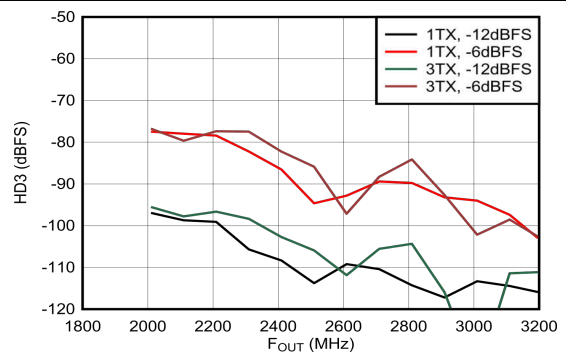
Matching at 2.6 GHz, single carrier 100-MHz BW TM1.1 NR

Figure 4-109. TX 100-MHz NR alt-ACPR vs DSA at 2.6 GHz



Matching at 2.6 GHz, $f_{\text{DAC}} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-110. TX HD2 vs Digital Amplitude and Output Frequency at 2.6 GHz

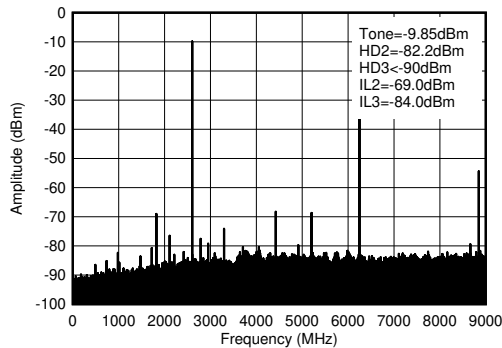


Matching at 2.6 GHz, $f_{\text{DAC}} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-111. TX HD3 vs Digital Amplitude and Output Frequency at 2.6 GHz

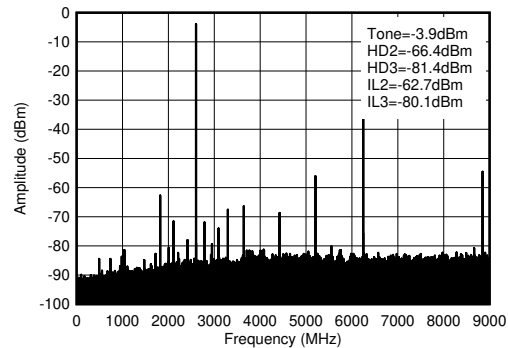
4.12.3 TX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



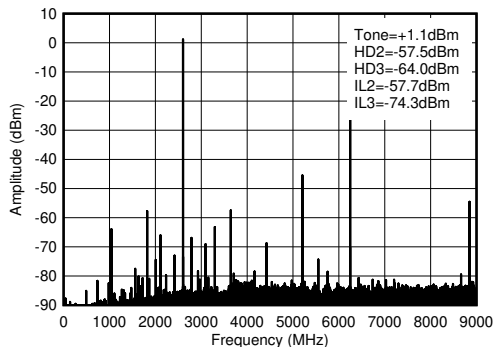
$f_{DAC} = 8847.36$ MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-112. TX Single Tone (-12 dBFS) Output Spectrum at 2.6 GHz ($0-f_{DAC}$)



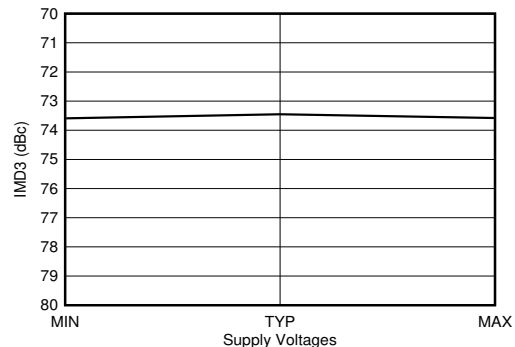
$f_{DAC} = 8847.36$ MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-113. TX Single Tone (-6 dBFS) Output Spectrum at 2.6 GHz ($0-f_{DAC}$)



$f_{DAC} = 8847.36$ MSPS, straight mode, 2.6 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$ and is due to mixing with digital clocks.

Figure 4-114. TX Single Tone (-1 dBFS) Output Spectrum at 2.6 GHz ($0-f_{DAC}$)

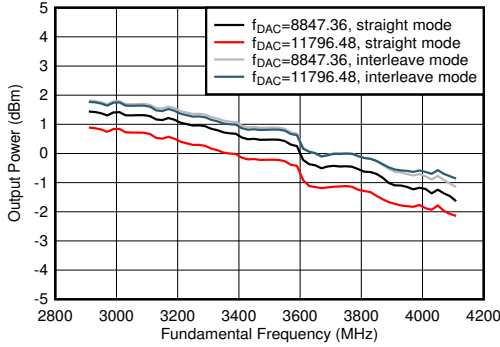


$f_{DAC} = 11796.48$ MSPS, interleave mode, 2.6 GHz matching. 40-MHz offset from tone. Output Power = -13 dBFS. All supplies simultaneously at MIN, TYP, or MAX voltages.

Figure 4-115. TX IMD3 vs Supply Voltage at 2.6 GHz

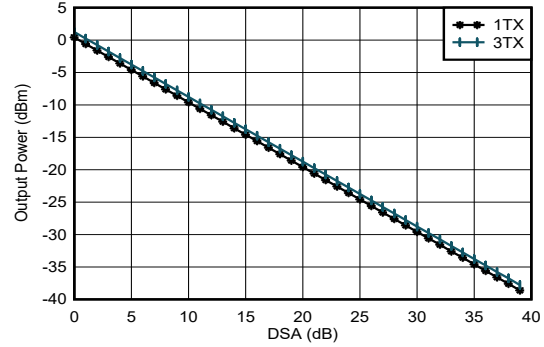
4.12.4 TX Typical Characteristics at 3.5 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



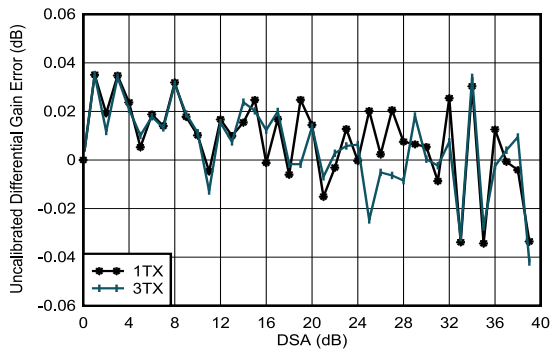
$A_{\text{out}} = -0.5\text{dBFS}$, 3.5 GHz Matching, included PCB and cable losses

Figure 4-116. TX Output Power vs Frequency



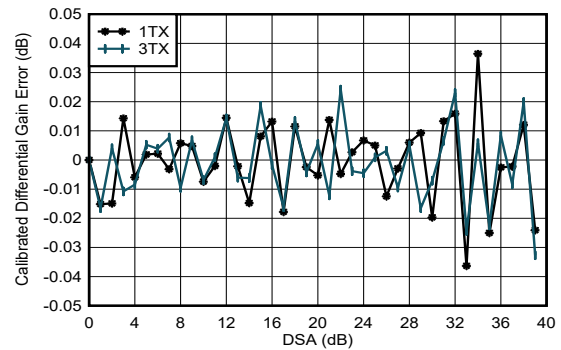
$A_{\text{out}} = -0.5$ dBFS, 3.5 GHz Matching, included PCB and cable losses

Figure 4-117. TX Output Power vs DSA Setting at 3.5 GHz



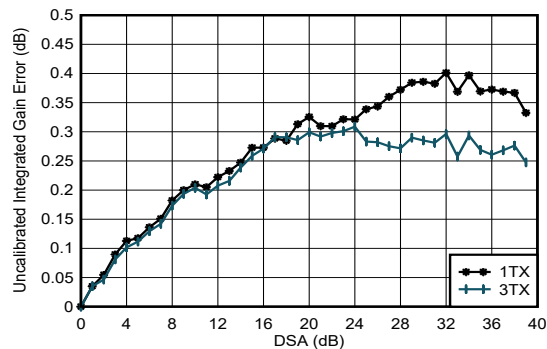
3.5 GHz Matching, included PCB and cable losses
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-118. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 3.5 GHz



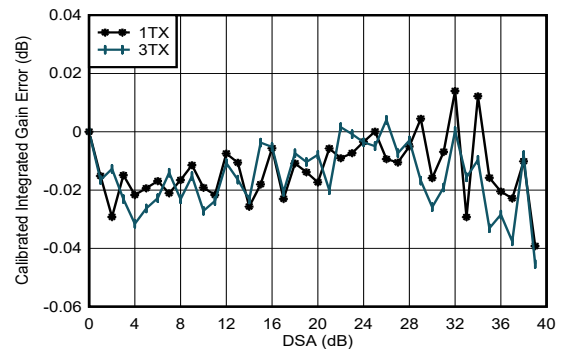
3.5 GHz Matching, included PCB and cable losses
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-119. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 3.5 GHz



3.5 GHz Matching, included PCB and cable losses
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-120. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 3.5 GHz

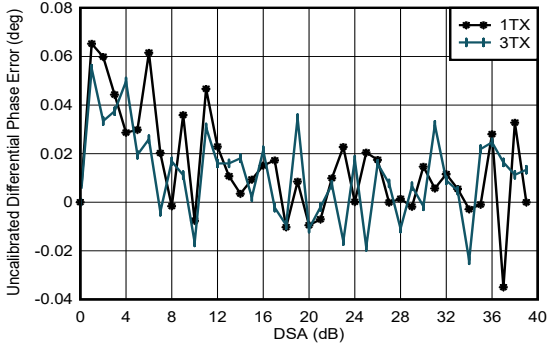


3.5 GHz Matching, included PCB and cable losses
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-121. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 3.5 GHz

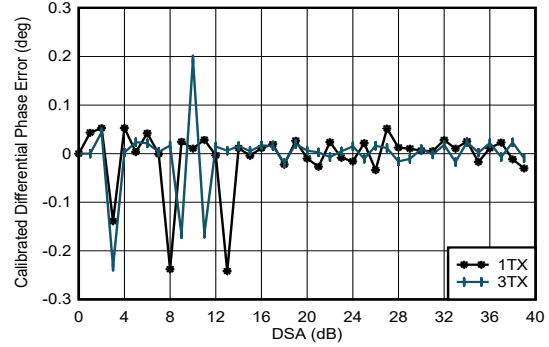
4.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



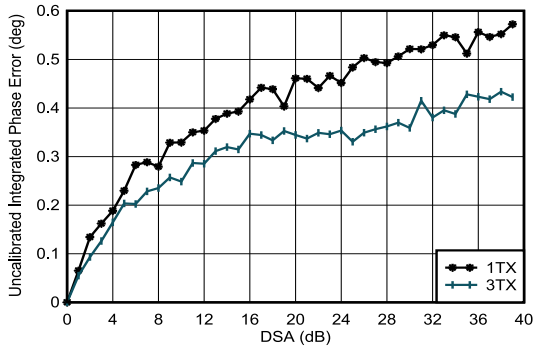
3.5 GHz Matching, included PCB and cable losses

Figure 4-122. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 3.5 GHz



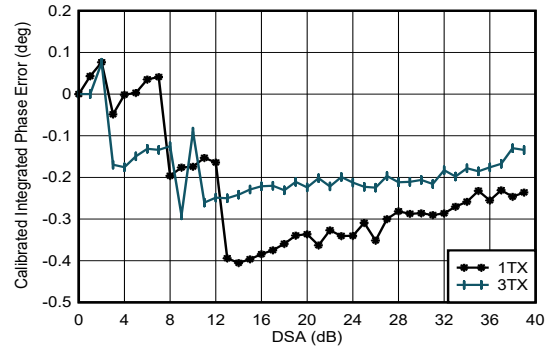
3.5 GHz Matching, included PCB and cable losses
Phase DNL spike may occur at any DSA setting.

Figure 4-123. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 3.5 GHz



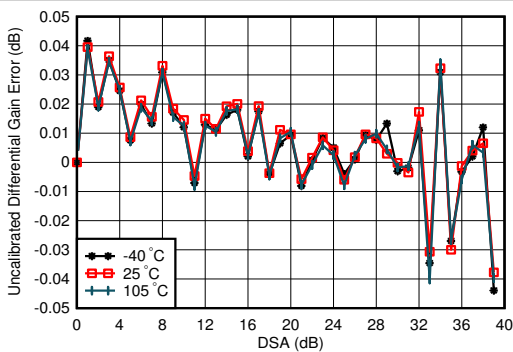
3.5 GHz Matching, included PCB and cable losses

Figure 4-124. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 3.5 GHz



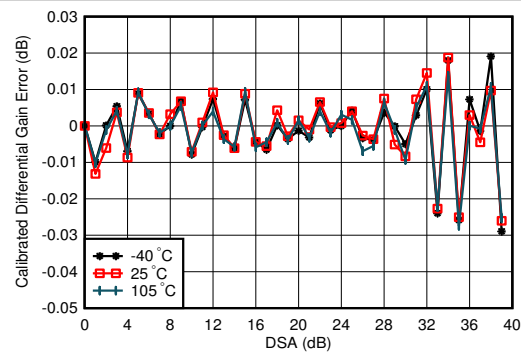
3.5 GHz Matching, included PCB and cable losses

Figure 4-125. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 3.5 GHz



3.5 GHz Matching, 1TX

Figure 4-126. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 3.5 GHz

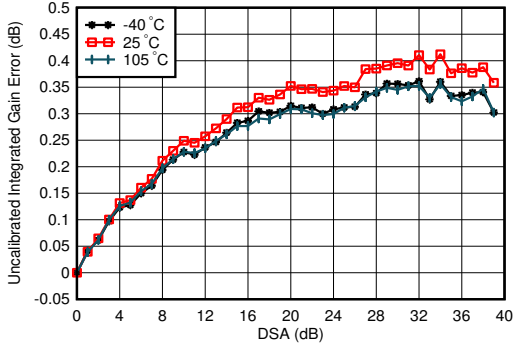


3.5 GHz Matching, 1TX, Calibrated at 25°C

Figure 4-127. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 3.5 GHz

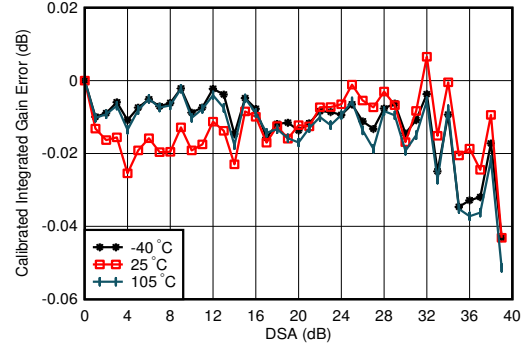
4.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



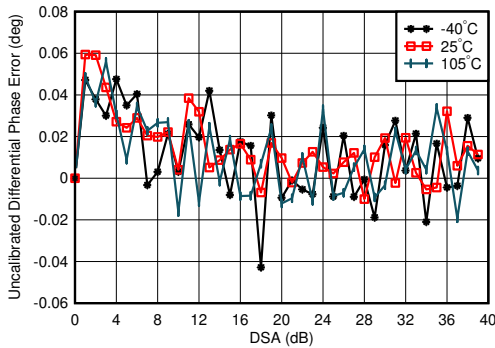
3.5 GHz Matching, 1TX

Figure 4-128. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX, Calibrated at 25°C

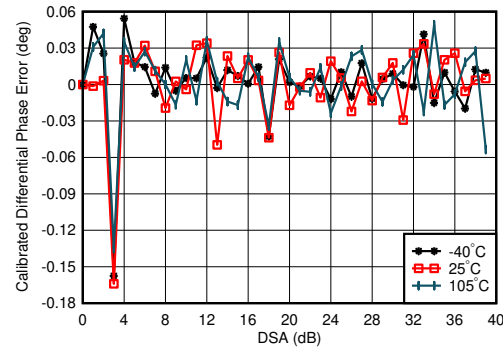
Figure 4-129. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX

$$\text{Differential Phase Error} = \text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$$

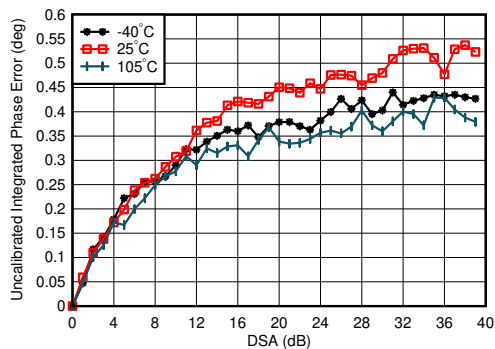
Figure 4-130. TX Uncalibrated Differential Phase Error vs DSA setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX, Calibrated at 25°C

$$\text{Differential Phase Error} = \text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$$

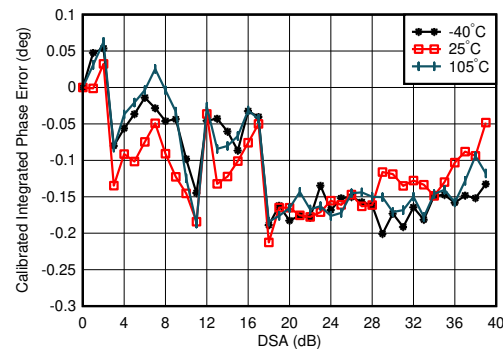
Figure 4-131. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 3.5 GHz



3.5 GHz Matching, 1TX

$$\text{Integrated Phase Error} = \text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$$

Figure 4-132. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5 GHz



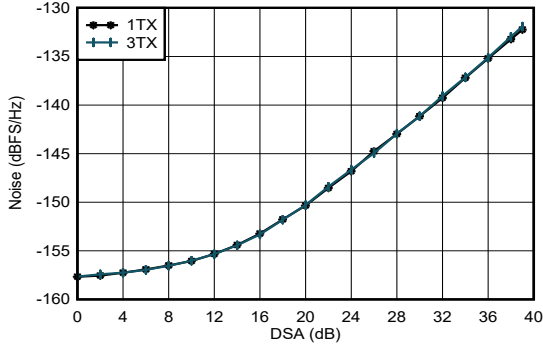
3.5 GHz Matching, 1TX, Calibrated at 25°C

$$\text{Integrated Phase Error} = \text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$$

Figure 4-133. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 3.5 GHz

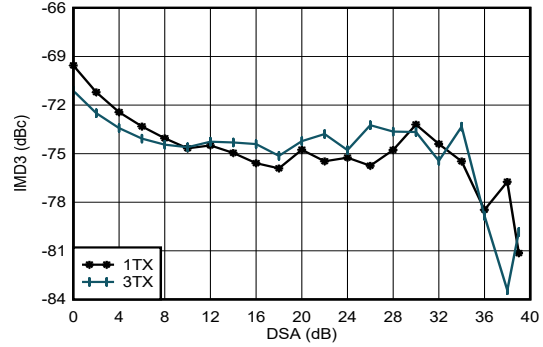
4.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



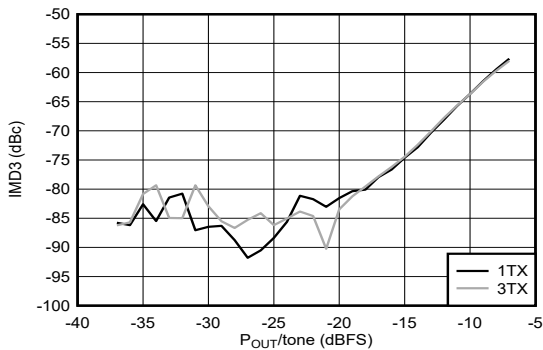
A. $f_{DAC} = 11796.48$ MSPS, interleave mode, matching at 3.5 GHz, $A_{out} = -13$ dBFS.

Figure 4-134. TX NSD vs DSA Setting at 3.5 GHz



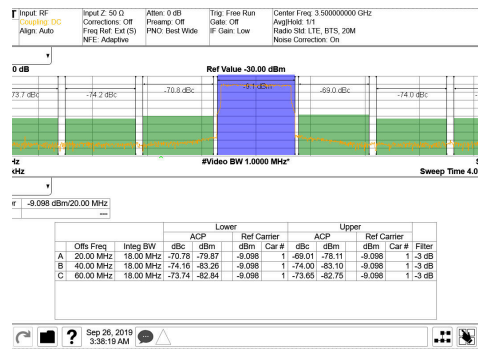
20-MHz tone spacing, 3.5 GHz Matching, -13 dBFS each tone, included PCB and cable losses

Figure 4-135. TX IMD3 vs DSA Setting at 3.5 GHz



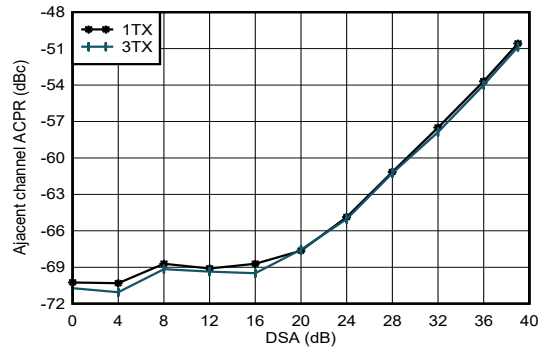
20-MHz tone spacing, 3.5 GHz Matching

Figure 4-136. TX IMD3 vs Digital Amplitude and Channel at 3.5 GHz



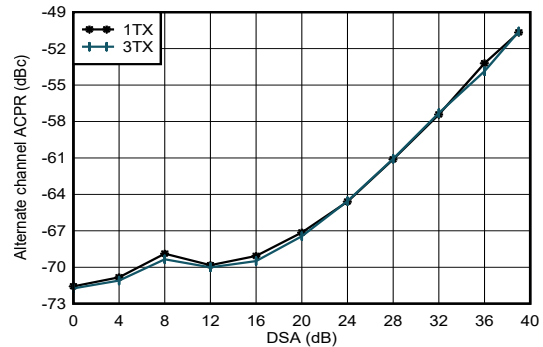
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

Figure 4-137. TX 20-MHz LTE Output Spectrum at 3.5 GHz (Band 42)



3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

Figure 4-138. TX 20-MHz LTE ACPR vs DSA Setting at 3.5 GHz

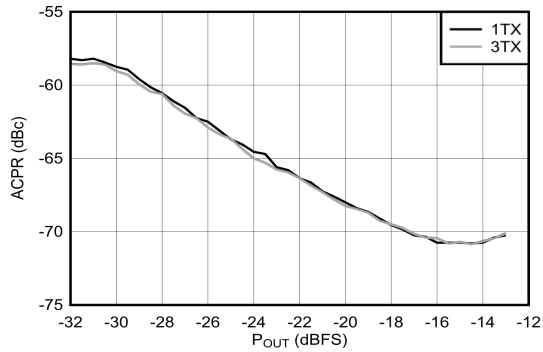


3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

Figure 4-139. TX 20-MHz LTE alt-ACPR vs DSA Setting at 3.5 GHz

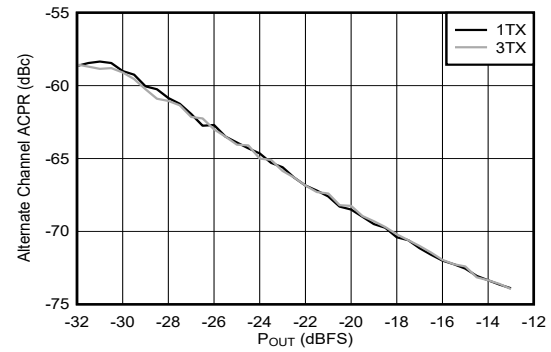
4.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



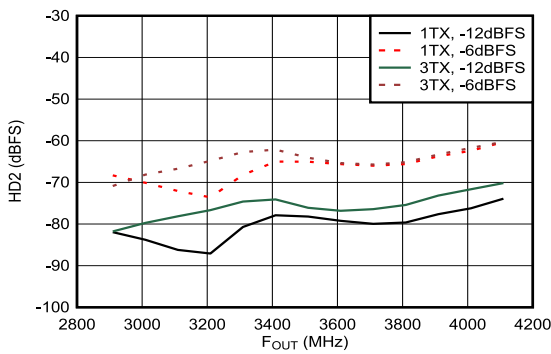
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

Figure 4-140. TX 20-MHz LTE ACPR vs Digital Level at 3.5 GHz



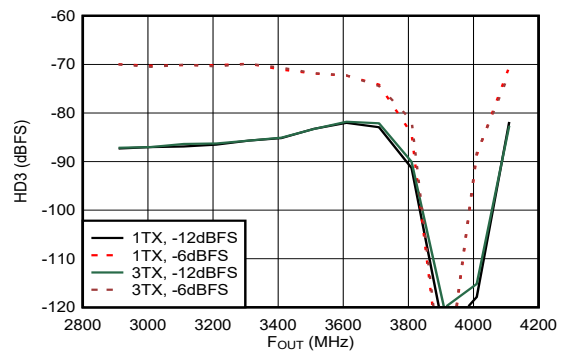
3.5 GHz Matching, single carrier 20-MHz BW TM1.1 LTE

Figure 4-141. TX 20-MHz LTE alt-ACPR vs Digital Level at 3.5 GHz



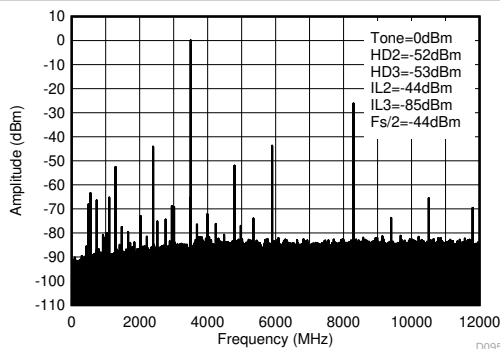
Matching at 3.5 GHz, $f_{DAC} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-142. TX Single Tone HD2 vs Frequency and Digital Level at 3.5 GHz



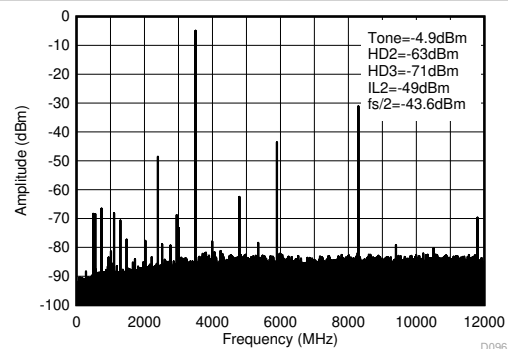
Matching at 3.5 GHz, $f_{DAC} = 11.79648$ GSPS, interleave mode, normalized to output power at harmonic frequency. Dip is due to HD3 falling near DC.

Figure 4-143. TX Single Tone HD3 vs Frequency and Digital Level at 3.5 GHz



Matching at 3.5 GHz, $f_{DAC} = 11.79648$ GSPS, interleave mode.

Figure 4-144. TX Single Tone (-1 dBFS) Output Spectrum at 3.5 GHz (0 - f_{DAC})

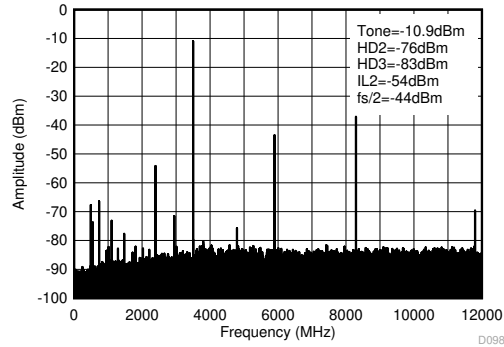


Matching at 3.5 GHz, $f_{DAC} = 11.79648$ GSPS, interleave mode.

Figure 4-145. TX Single Tone (-6 dBFS) Output Spectrum at 3.5 GHz (0 - f_{DAC})

4.12.4 TX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled

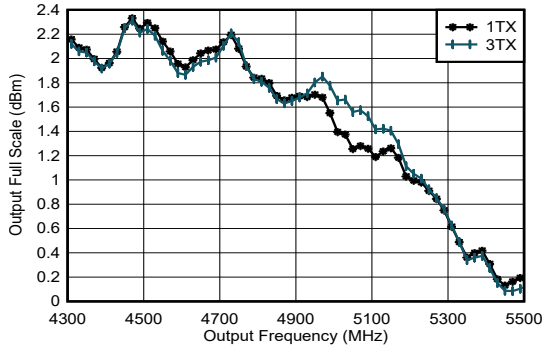


Matching at 3.5 GHz, $f_{\text{DAC}} = 11.79648$ GSPS, interleave mode.

Figure 4-146. TX Single Tone (-12 dBFS) Output Spectrum at 3.5 GHz (0- f_{DAC})

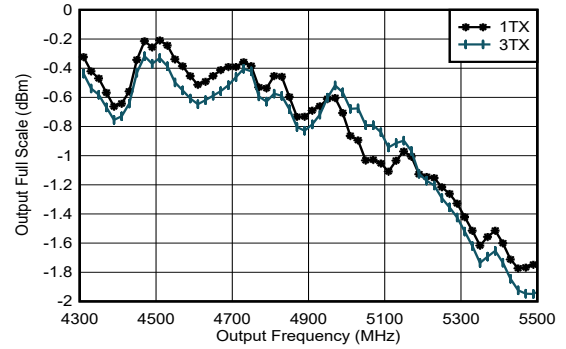
4.12.5 TX Typical Characteristics at 4.9 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



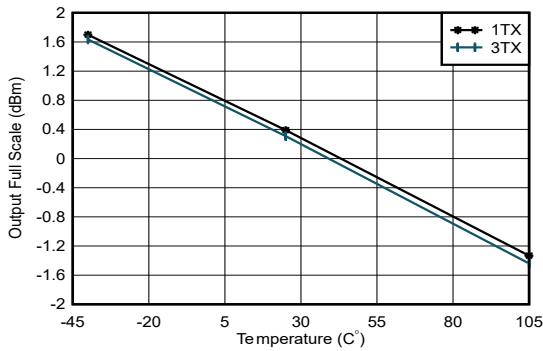
Excluding PCB and cable losses, $A_{\text{out}} = -0.5$ dBFS, DSA = 0, 4.9 GHz matching

Figure 4-147. TX Full Scale vs RF Frequency and Channel at 11796.48 MSPS



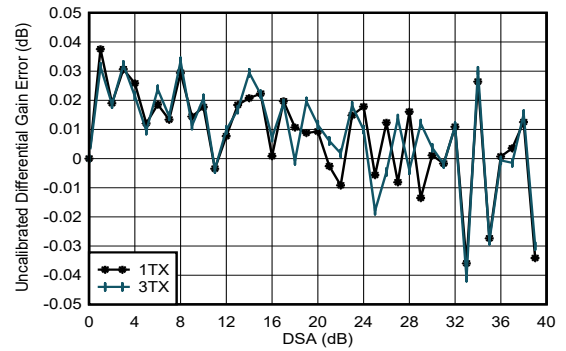
Excluding PCB and cable losses, $A_{\text{out}} = -0.5$ dBFS, DSA = 0, 4.9 GHz matching

Figure 4-148. TX Full Scale vs RF Frequency and Channel at 5898.24 MSPS, Straight Mode, 2nd Nyquist Zone



$f_{\text{DAC}} = 11796.48$ MSPS, $A_{\text{out}} = -0.5$ dBFS, matching 4.9 GHz

Figure 4-149. TX Output Power vs DSA Setting and Channel at 4.9 GHz

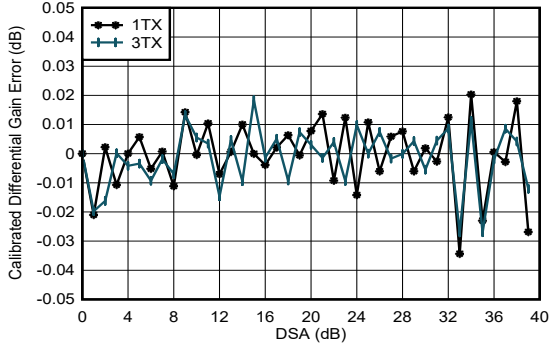


$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, matching at 4.9 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-150. TX Uncalibrated Differential Gain Error vs DSA Setting and Channel at 4.9 GHz

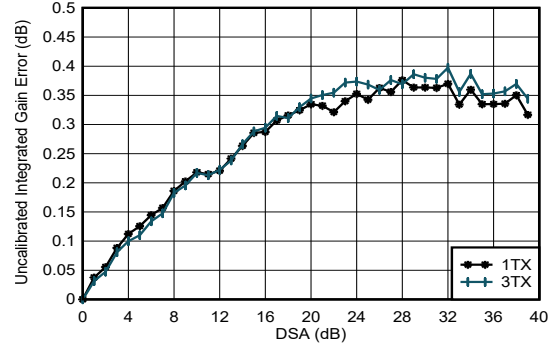
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



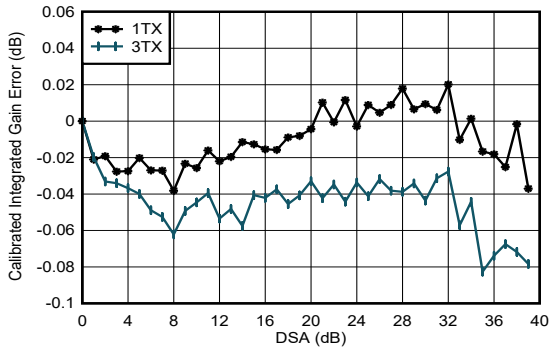
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, matching at 4.9 GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-151. TX Calibrated Differential Gain Error vs DSA Setting and Channel at 4.9 GHz



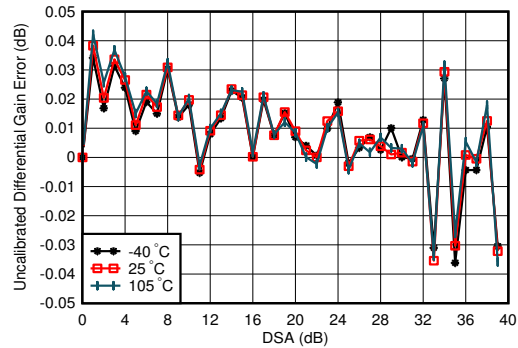
$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, matching at 4.9 GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-152. TX Uncalibrated Integrated Gain Error vs DSA Setting and Channel at 4.9 GHz



$f_{\text{DAC}} = 11796.48$ MSPS, interleave mode, matching at 4.9 GHz
 Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-153. TX Calibrated Integrated Gain Error vs DSA Setting and Channel at 4.9 GHz

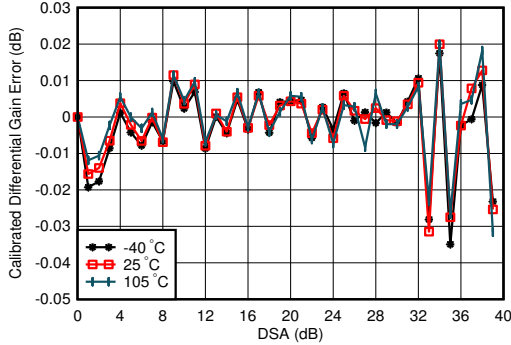


$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
 Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-154. TX Uncalibrated Differential Gain Error vs DSA Setting and Temperature at 4.9 GHz

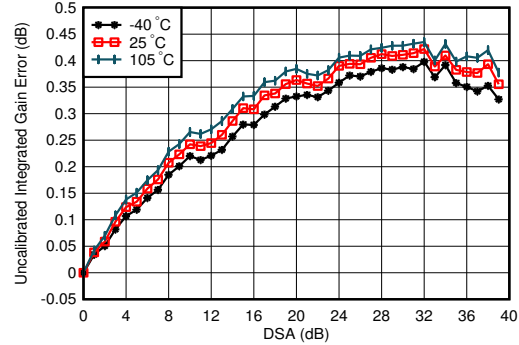
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



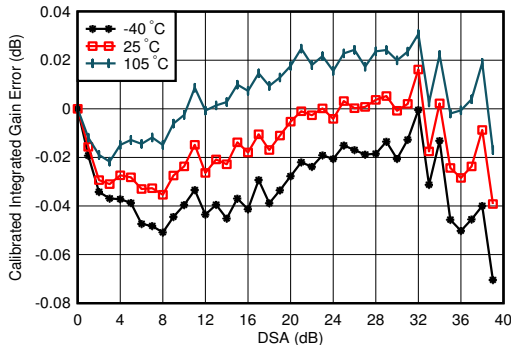
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Differential Gain Error = $P_{\text{OUT}}(\text{DSA Setting} - 1) - P_{\text{OUT}}(\text{DSA Setting}) + 1$

Figure 4-155. TX Calibrated Differential Gain Error vs DSA Setting and Temperature at 4.9 GHz



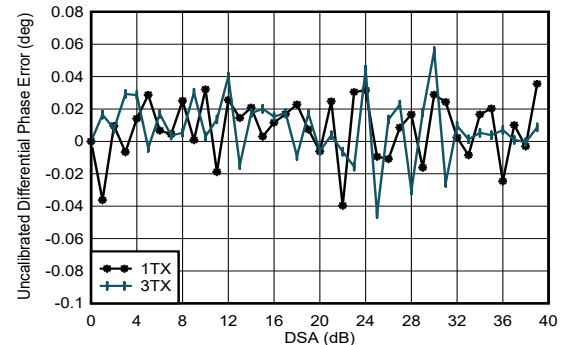
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-156. TX Uncalibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9 GHz



$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Integrated Gain Error = $P_{\text{OUT}}(\text{DSA Setting}) - P_{\text{OUT}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-157. TX Calibrated Integrated Gain Error vs DSA Setting and Temperature at 4.9 GHz

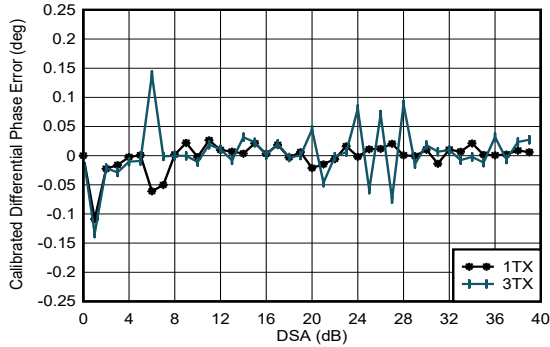


$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-158. TX Uncalibrated Differential Phase Error vs DSA Setting and Channel at 4.9 GHz

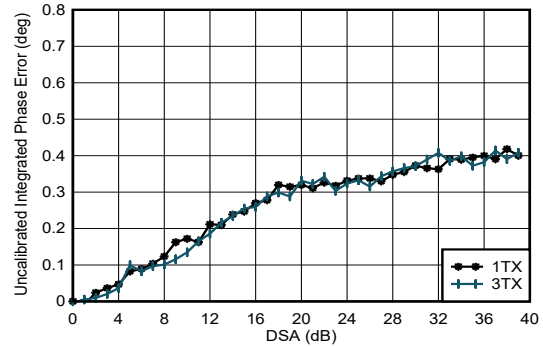
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



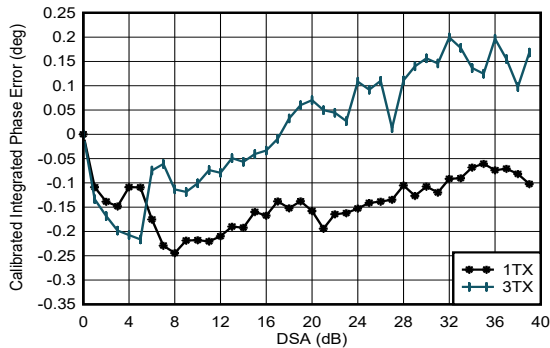
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$
 Phase DNL spike may occur at any DSA setting.

Figure 4-159. TX Calibrated Differential Phase Error vs DSA Setting and Channel at 4.9 GHz



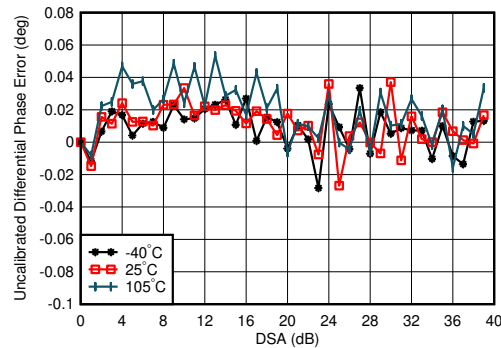
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-160. TX Uncalibrated Integrated Phase Error vs DSA Setting and Channel at 4.9 GHz



$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-161. TX Calibrated Integrated Phase Error vs DSA Setting and Channel at 4.9 GHz

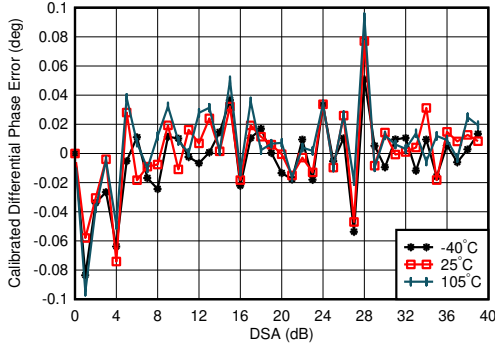


$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
 Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-162. TX Uncalibrated Differential Phase Error vs DSA Setting and Temperature at 4.9 GHz

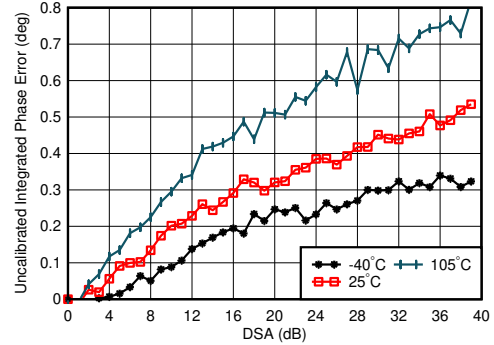
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



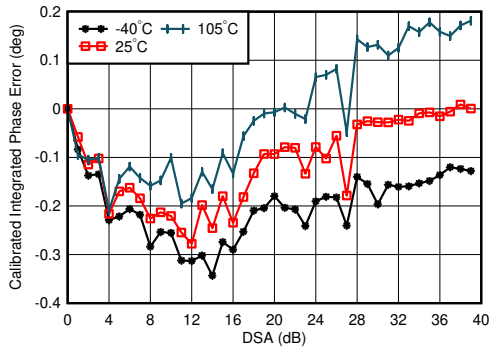
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Differential Phase Error = $\text{Phase}_{\text{OUT}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{OUT}}(\text{DSA Setting})$

Figure 4-163. TX Calibrated Differential Phase Error vs DSA Setting and Temperature at 4.9 GHz



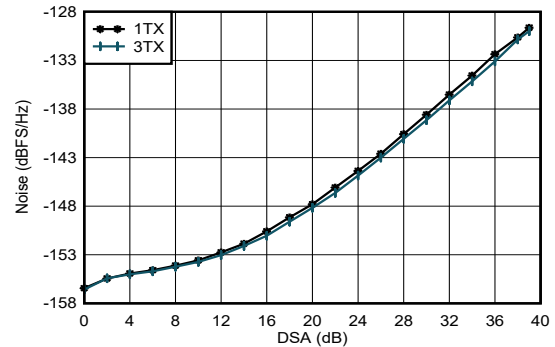
$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-164. TX Uncalibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9 GHz



$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, channel with the median variation over DSA setting at 25°C
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-165. TX Calibrated Integrated Phase Error vs DSA Setting and Temperature at 4.9 GHz

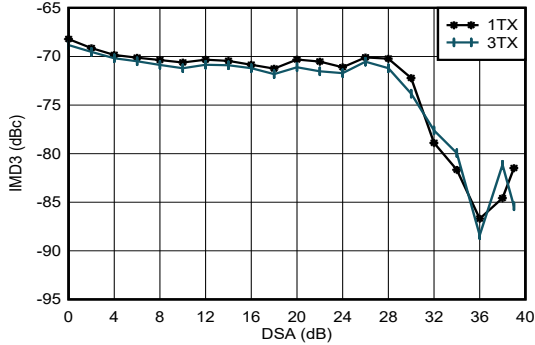


$f_{\text{DAC}} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, $P_{\text{OUT}} = -13$ dBFS

Figure 4-166. TX Output Noise vs Channel and Attenuation at 2.6 GHz

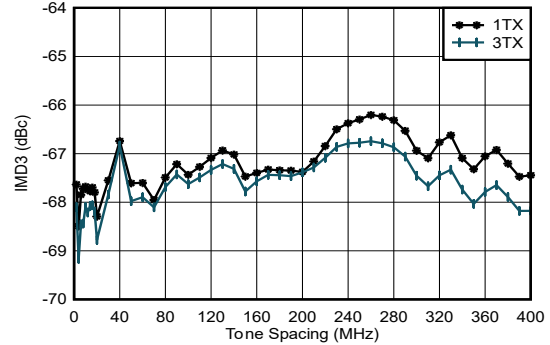
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, $\text{Sin}(x)/x$ enabled, DSA calibrated, TX Clock Dither Enabled



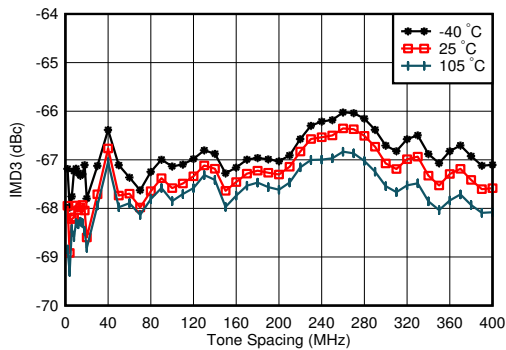
$f_{DAC} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, $f_{CENTER} = 4.9\text{GHz}$, -13 dBFS each tone

Figure 4-167. TX IMD3 vs DSA Setting at 4.9 GHz



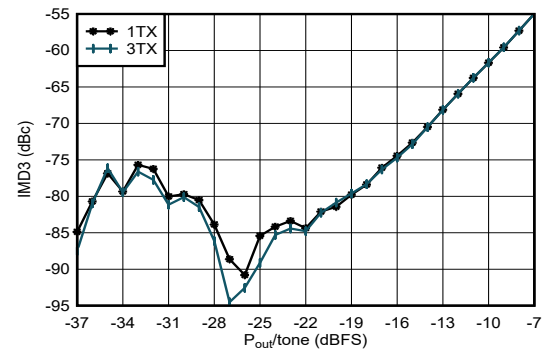
$f_{DAC} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, $f_{CENTER} = 4.9\text{GHz}$, -13 dBFS each tone

Figure 4-168. TX IMD3 vs Tone Spacing and Channel at 4.9 GHz



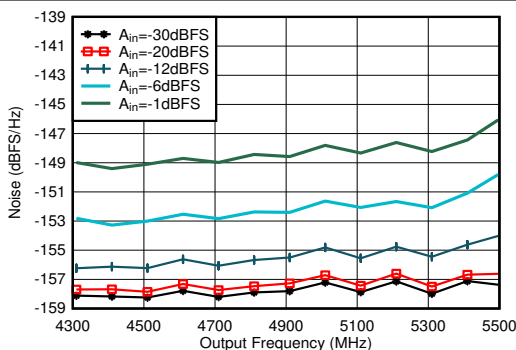
$f_{DAC} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, $f_{CENTER} = 4.9$ GHz, -13 dBFS each tone, worst channel

Figure 4-169. TX IMD3 vs Tone Spacing and Temperature at 4.9 GHz



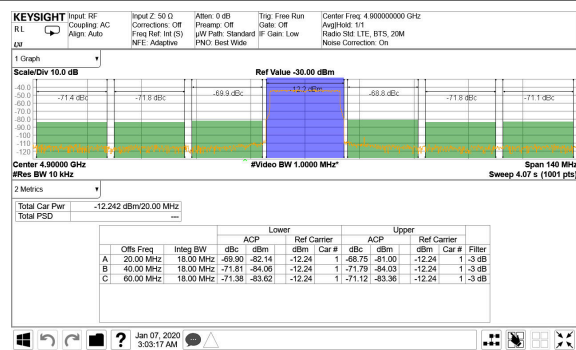
$f_{DAC} = 11796.48$ MSPS, interleaved mode, matching at 4.9 GHz, $f_{CENTER} = 4.9$ GHz, $f_{SPACING} = 20$ MHz

Figure 4-170. TX IMD3 vs Digital Level at 4.9 GHz



Matching at 4.9 GHz, Single tone, $f_{DAC} = 11.79648$ GSPS, interleave mode, 40-MHz offset, DSA=0dB

Figure 4-171. TX Single Tone Output Noise vs Frequency and Amplitude at 4.9 GHz

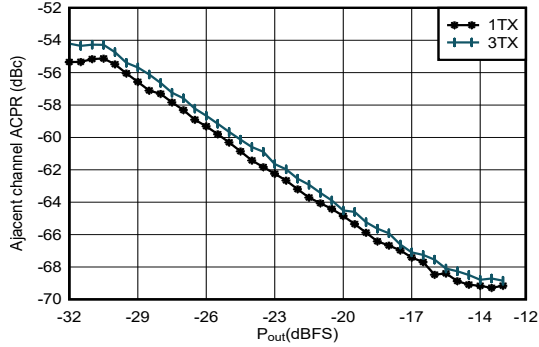


TM1.1, $P_{OUT_RMS} = -13$ dBFS

Figure 4-172. TX 20-MHz LTE Output Spectrum at 4.9 GHz

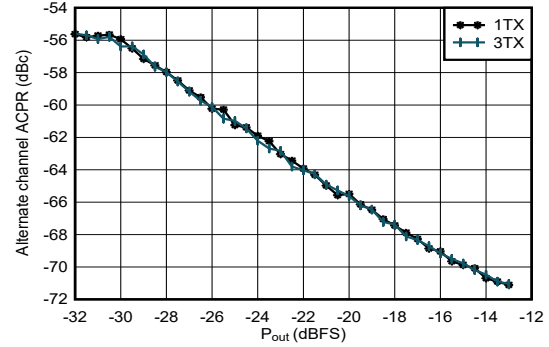
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



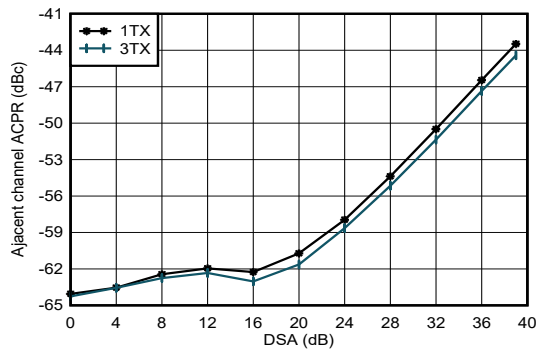
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-173. TX 20-MHz LTE ACPR vs Digital Level at 4.9 GHz



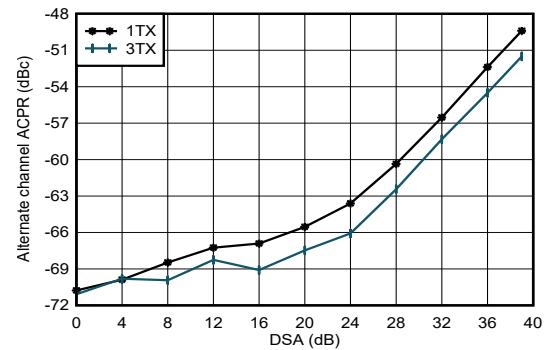
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-174. TX 20-MHz LTE alt-ACPR vs Digital Level at 4.9 GHz



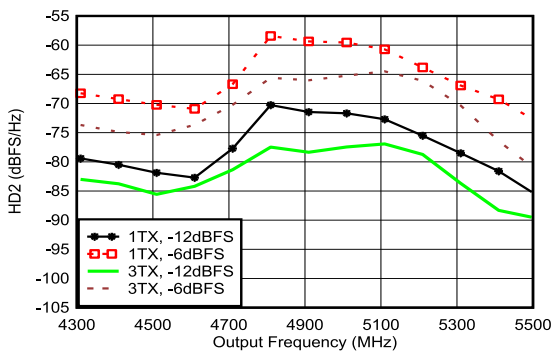
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-175. TX 20-MHz LTE ACPR vs DSA at 4.9 GHz



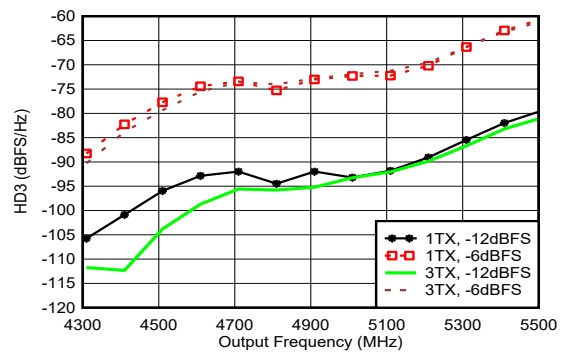
Matching at 4.9 GHz, single carrier 20-MHz BW TM1.1 LTE

Figure 4-176. TX 20-MHz LTE alt-ACPR vs DSA at 4.9 GHz



Matching at 4.9 GHz, $f_{DAC} = 11.79648$ GSPPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-177. TX HD2 vs Digital Amplitude and Output Frequency at 4.9 GHz

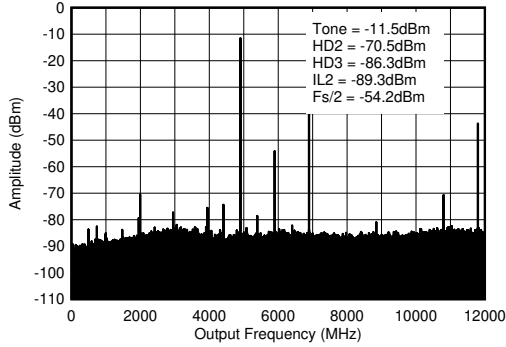


Matching at 4.9 GHz, $f_{DAC} = 11.79648$ GSPPS, interleave mode, normalized to output power at harmonic frequency

Figure 4-178. TX HD3 vs Digital Amplitude and Output Frequency at 4.9 GHz

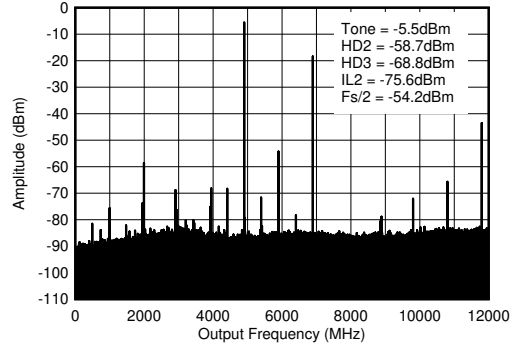
4.12.5 TX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), interleave mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled



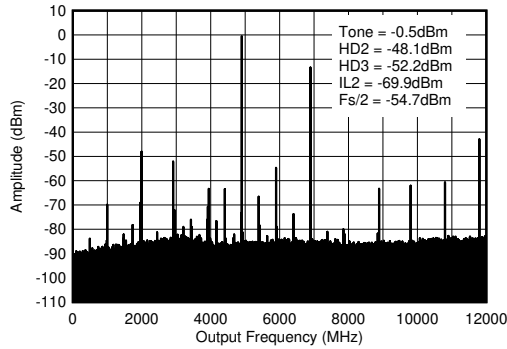
$f_{DAC} = 11796.48$ MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$.

Figure 4-179. TX Single Tone (-12 dBFS) Output Spectrum at 4.9 GHz ($0-f_{DAC}$)



$f_{DAC} = 11796.48$ MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$.

Figure 4-180. TX Single Tone (-6 dBFS) Output Spectrum at 4.9 GHz ($0-f_{DAC}$)

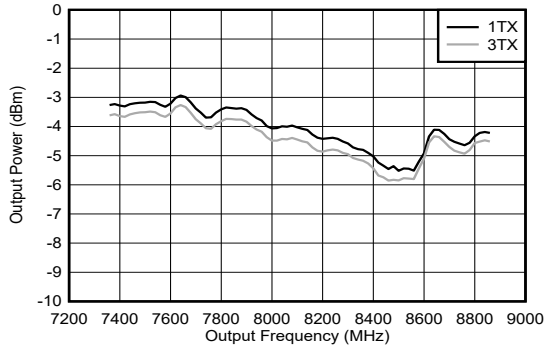


$f_{DAC} = 11796.48$ MSPS, interleave mode, 4.9 GHz matching, includes PCB and cable losses. $IL_n = f_s/n \pm f_{OUT}$.

Figure 4-181. TX Single Tone (-1 dBFS) Output Spectrum at 4.9 GHz ($0-f_{DAC}$)

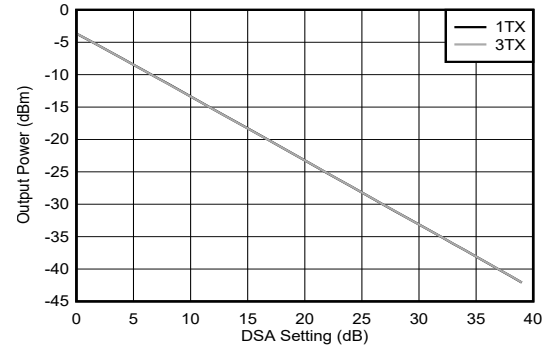
4.12.6 TX Typical Characteristics at 8.1 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



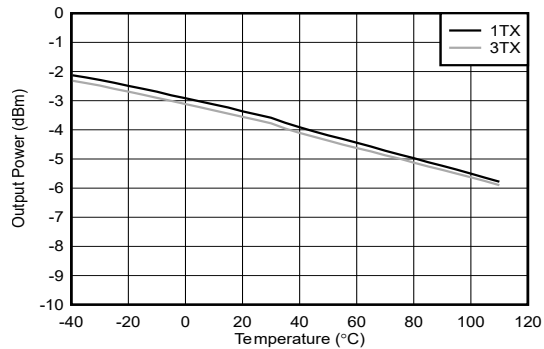
includes PCB and cable losses.

Figure 4-182. TX Output Power vs Frequency at 8.1 GHz



includes PCB and cable losses.

Figure 4-183. TX Output Power vs DSA Setting at 8.1 GHz



includes PCB and cable losses.

Figure 4-184. TX Output Power vs Temperature at 8.1 GHz

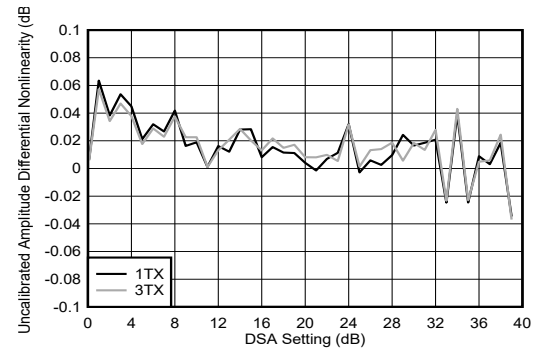


Figure 4-185. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.1 GHz

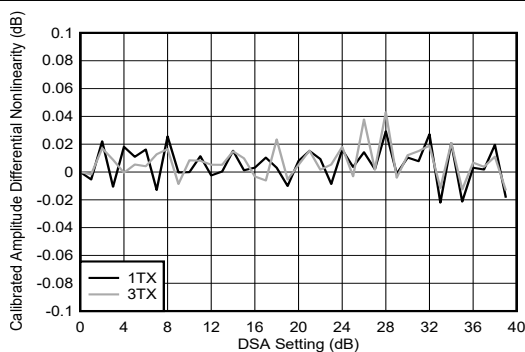


Figure 4-186. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.1 GHz

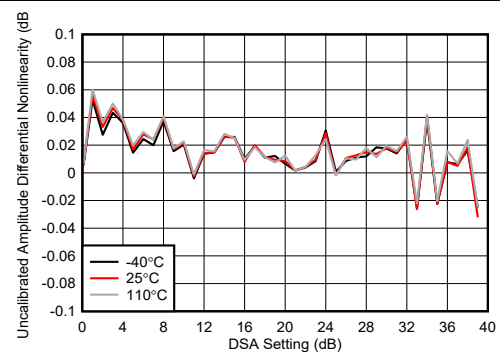


Figure 4-187. TX DSA Uncalibrated Amplitude Differential Nonlinearity at 8.1 GHz

4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

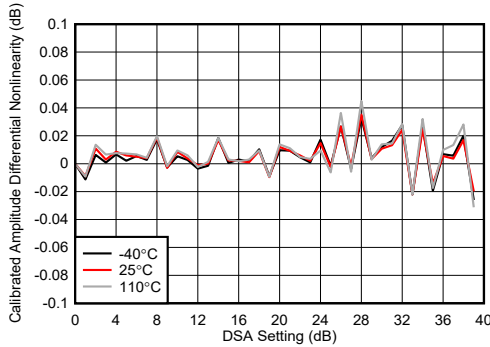


Figure 4-188. TX DSA Calibrated Amplitude Differential Nonlinearity at 8.11 GHz

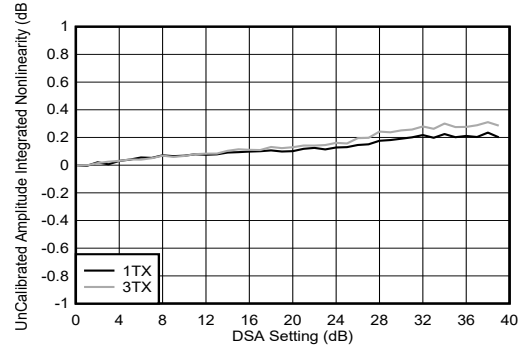


Figure 4-189. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.11 GHz

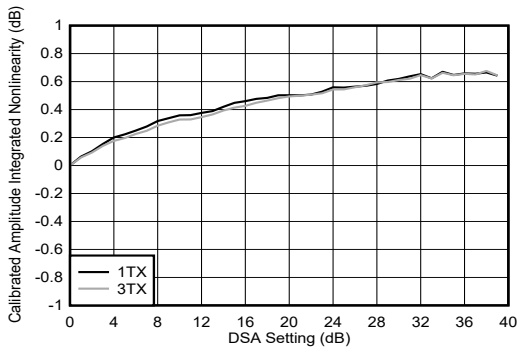


Figure 4-190. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.11 GHz

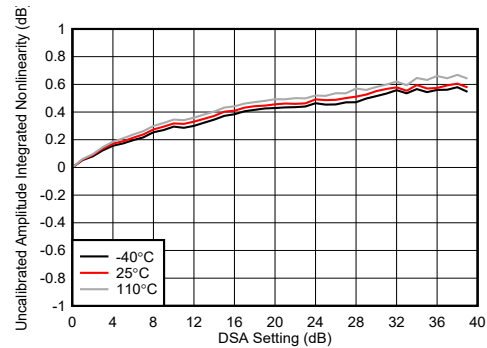


Figure 4-191. TX DSA Uncalibrated Amplitude Integrated Nonlinearity at 8.11 GHz

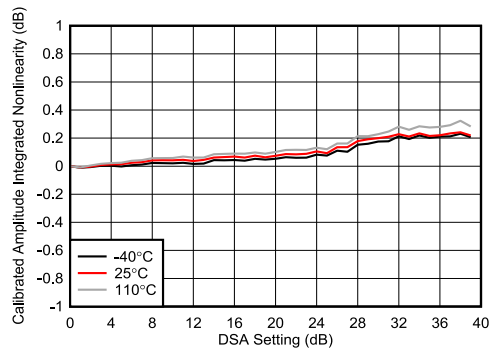


Figure 4-192. TX DSA Calibrated Amplitude Integrated Nonlinearity at 8.11 GHz

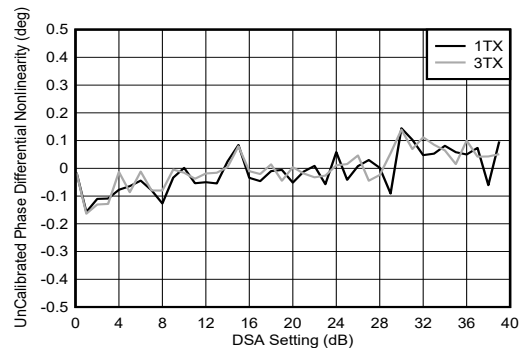


Figure 4-193. TX DSA Uncalibrated Phase Differential Nonlinearity at 8.11 GHz

4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

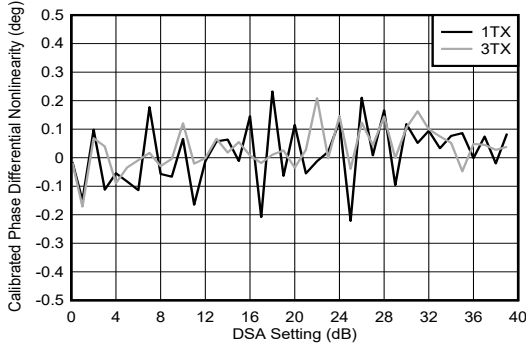


Figure 4-194. TX DSA Calibrated Phase Differential Nonlinearity at 8.11 GHz

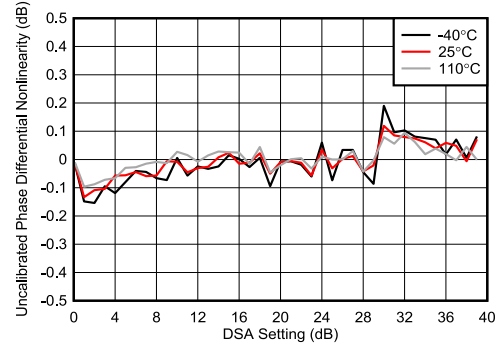


Figure 4-195. TX DSA Uncalibrated Phase Differential Nonlinearity at 8.11 GHz

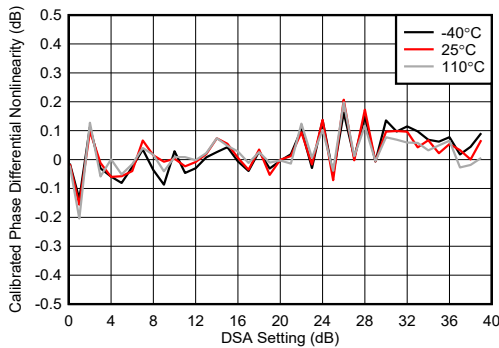


Figure 4-196. TX DSA Calibrated Phase Differential Nonlinearity at 8.11 GHz

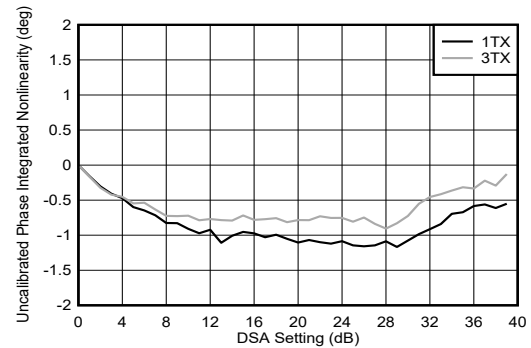


Figure 4-197. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.11 GHz

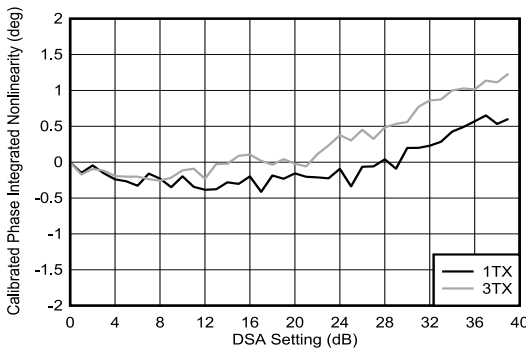


Figure 4-198. TX DSA Calibrated Phase Integrated Nonlinearity at 8.11 GHz

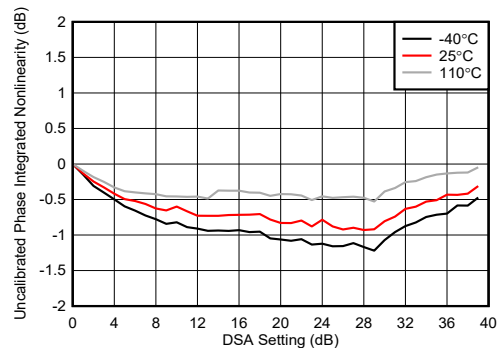


Figure 4-199. TX DSA Uncalibrated Phase Integrated Nonlinearity at 8.11 GHz

4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

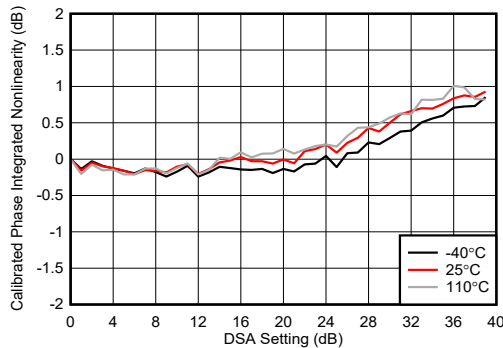
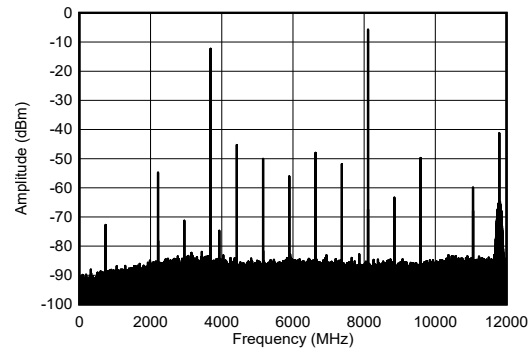
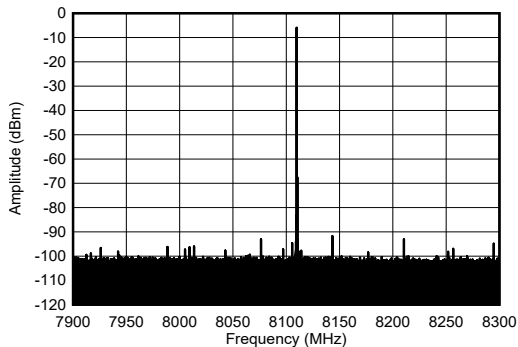


Figure 4-200. TX DSA Calibrated Phase Integrated Nonlinearity at 8.1 GHz



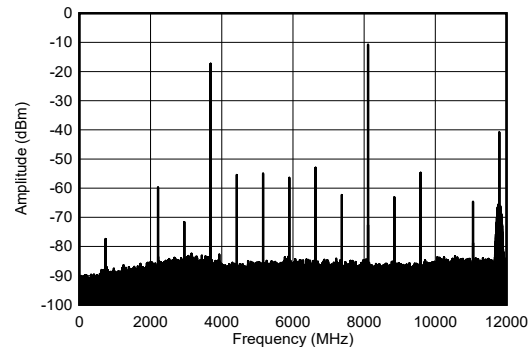
-1 dBFS

Figure 4-201. TX Single Tone Output Spectrum at 8.1 GHz



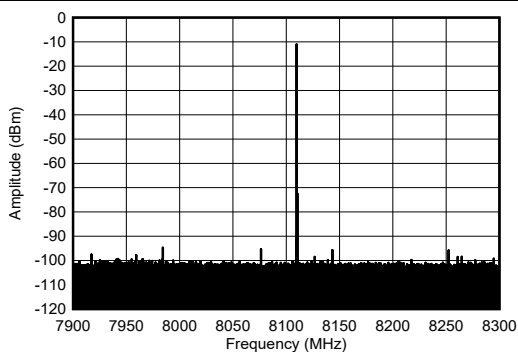
-1 dBFS

Figure 4-202. TX Single Tone Output Spectrum at 8.1 GHz



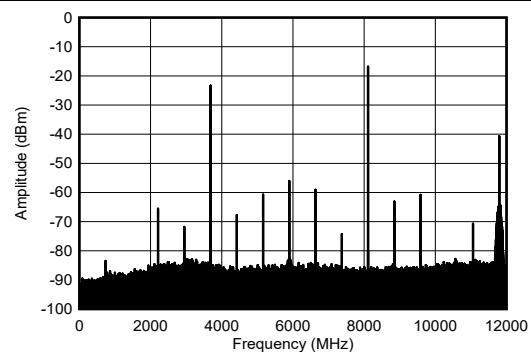
-6 dBFS

Figure 4-203. TX Single Tone Output Spectrum at 8.1 GHz



-6 dBFS

Figure 4-204. TX Single Tone Output Spectrum at 8.1 GHz

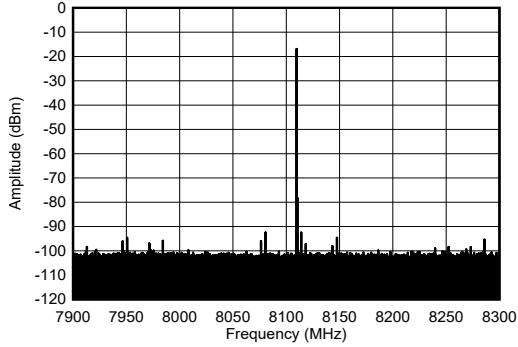


-12 dBFS

Figure 4-205. TX Single Tone Output Spectrum at 8.1 GHz

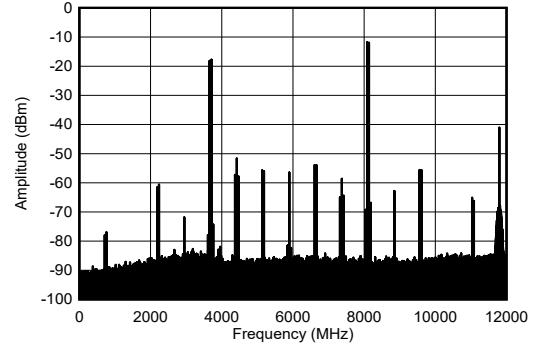
4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



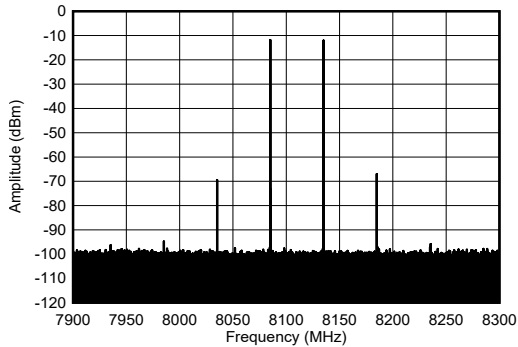
-12 dBFS

Figure 4-206. TX Single Tone Output Spectrum at 8.11 GHz



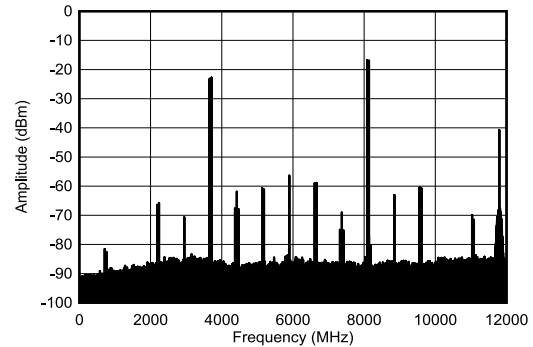
50 MHz tone spacing, -7 dBFS each tone

Figure 4-207. TX Dual Tone Output Spectrum at 8.11 GHz



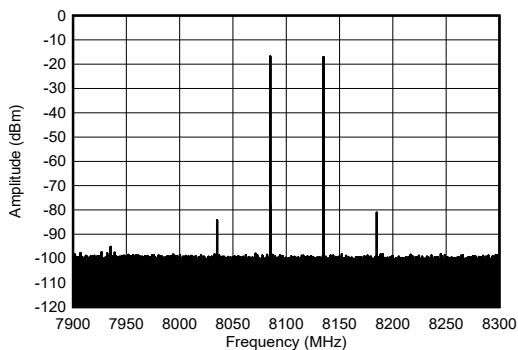
50 MHz tone spacing, -7 dBFS each tone

Figure 4-208. TX Dual Tone Output Spectrum at 8.11 GHz



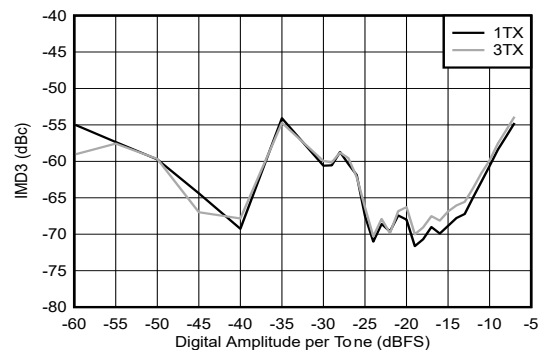
50 MHz tone spacing, -12 dBFS each tone

Figure 4-209. TX Dual Tone Output Spectrum at 8.11 GHz



50 MHz tone spacing, -12 dBFS each tone

Figure 4-210. TX Dual Tone Output Spectrum at 8.11 GHz

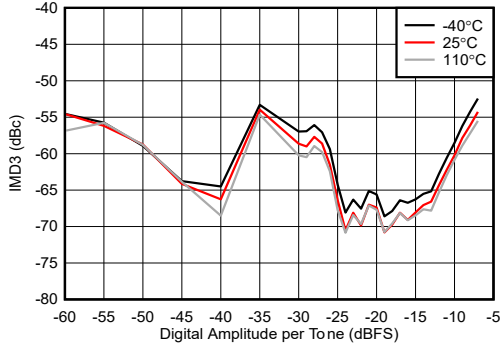


-7 dBFS each tone, 50 MHz tone spacing

Figure 4-211. TX IMD3 vs Digital Amplitude at 8.11 GHz

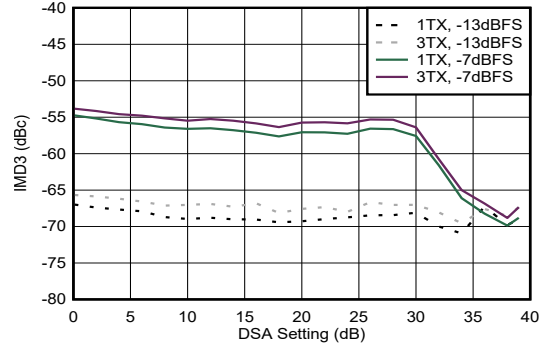
4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



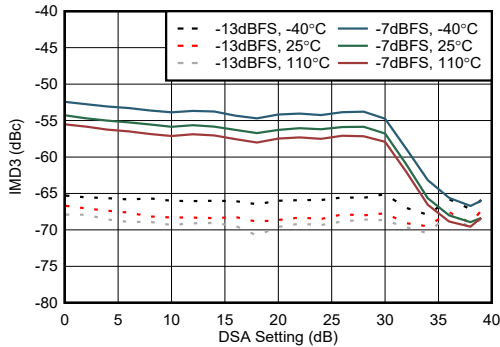
-7 dBFS each tone, 50 MHz tone spacing

Figure 4-212. TX IMD3 vs Digital Amplitude at 8.1 GHz



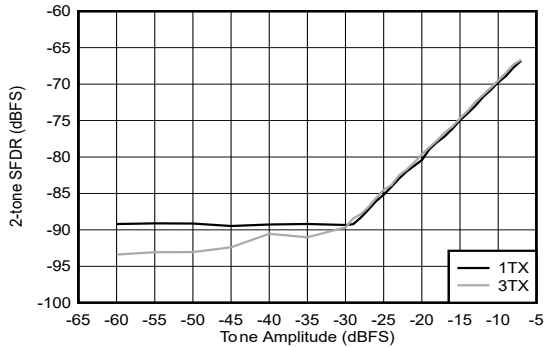
50 MHz tone spacing

Figure 4-213. TX IMD3 vs DSA Setting at 8.1 GHz



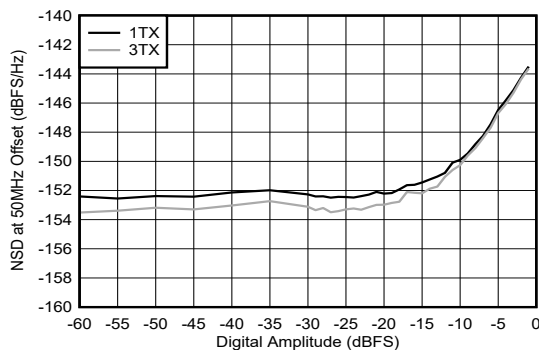
50 MHz tone spacing

Figure 4-214. TX IMD3 vs DSA Setting at 8.1 GHz



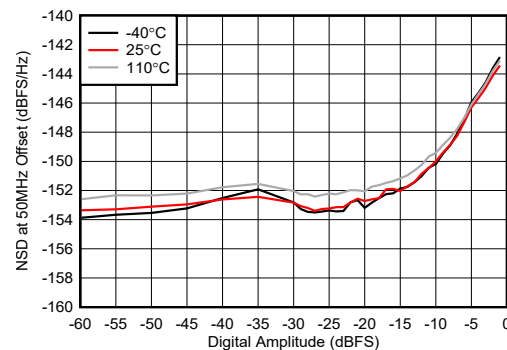
50 MHz tone spacing

Figure 4-215. TX 2-Tone SFDR vs Digital Amplitude at 8.1 GHz



50 MHz offset

Figure 4-216. TX NSD vs Digital Amplitude at 8.1 GHz

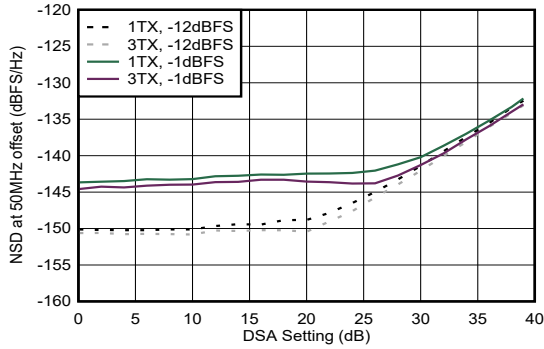


50 MHz offset

Figure 4-217. TX NSD vs Digital Amplitude at 8.1 GHz

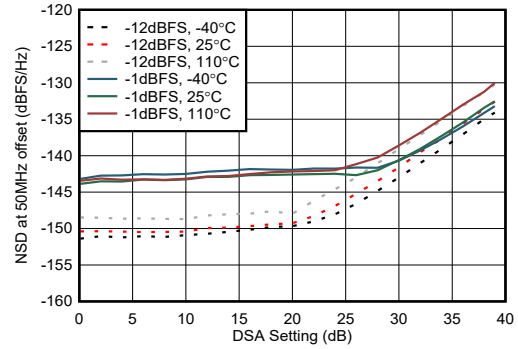
4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching



50 MHz offset

Figure 4-218. TX NSD vs DSA Setting at 8.1 GHz



50 MHz offset

Figure 4-219. TX NSD vs DSA Setting at 8.1 GHz

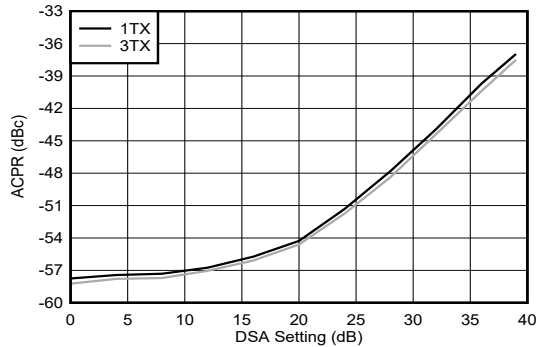


Figure 4-220. TX NR100MHz ACPR vs DSA Setting 8.1 GHz

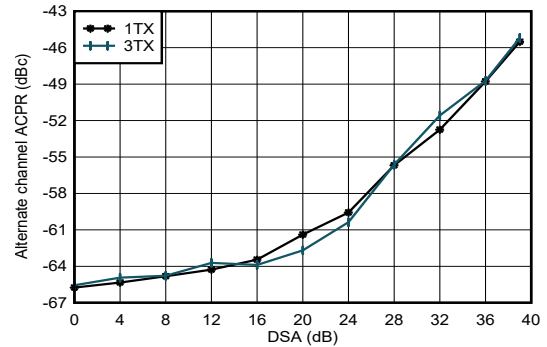


Figure 4-221. TX NR100 MHz alt-ACPR vs DSA Setting 8.1 GHz

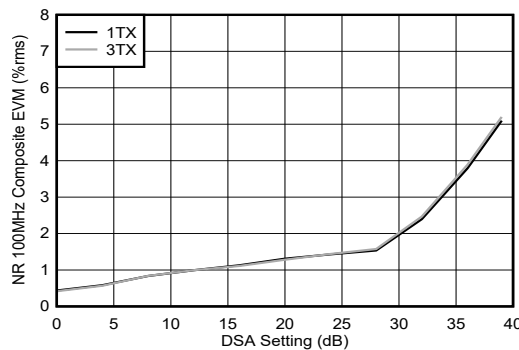


Figure 4-222. TX NR100 MHz EVM vs DSA Setting 8.1 GHz

4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

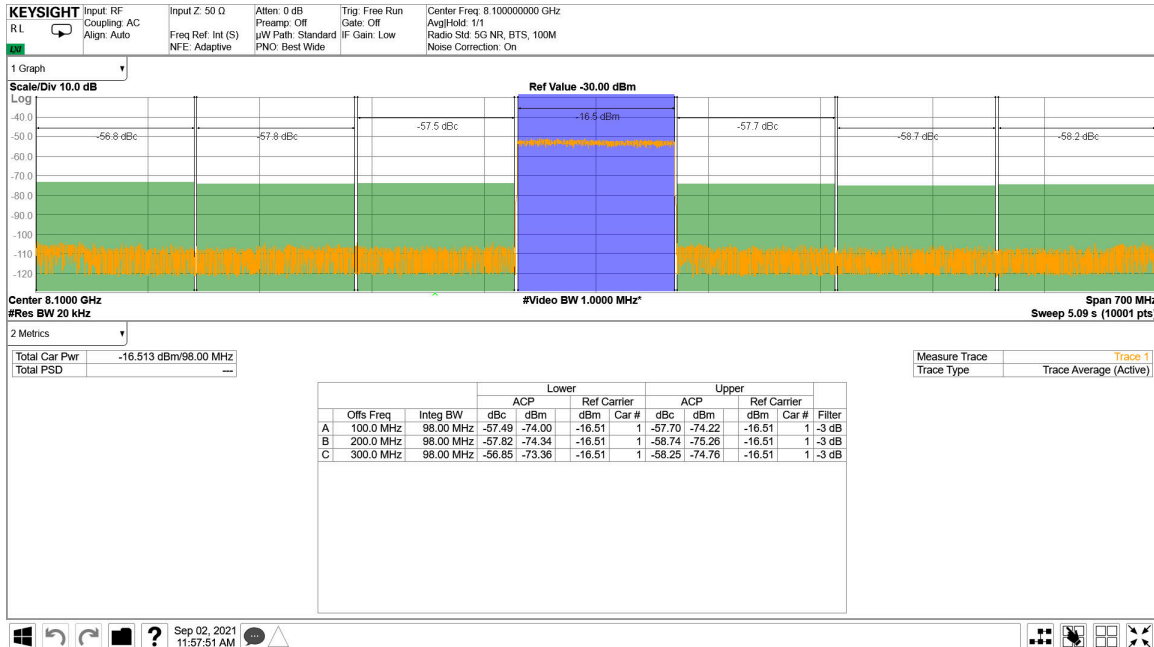


Figure 4-223. TX 100 MHz NR Output Spectrum at 8.1 GHz

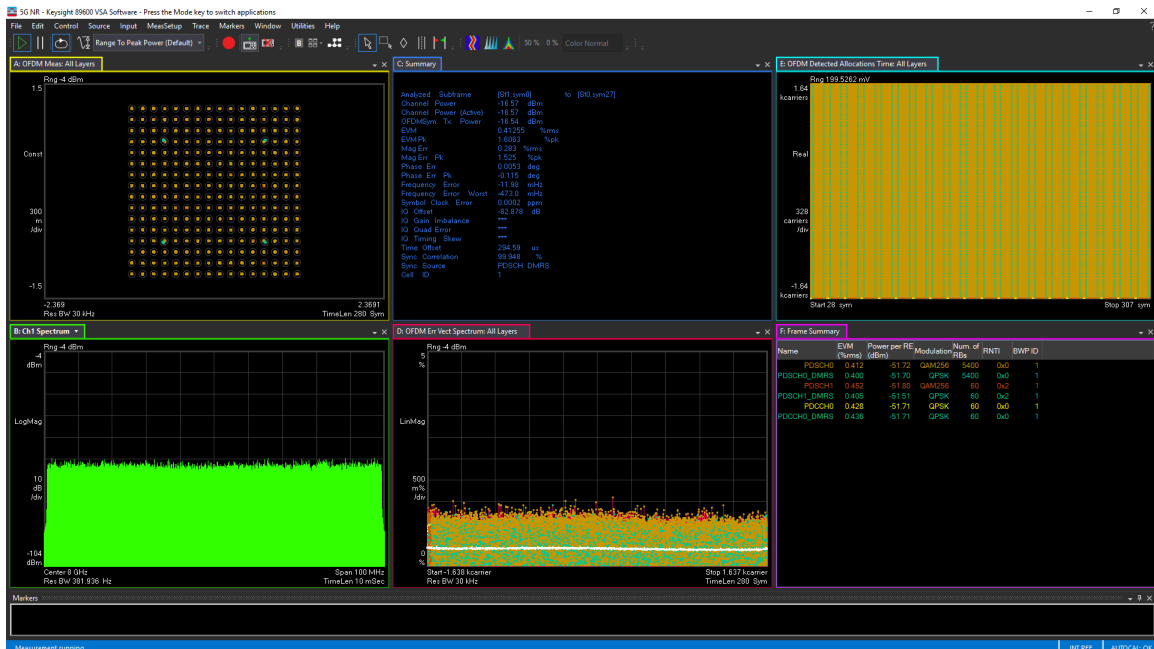


Figure 4-224. TX 100 MHz NR EVM at 8.1 GHz

4.12.6 TX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (24x interpolation), mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 8.1 GHz matching

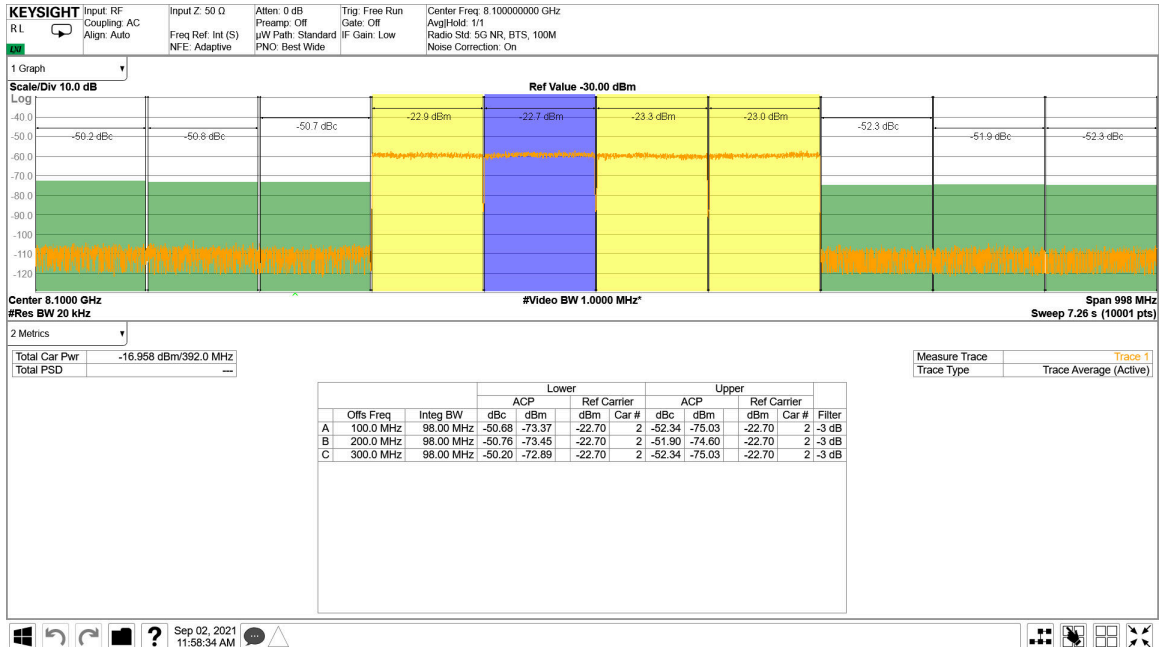


Figure 4-225. TX 4x100 MHz NR Output Spectrum 8.1 GHz

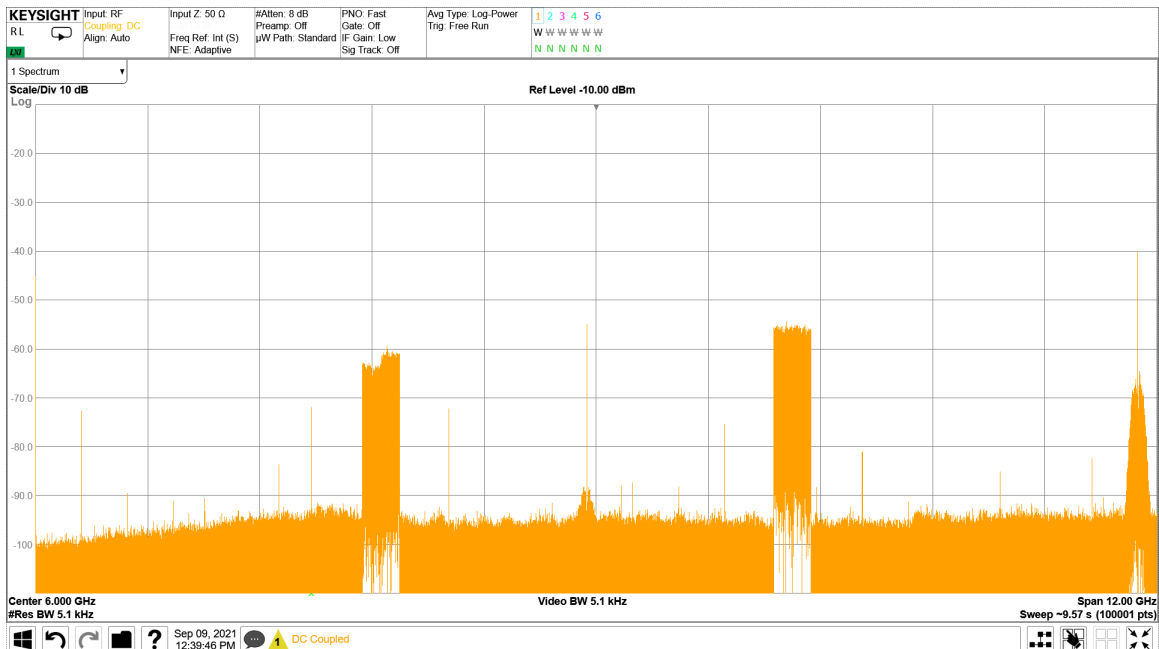
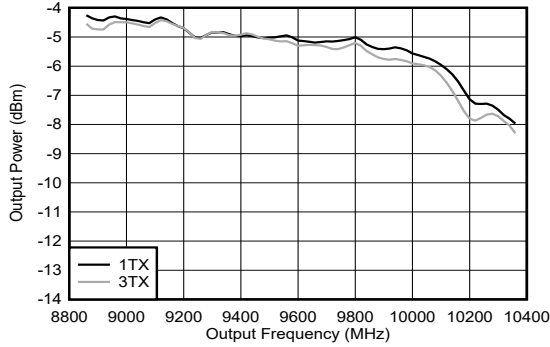


Figure 4-226. TX 4x100 MHz NR Output Spectrum 8.1 GHz

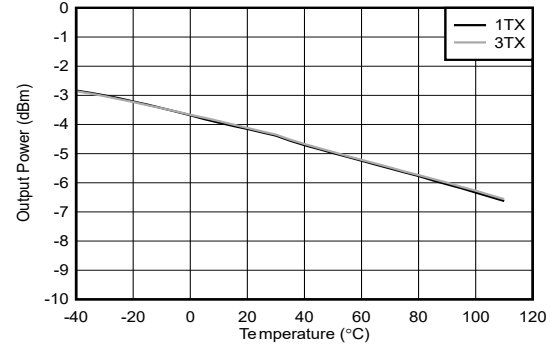
4.12.7 TX Typical Characteristics at 9.6 GHz

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching



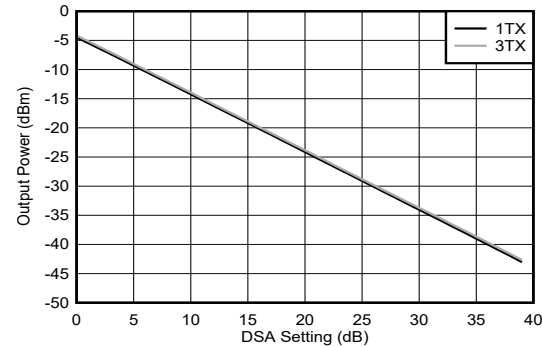
Includes PCB and cable losses.

Figure 4-227. TX Output Power vs Frequency at 9.61 GHz



Includes PCB and cable losses.

Figure 4-228. TX Output Power vs Frequency at 9.61 GHz



Includes PCB and cable losses.

Figure 4-229. TX Output Power vs DSA Setting at 9.61 GHz

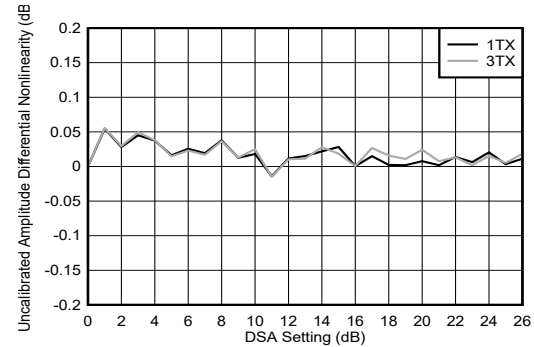


Figure 4-230. TX DSA Uncalibrated Amplitude Differential Nonlinearity

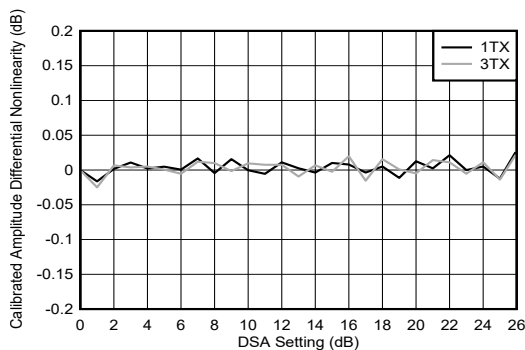


Figure 4-231. TX DSA Calibrated Amplitude Differential Nonlinearity

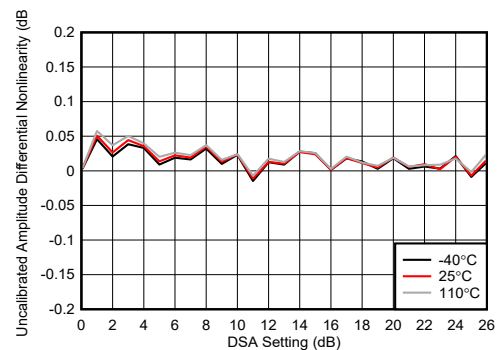


Figure 4-232. TX DSA Uncalibrated Amplitude Differential Nonlinearity

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching

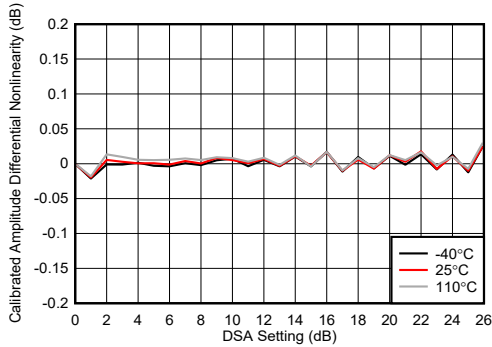


Figure 4-233. TX DSA Calibrated Amplitude Differential Nonlinearity

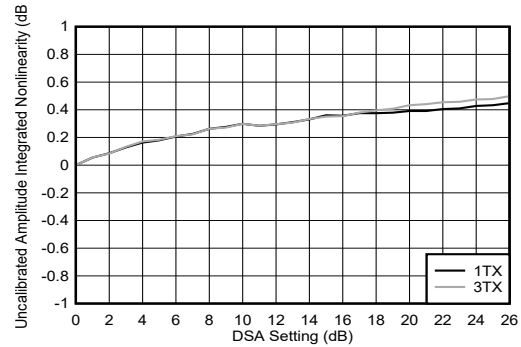


Figure 4-234. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

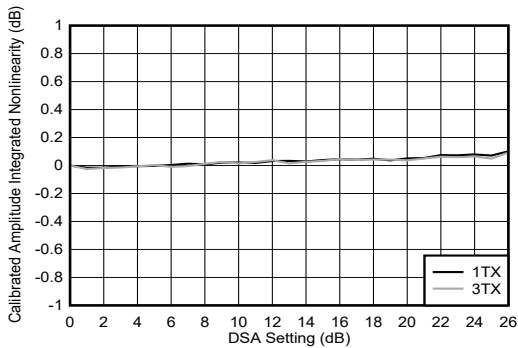


Figure 4-235. TX DSA Calibrated Amplitude Integrated Nonlinearity

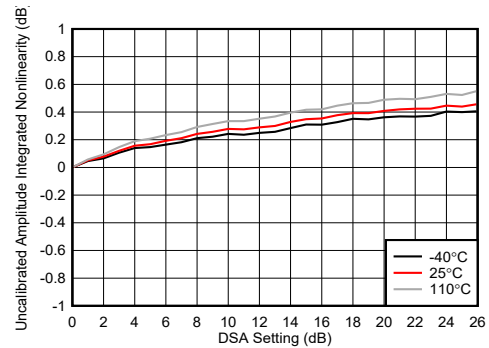


Figure 4-236. TX DSA Uncalibrated Amplitude Integrated Nonlinearity

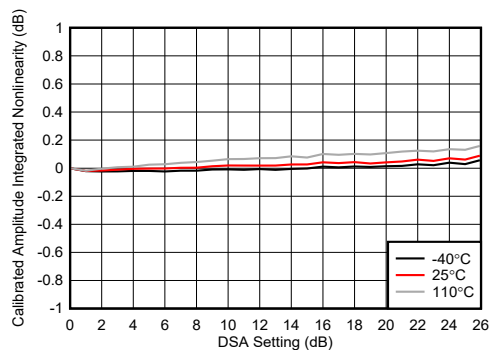


Figure 4-237. TX DSA Calibrated Amplitude Integrated Nonlinearity

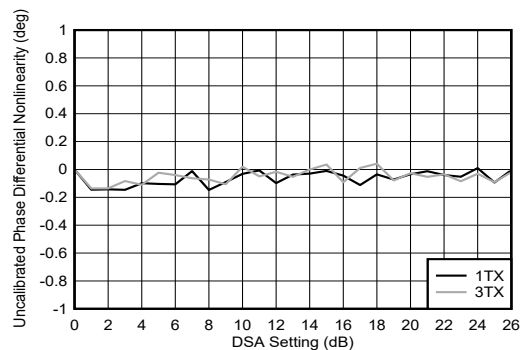


Figure 4-238. TX DSA Uncalibrated Phase Differential Nonlinearity

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching

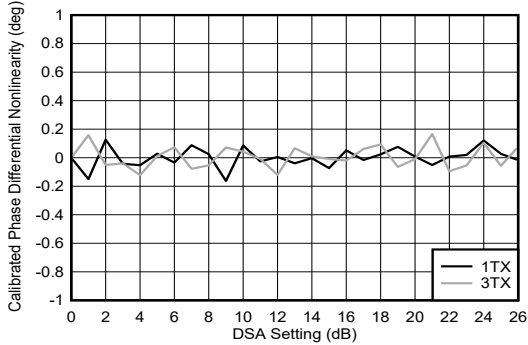


Figure 4-239. TX DSA Calibrated Phase Differential Nonlinearity

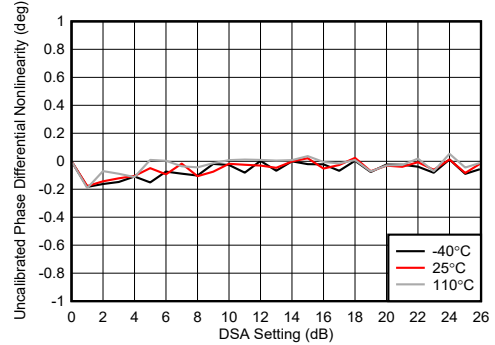


Figure 4-240. TX DSA Uncalibrated Phase Differential Nonlinearity

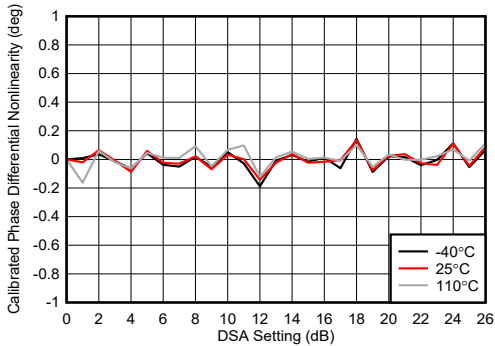


Figure 4-241. TX DSA Calibrated Phase Differential Nonlinearity

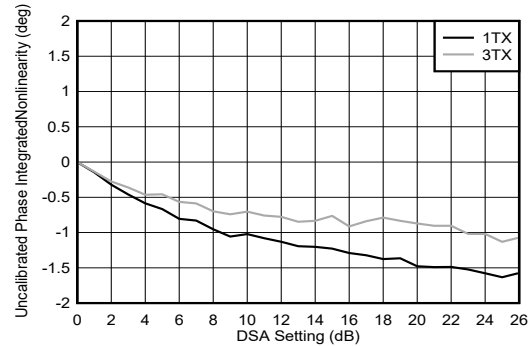


Figure 4-242. TX DSA Uncalibrated Phase Integrated Nonlinearity

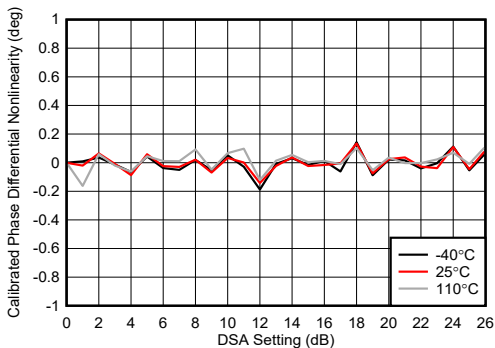


Figure 4-243. TX DSA Calibrated Phase Integrated Nonlinearity

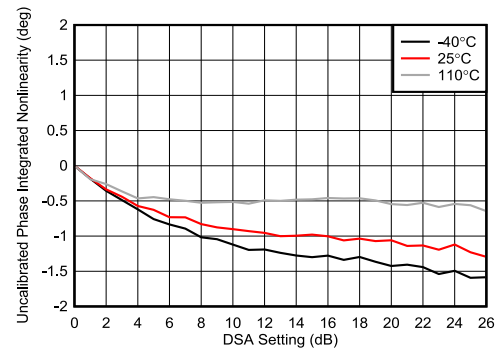


Figure 4-244. TX DSA Uncalibrated Phase Integrated Nonlinearity

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching

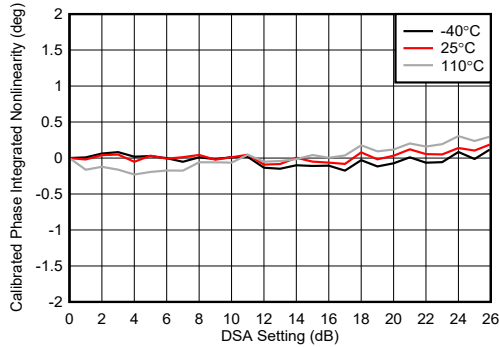
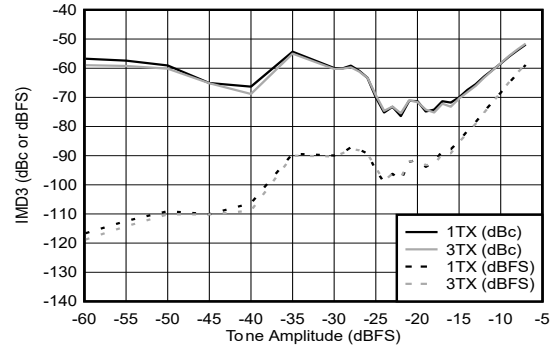
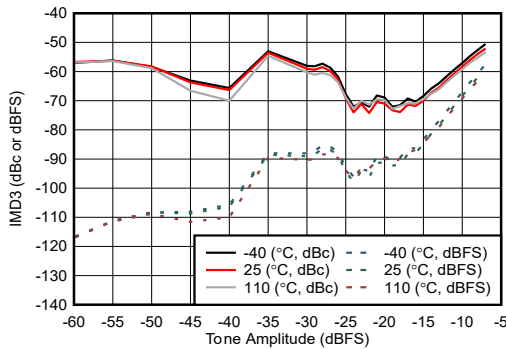


Figure 4-245. TX DSA Calibrated Amplitude Integrated Nonlinearity



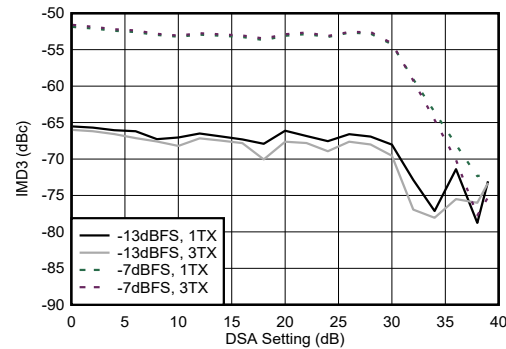
50 MHz tone spacing

Figure 4-246. TX IMD3 vs Digital Amplitude at 9.61 GHz



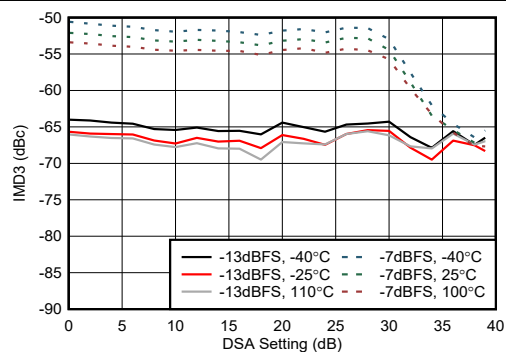
50 MHz tone spacing

Figure 4-247. TX IMD3 vs Digital Amplitude at 9.61 GHz



50 MHz tone spacing

Figure 4-248. TX IMD3 vs DSA Setting at 9.61 GHz



50 MHz tone spacing

Figure 4-249. TX IMD3 vs DSA Setting at 9.61 GHz

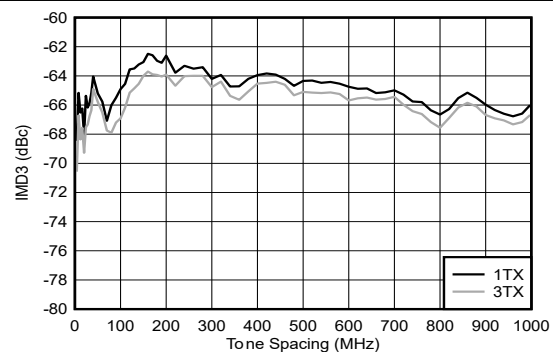


Figure 4-250. TX IMD3 vs Tone Spacing at 9.61 GHz

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching

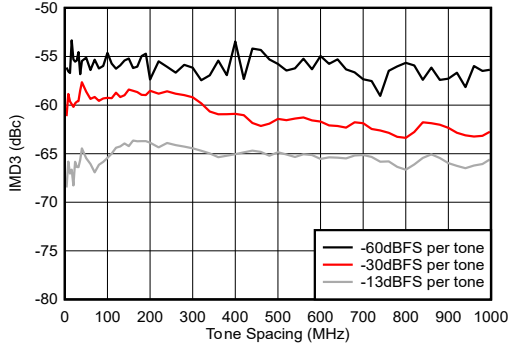


Figure 4-251. TX IMD3 vs Tone Spacing at 9.61 GHz

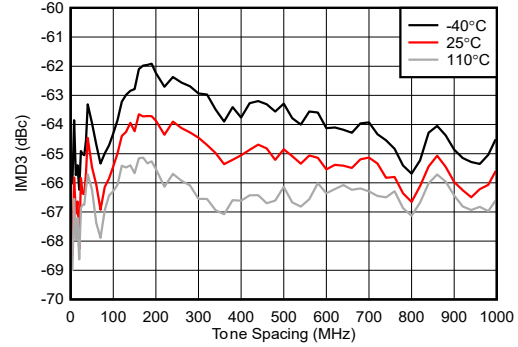


Figure 4-252. TX IMD3 vs Tone Spacing at 9.6 1GHz

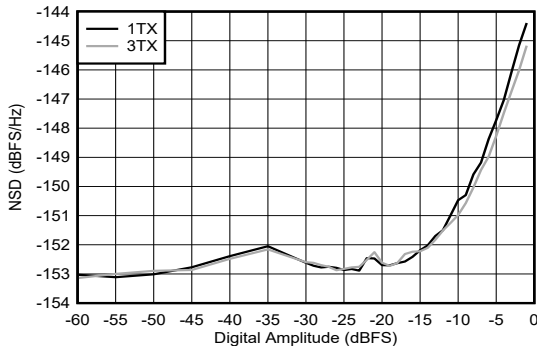


Figure 4-253. TX NSD vs Digital Amplitude at 9.61 GHz

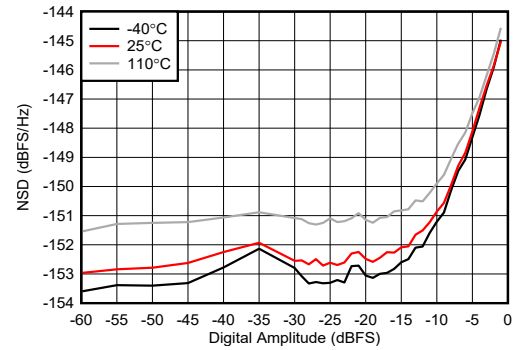


Figure 4-254. TX NSD vs Digital Amplitude at 9.61 GHz

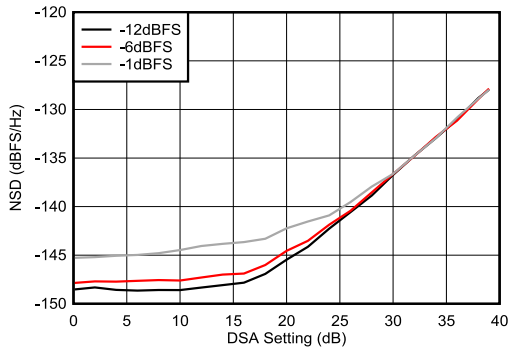


Figure 4-255. TX NSD vs DSA Setting at 9.61 GHz

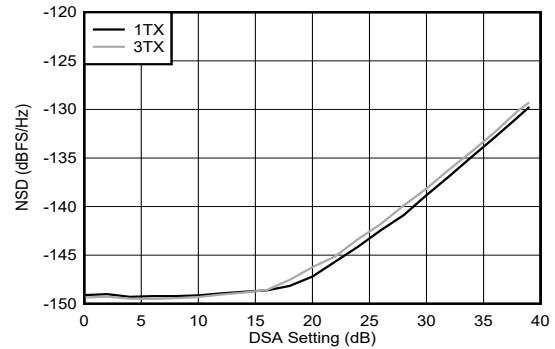


Figure 4-256. TX NSD vs DSA Setting at 9.61 GHz

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching

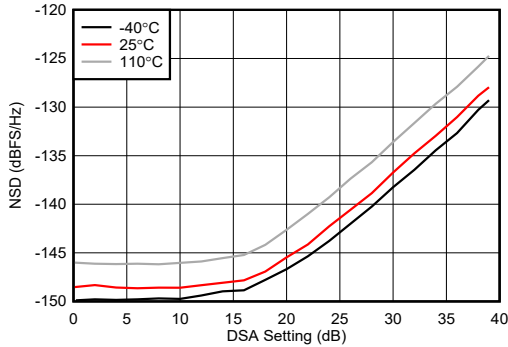
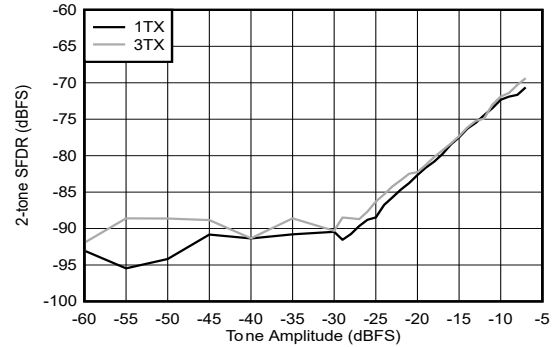
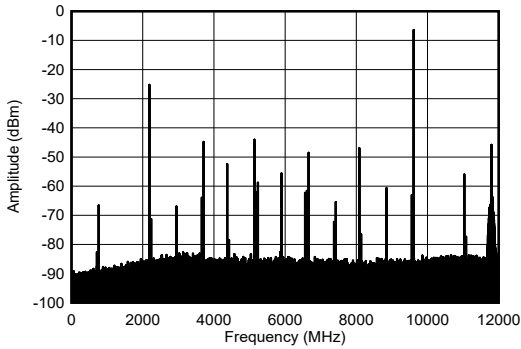


Figure 4-257. TX NSD vs DSA Setting at 9.61 GHz



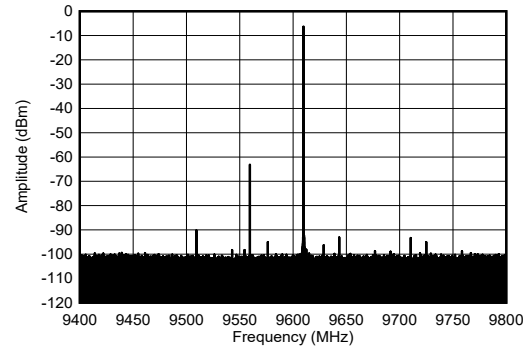
50 MHz tone spacing

Figure 4-258. TX 2-tone SFDR vs Digital Amplitude at 9.61 GHz



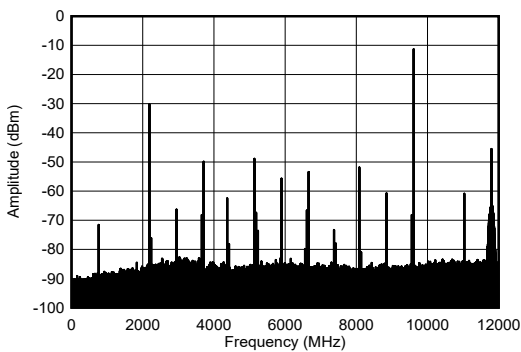
Includes PCB and cable losses.

Figure 4-259. TX Single Tone Spectrum at 9.61 GHz and -1 dBFS (wideband)



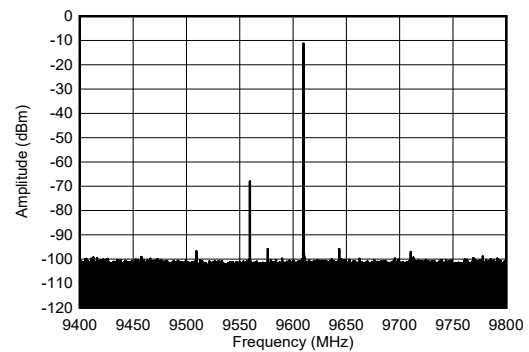
Includes PCB and cable losses.

Figure 4-260. TX Single Tone Spectrum at 9.61 GHz and -1 dBFS (1.2 GHz BW)



Includes PCB and cable losses.

Figure 4-261. TX Single Tone Spectrum at 9.61 GHz and -6 dBFS (wideband)

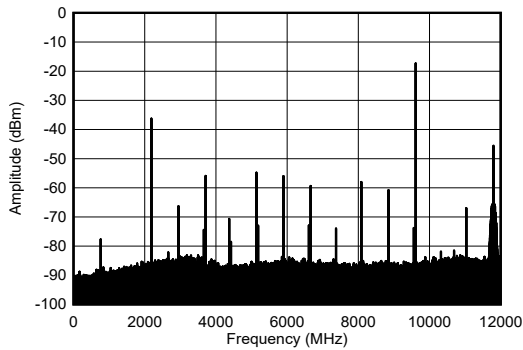


Includes PCB and cable losses.

Figure 4-262. TX Single Tone Spectrum at 9.61 GHz and -6 dBFS (1.2 GHz BW)

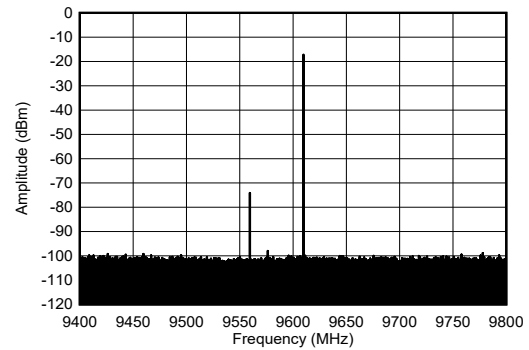
4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching



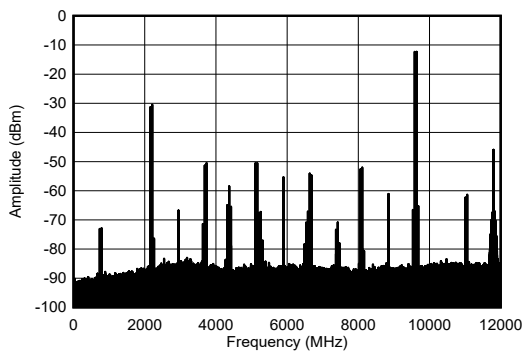
Includes PCB and cable losses.

Figure 4-263. TX Single Tone Spectrum at 9.61 GHz and -12 dBFS (wideband)



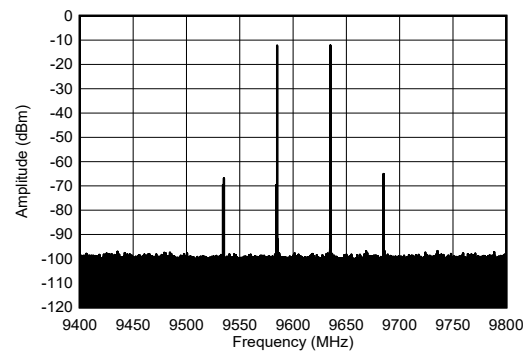
Includes PCB and cable losses.

Figure 4-264. TX Single Tone Spectrum at 9.61 GHz and -12 dBFS (1.2GHz BW)



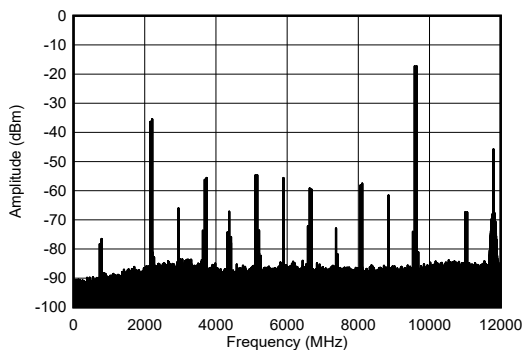
Includes PCB and cable losses, 50 MHz tone spacing.

Figure 4-265. TX 2-Tone Spectrum at 9.61 GHz and -7 dBFS (wideband)



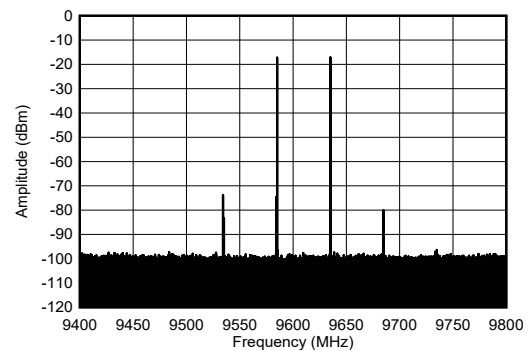
Includes PCB and cable losses, 50 MHz tone spacing.

Figure 4-266. TX 2-Tone Spectrum at 9.61 GHz and -7 dBFS (1.2 GHz BW)



Includes PCB and cable losses, 50 MHz tone spacing.

Figure 4-267. TX 2-Tone Spectrum at 9.61 GHz and -12 dBFS (wideband)

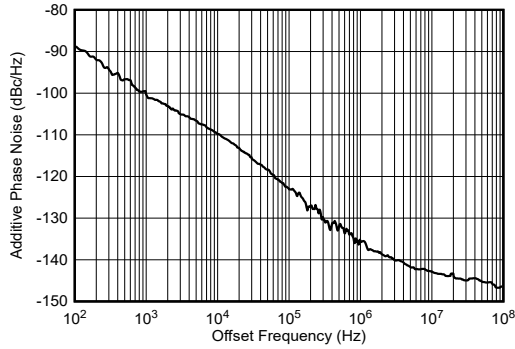


Includes PCB and cable losses, 50 MHz tone spacing.

Figure 4-268. TX 2-Tone Spectrum at 9.61 GHz and -12 dBFS (1.2 GHz BW)

4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{\text{DAC}} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{\text{REF}} = 491.52$ MHz, $A_{\text{OUT}} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching



Single sideband, external clock mode, input clock phase noise removed

Figure 4-269. TX Additive Phase Noise vs Offset Frequency at 9.61 GHz

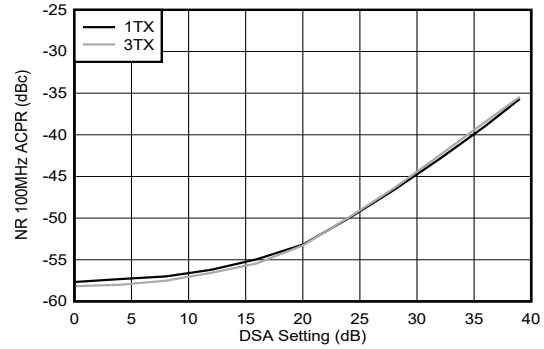


Figure 4-270. TX NR100 MHz ACPR vs DSA Setting at 9.61 GHz

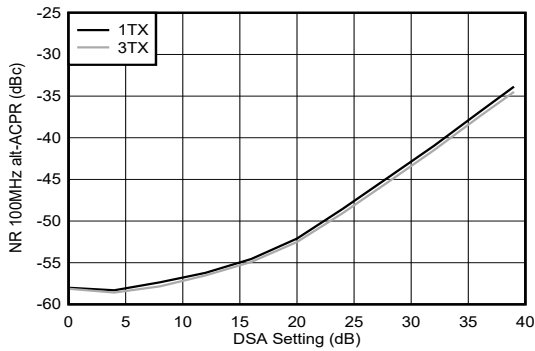


Figure 4-271. TX NR100 MHz alt-ACPR vs DSA Setting at 9.61 GHz

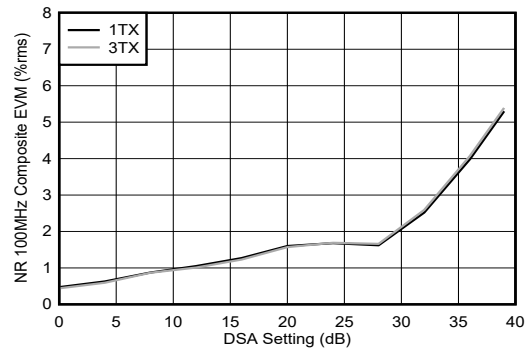
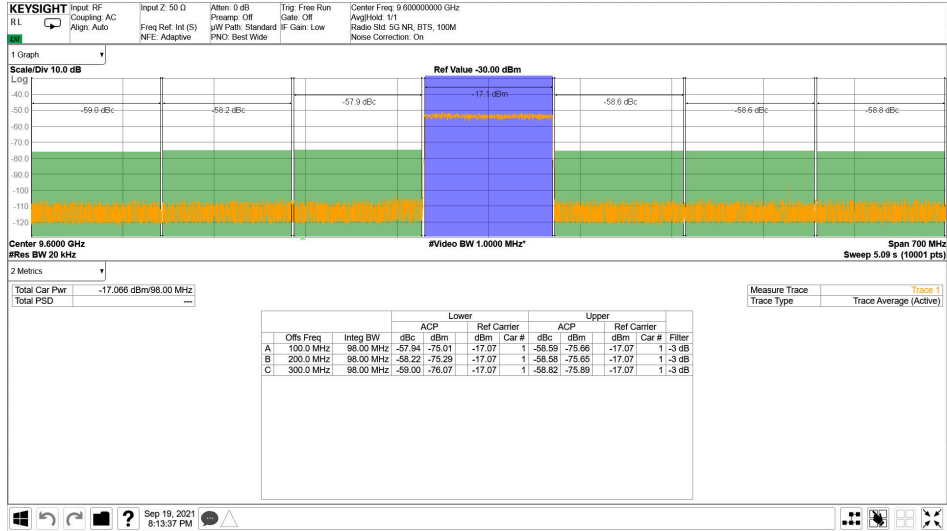


Figure 4-272. TX NR100 MHz EVM vs DSA Setting at 9.61 GHz

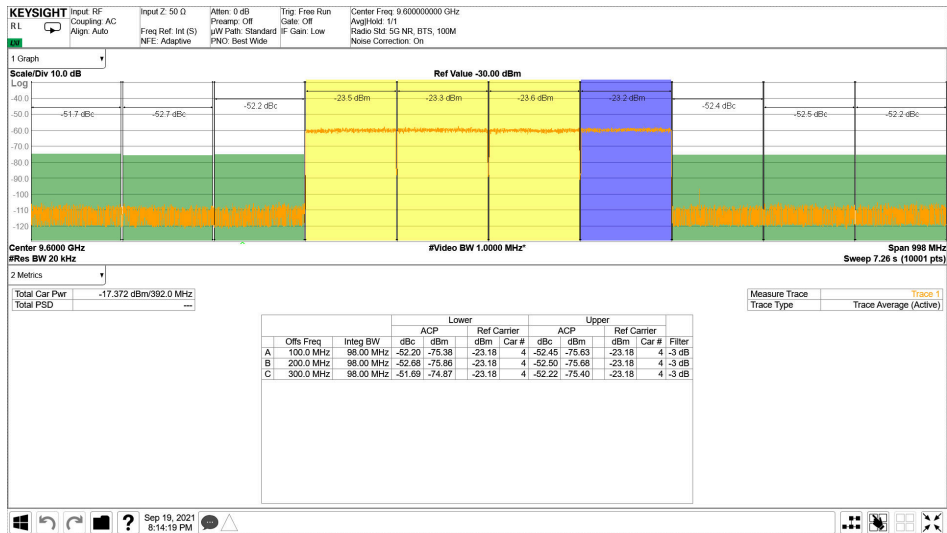
4.12.7 TX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$ with nominal supplies. Default conditions: TX input data rate = 491.52 MSPS, $f_{DAC} = 11796.48$ MSPS (8x interpolation), Mixed mode, 1st Nyquist zone output, PLL clock mode with $f_{REF} = 491.52$ MHz, $A_{OUT} = -1$ dBFS, DSA = 0 dB, Sin(x)/x enabled, DSA calibrated, TX Clock Dither Enabled, 9.6GHz matching



Includes PCB and cable losses.

Figure 4-273. TX NR100 MHz Output Spectrum at 9.61 GHz

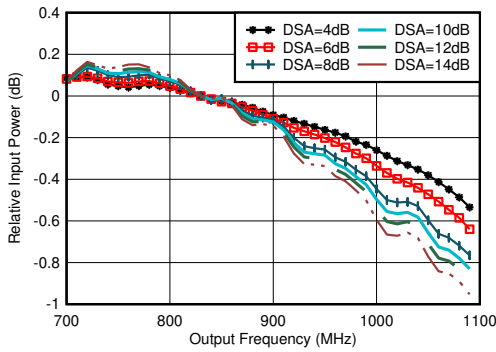


Includes PCB and cable losses.

Figure 4-274. TX 4xNR100 MHz Output Spectrum at 9.61 GHz

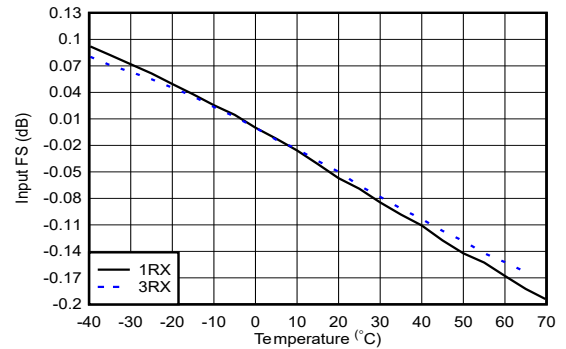
4.12.8 RX Typical Characteristics at 800 MHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



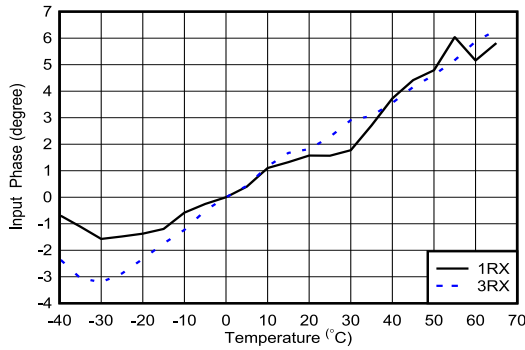
With 0.8 GHz matching, normalized to 830 MHz

Figure 4-275. RX In-Band Gain Flatness for Channel 1RX, $f_{IN} = 830\text{ MHz}$



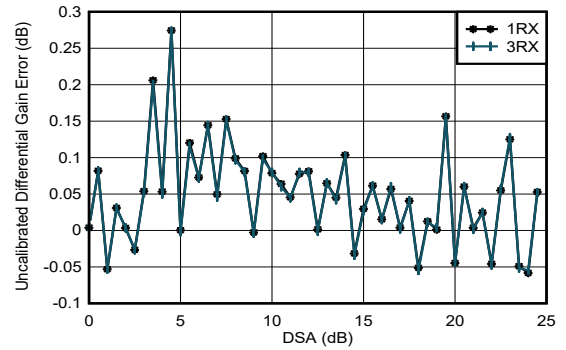
With 0.8 GHz matching, normalized to fullscale at 25°C for each channel

Figure 4-276. RX Input Fullscale vs Temperature and Channel at 800 MHz



With 0.8 GHz matching, normalized to phase at 25°C

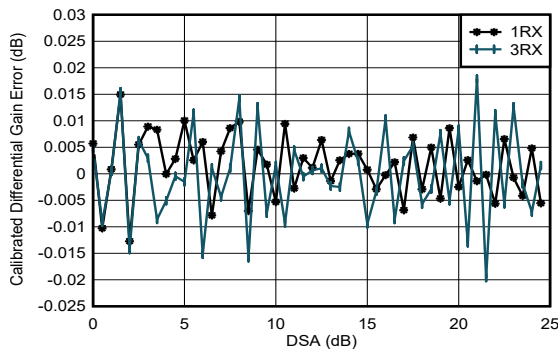
Figure 4-277. RX Input Phase vs Temperature and DSA at $f_{OUT} = 0.8\text{ GHz}$



With 0.8 GHz matching

Differential Amplitude Error = $P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$

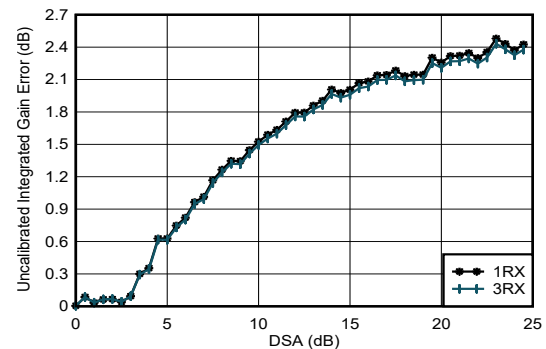
Figure 4-278. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching

Differential Amplitude Error = $P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$

Figure 4-279. RX Calibrated Differential Amplitude Error vs DSA Setting at 0.8 GHz



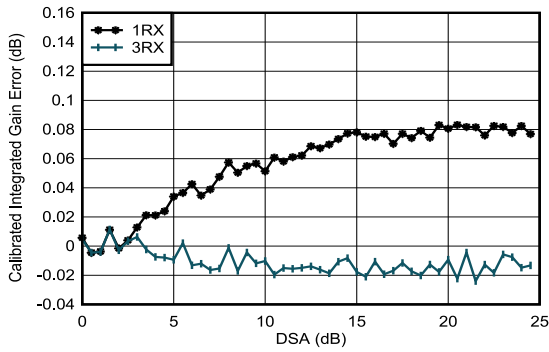
With 0.8 GHz matching

Integrated Amplitude Error = $P_{IN}(\text{DSA Setting}) - P_{IN}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-280. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 0.8 GHz

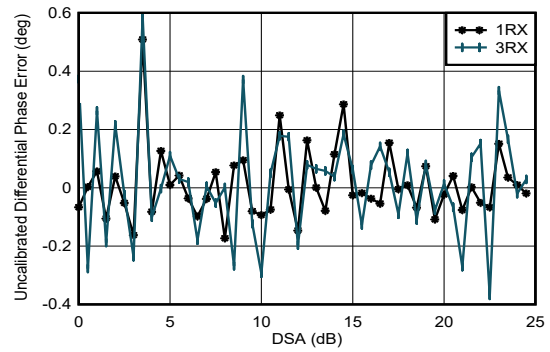
4.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



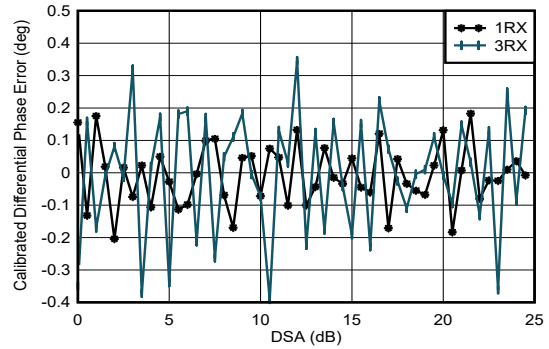
With 0.8 GHz matching
 Integrated Amplitude Error = $P_{IN}(\text{DSA Setting}) - P_{IN}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-281. RX Calibrated Integrated Amplitude Error vs DSA Setting at 2.6 GHz



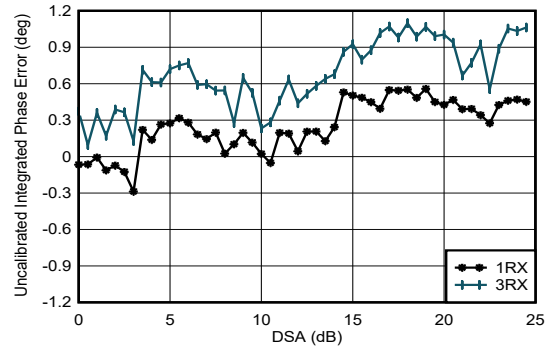
With 0.8 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-282. RX Uncalibrated Differential Phase Error vs DSA Setting at 0.8 GHz



With 0.8 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-283. RX Calibrated Differential Phase Error vs DSA Setting at 0.8 GHz

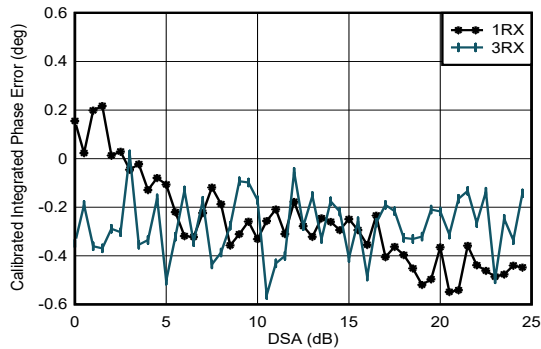


With 0.8 GHz matching
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-284. RX Uncalibrated Integrated Phase Error vs DSA Setting at 0.8 GHz

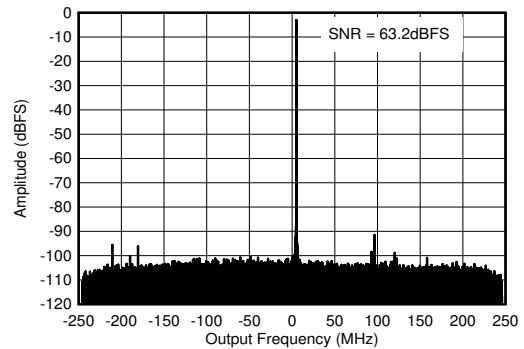
4.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



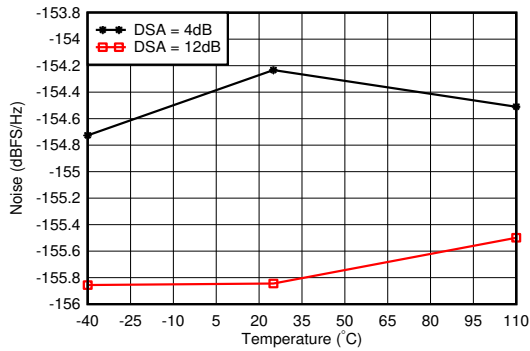
With 0.8 GHz matching
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

Figure 4-285. RX Calibrated Integrated Phase Error vs DSA Setting at 0.8 GHz



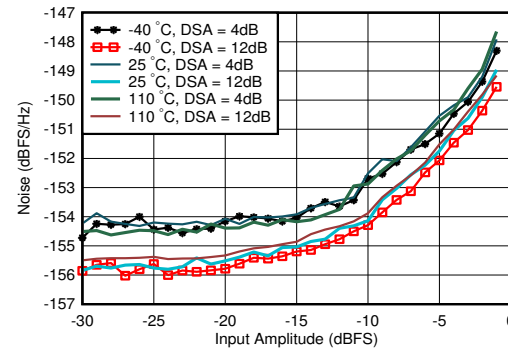
With 0.8 GHz matching, $f_{\text{IN}} = 840 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$

Figure 4-286. RX Output FFT at 0.8 GHz



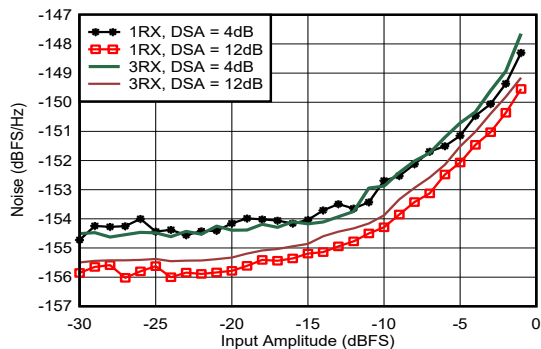
With 0.8 GHz matching, 12.5-MHz offset from tone

Figure 4-287. RX Noise Spectral Density vs Temperature at 0.8 GHz



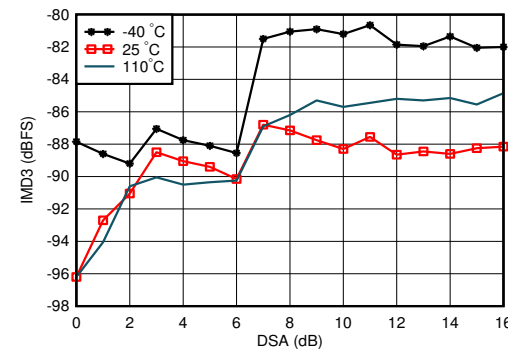
With 0.8 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

Figure 4-288. RX Noise Spectral Density vs Input Amplitude and Temperature at 0.8 GHz



With 0.8 GHz matching, 12.5-MHz offset from tone

Figure 4-289. RX Noise Spectral Density vs Input Amplitude and Channel at 0.8 GHz

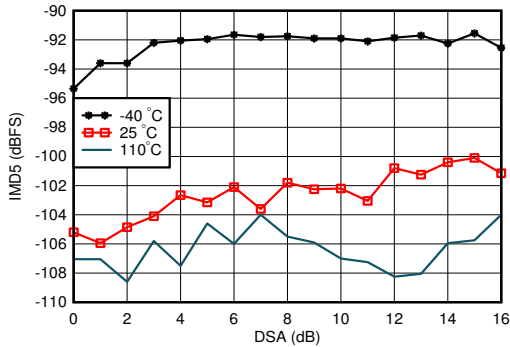


A. With 0.8 GHz matching, each tone -7 dBFS , tone spacing = 20 MHz

Figure 4-290. RX IMD3 vs DSA Setting and Temperature at 0.8 GHz

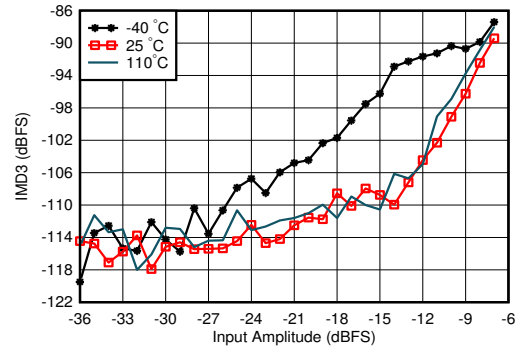
4.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



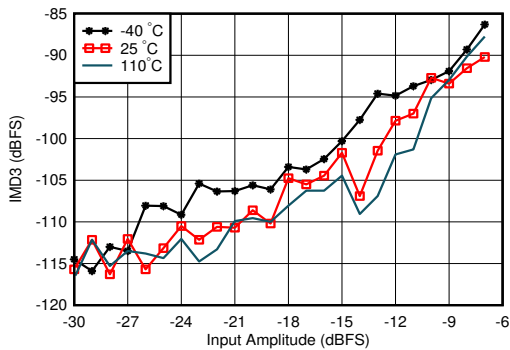
With 0.8 GHz matching, each tone -7 dBFS , tone spacing = 20 MHz

Figure 4-291. RX IMD5 vs DSA Setting and Temperature at 0.8 GHz



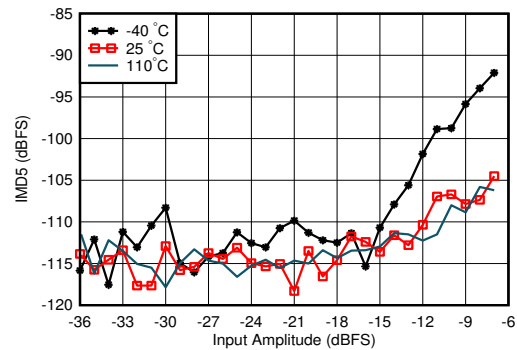
With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

Figure 4-292. RX IMD3 vs Input Level and Temperature at 0.8 GHz



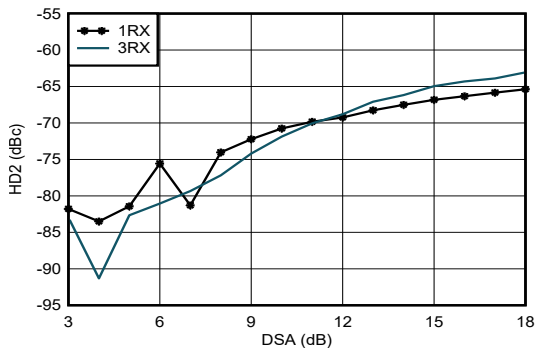
With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

Figure 4-293. RX IMD3 vs Input Level and Temperature at 0.8 GHz



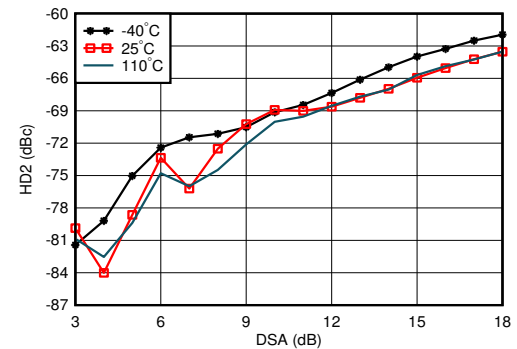
With 0.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

Figure 4-294. RX IMD5 vs Input Level and Temperature at 0.8 GHz



With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-295. RX HD2 vs DSA Setting and Channel at 0.8 GHz

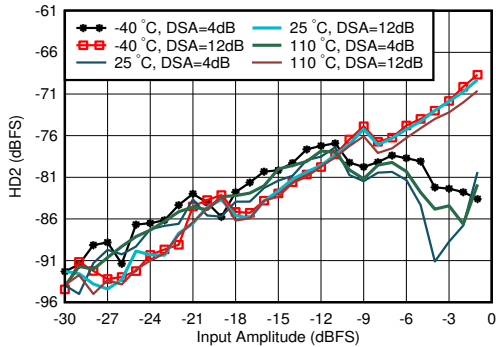


With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-296. RX HD2 vs DSA Setting and Temperature at 0.8 GHz

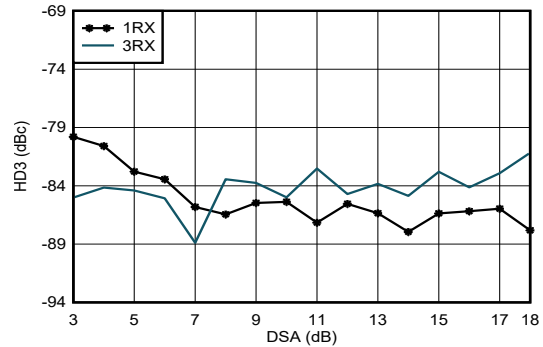
4.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



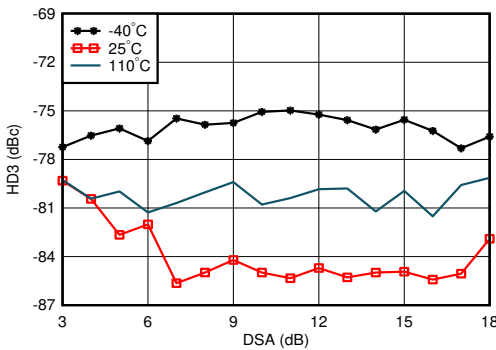
With 0.8 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-297. RX HD2 vs Input Level and Temperature at 0.8 GHz



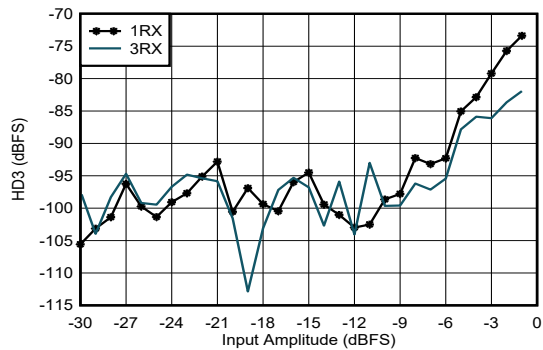
With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-298. RX HD3 vs DSA Setting and Channel at 0.8 GHz



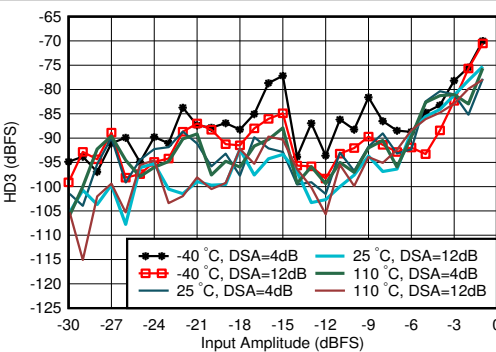
With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-299. RX HD3 vs DSA Setting and Temperature at 0.8 GHz



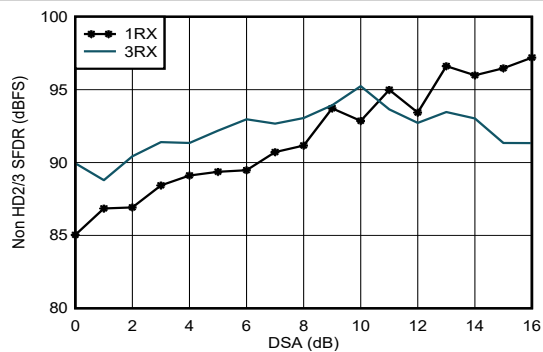
With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-300. RX HD3 vs Input Level and Channel at 0.8 GHz



With 0.8 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-301. RX HD3 vs Input Level and Temperature at 0.8 GHz

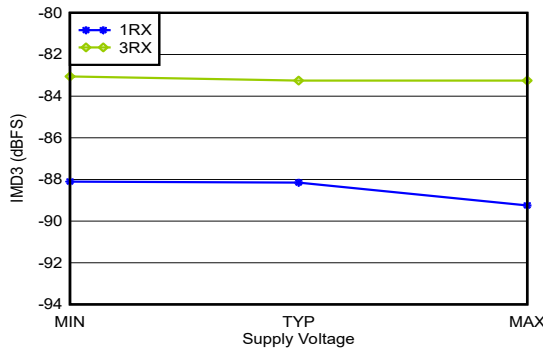


With 0.8 GHz matching

Figure 4-302. RX Non-HD2/3 vs DSA Setting at 0.8 GHz

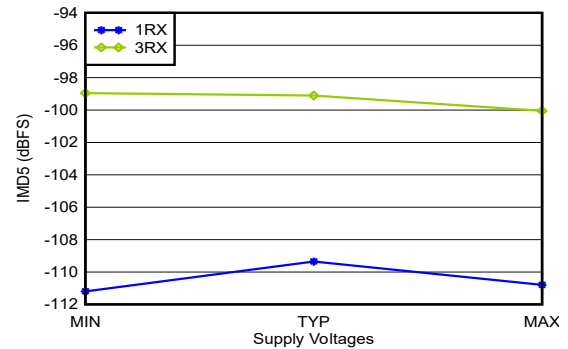
4.12.8 RX Typical Characteristics at 800 MHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



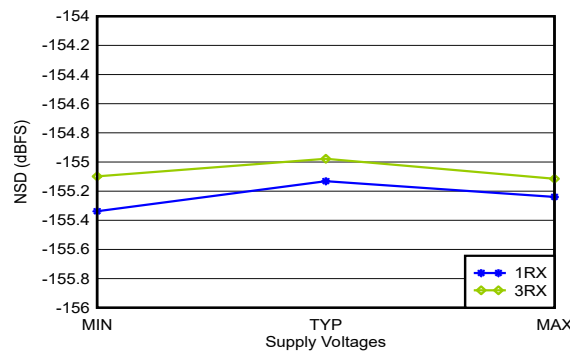
With 0.8 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-303. RX IMD3 vs Supply and Channel at 0.8 GHz



With 0.8 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-304. RX IMD5 vs Supply and Channel at 0.8 GHz

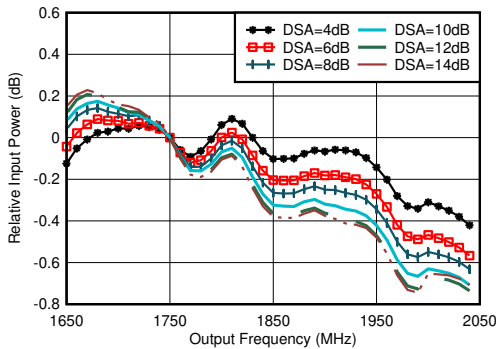


With 0.8 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-305. RX Noise Spectral Density vs Supply and Channel at 0.8 GHz

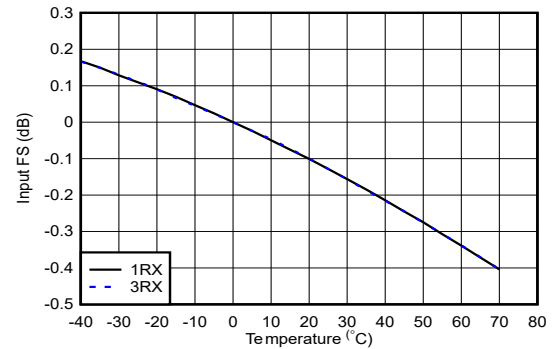
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



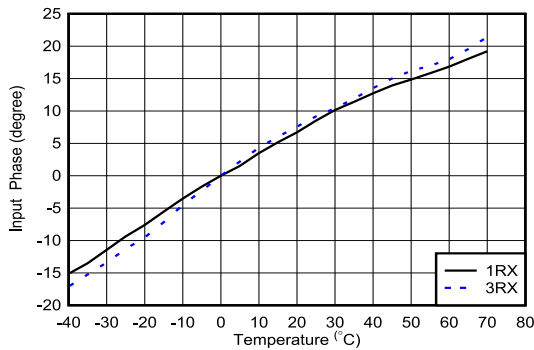
With 1.8 GHz matching, normalized to 1.75 GHz

Figure 4-306. RX In-Band Gain Flatness, $f_{IN} = 1750\text{ MHz}$



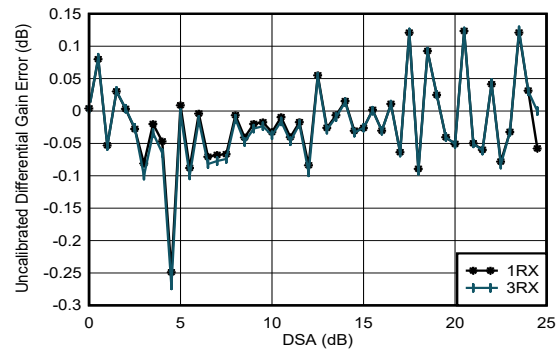
With 1.8 GHz matching, normalized to fullscale at 25°C for each channel

Figure 4-307. RX Input Fullscale vs Temperature and Channel at 1.75 GHz



With 2.6 GHz matching, normalized to phase at 25°C

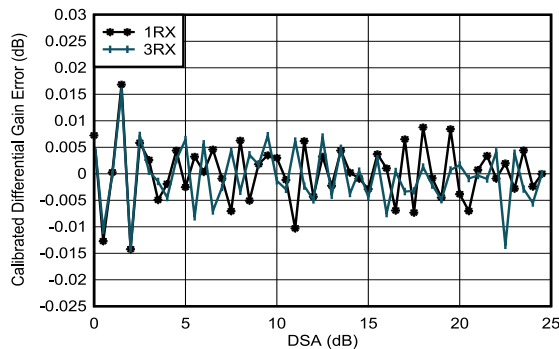
Figure 4-308. RX Input Phase vs Temperature and DSA at $f_{IN} = 1.75\text{ GHz}$



With 1.8 GHz matching

Differential Amplitude Error = $P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$

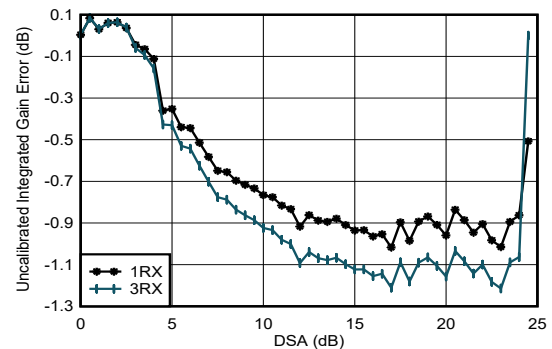
Figure 4-309. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 1.75 GHz



With 1.8 GHz matching

Differential Amplitude Error = $P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$

Figure 4-310. RX Calibrated Differential Amplitude Error vs DSA Setting at 1.75 GHz



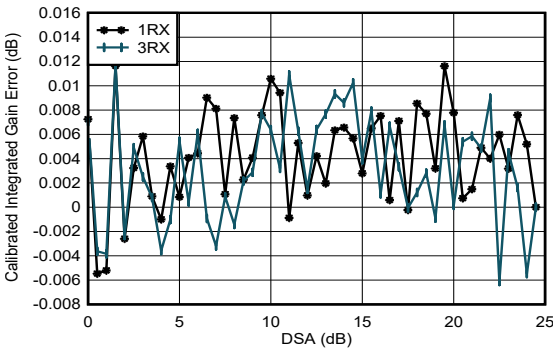
With 1.8 GHz matching

Integrated Amplitude Error = $P_{IN}(\text{DSA Setting}) - P_{IN}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-311. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 1.75 GHz

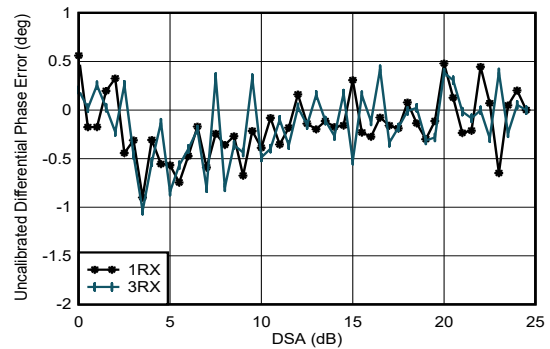
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



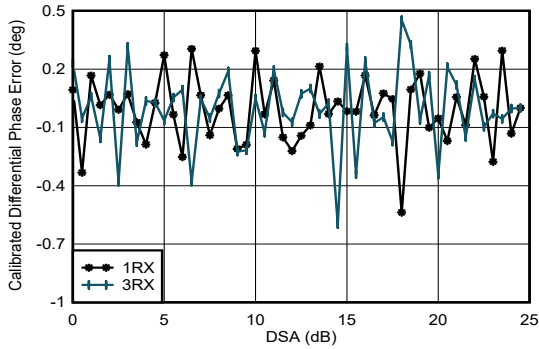
With 1.8 GHz matching
 Integrated Amplitude Error = $P_{IN}(\text{DSA Setting}) - P_{IN}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-312. RX Calibrated Integrated Amplitude Error vs DSA Setting at 1.75 GHz



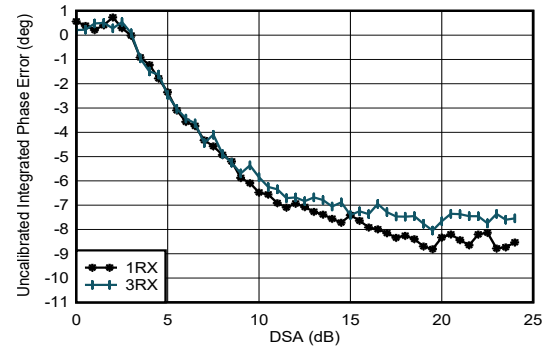
With 1.8 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-313. RX Uncalibrated Differential Phase Error vs DSA Setting at 1.75 GHz



With 1.8 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-314. RX Calibrated Differential Phase Error vs DSA Setting at 1.75 GHz

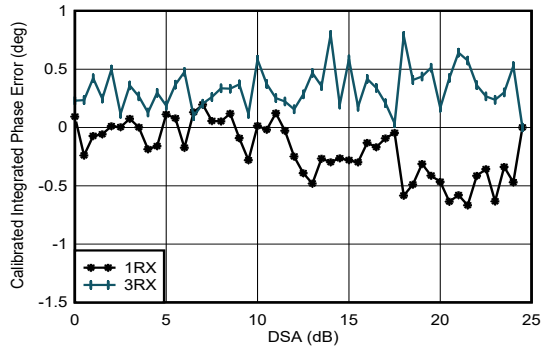


With 1.8 GHz matching
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-315. RX Uncalibrated Integrated Phase Error vs DSA Setting at 1.75 GHz

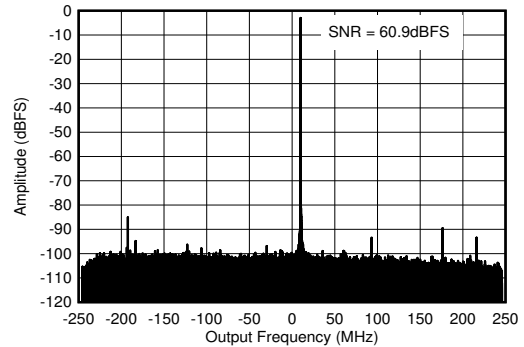
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



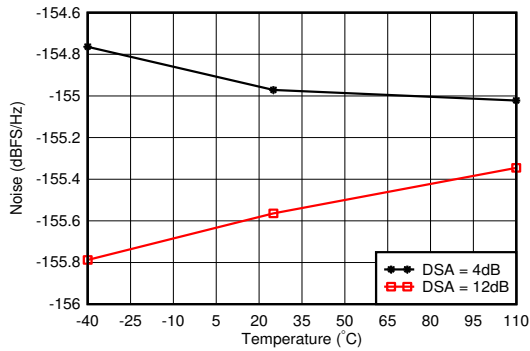
With 1.8 GHz matching
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

Figure 4-316. RX Calibrated Integrated Phase Error vs DSA Setting at 1.75 GHz



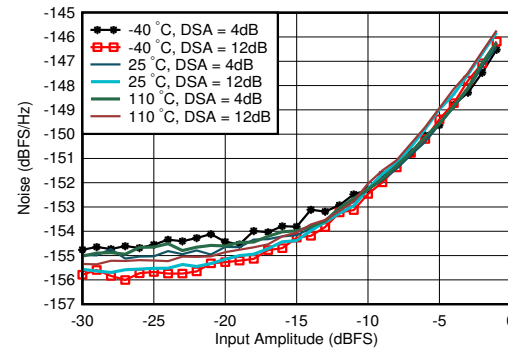
With 1.8 GHz matching, $f_{IN} = 2610\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$

Figure 4-317. RX Output FFT at 1.75 GHz



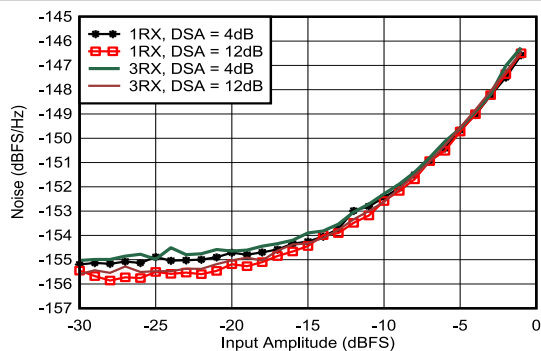
With 1.8 GHz matching, 12.5-MHz offset from tone

Figure 4-318. RX Noise Spectral Density vs Temperature at 1.75 GHz



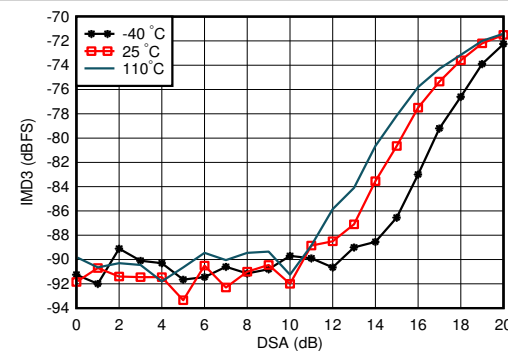
With 1.8 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

Figure 4-319. RX Noise Spectral Density vs Input Amplitude and Temperature at 1.75 GHz



With 1.8 GHz matching, 12.5-MHz offset from tone

Figure 4-320. RX Noise Spectral Density vs Input Amplitude and Channel at 1.75 GHz

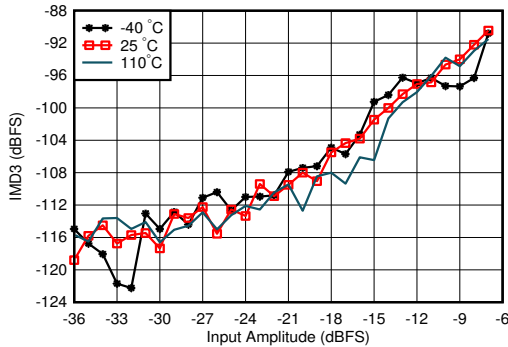


With 1.8 GHz matching, each tone -7 dBFS , tone spacing = 20 MHz

Figure 4-321. RX IMD3 vs DSA Setting and Temperature at 1.75 GHz

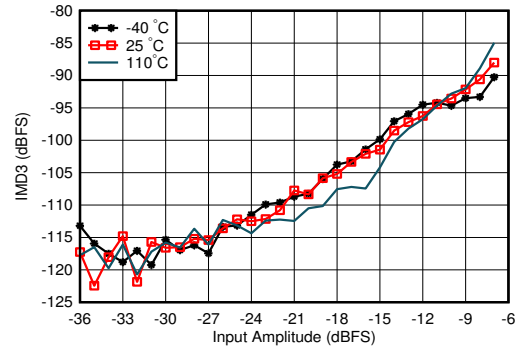
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



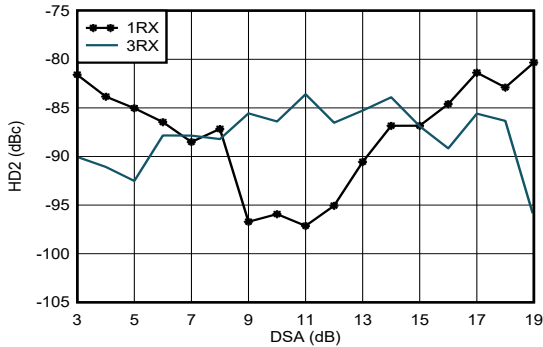
With 1.8 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

Figure 4-322. RX IMD3 vs Input Level and Temperature at 1.75 GHz



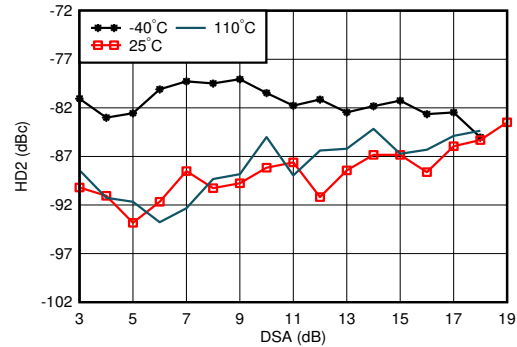
With 1.8 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

Figure 4-323. RX IMD3 vs Input Level and Temperature at 1.75 GHz



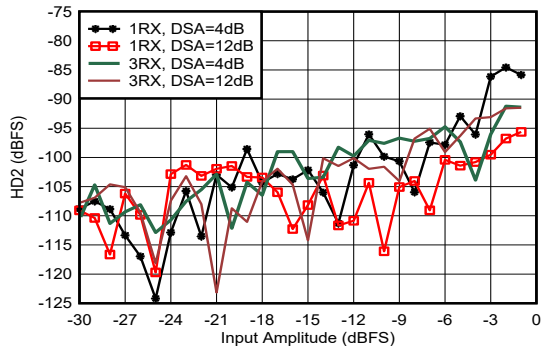
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-324. RX HD2 vs DSA Setting and Channel at 1.9 GHz



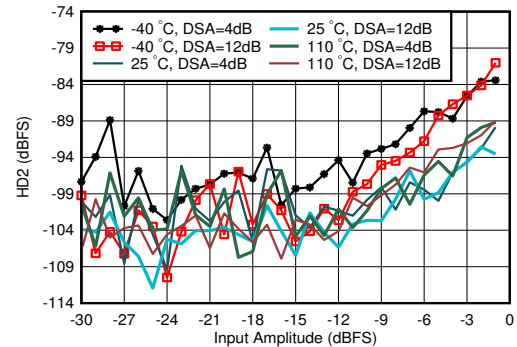
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-325. RX HD2 vs DSA Setting and Temperature at 1.9 GHz



With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-326. RX HD2 vs Input Amplitude and Channel at 1.9 GHz

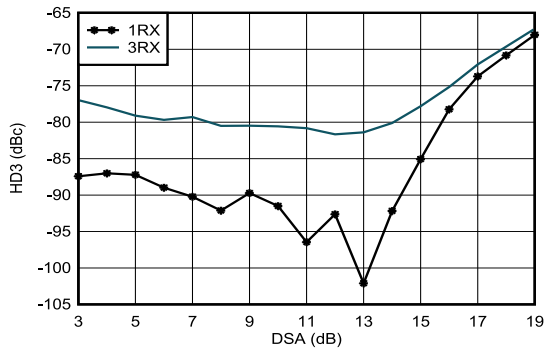


With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-327. RX HD2 vs Input Amplitude and Temperature at 1.9 GHz

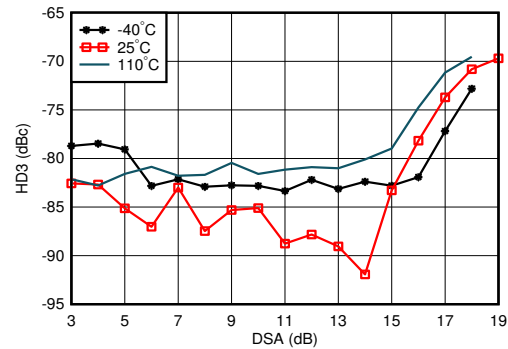
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



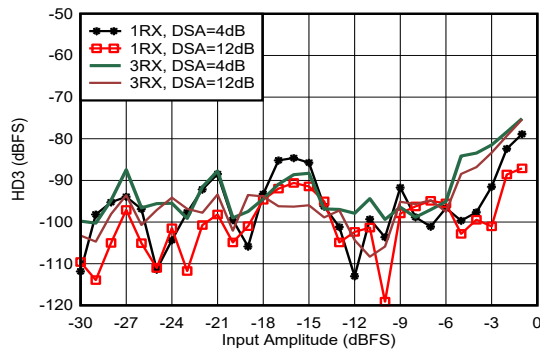
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, DDC bypass mode (TI only mode for characterization)

Figure 4-328. RX HD3 vs DSA Setting and Channel at 1.9 GHz



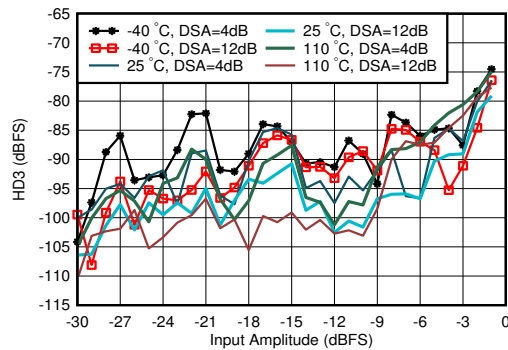
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, DDC bypass mode (TI only mode for characterization)

Figure 4-329. RX HD3 vs DSA Setting and Temperature at 1.9 GHz



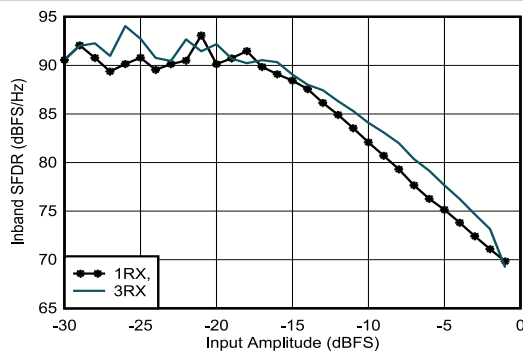
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, DDC bypass mode (TI only mode for characterization)

Figure 4-330. RX HD3 vs Input Level and Channel at 1.9 GHz



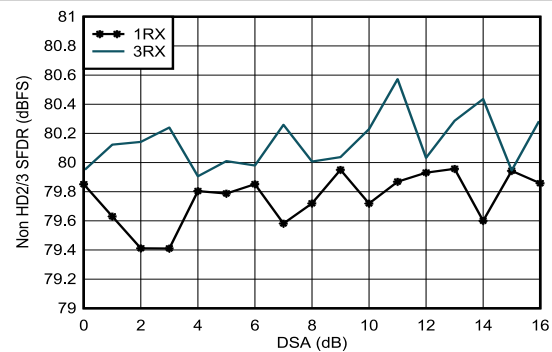
With 1.8 GHz matching, $f_{in} = 1900\text{ MHz}$, DDC bypass mode (TI only mode for characterization)

Figure 4-331. RX HD3 vs Input Level and Temperature at 1.9 GHz



With 1.8 GHz matching, decimated by 3

Figure 4-332. RX In-Band SFDR ($\pm 400\text{ MHz}$) vs Input Amplitude at 1.75 GHz

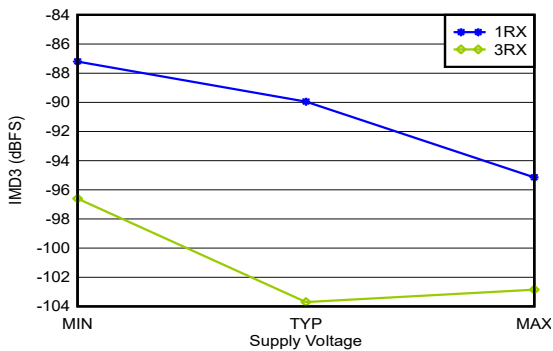


With 1.8 GHz matching

Figure 4-333. RX Non-HD2/3 vs DSA Setting at 1.75 GHz

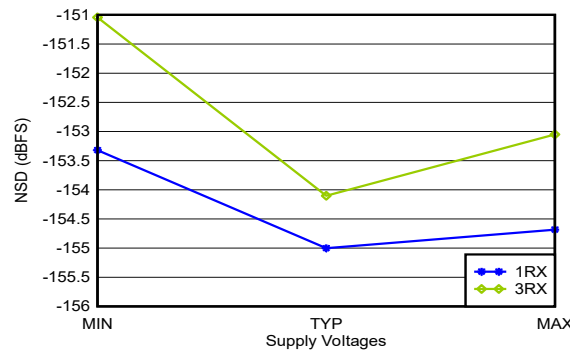
4.12.9 RX Typical Characteristics at 1.75-1.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



With 1.8 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-334. RX IMD3 vs Supply and Channel at 1.75 GHz

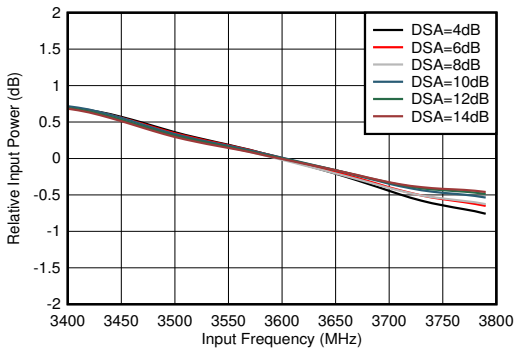


With 1.8 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-335. RX Noise Spectral Density vs Supply and Channel at 1.75 GHz

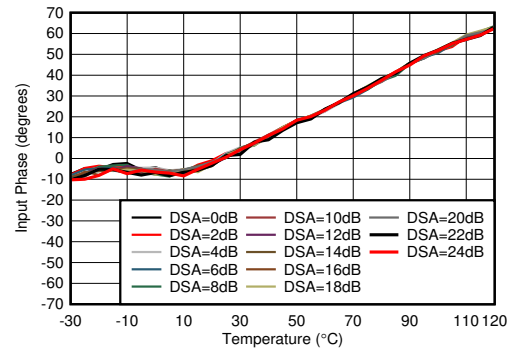
4.12.10 RX Typical Characteristics at 3.5 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



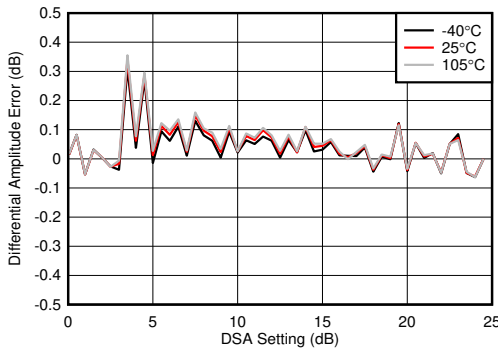
With 3.6 GHz matching, normalized to 3.6 GHz

Figure 4-336. RX In-Band Gain Flatness, $f_{\text{IN}} = 3600 \text{ MHz}$



With 3.6 GHz matching, normalized to phase at 25°C

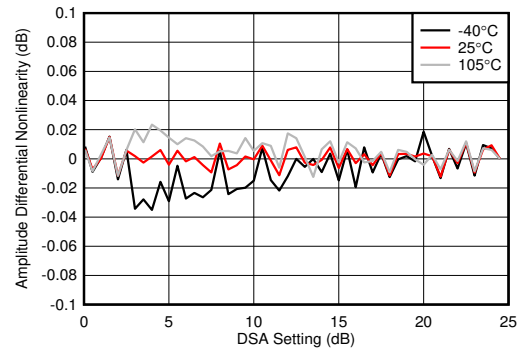
Figure 4-337. RX Input Phase vs Temperature at 3.6 GHz



With 3.6 GHz matching

$$\text{Differential Amplitude Error} = P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$$

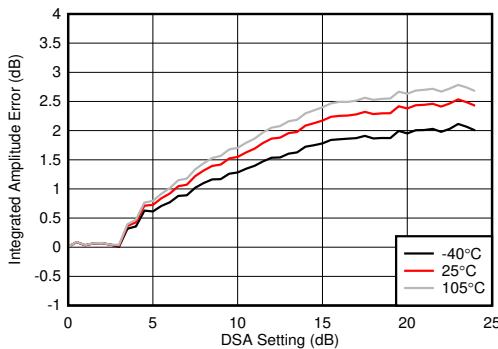
Figure 4-338. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

$$\text{Differential Amplitude Error} = P_{\text{IN}}(\text{DSA Setting} - 1) - P_{\text{IN}}(\text{DSA Setting}) + 1$$

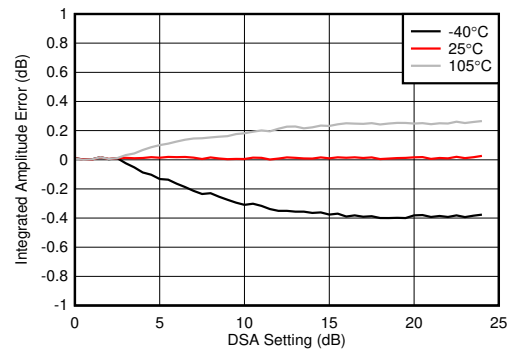
Figure 4-339. RX Calibrated Differential Amplitude Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching

$$\text{Integrated Amplitude Error} = P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$$

Figure 4-340. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 3.6 GHz



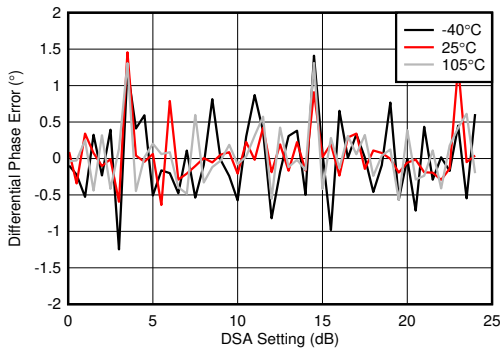
With 3.6 GHz matching

$$\text{Integrated Amplitude Error} = P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$$

Figure 4-341. RX Calibrated Integrated Amplitude Error vs DSA Setting at 3.6 GHz

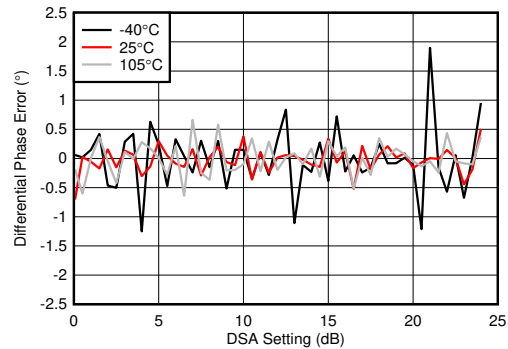
4.12.10 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



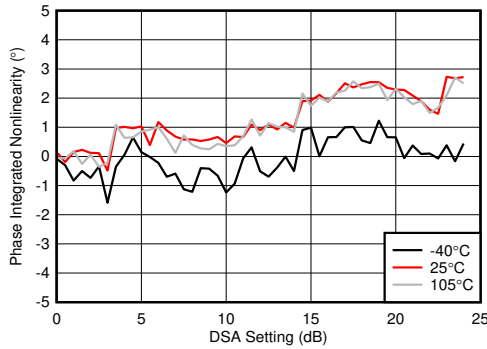
With 3.6 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-342. RX Uncalibrated Phase Error vs DSA Setting at 3.6 GHz



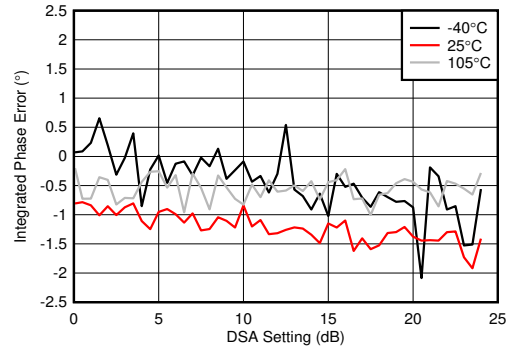
With 3.6 GHz matching
 Differential Phase Error = $\text{Phase}_{IN}(\text{DSA Setting} - 1) - \text{Phase}_{IN}(\text{DSA Setting})$

Figure 4-343. RX Calibrated Differential Phase Error vs DSA Setting at 3.6 GHz



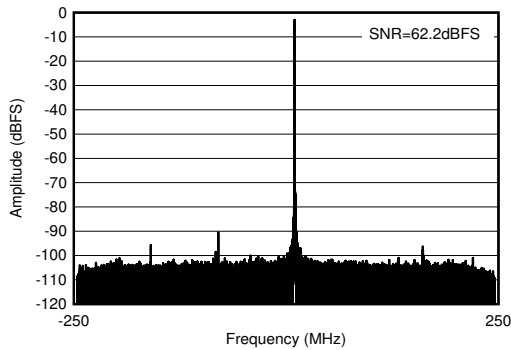
With 3.6 GHz matching
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-344. RX Uncalibrated Integrated Phase Error vs DSA Setting at 3.6 GHz



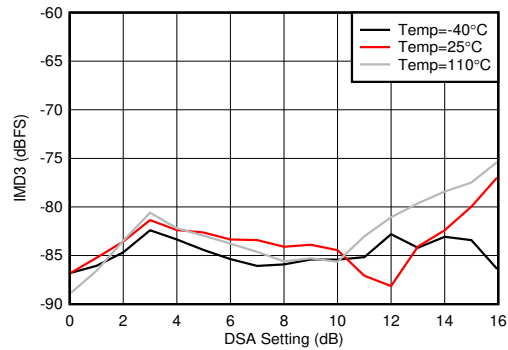
With 3.6 GHz matching
 Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-345. RX Calibrated Integrated Phase Error vs DSA Setting at 3.6 GHz



With 3.6 GHz matching, $f_{IN} = 3610\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$

Figure 4-346. RX Output FFT at 3.6 GHz

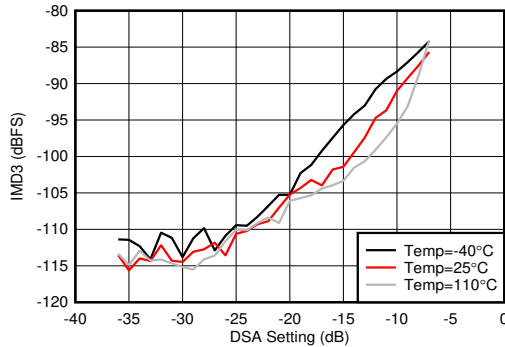


With 3.5 GHz matching, each tone at -7 dBFS , 20-MHz tone spacing

Figure 4-347. RX IMD3 vs DSA Setting and Temperature at 3.6 GHz

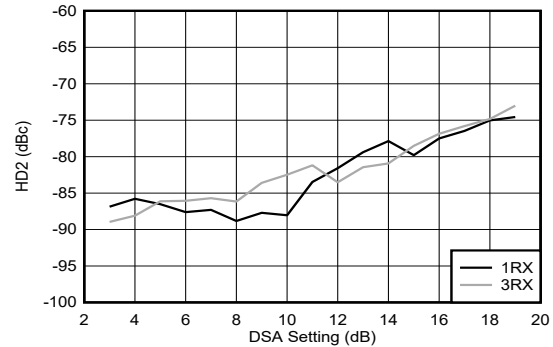
4.12.10 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



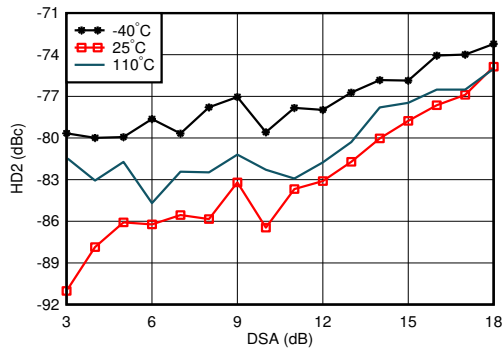
With 3.5 GHz matching, 20-MHz tone spacing

Figure 4-348. RX IMD3 vs Input Level and Temperature at 3.6 GHz



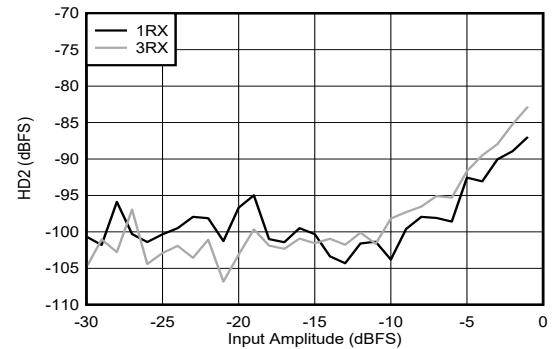
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-349. RX HD2 vs DSA Setting and Channel at 3.6 GHz



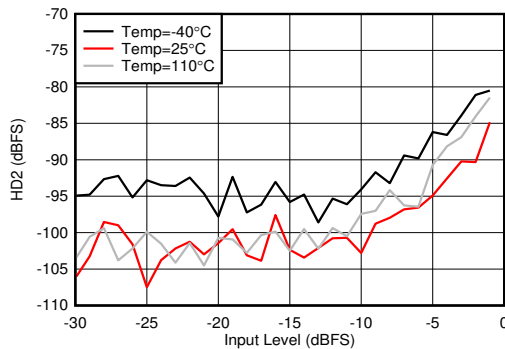
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-350. RX HD2 vs DSA Setting and Temperature at 3.6 GHz



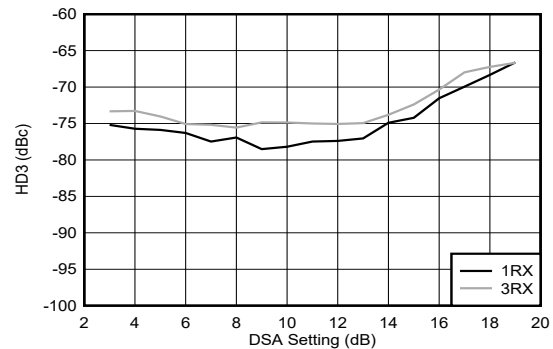
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-351. RX HD2 vs Input Level and Channel at 3.6 GHz



With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-352. RX HD2 vs Input Level and Temperature at 3.6 GHz

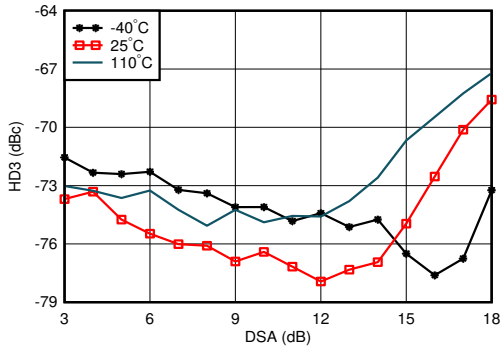


With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-353. RX HD3 vs DSA Setting and Channel at 3.6 GHz

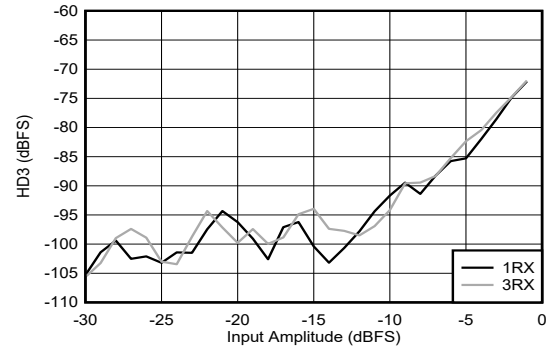
4.12.10 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



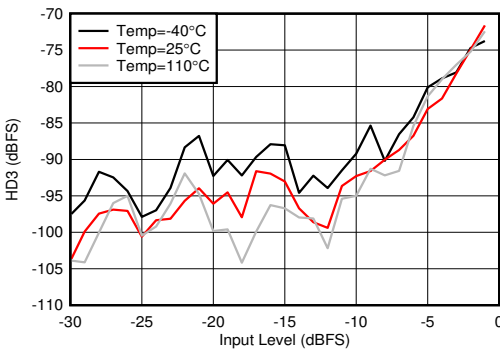
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-354. RX HD3 vs DSA Setting and Temperature at 3.6 GHz



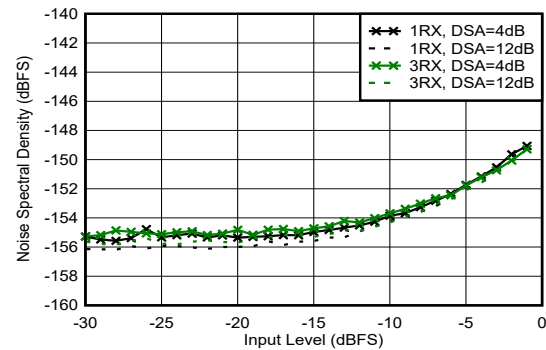
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-355. RX HD3 vs Input Level and Channel at 3.6 GHz



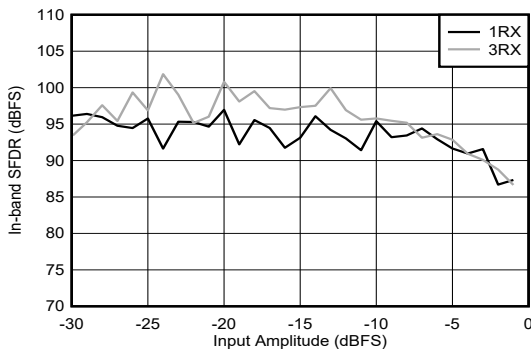
With 3.5 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-356. RX HD3 vs Input Level and Temperature at 3.6 GHz



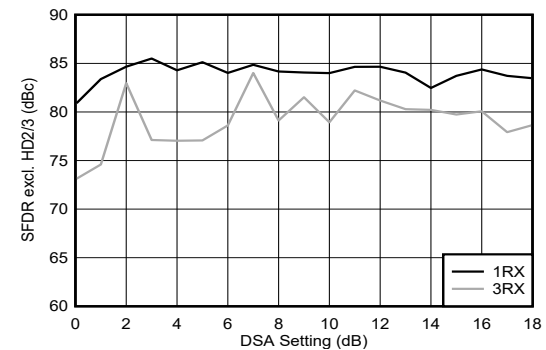
With 3.5 GHz matching, 12.5-MHz offset from tone

Figure 4-357. RX Noise Spectral Density vs Input Level and DSA Setting at 3.6 GHz



With 3.5 GHz matching

Figure 4-358. RX In-Band SFDR ($\pm 200\text{ MHz}$) vs Input Level and Channel at 3.6 GHz

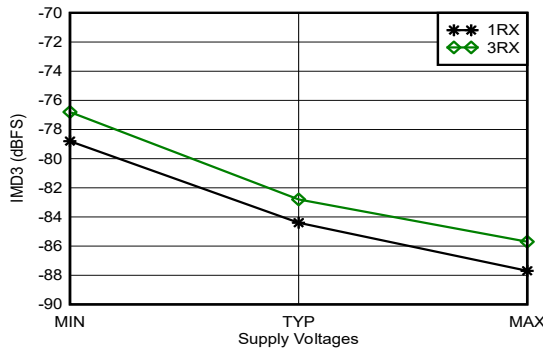


With 3.5 GHz matching

Figure 4-359. RX SFDR Excluding HD2/3 vs DSA Setting and Channel at 3.6 GHz

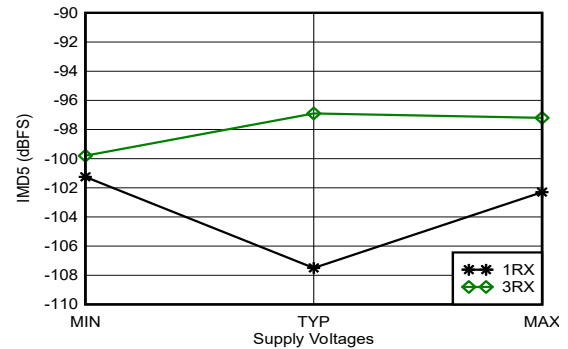
4.12.10 RX Typical Characteristics at 3.5 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



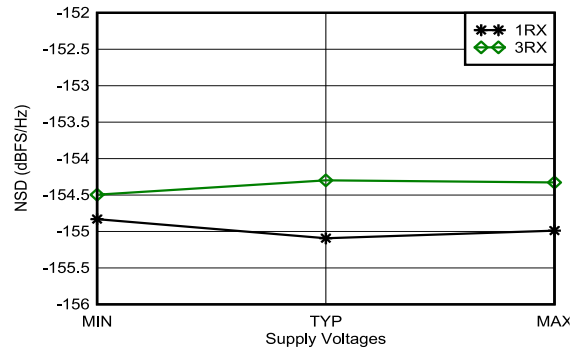
With 3.6 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-360. RX IMD3 vs Supply Voltage and Channel at 3.6 GHz



With 3.6 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-361. RX IMD5 vs Supply Voltage and Channel at 3.6 GHz

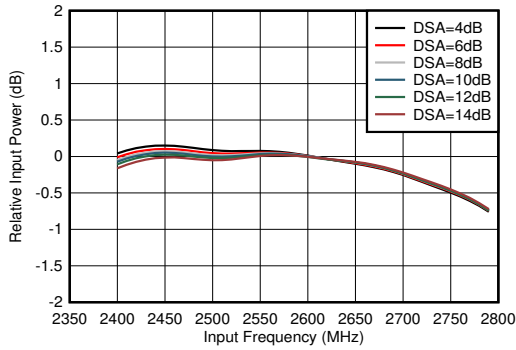


With 3.6 GHz matching, tone at -20 dBFS , 12.5-MHz offset frequency, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-362. RX Noise Spectral Density vs Supply Voltage and Channel at 3.6 GHz

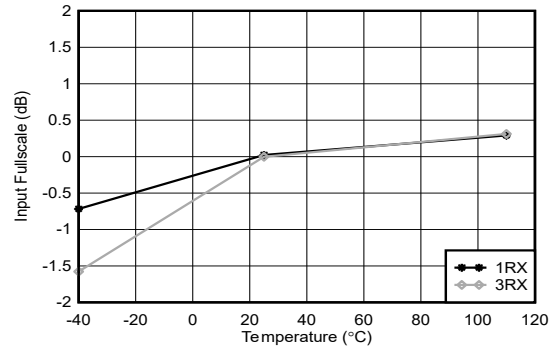
4.12.11 RX Typical Characteristics at 2.6 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



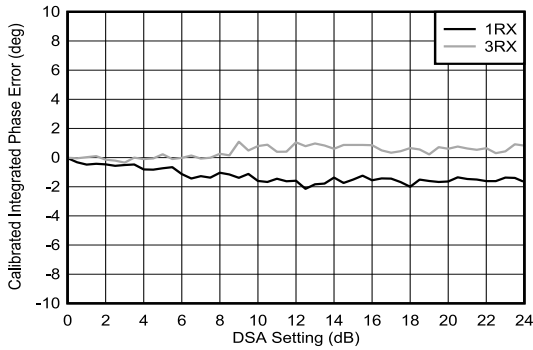
With matching, normalized to power at 2.6 GHz for each DSA setting

Figure 4-363. RX Inband Gain Flatness, $f_{\text{IN}} = 2600 \text{ MHz}$



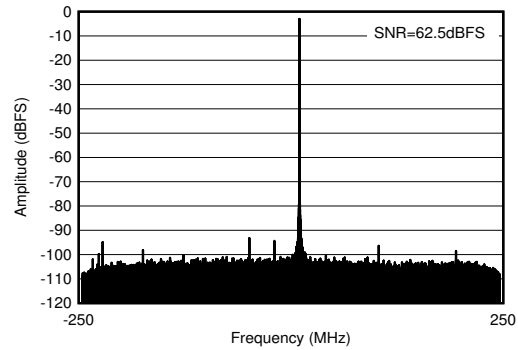
With 2.6 GHz matching, normalized to fullscale at 25°C for each channel

Figure 4-364. RX Input Fullscale vs Temperature and Channel at 2.6 GHz



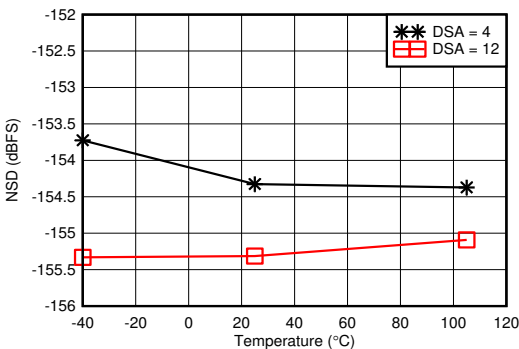
With 2.6 GHz matching
Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

Figure 4-365. RX Calibrated Integrated Phase Error vs DSA Setting at 2.6 GHz



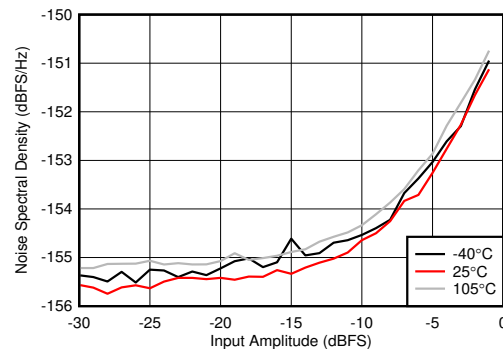
With 2.6 GHz matching, $f_{\text{IN}} = 2610 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$

Figure 4-366. RX Output FFT at 2.6 GHz



With 2.6 GHz matching, 12.5-MHz offset from tone

Figure 4-367. RX Noise Spectral Density vs Temperature at 2.6 GHz

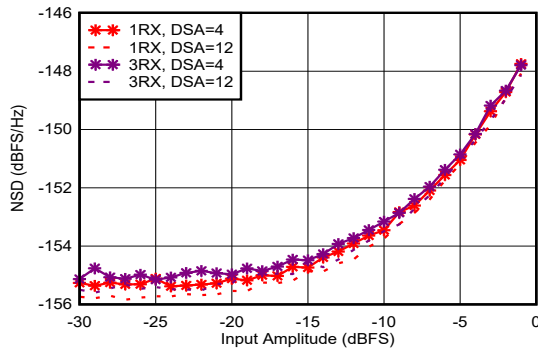


With 2.6 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

Figure 4-368. RX Noise Spectral Density vs Input Amplitude and Temperature at 2.6 GHz

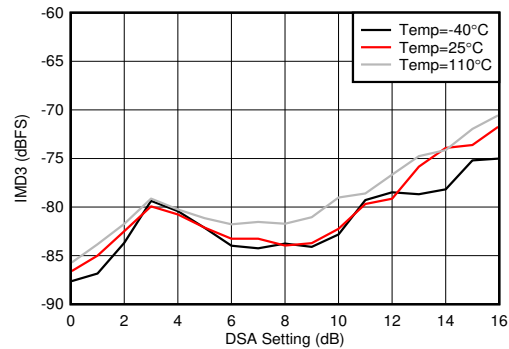
4.12.11 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



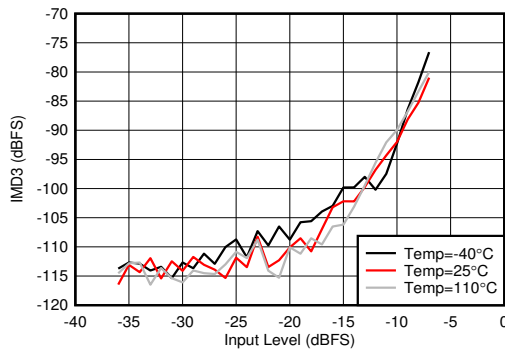
With 2.6 GHz matching, 12.5-MHz offset from tone

Figure 4-369. RX Noise Spectral Density vs Input Amplitude and Channel at 2.6 GHz



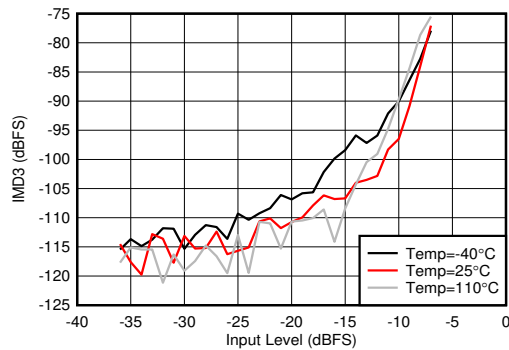
With 2.6 GHz matching, each tone -7 dBFS , tone spacing = 20 MHz

Figure 4-370. RX IMD3 vs DSA Setting and Temperature at 2.6 GHz



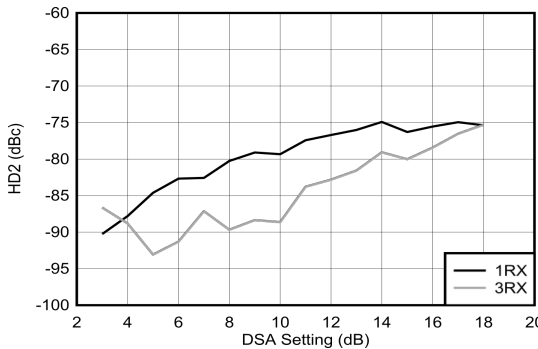
With 2.6 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

Figure 4-371. RX IMD3 vs Input Level and Temperature at 2.6 GHz



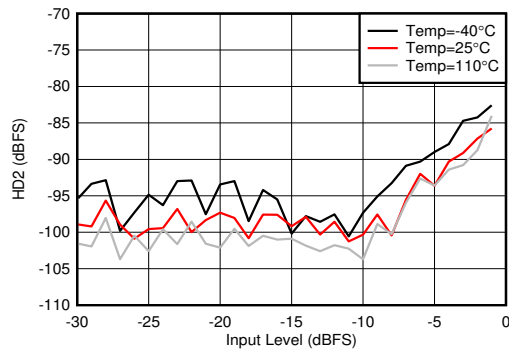
With 2.6 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

Figure 4-372. RX IMD3 vs Input Level and Temperature at 2.6 GHz



With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-373. RX HD2 vs DSA Setting and Channel at 2.6 GHz

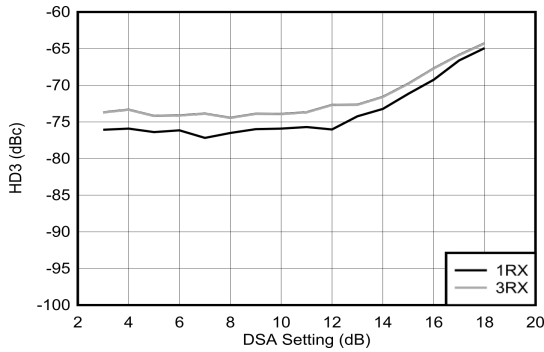


With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-374. RX HD2 vs Input Level and Temperature at 2.6 GHz

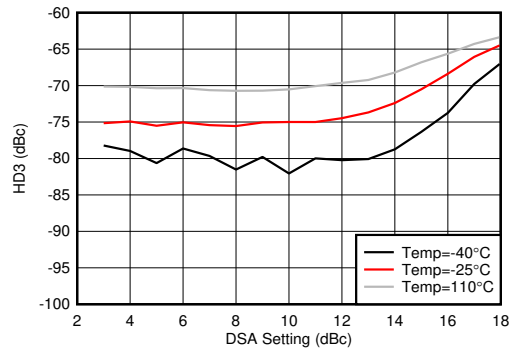
4.12.11 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



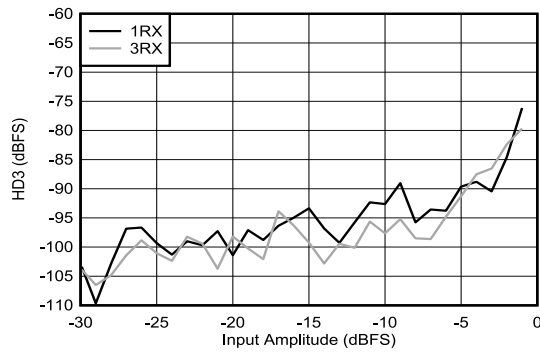
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-375. RX HD3 vs DSA Setting and Channel at 2.6 GHz



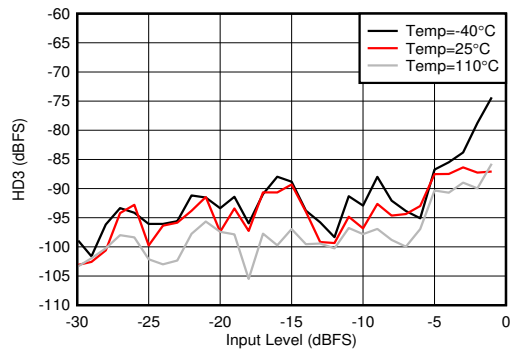
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-376. RX HD3 vs DSA Setting and Temperature at 2.6 GHz



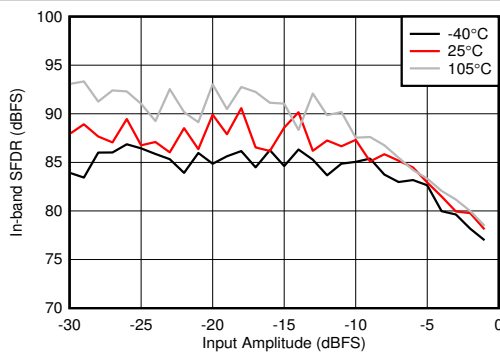
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-377. RX HD3 vs Input Level and Channel at 2.6 GHz



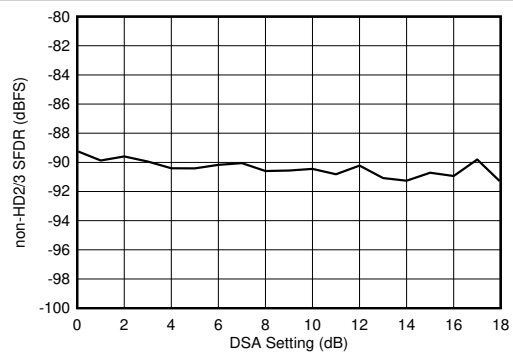
With 2.6 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-378. RX HD3 vs Input Level and Temperature at 2.6 GHz



With 2.6 GHz matching, decimate by 4

Figure 4-379. RX In-Band SFDR ($\pm 300\text{ MHz}$) vs Input Amplitude and Temperature at 2.6 GHz

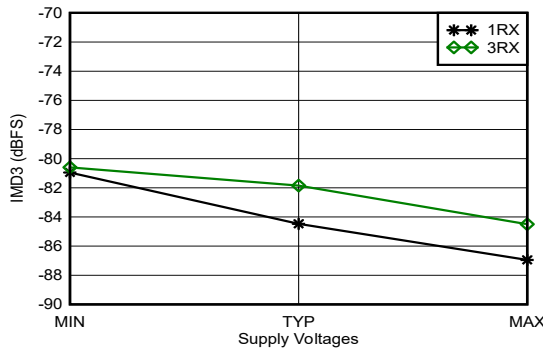


With 2.6 GHz matching

Figure 4-380. RX Non-HD2/3 vs DSA Setting at 2.6 GHz

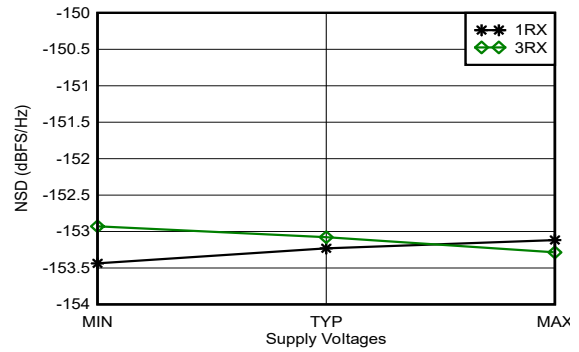
4.12.11 RX Typical Characteristics at 2.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



With 2.6 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-381. RX IMD3 vs Supply and Channel at 2.6 GHz

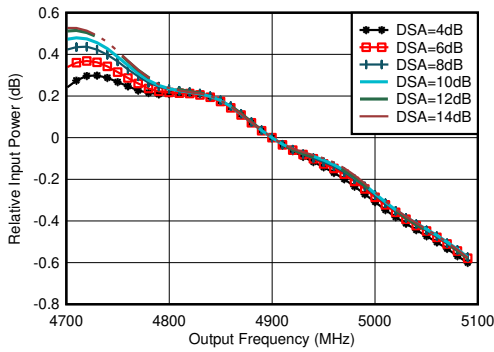


With 2.6 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-382. RX Noise Spectral Density vs Supply and Channel at 2.6 GHz

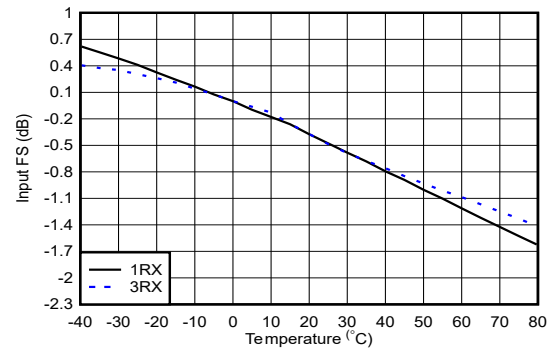
4.12.12 RX Typical Characteristics at 4.9 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



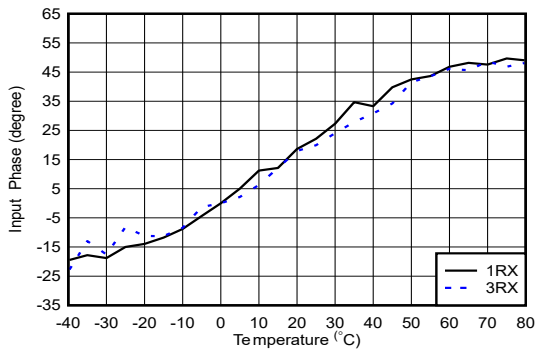
With matching, normalized to power at 4.9GHz for each DSA setting

Figure 4-383. RX Inband Gain Flatness, $f_{IN} = 4900\text{ MHz}$



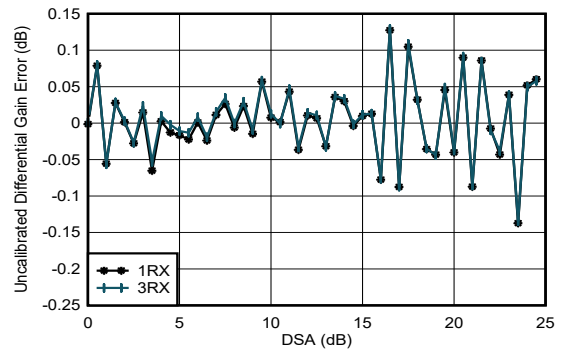
With 4.9 GHz matching, normalized to fullscale at 25°C for each channel

Figure 4-384. RX Input Fullscale vs Temperature and Channel at 4.9 GHz



With 4.9 GHz matching, normalized to phase at 25°C

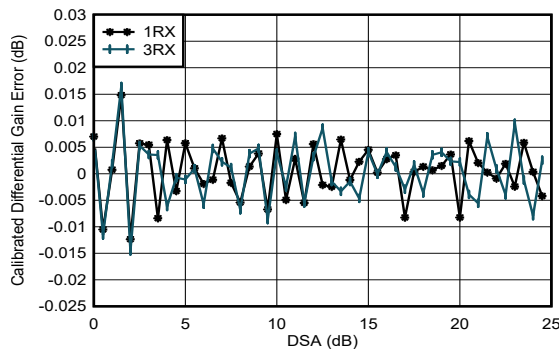
Figure 4-385. RX Input Phase vs Temperature and DSA at $f_{OUT} = 4.9\text{ GHz}$



With 4.9 GHz matching

$$\text{Differential Amplitude Error} = P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$$

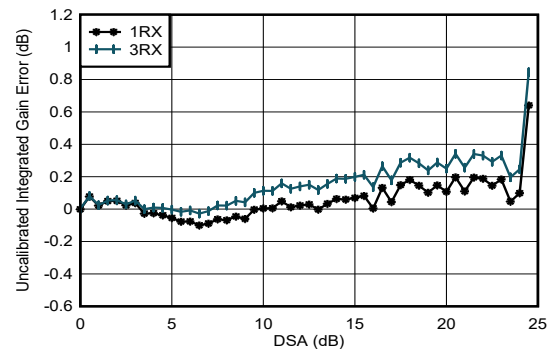
Figure 4-386. RX Uncalibrated Differential Amplitude Error vs DSA Setting at 4.9 GHz



With 4.9 GHz matching

$$\text{Differential Amplitude Error} = P_{IN}(\text{DSA Setting} - 1) - P_{IN}(\text{DSA Setting}) + 1$$

Figure 4-387. RX Calibrated Differential Amplitude Error vs DSA Setting at 4.9 GHz



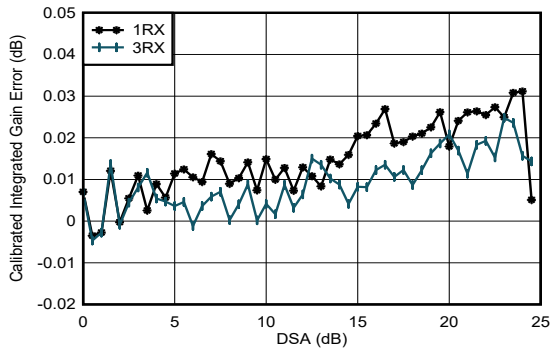
With 4.9 GHz matching

$$\text{Integrated Amplitude Error} = P_{IN}(\text{DSA Setting}) - P_{IN}(\text{DSA Setting} = 0) + (\text{DSA Setting})$$

Figure 4-388. RX Uncalibrated Integrated Amplitude Error vs DSA Setting at 4.9 GHz

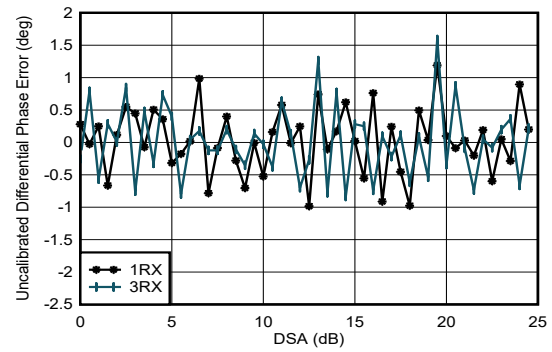
4.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



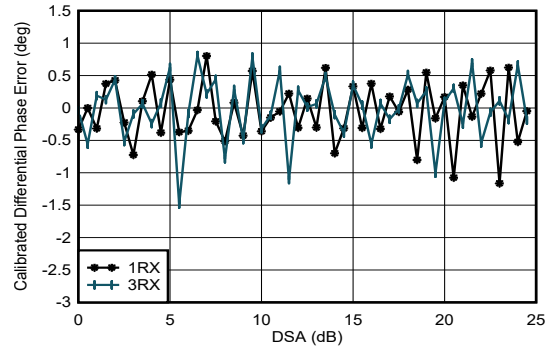
With 4.9 GHz matching
Integrated Amplitude Error = $P_{\text{IN}}(\text{DSA Setting}) - P_{\text{IN}}(\text{DSA Setting} = 0) + (\text{DSA Setting})$

Figure 4-389. RX Calibrated Integrated Amplitude Error vs DSA Setting at 4.9 GHz



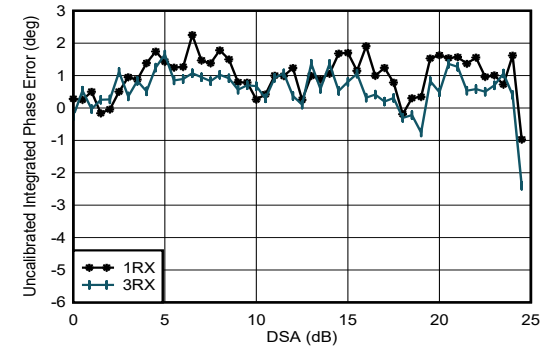
With 4.9 GHz matching
Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

Figure 4-390. RX Uncalibrated Differential Phase Error vs DSA Setting at 4.9 GHz



With 4.9 GHz matching
Differential Phase Error = $\text{Phase}_{\text{IN}}(\text{DSA Setting} - 1) - \text{Phase}_{\text{IN}}(\text{DSA Setting})$

Figure 4-391. RX Calibrated Differential Phase Error vs DSA Setting at 4.9 GHz

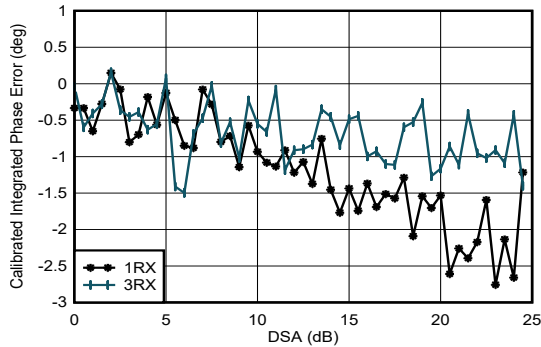


With 4.9 GHz matching
Integrated Phase Error = $\text{Phase}(\text{DSA Setting}) - \text{Phase}(\text{DSA Setting} = 0)$

Figure 4-392. RX Uncalibrated Integrated Phase Error vs DSA Setting at 4.9 GHz

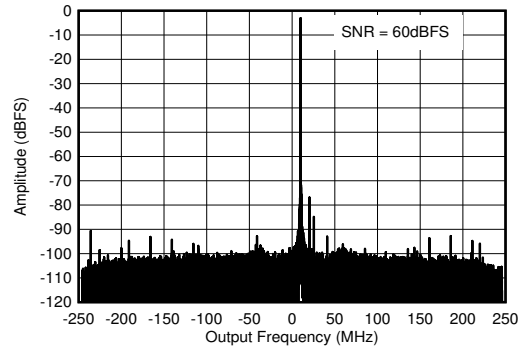
4.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



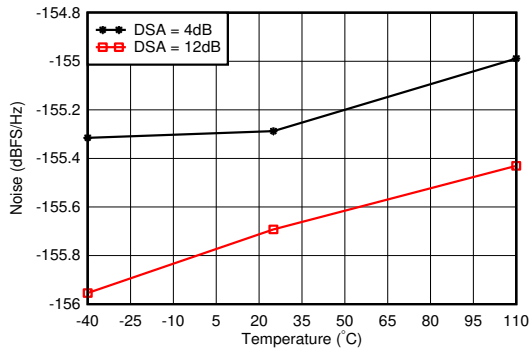
With 4.9 GHz matching
 Integrated Phase Error = Phase(DSA Setting) – Phase(DSA Setting = 0)

Figure 4-393. RX Calibrated Integrated Phase Error vs DSA Setting at 4.9 GHz



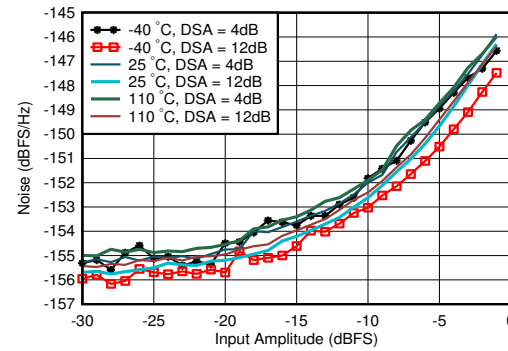
With 4.9 GHz matching, $f_{\text{IN}} = 4910 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$

Figure 4-394. RX Output FFT at 4.9 GHz



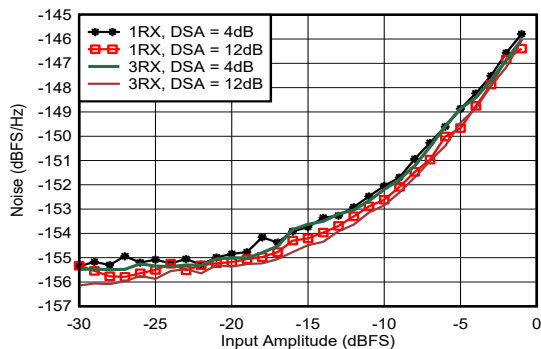
With 4.9 GHz matching, 12.5-MHz offset from tone

Figure 4-395. RX Noise Spectral Density vs Temperature at 4.9 GHz



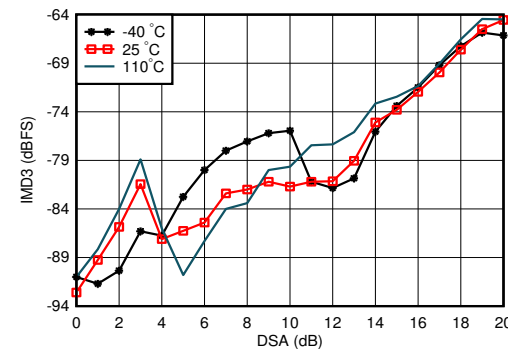
With 4.9 GHz matching, DSA Setting = 12 dB, 12.5-MHz offset from tone

Figure 4-396. RX Noise Spectral Density vs Input Amplitude and Temperature at 4.9 GHz



With 4.9 GHz matching, 12.5-MHz offset from tone

Figure 4-397. RX Noise Spectral Density vs Input Amplitude and Channel at 4.9 GHz

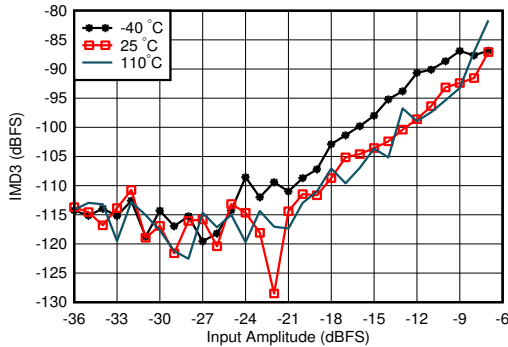


With 4.9 GHz matching, each tone -7 dBFS , tone spacing = 20 MHz

Figure 4-398. RX IMD3 vs DSA Setting and Temperature at 4.9 GHz

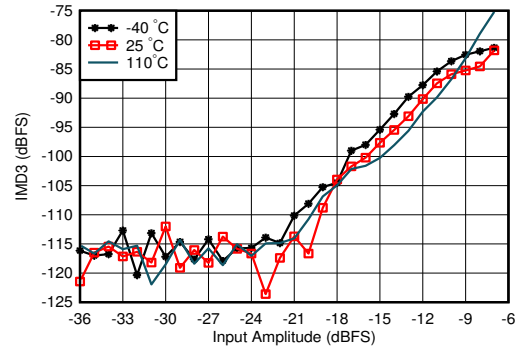
4.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



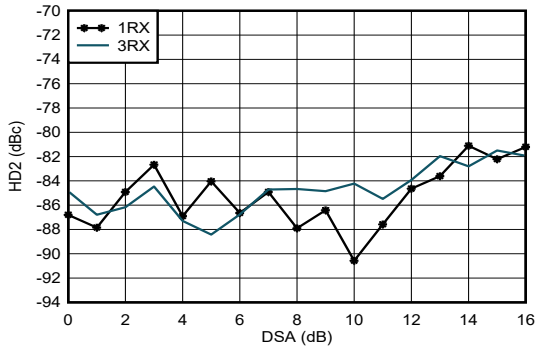
With 4.9 GHz matching, tone spacing = 20 MHz, DSA = 4 dB

Figure 4-399. RX IMD3 vs Input Level and Temperature at 4.9 GHz



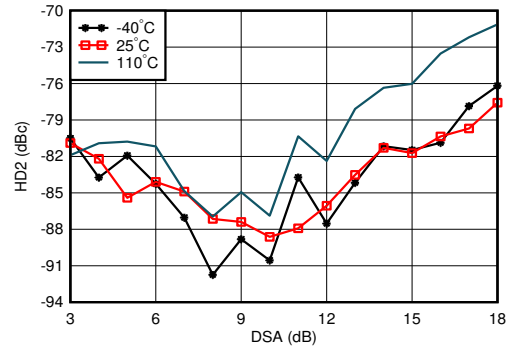
With 4.9 GHz matching, tone spacing = 20 MHz, DSA = 12 dB

Figure 4-400. RX IMD3 vs Input Level and Temperature at 4.9 GHz



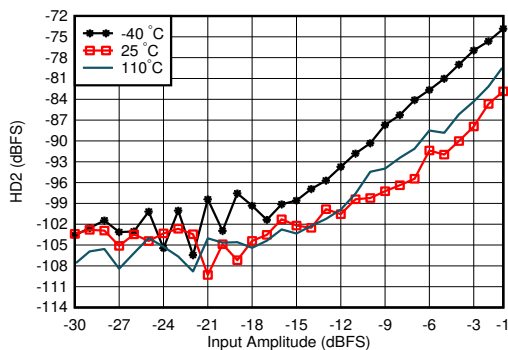
With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-401. RX HD2 vs DSA Setting and Channel at 4.9 GHz



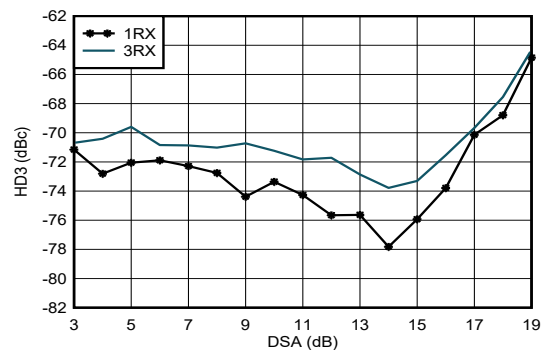
With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-402. RX HD2 vs DSA and Temperature at 4.9 GHz



With 4.9 GHz matching, measured after HD2 trim, DDC bypass mode (TI only mode for characterization)

Figure 4-403. RX HD2 vs Input Level and Temperature at 4.9 GHz

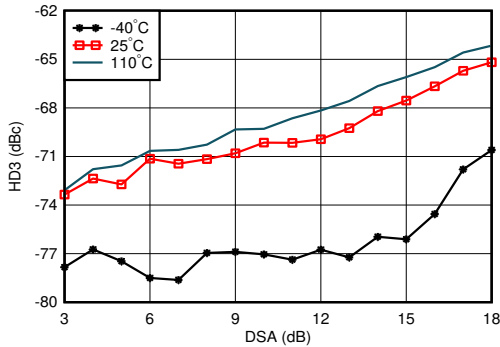


With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-404. RX HD3 vs DSA Setting and Channel at 4.9 GHz

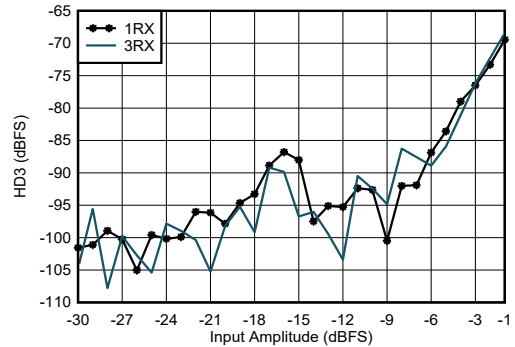
4.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{REF} = 491.52\text{ MHz}$, $A_{IN} = -3\text{ dBFS}$, DSA setting = 4 dB.



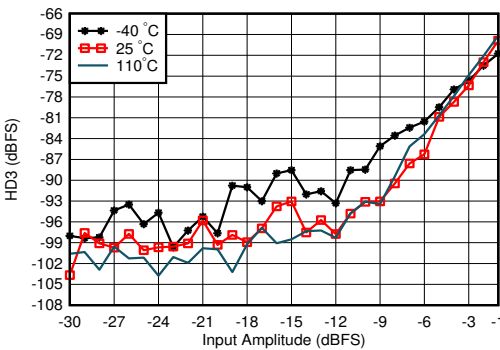
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-405. RX HD3 vs DSA Setting and Temperature at 4.9 GHz



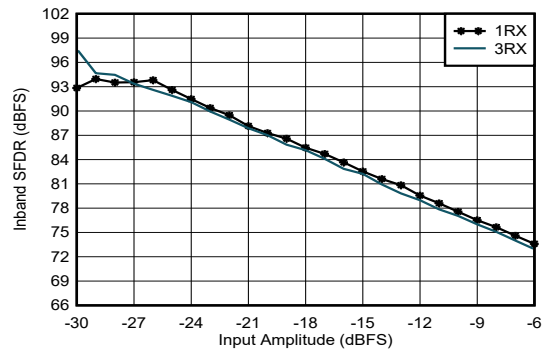
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-406. RX HD3 vs Input Level and Channel at 4.9 GHz



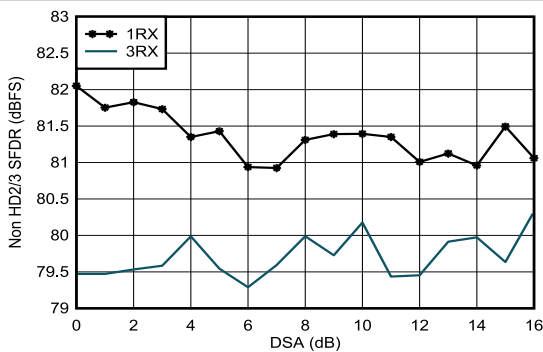
With 4.9 GHz matching, DDC bypass mode (TI only mode for characterization)

Figure 4-407. RX HD3 vs Input Level and Temperature at 4.9 GHz



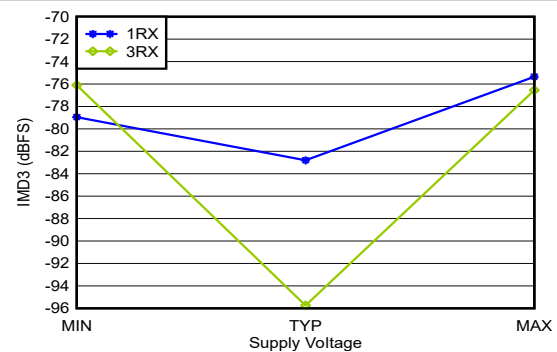
With 4.9 GHz matching, decimate by 3

Figure 4-408. RX In-Band SFDR ($\pm 400\text{ MHz}$) vs Input Amplitude and Channel at 4.9 GHz



With 4.9 GHz matching

Figure 4-409. RX Non-HD2/3 vs DSA Setting at 4.9 GHz

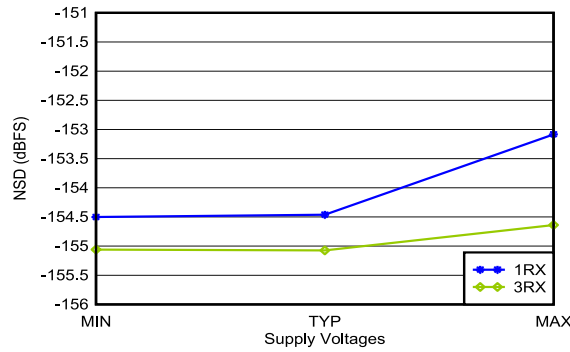


With 4.9 GHz matching, -7 dBFS each tone, 20-MHz tone spacing, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-410. RX IMD3 vs Supply and Channel at 4.9 GHz

4.12.12 RX Typical Characteristics at 4.9 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), PLL clock mode with $f_{\text{REF}} = 491.52 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 4 dB.



With 4.9 GHz matching, 12.5-MHz offset, all supplies at MIN, TYP, or MAX recommended operating voltages

Figure 4-411. RX Noise Spectral Density vs Supply and Channel at 4.9 GHz

4.12.13 RX Typical Characteristics at 8.1 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 GHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 8.1 GHz matching.

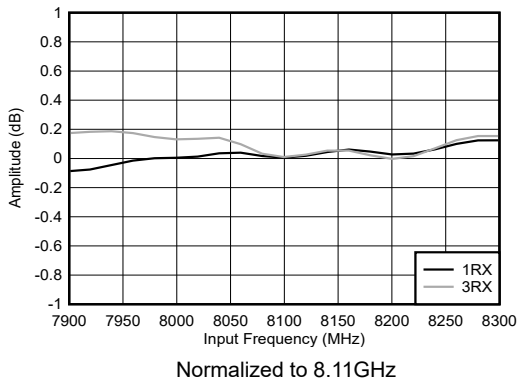


Figure 4-412. RX Amplitude vs Frequency and Channel

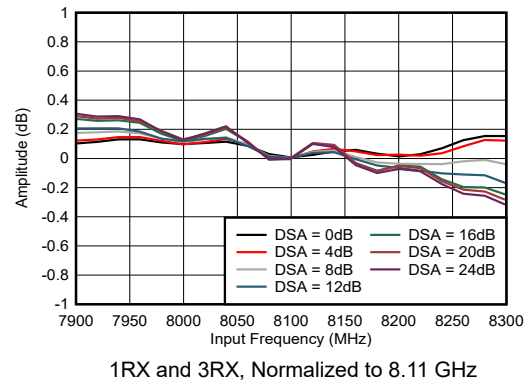


Figure 4-413. RX Amplitude vs Frequency and DSA Setting

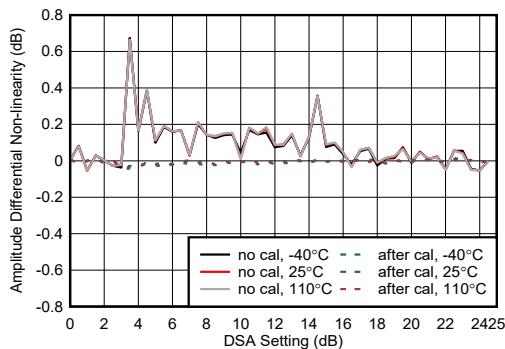


Figure 4-414. RX Amplitude Differential Nonlinearity at 8.11 GHz

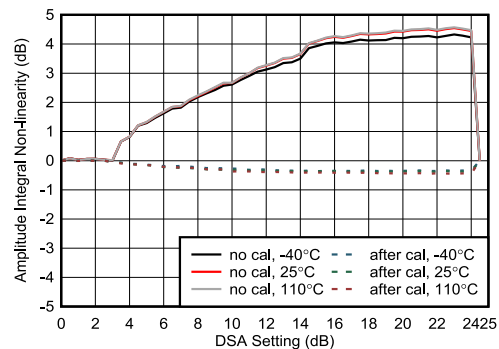


Figure 4-415. RX Amplitude Integrated Nonlinearity at 8.11 GHz

4.12.13 RX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 8.1 GHz matching.

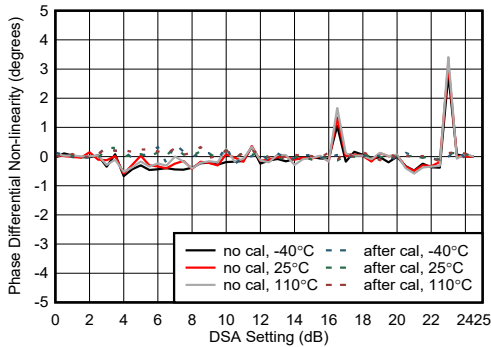


Figure 4-416. RX Phase Differential Nonlinearity at 8.11 GHz

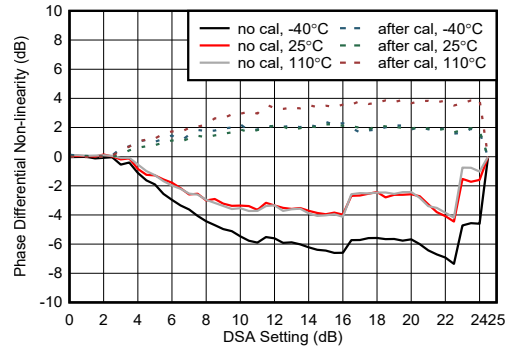


Figure 4-417. RX Phase Differential Nonlinearity at 8.11 GHz

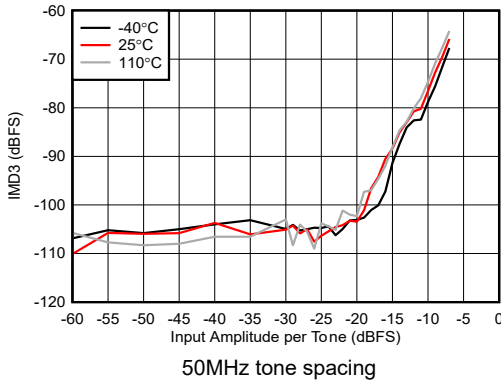


Figure 4-418. RX IMD3 vs Input Amplitude at 8.11 GHz

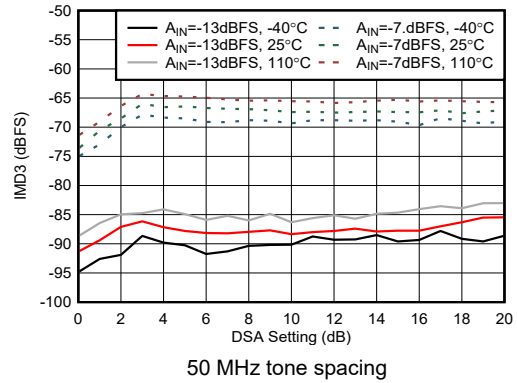


Figure 4-419. RX IMD3 vs DSA Setting at 8.11 GHz

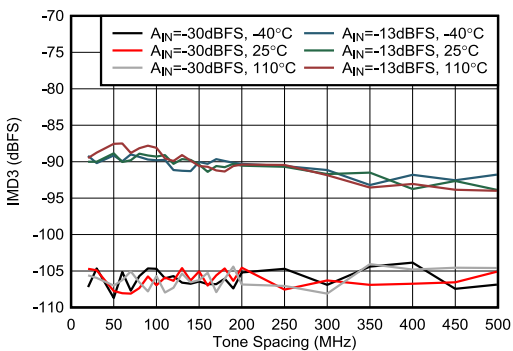


Figure 4-420. RX IMD3 vs Tone Spacing at 8.11 GHz

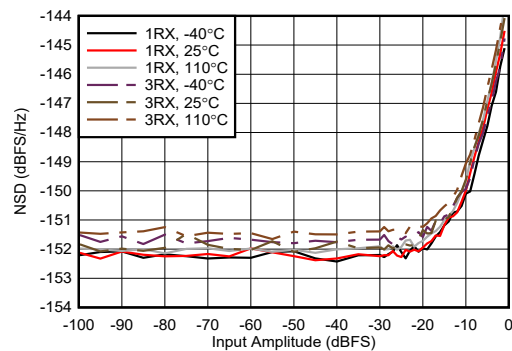


Figure 4-421. RX NSD vs Digital Amplitude at 8.11 GHz

4.12.13 RX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 8.1 GHz matching.

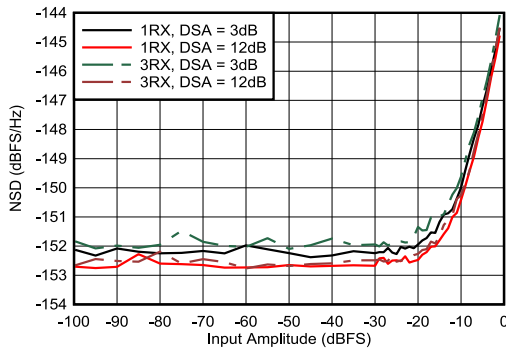


Figure 4-422. RX NSD vs Digital Amplitude at 8.1 GHz

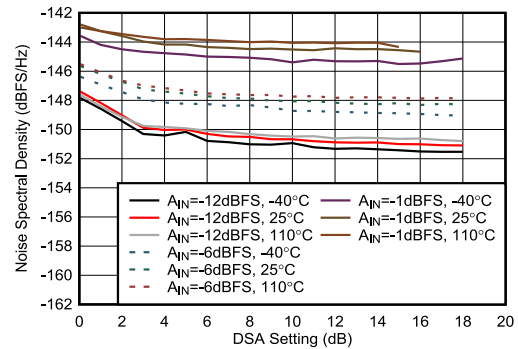


Figure 4-423. RX NSD vs DSA Setting at 8.1 GHz

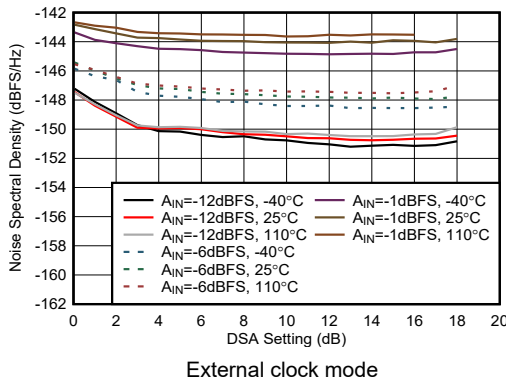


Figure 4-424. RX NSD vs DSA Setting at 8.1 GHz

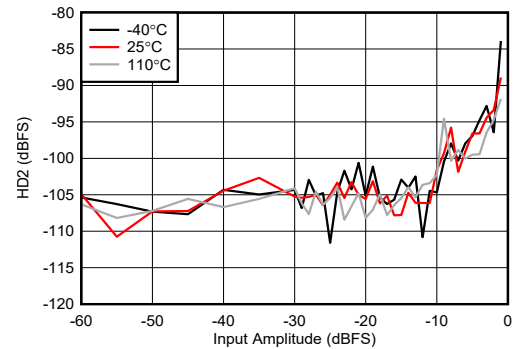


Figure 4-425. RX HD2 vs Digital Amplitude at 8.1 GHz

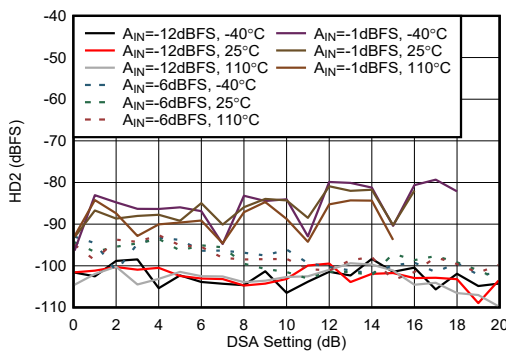


Figure 4-426. RX HD2 vs DSA Setting at 8.1 GHz

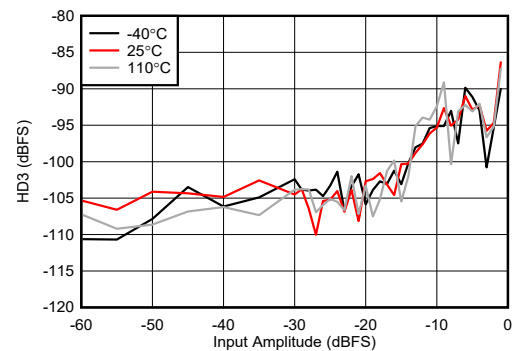


Figure 4-427. RX HD3 vs Digital Amplitude at 8.1 GHz

4.12.13 RX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 8.1 GHz matching.

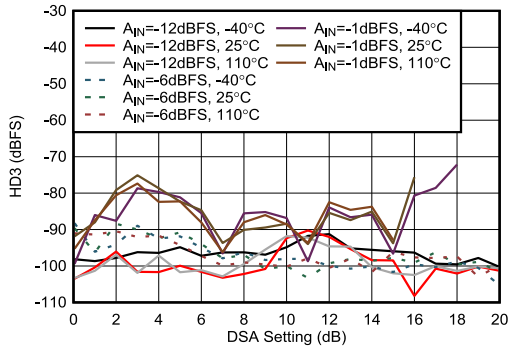


Figure 4-428. RX HD3 vs DSA Setting at 8.1 GHz

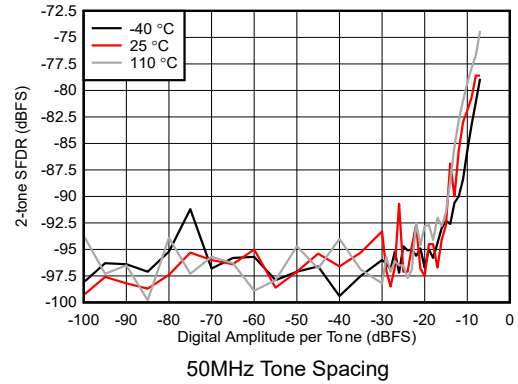


Figure 4-429. RX 2-tone SFDR vs Digital Amplitude at 8.1 GHz

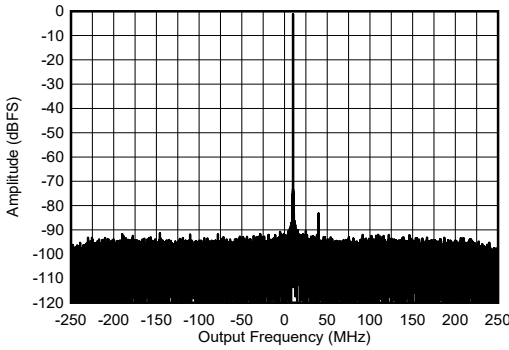


Figure 4-430. RX Single Tone Output FFT at 8.1 GHz, -1 dBFS

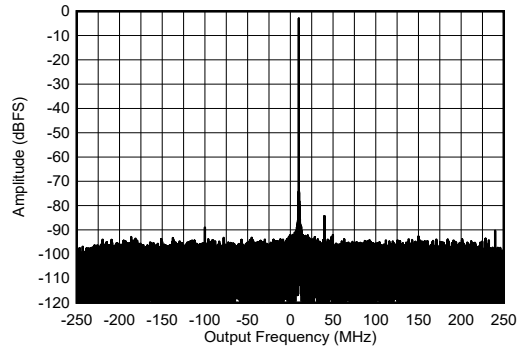


Figure 4-431. RX Single Tone Output FFT at 8.1 GHz, -3 dBFS

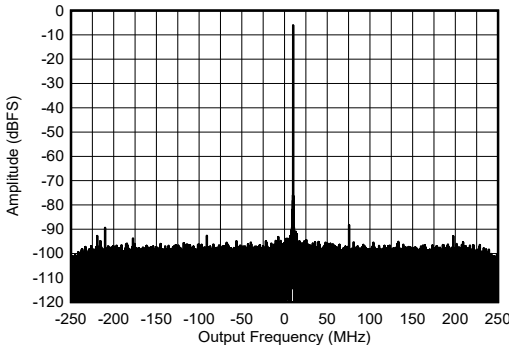


Figure 4-432. RX Single Tone Output FFT at 8.1 GHz, -6 dBFS

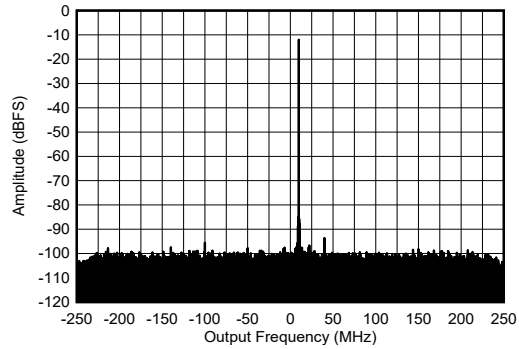


Figure 4-433. RX Single Tone Output FFT at 8.1 GHz, -12 dBFS

4.12.13 RX Typical Characteristics at 8.1 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 491.52 MSPS (decimate by 6), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 8.1 GHz matching.

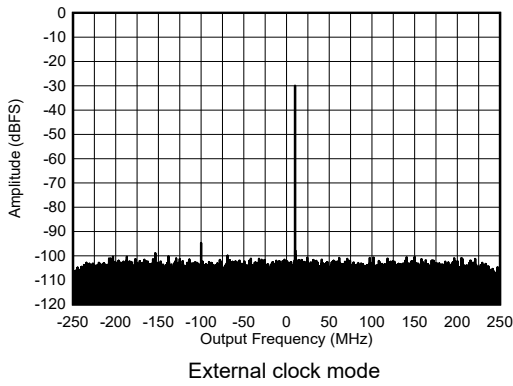


Figure 4-434. RX Single Tone Output FFT at 8.11 GHz, -30 dBFS

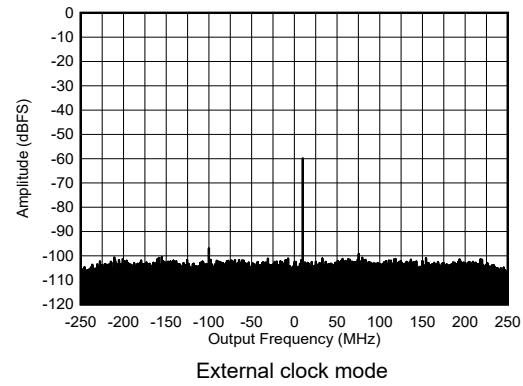


Figure 4-435. RX Single Tone Output FFT at 8.11 GHz, -60 dBFS

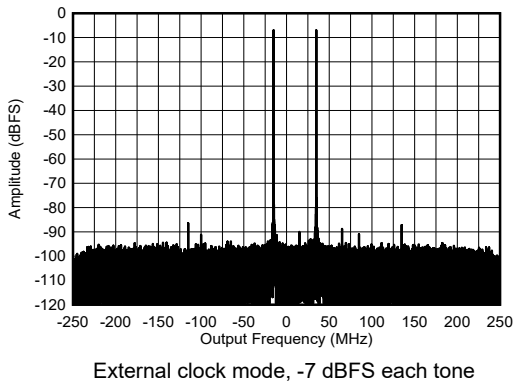


Figure 4-436. RX Dual Tone Output FFT at 8.11 GHz

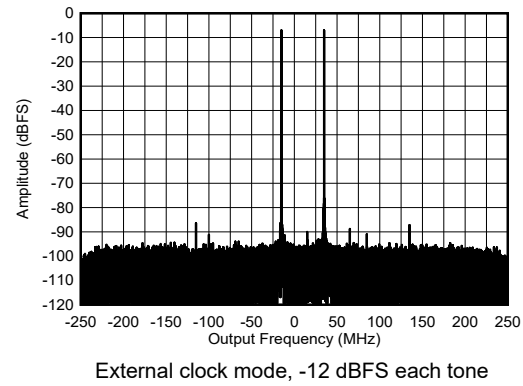


Figure 4-437. RX Dual Tone Output FFT at 8.11 GHz

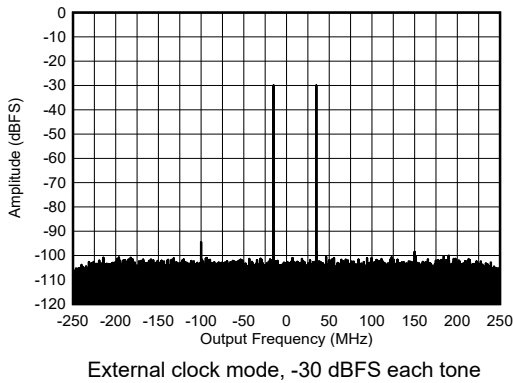


Figure 4-438. RX Dual Tone Output FFT at 8.11 GHz

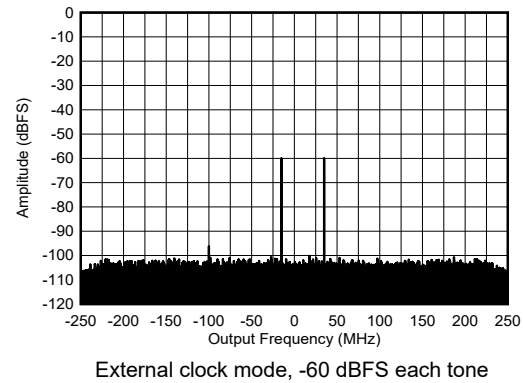


Figure 4-439. RX Dual Tone Output FFT at 8.11 GHz

4.12.14 RX Typical Characteristics at 9.6 GHz

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 1474.56 MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48\text{ MHz}$, $A_{\text{IN}} = -3\text{ dBFS}$, DSA setting = 3 dB, 9.6 GHz matching.

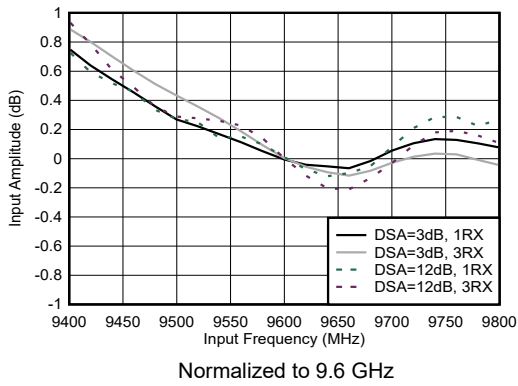


Figure 4-440. RX Input Amplitude vs Frequency

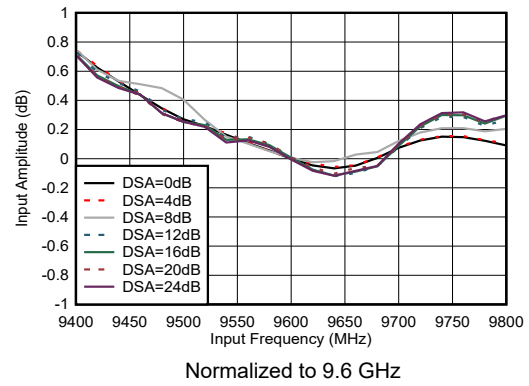


Figure 4-441. RX Input Amplitude vs Frequency at 9.6 GHz

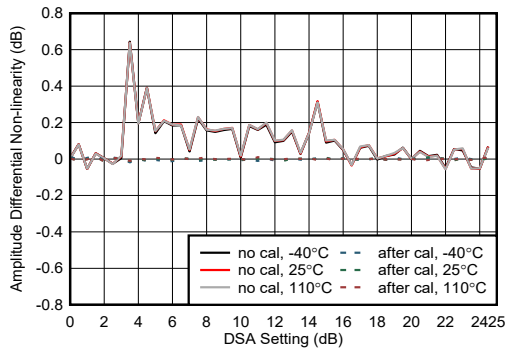


Figure 4-442. RX Amplitude Differential Non-linearity at 9.6 GHz

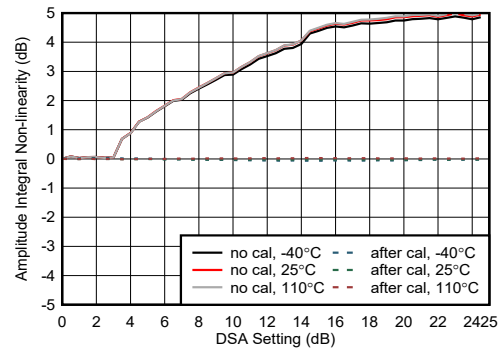


Figure 4-443. RX Amplitude Integrated Non-linearity at 9.6 GHz

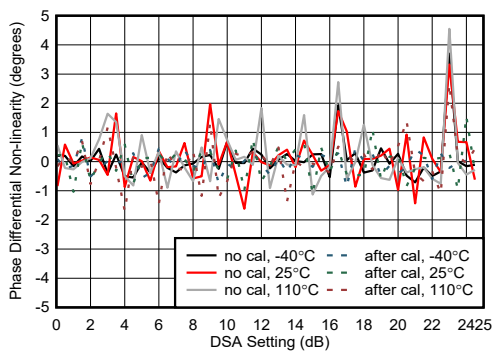


Figure 4-444. RX Phase Differential Non-linearity at 9.6 GHz

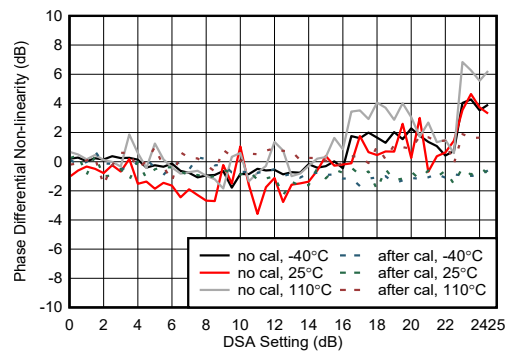


Figure 4-445. RX Phase Integrated Non-linearity at 9.6 GHz

4.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 1474.56 MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 9.6 GHz matching.

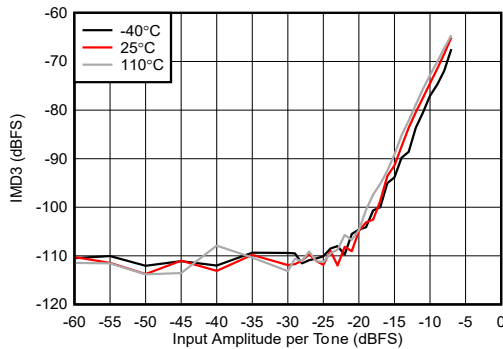
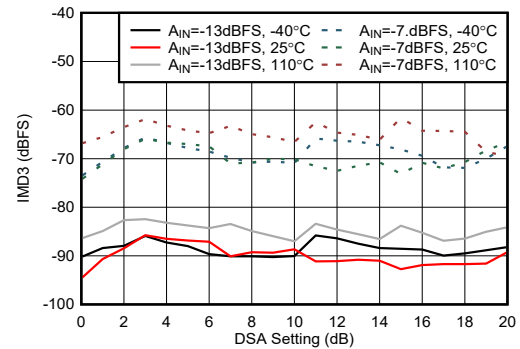
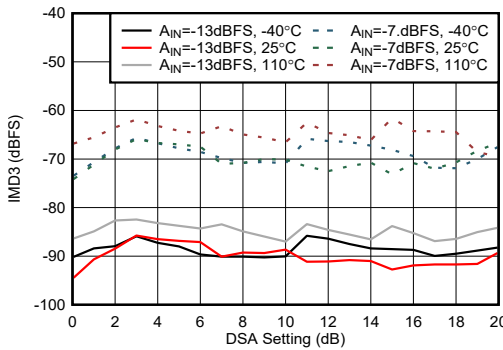


Figure 4-446. RX IMD3 vs Digital Amplitude at 9.6 GHz



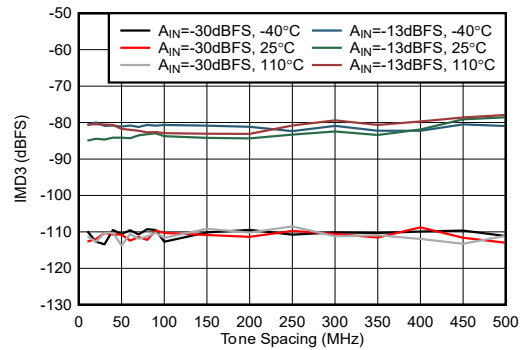
50 MHz tone spacing

Figure 4-447. RX IMD3 vs DSA Setting at 9.6 GHz



50 MHz tone spacing

Figure 4-448. RX IMD3 vs DSA Setting at 9.6 GHz



50 MHz tone spacing

Figure 4-449. RX IMD3 vs Tone Spacing at 9.6 GHz

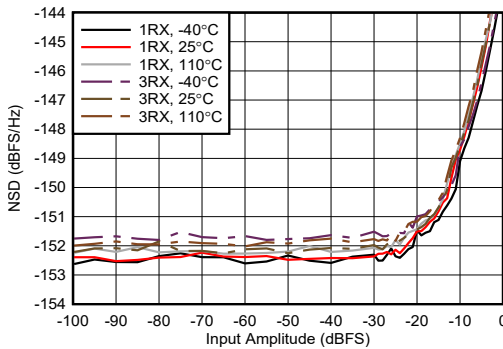


Figure 4-450. RX NSD vs Digital Amplitude at 9.6 GHz

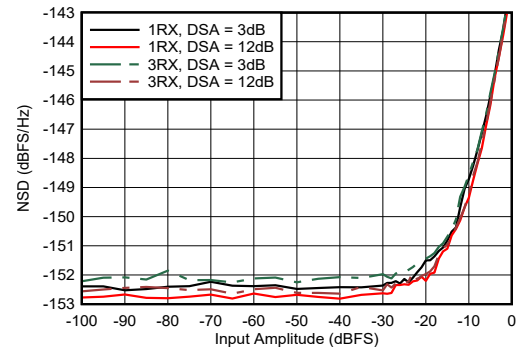


Figure 4-451. RX NSD vs Digital Amplitude at 9.6 GHz

4.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 1474.56 MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 9.6 GHz matching.

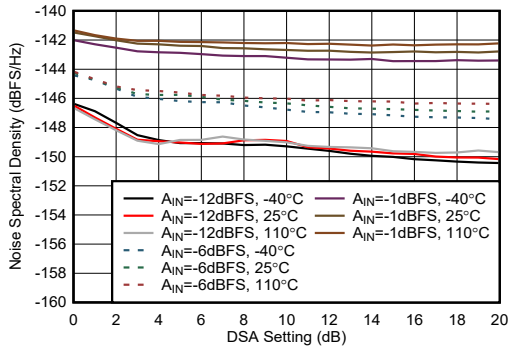


Figure 4-452. RX NSD vs DSA Setting at 9.6 GHz

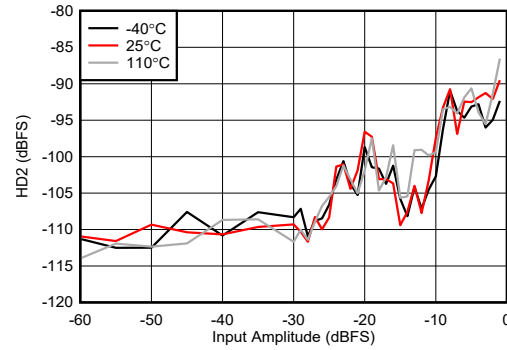


Figure 4-453. RX HD2 vs Digital Level at 9.6 GHz

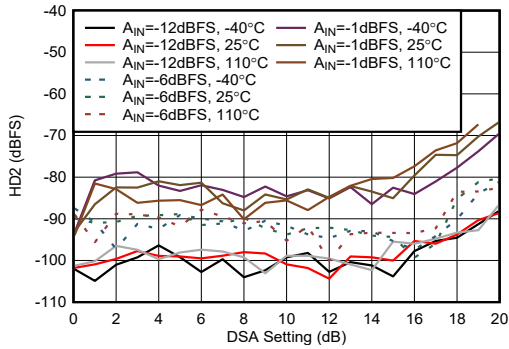


Figure 4-454. RX HD2 vs DSA Setting at 9.6 GHz

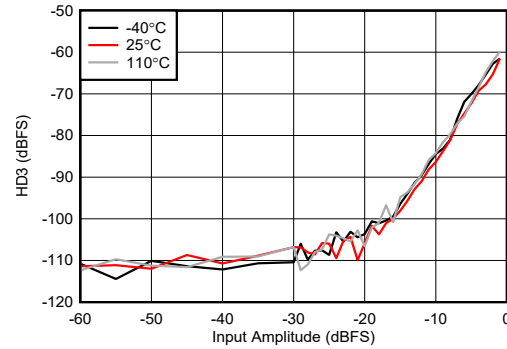


Figure 4-455. RX HD3 vs Digital Level at 9.6 GHz

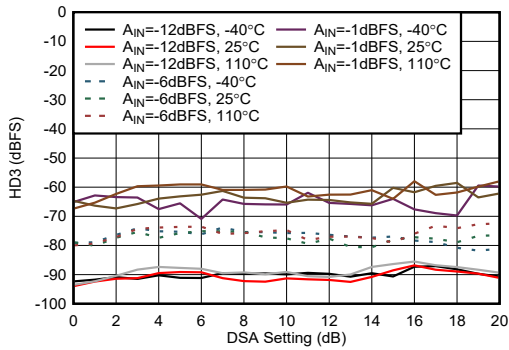
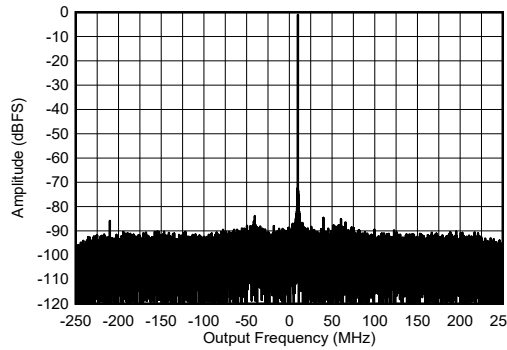


Figure 4-456. RX HD3 vs DSA Setting at 9.6 GHz

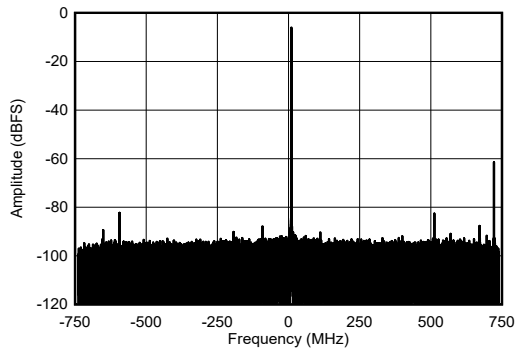


-1 dBFS

Figure 4-457. RX Single Tone Output FFT at 9.61 GHz

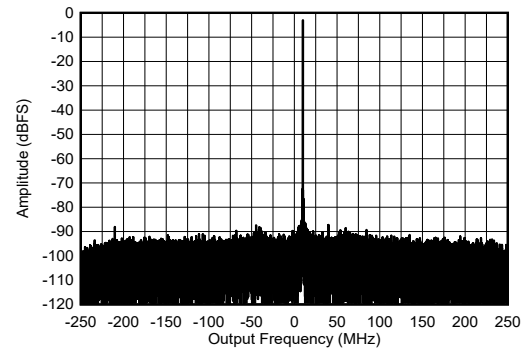
4.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 1474.56 MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 9.6 GHz matching.



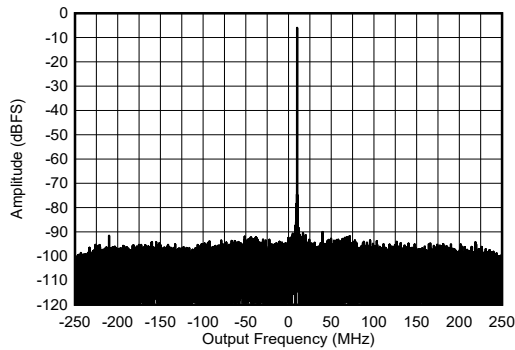
-6 dBFS

Figure 4-458. RX Single Tone Output FFT at 9.61 GHz



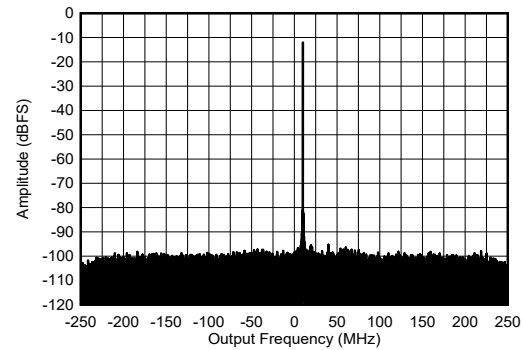
-3 dBFS

Figure 4-459. RX Single Tone Output FFT at 9.61 GHz



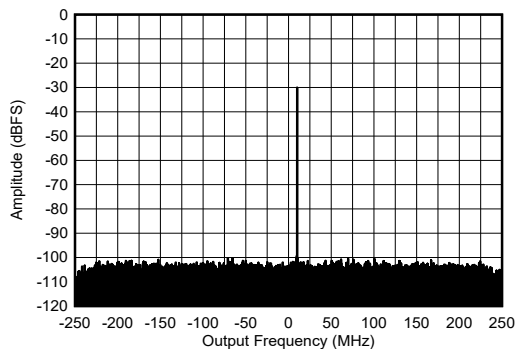
-6 dBFS

Figure 4-460. RX Single Tone Output FFT at 9.61 GHz



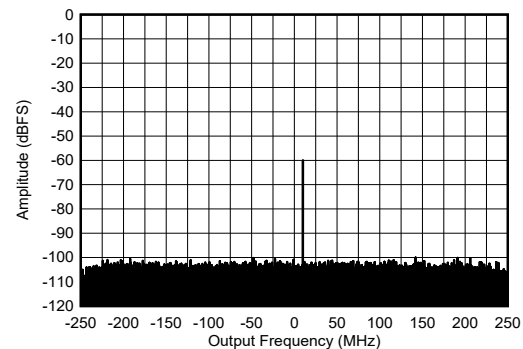
-12 dBFS

Figure 4-461. RX Single Tone Output FFT at 9.61 GHz



-30 dBFS

Figure 4-462. RX Single Tone Output FFT at 9.61 GHz

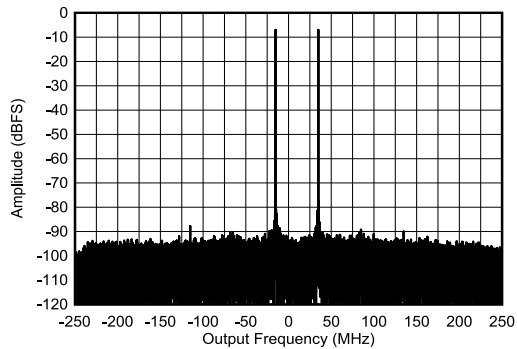


-60 dBFS

Figure 4-463. RX Single Tone Output FFT at 9.61 GHz

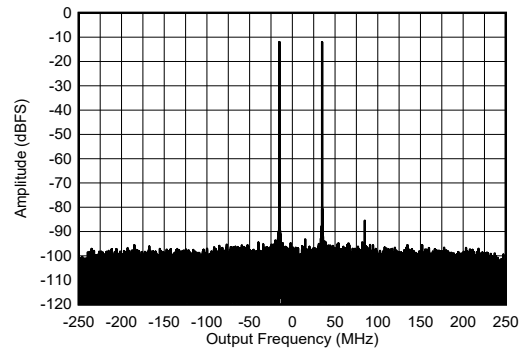
4.12.14 RX Typical Characteristics at 9.6 GHz (continued)

Typical values at $T_A = +25^\circ\text{C}$, ADC Sampling Rate = 2949.12 MHz. Default conditions: output sample rate = 1474.56 MSPS (decimate by 2), External clock mode with $f_{\text{CLK}} = 11796.48 \text{ MHz}$, $A_{\text{IN}} = -3 \text{ dBFS}$, DSA setting = 3 dB, 9.6 GHz matching.



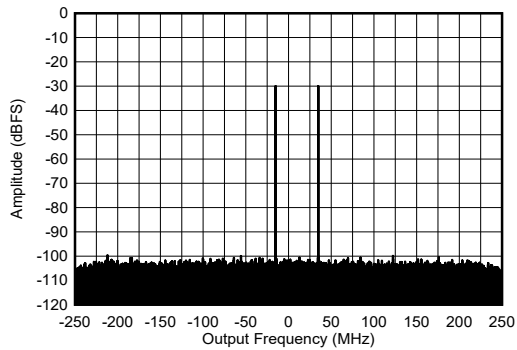
9.585 and 9.635 GHz, -7 dBFS each tone

Figure 4-464. RX Two Tone Output FFT at 9.61 GHz



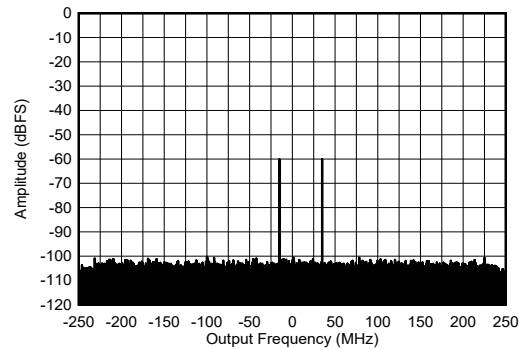
9.585 and 9.635 GHz, -12 dBFS each tone

Figure 4-465. RX Two Tone Output FFT at 9.61 GHz



9.585 and 9.635 GHz, -30 dBFS each tone

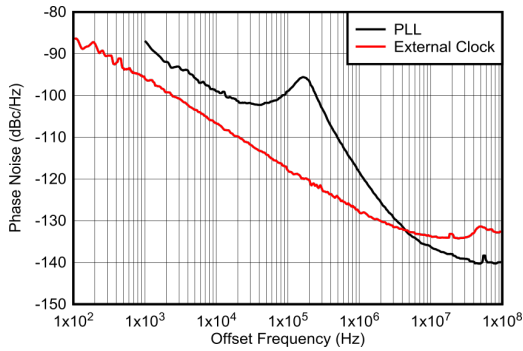
Figure 4-466. RX Two Tone Output FFT at 9.61 GHz



9.585 and 9.635 GHz, -60 dBFS each tone

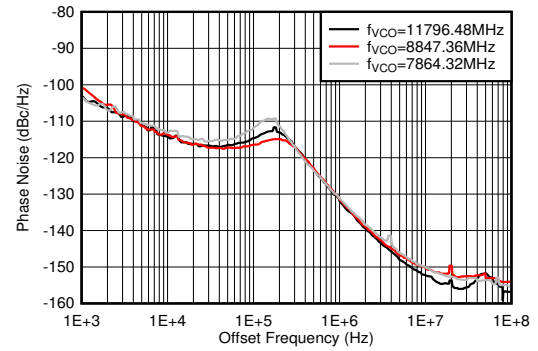
Figure 4-467. RX Two Tone Output FFT at 9.61 GHz

4.12.15 PLL and Clock Typical Characteristics



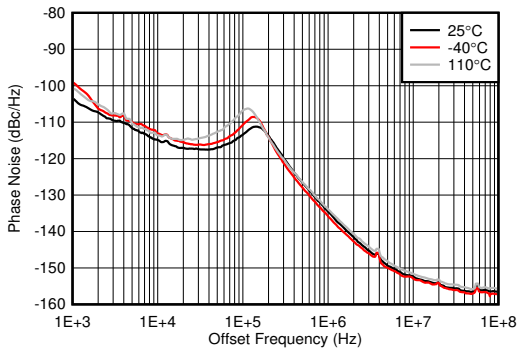
measured at TX output, normalized to 12 GHz by $20 \times \log_{10}(12\text{GHz}/F_{\text{OUT}})$

Figure 4-468. Phase Noise vs Offset Frequency for PLL and External Clock at 12 GHz



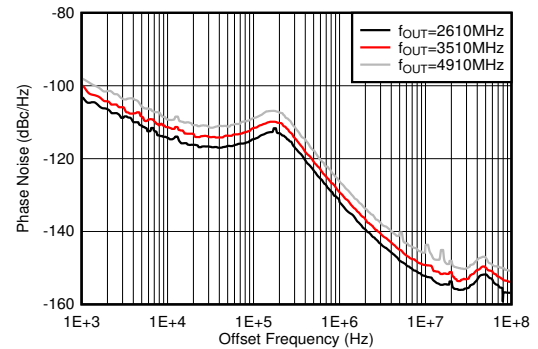
PLL enabled, $f_{\text{REF}} = 491.52$ MSPS, measured at TX output

Figure 4-469. Phase Noise vs Offset Frequency and f_{VCO} at $f_{\text{OUT}} = 2610$ MHz



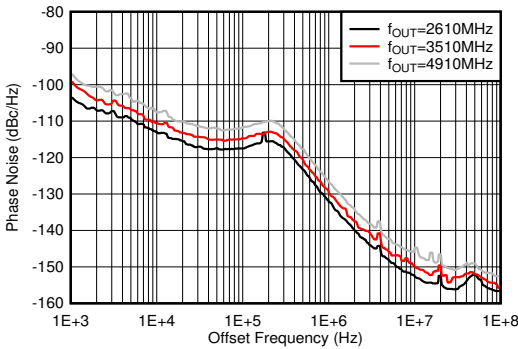
PLL enabled, $f_{\text{VCO}} = 11796.48$ MHz, $f_{\text{REF}} = 491.52$ MSPS, measured at TX output

Figure 4-470. Phase Noise for 12-GHz VCO vs Offset Frequency and Temperature at $f_{\text{OUT}} = 1910$ MHz



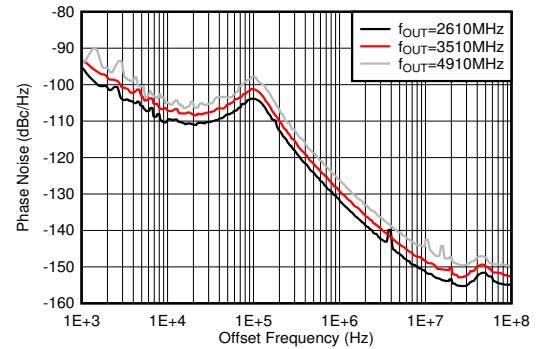
PLL enabled, $f_{\text{VCO}} = 11796.48$ MHz, $f_{\text{REF}} = 491.52$ MSPS, measured at TX output

Figure 4-471. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



PLL enabled, $f_{\text{VCO}} = 11796.48$ MHz, $f_{\text{REF}} = 491.52$ MSPS, measured at TX output

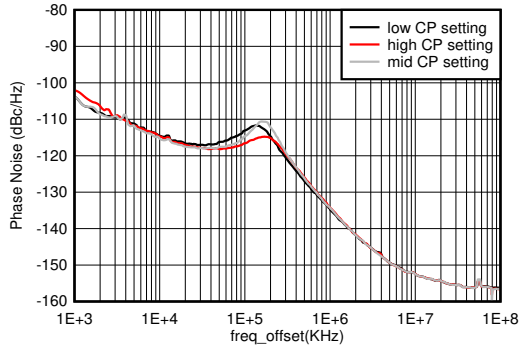
Figure 4-472. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at -40°C



PLL enabled, $f_{\text{VCO}} = 11796.48$ MHz, $f_{\text{REF}} = 491.52$ MSPS, measured at TX output

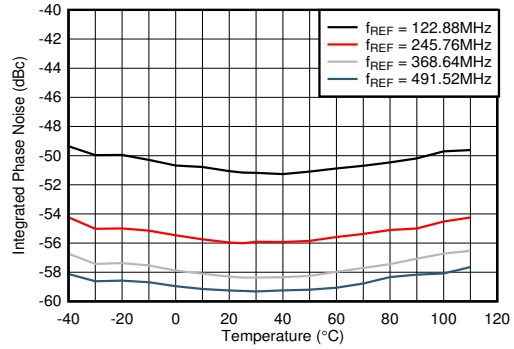
Figure 4-473. Phase Noise for 12-GHz VCO vs Offset Frequency and f_{OUT} at 110°C

4.12.15 PLL and Clock Typical Characteristics (continued)



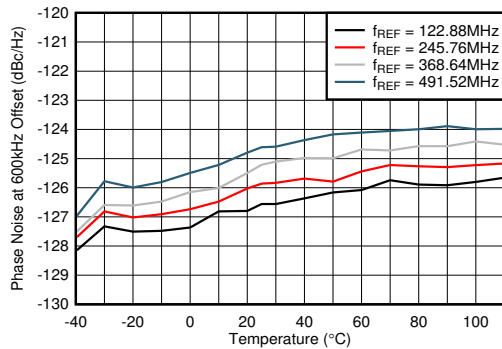
PLL enabled, $f_{VCO} = 11796.48$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-474. Phase Noise for 12-GHz VCO vs Offset Frequency and CP Setting at $f_{OUT} = 2.6$ GHz



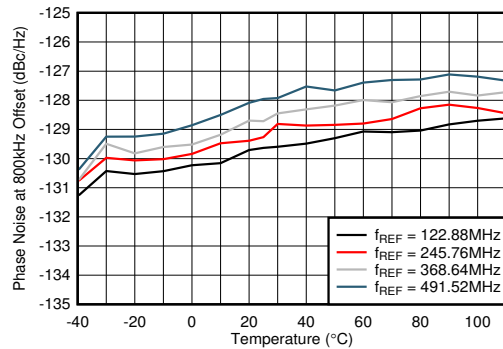
PLL enabled, $f_{VCO} = 11796.48$ MHz, 1-kHz to 100-MHz, single-sided integration bandwidth, measured at TX output

Figure 4-475. Integrated Phase Noise for 12-GHz VCO vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



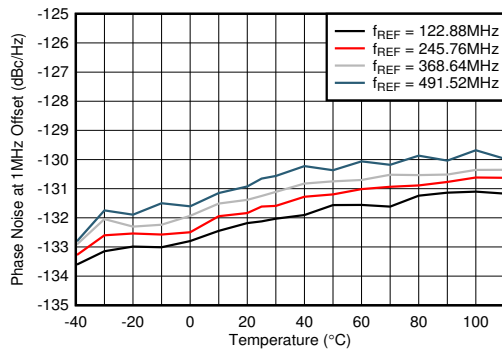
PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

Figure 4-476. Phase Noise for 12-GHz VCO at 600 kHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



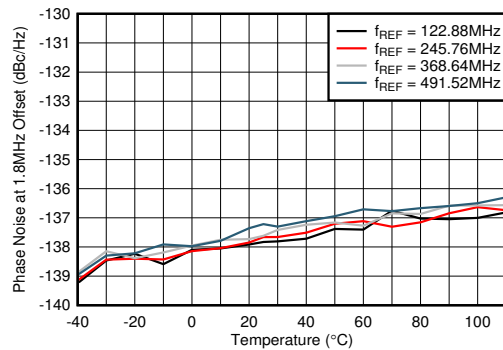
A. PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

Figure 4-477. Phase Noise for 12-GHz VCO at 800-kHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

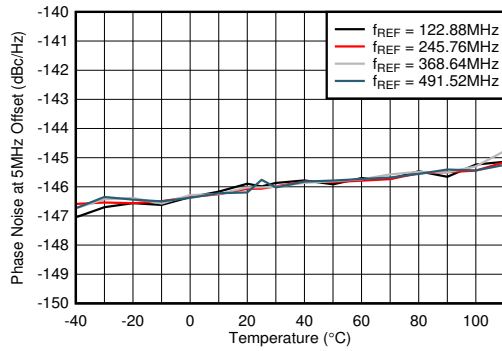
Figure 4-478. Phase Noise for 12-GHz VCO at 1-MHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

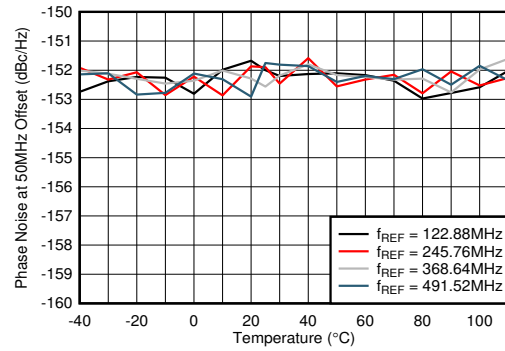
Figure 4-479. Phase Noise for 12-GHz VCO at 1.8-MHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz

4.12.15 PLL and Clock Typical Characteristics (continued)



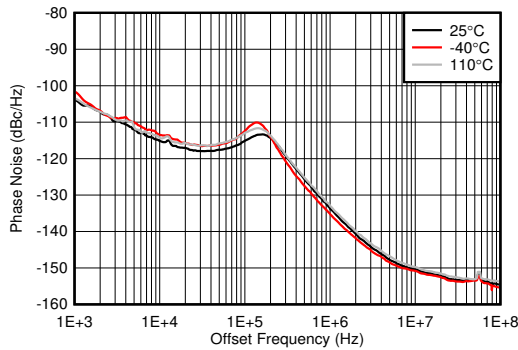
PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

Figure 4-480. Phase Noise for 12-GHz VCO at 5-MHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



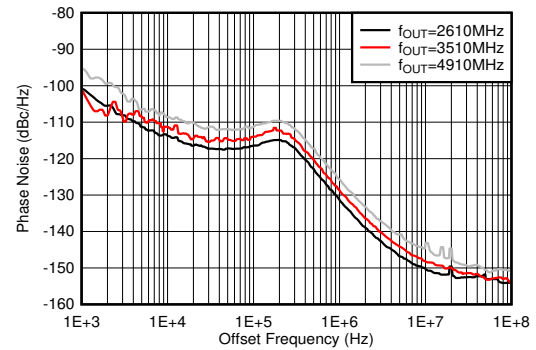
PLL enabled, $f_{VCO} = 11796.48$ MHz, measured at TX output

Figure 4-481. Phase Noise for 12-GHz VCO at 50-MHz Offset vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



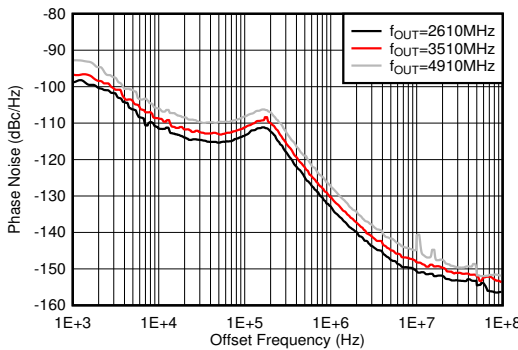
PLL enabled, $f_{VCO} = 9830.4$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-482. Phase Noise for 10-GHz VCO vs Offset Frequency and Temperature at $f_{OUT} = 1910$ MHz



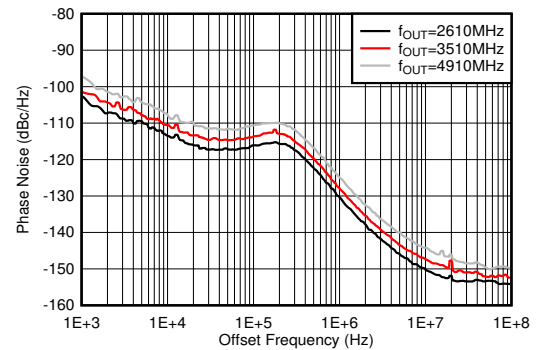
PLL enabled, $f_{VCO} = 9830.4$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-483. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



PLL enabled, $f_{VCO} = 9830.4$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

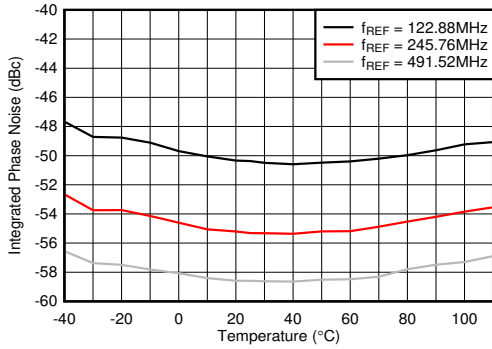
Figure 4-484. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at -40°C



PLL enabled, $f_{VCO} = 9830.4$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

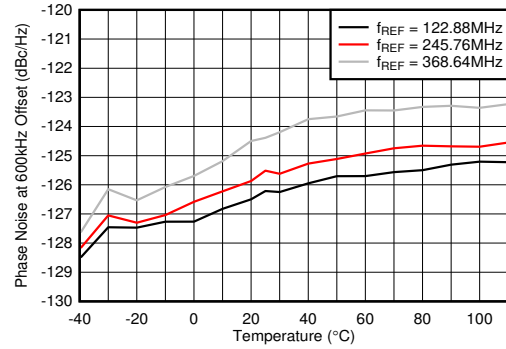
Figure 4-485. Phase Noise for 10-GHz VCO vs Offset Frequency and f_{OUT} at 110°C

4.12.15 PLL and Clock Typical Characteristics (continued)



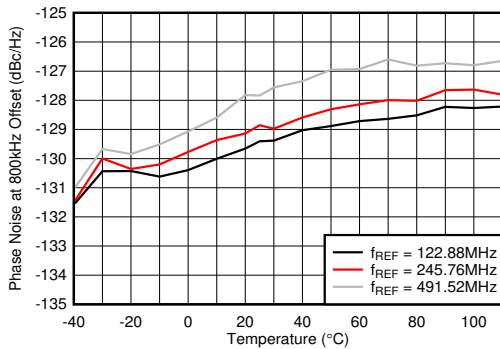
PLL enabled, $f_{VCO} = 9830.4$ MHz, 1-kHz to 100-MHz, single-sided integration bandwidth, measured at TX output

Figure 4-486. Integrated Phase Noise for 10-GHz VCO vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



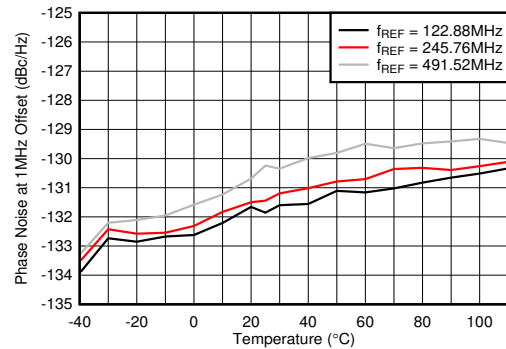
PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

Figure 4-487. Phase Noise for 10-GHz VCO at 600 kHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



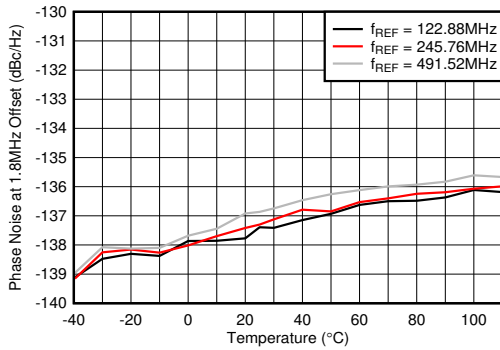
PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

Figure 4-488. Phase Noise for 10-GHz VCO at 800 kHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



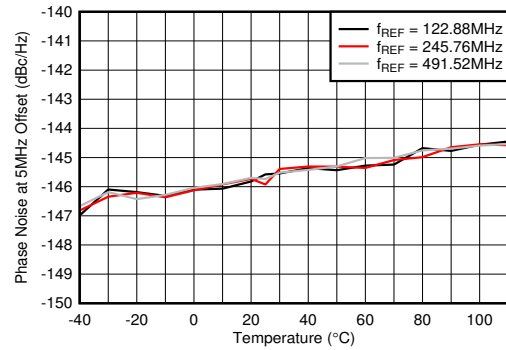
PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

Figure 4-489. Phase Noise for 10-GHz VCO at 1 MHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

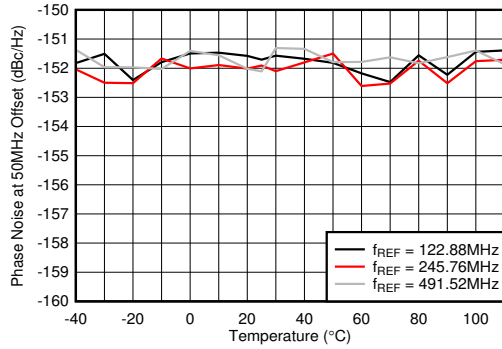
Figure 4-490. Phase Noise for 10-GHz VCO at 1.8 MHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

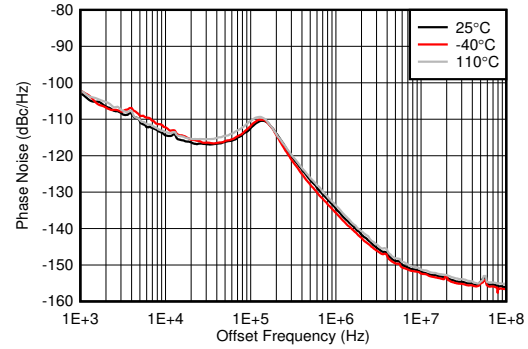
Figure 4-491. Phase Noise for 10-GHz VCO at 5 MHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz

4.12.15 PLL and Clock Typical Characteristics (continued)



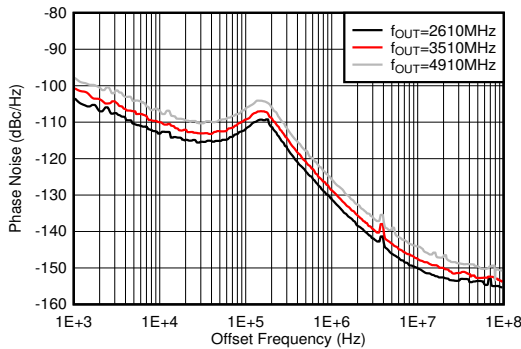
PLL enabled, $f_{VCO} = 9830.4$ MHz, measured at TX output

Figure 4-492. Phase Noise for 10-GHz VCO at 50 MHz vs Temperature and f_{REF} at $f_{OUT} = 2.6$ GHz



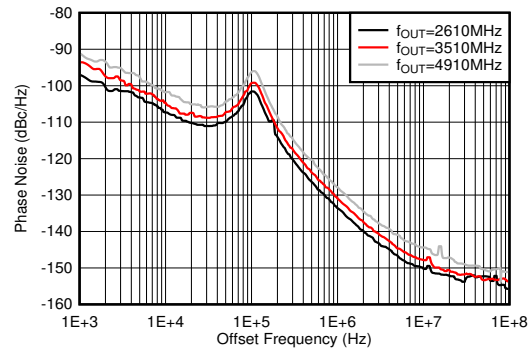
PLL enabled, $f_{VCO} = 8847.36$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-493. Phase Noise for 9-GHz VCO vs Offset Frequency and Temperature at $f_{OUT} = 1910$ MHz



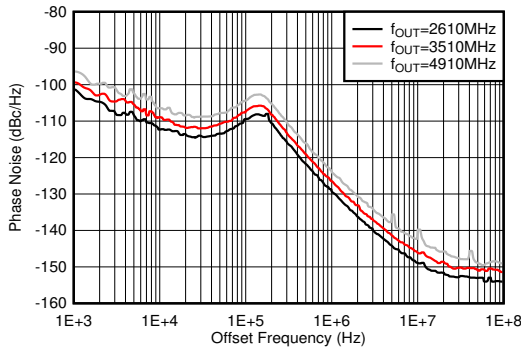
PLL enabled, $f_{VCO} = 8847.36$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-494. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at 25°C



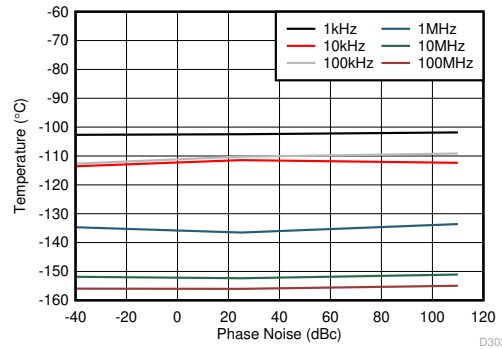
PLL enabled, $f_{VCO} = 8847.36$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-495. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at -40°C



PLL enabled, $f_{VCO} = 8847.36$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

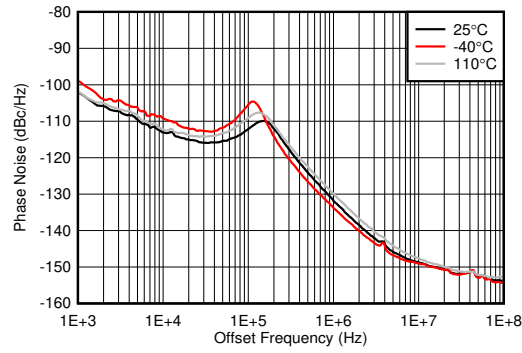
Figure 4-496. Phase Noise for 9-GHz VCO vs Offset Frequency and f_{OUT} at 110°C



PLL enabled, $f_{VCO} = 8847.36$ MHz, $f_{REF} = 491.52$ MSPS, minimum LPF BW, measured at TX output

Figure 4-497. Phase Noise for 9-GHz VCO vs Temperature Over Offset Frequency at $f_{OUT} = 2.6$ GHz

4.12.15 PLL and Clock Typical Characteristics (continued)



PLL enabled, $f_{VCO} = 7864.32$ MHz, $f_{REF} = 491.52$ MSPS, measured at TX output

Figure 4-498. Phase Noise for 8-GHz VCO vs Offset Frequency and Temperature at $f_{OUT} = 1910$ MHz

5 Device and Documentation Support

5.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

5.2 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

5.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.
All trademarks are the property of their respective owners.

5.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

5.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

6 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from May 24, 2023 to May 1, 2025 (from Revision * (May 2023) to Revision A (May 2025))

	<u>Page</u>
• RX Input Max Power moved from RF ADC Electrical Characteristics to Absolute Maximum Ratings.....	4

7 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
AFE7953IABJ	Active	Production	FCBGA (ABJ) 400	90 JEDEC TRAY (5+1)	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	AFE7953I
AFE7953IALK	Active	Production	FCBGA (ALK) 400	90 JEDEC TRAY (5+1)	No	SNPB	Level-3-220C-168 HR	-40 to 85	AFE7953 SNPB

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

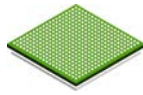
TRAY


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
AFE7953IABJ	ABJ	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2
AFE7953IABJ	ABJ	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2
AFE7953IALK	ALK	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2
AFE7953IALK	ALK	FCBGA	400	90	6 x 15	150	315	135.9	7620	19.5	21	19.2

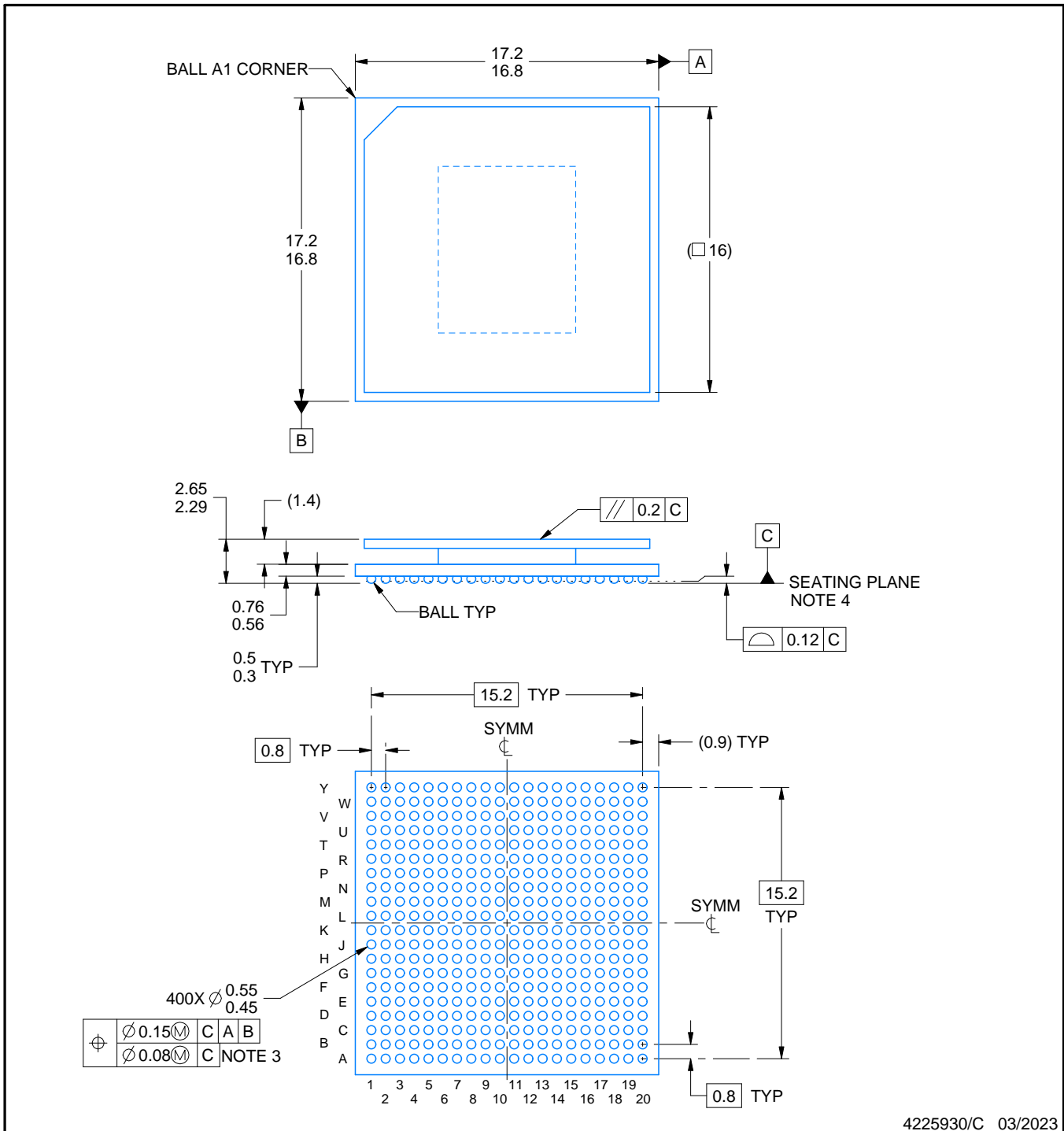
ALK0400A



PACKAGE OUTLINE

FCBGA - 2.65 mm max height

BALL GRID ARRAY



4225930/C 03/2023

NOTES:

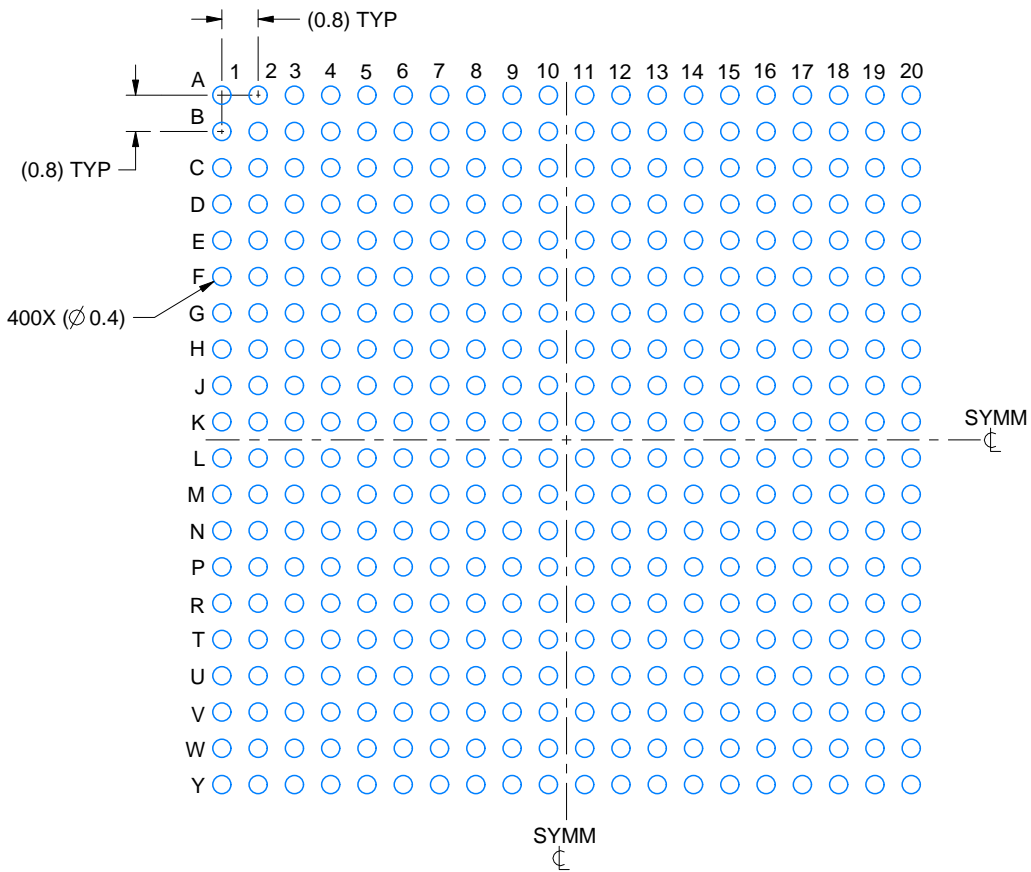
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
4. Primary datum C and seating plane are defined by the spherical crowns of the solder balls.
5. Pb-Free die bump and SnPb solder ball.
6. The lids are electrically floating (e.g. not tied to GND).

EXAMPLE BOARD LAYOUT

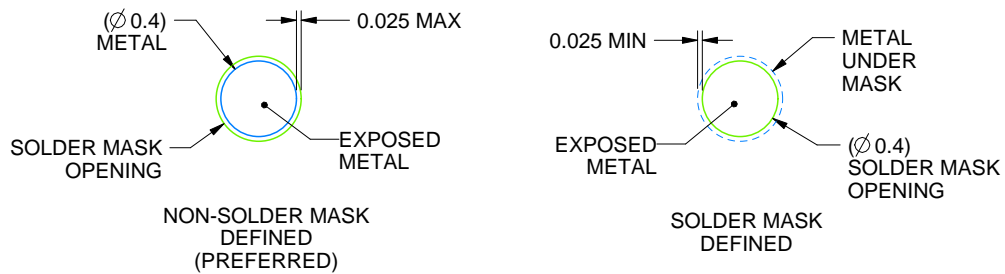
ALK0400A

FCBGA - 2.65 mm max height

BALL GRID ARRAY



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS
NOT TO SCALE

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NOTES: (continued)

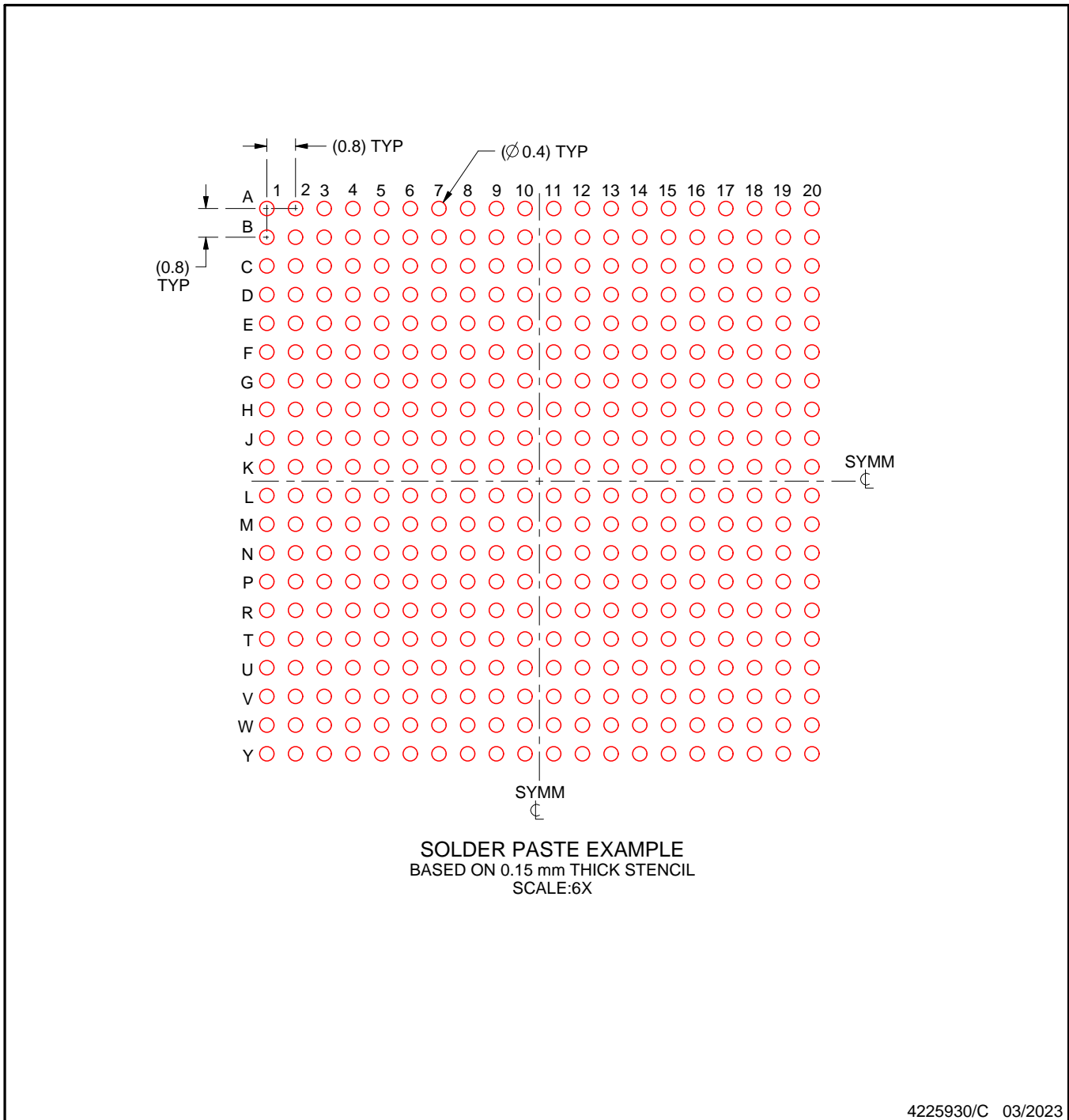
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SPRU811 (www.ti.com/lit/spru811).

EXAMPLE STENCIL DESIGN

ALK0400A

FCBGA - 2.65 mm max height

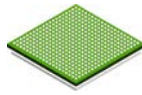
BALL GRID ARRAY



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

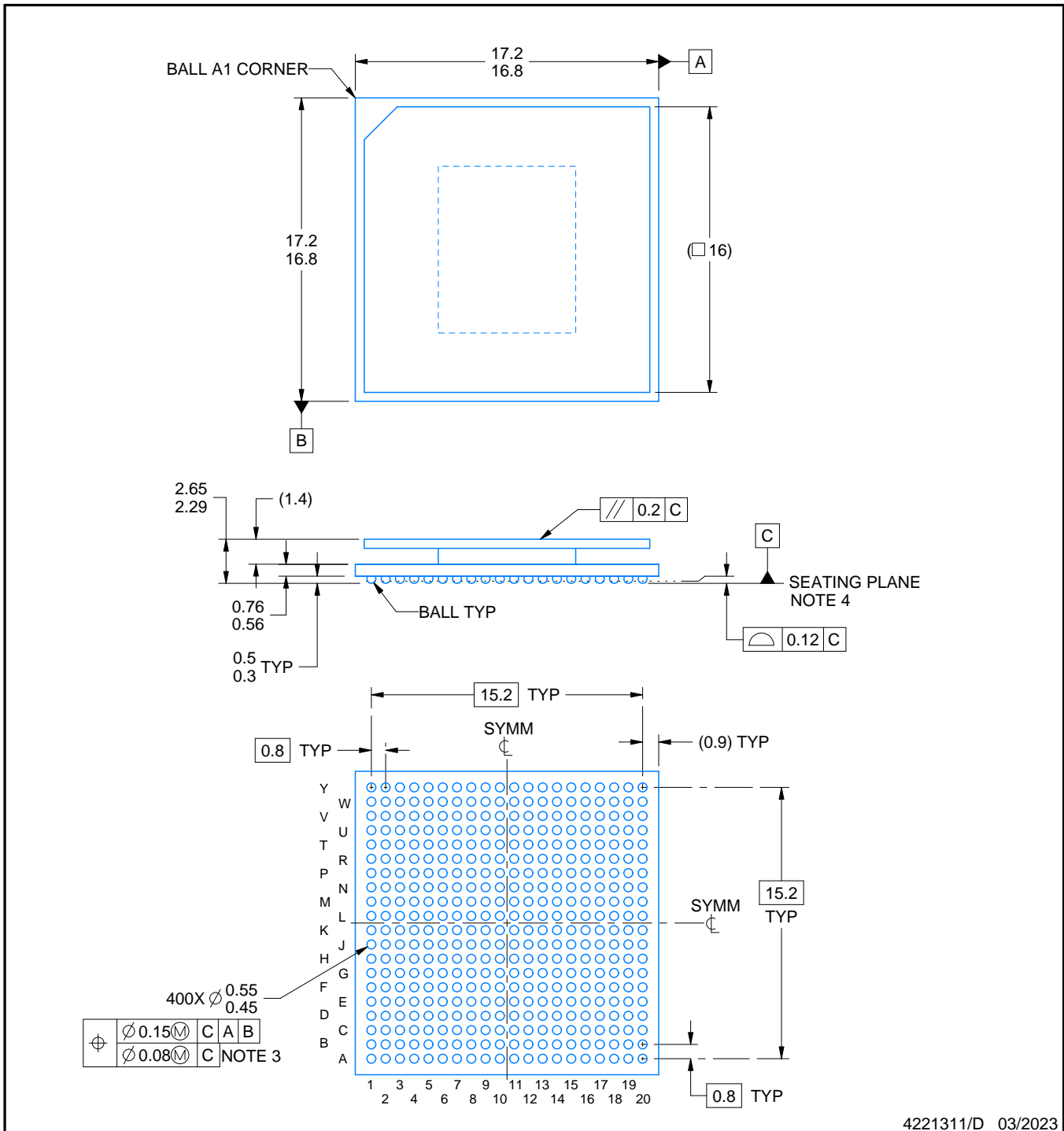
ABJ0400A



PACKAGE OUTLINE

FCBGA - 2.65 mm max height

BALL GRID ARRAY



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NOTES:

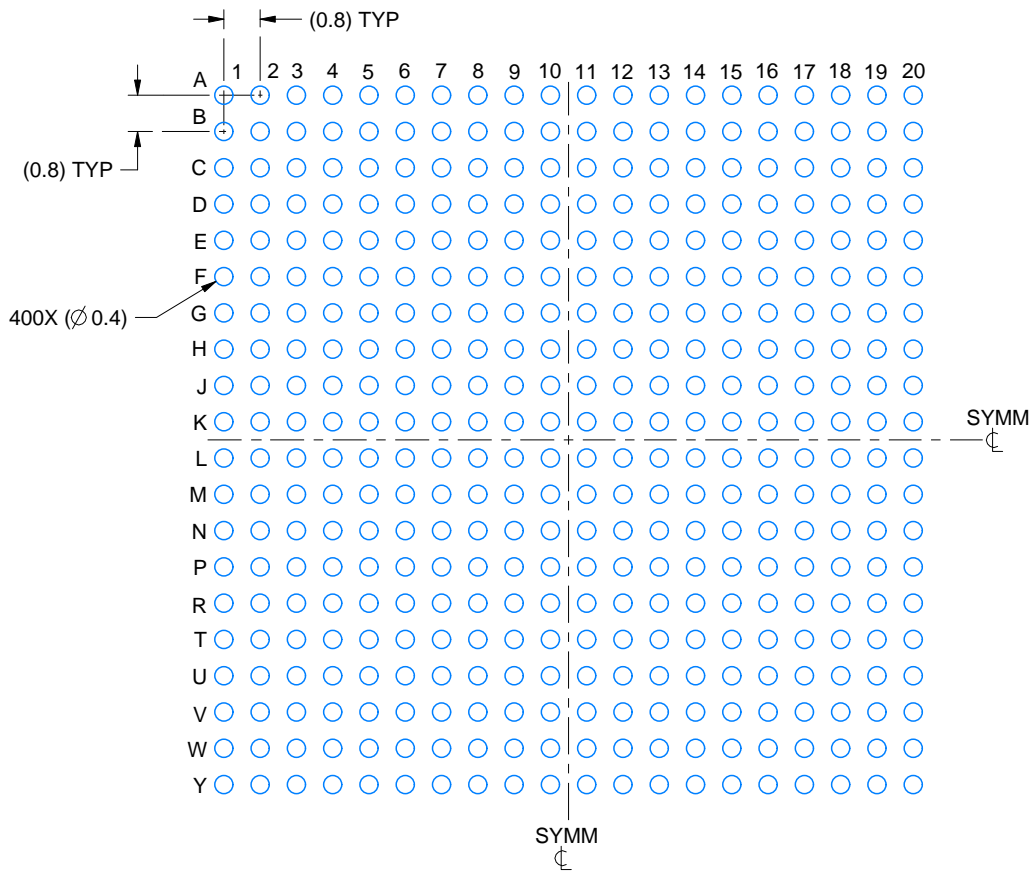
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
4. Primary datum C and seating plane are defined by the spherical crowns of the solder balls.
5. The lids are electrically floating (e.g. not tied to GND).

EXAMPLE BOARD LAYOUT

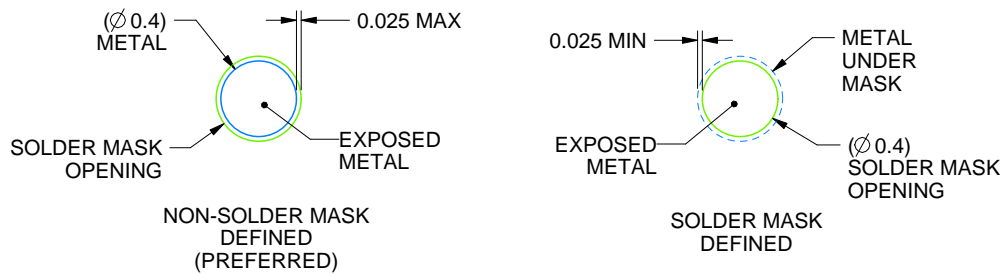
ABJ0400A

FCBGA - 2.65 mm max height

BALL GRID ARRAY



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS
NOT TO SCALE

4221311/D 03/2023

NOTES: (continued)

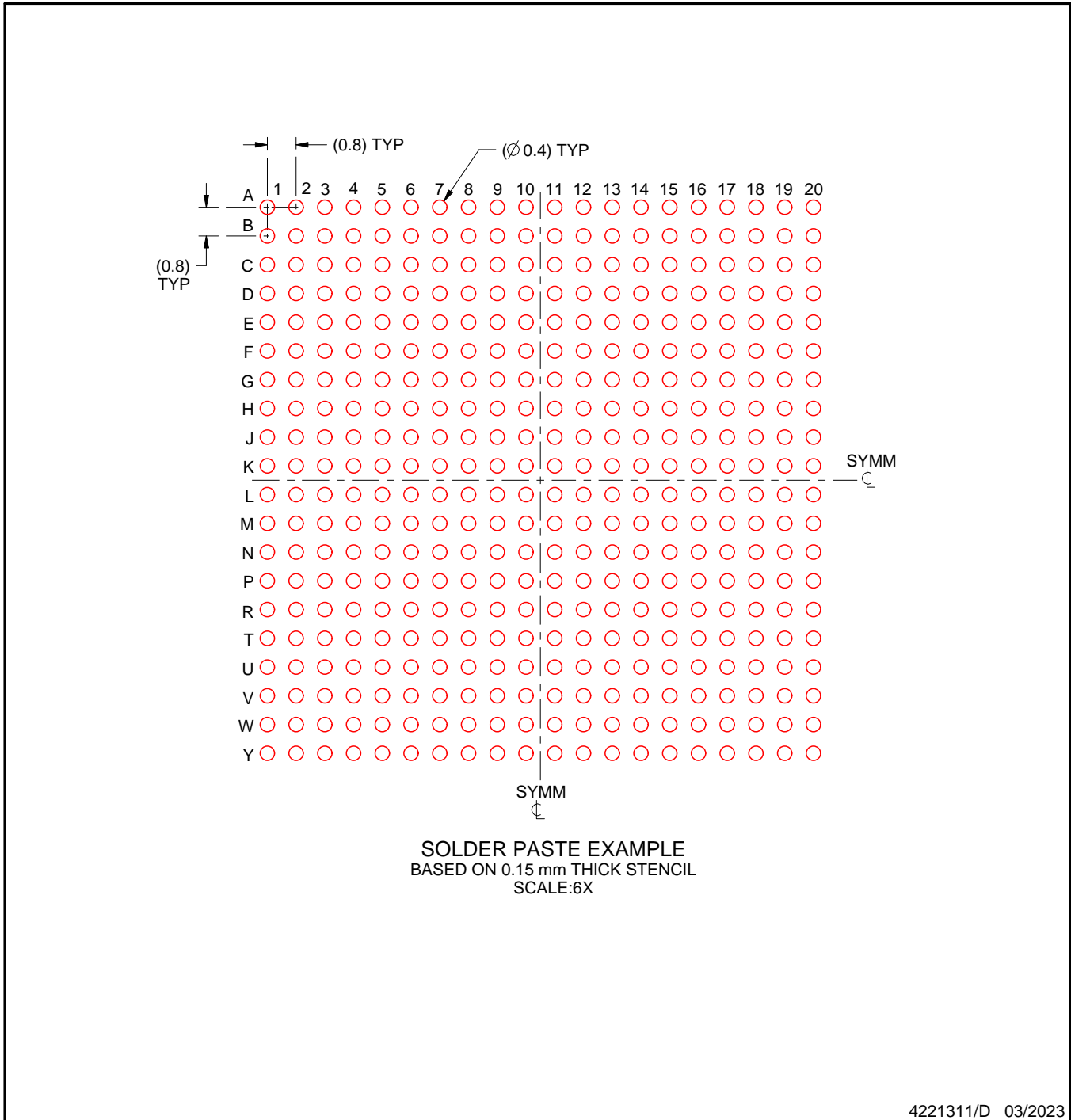
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SPRU811 (www.ti.com/lit/spru811).

EXAMPLE STENCIL DESIGN

ABJ0400A

FCBGA - 2.65 mm max height

BALL GRID ARRAY



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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